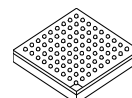


MCIMX7SxDxxxxxD  
MCIMX7SxExxxxxD

# i.MX 7Solo Family of Applications Processors Datasheet



## Package Information

Plastic Package  
BGA 12 x 12 mm, 0.4 mm pitch  
BGA 19 x 19 mm, 0.75 mm pitch

## Ordering Information

See [Table 1 on page 3](#)

## 1 i.MX 7Solo introduction

The i.MX 7Solo family of processors represents NXP's latest achievement in high-performance processing for low-power requirements with a high degree of functional integration. These processors are targeted towards the growing market of connected and portable devices.

The i.MX 7Solo family of processors features advanced implementation of the Arm® Cortex®-A7 core, which operates at speeds of up to 800 MHz. The i.MX 7Solo family provides up to 32-bit DDR3/DDR3L/LPDDR2/LPDDR3-1066 memory interface and a number of other interfaces for connecting peripherals, such as WLAN, Bluetooth, GPS, displays, and camera sensors.

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The i.MX 7Solo family of processors is specifically useful for applications such as:

- Audio
- Connected devices
- Access control panels
- Human-machine interfaces (HMI)
- Portable medical and health care
- IP phones
- Smart appliances
- Point of Sale
- eReaders
- Wearables
- Home energy management systems

The features of the i.MX 7Solo family of processors include the following:

- Arm Cortex-A7 plus Arm Cortex-M4—Heterogeneous Multicore Processing architecture enables the device to run an open operating system like Linux/Android on the Cortex-A7 core and an RTOS like FreeRTOS™ on the Cortex-M4 core.
- Arm Cortex-A7 core—The processor enhances the capabilities of portable, connected applications by fulfilling the ever-increasing MIPS needs of operating systems and applications at lowest power consumption levels per MHz.
- Multilevel memory system—The multilevel Cortex-A7 memory system is based on the L1 instruction and data caches, L2 cache, and internal and external memory. The processor supports many types of external memory devices, including DDR3, DDR3L, LPDDR2 and LPDDR3, NOR Flash, NAND Flash (MLC and SLC), QSPI Flash, and managed NAND, including eMMC rev.
- Power efficiency—Power management implemented throughout the IC enables features and peripherals to consume minimum power in both active and various low-power modes.
- Multimedia—The multimedia performance is enhanced by a multilevel cache system, NEON™ MPE (Media Processor Engine) coprocessor, a programmable smart DMA (SDMA) controller.
- Gigabit Ethernet with AVB—10/100/1000 Mbps Ethernet controllers supporting IEEE Std 1588 time synchronization.
- Human-machine interface (HMI)—i.MX 7Solo processor provides up to two separate display interfaces (parallel display and two-lane MIPI-DSI), CMOS sensor interface (two-lane MIPI-CSI and parallel).
- Interface flexibility—i.MX 7Solo processor supports connections to a variety of interfaces: one high-speed USB on-the-go module with PHY, High-Speed Inter-Chip USB, multiple expansion card ports (high-speed MMC/SDIO host and other), a Gigabit Ethernet controller with support for Ethernet AVB, two 12-bit ADCs with a total of 8 single-ended inputs, two CAN ports, and a variety of other popular interfaces (such as UART, I<sup>2</sup>C, and I<sup>2</sup>S).
- Advanced security—The processors deliver hardware-enabled security features that enable secure e-commerce, digital rights management (DRM), information encryption, secure boot, and secure

software downloads. The security features are discussed in detail in the i.MX 7Dual security reference manual.

- Integrated power management—The processors integrate linear regulators and internally generate voltage levels for different power domains. This significantly simplifies system power management structure.

For a comprehensive list of the i.MX 7Solo features, see [Section 1.2, “Features.”](#)

## 1.1 Ordering information

[Table 1](#) provides examples of orderable sample part numbers covered by this data sheet.

**Table 1. Orderable parts**

| Part Number     | Options                                           | Cortex-A7 CPU Speed Grade | Qualification Tier      | Temperature (T <sub>j</sub> ) | Package                         |
|-----------------|---------------------------------------------------|---------------------------|-------------------------|-------------------------------|---------------------------------|
| MCIMX7S5EVM08SD | CAN,<br>1 x Gb ETH<br>10 tamper pins<br>2 x ADC   | 800 MHz                   | Industrial <sup>1</sup> | -20 to +105°C                 | 19x19 mm<br>0.75mm pitch<br>BGA |
| MCIMX7S3DVK08SD | No CAN,<br>1 x Gb ETH<br>4 tamper pins<br>1 x ADC | 800 MHz                   | Consumer <sup>2</sup>   | 0 to +95°C                    | 12x12 mm<br>0.4 mm pitch<br>BGA |
| MCIMX7S5EVK08SD | CAN<br>1 x Gb ETH<br>4 tamper pins<br>1 x ADC     | 800 MHz                   | Industrial <sup>1</sup> | -20 to +105°C                 | 12x12 mm<br>0.4 mm pitch<br>BGA |
| MCIMX7S3EVK08SD | No CAN<br>1 x Gb ETH<br>4 tamper pins<br>1 x ADC  | 800 MHz                   | Industrial <sup>1</sup> | -20 to +105°C                 | 12x12 mm<br>0.4 mm pitch<br>BGA |

<sup>1</sup> Industrial qualification grade assumes 10-year lifetime with 100% duty cycle.

<sup>2</sup> Consumer qualification grade assumes 5-year lifetime with 50% duty cycle.

Figure 1 describes the part number nomenclature so that the users can identify the characteristics of the specific part number.

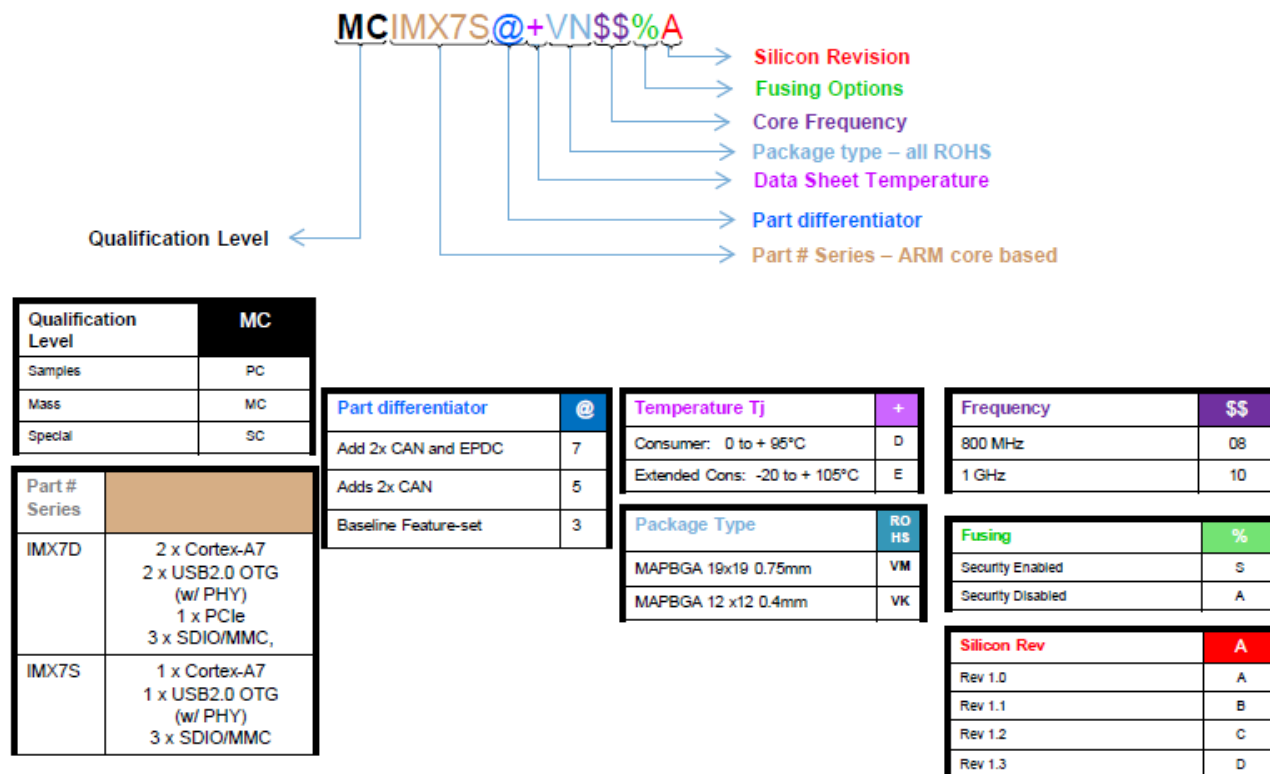


Figure 1. Part number nomenclature—i.MX 7Solo family of processors

## 1.2 Features

The i.MX 7Solo family of processors is based on Arm Cortex-A7 MPCore™ Platform, which has the following features:

- Arm Cortex-A7 Core (with TrustZone® technology)
- The core includes:
  - 32 KByte L1 Instruction Cache
  - 32 KByte L1 Data Cache
  - Private Timer and Watchdog
  - NEON MPE (media processing engine) coprocessor

The Arm Cortex-A7 Core complex shares:

- General interrupt controller (GIC) with 128 interrupt support
- Global timer
- Snoop control unit (SCU)
- 512 KB unified I/D L2 cache
- Two master AXI bus interfaces output of L2 cache

- Frequency of the core (including NEON and L1 cache), as per [Table 9](#).
- NEON MPE coprocessor
  - SIMD Media Processing Architecture
  - NEON register file with 32x64-bit general-purpose registers
  - NEON Integer execute pipeline (ALU, Shift, MAC)
  - NEON dual, single-precision floating point execute pipeline (FADD, FMUL)
  - NEON load/store and permute pipeline

The Arm Cortex-M4 platform:

- Cortex-M4 CPU core
- MPU (memory protection unit)
- FPU (floating-point unit)
- 16 KByte instruction cache
- 16 KByte data cache
- 64 KByte TCM (tightly-coupled memory)

The SoC-level memory system consists of the following additional components:

- Boot ROM, including HAB (96 KB)
- Internal multimedia / shared, fast access RAM (256 KB of total OCRM)
- Secure/nonsecure RAM (32 KB)
- External memory interfaces: The i.MX 7Solo family of processors supports the latest, high-volume, cost effective DRAM, NOR, and NAND Flash memory standards.
  - Up to 32-bit LP-DDR2-1066, DDR3-1066, DDR3L-1066, and LPDDR3-1066
  - 8-bit NAND-Flash, including support for Raw MLC/SLC, 2 KB, 4 KB, and 8 KB page size, BA-NAND, PBA-NAND, LBA-NAND, OneNAND™ and others. BCH ECC up to 62 bits.
  - 16/32-bit NOR Flash. All EIMv2 pins are muxed on other interfaces.

Each i.MX 7Solo processor enables the following interfaces to external devices (some of them are muxed and not available simultaneously):

- Displays—Available interfaces.
  - One parallel 24-bit display port
  - One MIPI DSI port
- Camera sensors:
  - One parallel Camera port (up to 24 bit and up to 133 MHz peak)
  - One MIPI-CSI port
- Expansion cards:
  - Three MMC/SD/SDIO card ports all supporting the following. Moreover, the third port can support HS400.
    - 1-bit or 4-bit transfer mode specifications for SD and SDIO cards, up to 208 MHz

- 1-bit, 4-bit, or 8-bit transfer mode specifications for MMC cards up to 200 MHz in both SDR and DDR modes, including HS200 and HS400 DDR modes
- USB:
  - One high-speed (HS) USB 2.0 OTG (Up to 480 Mbps), with integrated HS USB PHY
  - One high-speed USB 2.0 (480 Mbps) host with integrated HSIC USB (high-speed inter-chip USB) PHY
- Miscellaneous IPs and interfaces:
  - Three instances of SAI supporting up to three I<sup>2</sup>S and AC97 ports
  - Seven UARTs, up to 4.0 Mbps:
    - Providing RS232 interface
    - Supporting 9-bit RS485 Multidrop mode
  - Four eCSPI (Enhanced CSPI)
  - Four I<sup>2</sup>C, supporting 400 kbps
  - 1-gigabit Ethernet controller (designed to be compatible with IEEE Std 1588), 10/100/1000 Mbps with AVB support
  - Four pulse width modulators (PWM)
  - System JTAG controller (SJC)
  - GPIO with interrupt capabilities
  - 8x8 key pad port (KPP)
  - One quad SPI
  - Four watchdog timers (WDOG)
  - One (12 x 12 mm) or two (19 x 19 mm) 2-channel, 12-bit analog-to-digital converters (ADC)—effective number of bits (ENOB) can vary (typically 9–10 bits) depending on the system implementation and the condition of the power/ground noise condition

The i.MX 7Solo family of processors integrates advanced power management unit and controllers:

- PMU (power-management unit), multiple LDO supplies, for on-chip resources
- Temperature sensor for monitoring the die temperature
- Software state retention and power gating for Arm and NEON
- Support for various levels of system power modes
- Flexible clock gating control scheme

The i.MX 7Solo family of processors uses dedicated hardware accelerators to meet the targeted multimedia performance. The use of hardware accelerators is a key factor in obtaining high performance at low power consumption numbers, while having the CPU core relatively free for performing other tasks.

The i.MX 7Solo family of processors incorporates the following hardware accelerators:

- PXP—PiXeL processing pipeline for image resize, rotation, overlay and CSC. Off loading key pixel processing operations are required to support the LCD.

Security functions are implemented by the following hardware:

- Arm TrustZone technology including separation of interrupts and memory mapping

- SJC—System JTAG Controller. Protecting JTAG from debug port attacks by regulating or blocking the access to the system debug features.
- CAAM—Cryptographic Acceleration and Assurance Module, containing cryptographic and hash engines, 32 KB secure RAM, and true and pseudo random number generator.
- SNVS—Secure Non-Volatile Storage, including secure real time clock
- CSU—Central Security Unit. Responsible for setting comprehensive security policy of the device. Configured during boot and by eFuses and determines the security-level operation mode as well as the TrustZone policy.
- HAB—High Assurance Boot—HABv4 with the new embedded enhancements: SHA-256, 2048-bit RSA key, SRK revocation mechanism, warm boot, CSU, and TrustZone initialization.

#### NOTE

The actual feature set depends on the part numbers as described in [Table 1](#). Functions, such as display and camera interfaces, connectivity interfaces, may not be enabled for specific part numbers.

## 2 Architectural overview

The following subsections provide an architectural overview of the i.MX 7Solo processor system.

### 2.1 Block diagram

Figure 2 shows the functional modules in the i.MX 7Solo processor system.

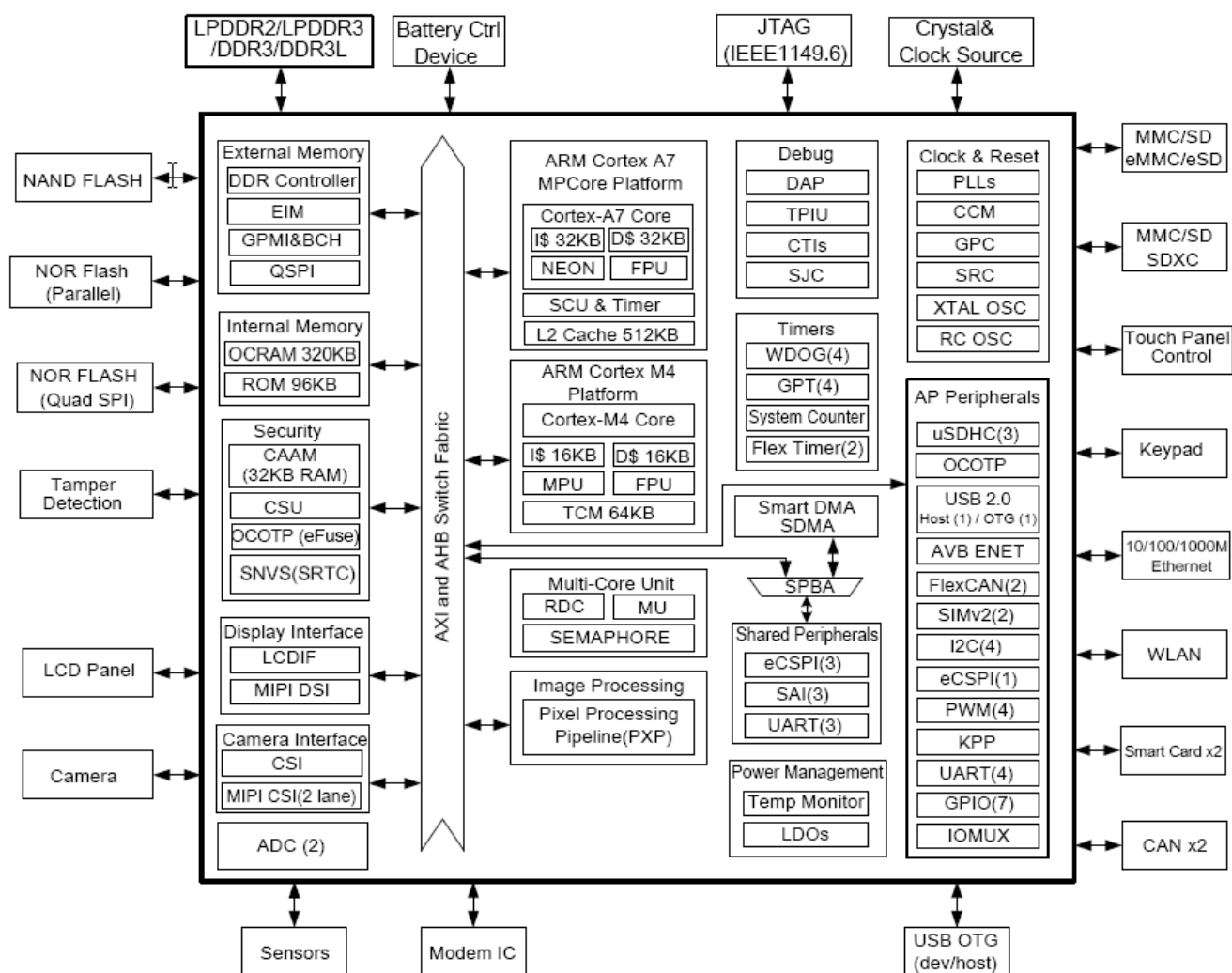


Figure 2. i.MX 7Solo System block diagram

### 3 Modules list

The i.MX 7Solo family of processors contains a variety of digital and analog modules. [Table 2](#) describes these modules in alphabetical order.

**Table 2. i.MX 7Solo modules list**

| Block Mnemonic    | Block Name                                                              | Subsystem                         | Brief Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|-------------------|-------------------------------------------------------------------------|-----------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ADC1<br>ADC2      | Analog to Digital Converter                                             |                                   | The ADC is a 12-bit general purpose analog to digital converter (ADC2 is not available in the 12x12 package).                                                                                                                                                                                                                                                                                                                                                                                              |
| Arm               | Arm Platform                                                            | Arm                               | The Arm Core Platform includes a Cortex-A7 core and 1x Cortex-M4. It also includes associated sub-blocks, such as the Level 2 Cache Controller, SCU (Snoop Control Unit), GIC (General Interrupt Controller), private timers, watchdog, and CoreSight debug modules.                                                                                                                                                                                                                                       |
| BCH               | Binary-BCH ECC Processor                                                | System control peripherals        | The BCH module provides up to 62-bit ECC encryption/decryption for NAND Flash controller (GPMI).                                                                                                                                                                                                                                                                                                                                                                                                           |
| CAAM              | Cryptographic accelerator and assurance module                          | Security                          | CAAM is a cryptographic accelerator and assurance module. CAAM implements several encryption and hashing functions, a run-time integrity checker, entropy source generator, and a Pseudo Random Number Generator (PRNG). The pseudo random number generator is certifiable by Cryptographic Algorithm Validation Program (CAVP) of National Institute of Standards and Technology (NIST). CAAM also implements a Secure Memory mechanism. In i.MX 7Solo processors, the security memory provided is 32 KB. |
| CCM<br>GPC<br>SRC | Clock Control Module, General Power Controller, System Reset Controller | Clocks, resets, and power control | These modules are responsible for clock and reset distribution in the system, and also for the system power management.                                                                                                                                                                                                                                                                                                                                                                                    |
| CSI               | Parallel CSI                                                            | Multimedia peripherals            | The CSI IP provides parallel CSI standard camera interface port. The CSI parallel data ports are up to 24 bits. It is designed to support 24-bit RGB888/YUV444, CCIR656 video interface, 8-bit YCbCr, YUV or RGB, and 8-bit/10-bit/16-bit Bayer data input.                                                                                                                                                                                                                                                |
| CSU               | Central Security Unit                                                   | security                          | The Central Security Unit (CSU) is responsible for setting comprehensive security policy within the i.MX 7Solo platform.                                                                                                                                                                                                                                                                                                                                                                                   |
| DAP               | Debug Access Port                                                       | System control peripherals        | The DAP provides real-time access for the debugger without halting the core to access: <ul style="list-style-type: none"> <li>• System memory and peripheral registers</li> <li>• All debug configuration registers</li> </ul> The DAP also provides debugger access to JTAG scan chains.                                                                                                                                                                                                                  |

**Table 2. i.MX 7Solo modules list(continued)**

| Block Mnemonic                                              | Block Name                          | Subsystem                     | Brief Description                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|-------------------------------------------------------------|-------------------------------------|-------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| eCSP11<br>eCSP12<br>eCSP13<br>eCSP14                        | Configurable SPI                    | Connectivity<br>Peripherals   | Full-duplex enhanced Synchronous Serial Interface, with data rate up to 52 Mbit/s. It is configurable to support Master/Slave modes, four chip selects to support multiple peripherals.                                                                                                                                                                                                                                                                          |
| EIM                                                         | NOR-Flash /PSRAM<br>interface       | Connectivity<br>Peripherals   | The EIM NOR-FLASH / PSRAM provides: <ul style="list-style-type: none"> <li>• Support for 16-bit (in Muxed I/O mode only) PSRAM memories (sync and async operating modes), at slow frequency</li> <li>• Support for 16-bit (in muxed and non-muxed I/O modes) NOR-Flash memories, at slow frequency</li> <li>• Multiple chip selects</li> </ul>                                                                                                                   |
| ENET1                                                       | Ethernet Controller                 | Connectivity<br>peripherals   | The Ethernet Media Access Controller (MAC) is designed to support 10/100/1000 Mbps Ethernet/IEEE 802.3 networks. An external transceiver interface and transceiver function are required to complete the interface to the media. The module has dedicated hardware to support the IEEE 1588 standard. See the ENET chapter of the <i>i.MX 7Solo Application Processor Reference Manual</i> (IMX7SRM) for details.                                                |
| FLEXCAN1<br>FLEXCAN2                                        | Flexible Controller Area<br>Network | Connectivity<br>peripherals   | The CAN protocol was primarily, but not only, designed to be used as a vehicle serial data bus, meeting the specific requirements of this field: real-time processing, reliable operation in the Electromagnetic interference (EMI) environment of a vehicle, cost-effectiveness and required bandwidth. The FlexCAN module is a full implementation of the CAN protocol specification, Version 2.0 B, which supports both standard and extended message frames. |
| FLEXTIMER1<br>FLEXTIMER2                                    | Flexible Timer Module               | Timer Peripherals             | Provide input signal capture and PWM support                                                                                                                                                                                                                                                                                                                                                                                                                     |
| GPIO1<br>GPIO2<br>GPIO3<br>GPIO4<br>GPIO5<br>GPIO6<br>GPIO7 | General Purpose I/O<br>Modules      | System control<br>peripherals | Used for general purpose input/output to external ICs. Each GPIO module supports up to 32 bits of I/O.                                                                                                                                                                                                                                                                                                                                                           |
| GPMI                                                        | General Purpose Memory<br>Interface | Connectivity<br>peripherals   | The GPMI module supports up to 8x NAND devices and 62-bit ECC encryption/decryption for NAND Flash Controller (GPMI2). GPMI supports separate DMA channels for each NAND device.                                                                                                                                                                                                                                                                                 |

Table 2. i.MX 7Solo modules list(continued)

| Block Mnemonic               | Block Name                  | Subsystem                  | Brief Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|------------------------------|-----------------------------|----------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| GPT                          | General Purpose Timer       | Timer peripherals          | Each GPT is a 32-bit “free-running” or “set and forget” mode timer with programmable prescaler and compare and capture register. A timer counter value can be captured using an external event and can be configured to trigger a capture event on either the leading or trailing edges of an input pulse. When the timer is configured to operate in “set and forget” mode, it is capable of providing precise interrupts at regular intervals with minimal processor intervention. The counter has output compare logic to provide the status and interrupt at comparison. This timer can be configured to run either on an external clock or on an internal clock. |
| I2C1<br>I2C2<br>I2C3<br>I2C4 | I <sup>2</sup> C Interface  | Connectivity peripherals   | I <sup>2</sup> C provide serial interface for external devices. Data rates of up to 320 kbps are supported.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| IOMUXC                       | IOMUX Control               | System control peripherals | This module enables flexible IO multiplexing. Each IO pad has default and several alternate functions. The alternate functions are software configurable.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| KPP                          | Key Pad Port                | Connectivity peripherals   | KPP Supports 8x8 external key pad matrix. KPP features are: <ul style="list-style-type: none"> <li>• Open drain design</li> <li>• Glitch suppression circuit design</li> <li>• Multiple keys detection</li> <li>• Standby key press detection</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                              |
| LCDIF                        | LCD interface               | Multimedia peripherals     | The LCDIF is a general purpose display controller used to drive a wide range of display devices varying in size and capability. The LCDIF is designed to support dumb (synchronous 24-bit Parallel RGB interface).                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| MIPI-CSI (two-lane)          | MIPI Camera Interface       | Multimedia peripherals     | This module provides a two-lane MIPI camera interface operating up to a maximum bit rate of 1.5 Gbps.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| MIPI DSI (two-lane)          | MIPI Display Interface      | Connectivity peripherals   | This module provides a two-lane MIPI display interface operating up to a maximum bit rate of 1.5 Gbps.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| DDRC                         | DDR Controller              | Connectivity peripherals   | The DDR Controller has the following features: <ul style="list-style-type: none"> <li>• Supports 16/32-bit DDR/DDR3L, LPDDR3, and LPDDR2-1066</li> <li>• Supports up to 2 Gbyte DDR memory space</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| MQS                          | Medium-quality sound module | Multimedia peripherals     | MQS is used to generate 2-channel, medium-quality, PWM-like audio, via two standard digital GPIO pins. The electronic specification is the same as the GPIO digital output.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |

Table 2. i.MX 7Solo modules list(continued)

| Block Mnemonic               | Block Name                | Subsystem                | Brief Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|------------------------------|---------------------------|--------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| OCOTP_CTRL                   | OTP Controller            | Security                 | The On-Chip OTP controller (OCOTP_CTRL) provides an interface for reading, programming, and/or overriding identification and control information stored in on-chip fuse elements. The module supports electrically-programmable poly fuses (eFUSES). The OCOTP_CTRL also provides a set of volatile software-accessible signals that can be used for software control of hardware elements, not requiring non-volatility. The OCOTP_CTRL provides the primary user-visible mechanism for interfacing with on-chip fuse elements. Among the uses for the fuses are unique chip identifiers, mask revision numbers, cryptographic keys, JTAG secure mode, boot characteristics, and various control signals, requiring permanent non-volatility. |
| OCRAM                        | On-Chip Memory controller | Data path                | The On-Chip Memory controller (OCRAM) module is designed as an interface between system's AXI bus and internal (on-chip) SRAM memory module. In i.MX 7Solo processors, the OCRM is used for controlling the 128 KB multimedia RAM through a 64-bit AXI bus.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| PMU                          | Power Management Unit     | Data path                | Integrated power management unit. Used to provide power to various SoC domains.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| PWM1<br>PWM2<br>PWM3<br>PWM4 | Pulse Width Modulation    | Connectivity peripherals | The pulse-width modulator (PWM) has a 16-bit counter and is optimized to generate sound from stored sample audio images and it can also generate tones. It uses 16-bit resolution and a 4x16 data FIFO to generate sound.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| PXP                          | PiXel Processing Pipeline | Display peripherals      | A high-performance pixel processor capable of 1 pixel/clock performance for combined operations, such as color-space conversion, alpha blending, gamma-mapping, and rotation. The PXP is enhanced with features specifically for gray scale applications. In addition, the PXP supports traditional pixel/frame processing paths for still-image and video processing applications.                                                                                                                                                                                                                                                                                                                                                            |
| QSPI                         | Quad SPI                  | Connectivity peripherals | Quad SPI module act as an interface to external serial flash devices. This module contains the following features: <ul style="list-style-type: none"> <li>• Flexible sequence engine to support various flash vendor devices</li> <li>• Single pad/Dual pad/Quad pad mode of operation</li> <li>• Single Data Rate/Double Data Rate mode of operation</li> <li>• Parallel Flash mode</li> <li>• DMA support</li> <li>• Memory mapped read access to connected flash devices</li> <li>• Multi-master access with priority and flexible and configurable buffer for each master</li> </ul>                                                                                                                                                       |

Table 2. i.MX 7Solo modules list(continued)

| Block Mnemonic       | Block Name                  | Subsystem                  | Brief Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|----------------------|-----------------------------|----------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SAI1<br>SAI2<br>SAI3 | Synchronous Audio Interface | Connectivity peripherals   | The SAI module provides a synchronous audio interface (SAI) that supports full duplex serial interfaces with frame synchronization, such as I <sup>2</sup> S, AC97, TDM, and codec/DSP interfaces.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| SDMA                 | Smart Direct Memory Access  | System control peripherals | <p>The SDMA is a multichannel flexible DMA engine. It helps in maximizing system performance by offloading the various cores in dynamic data routing. It has the following features:</p> <ul style="list-style-type: none"> <li>• Powered by a 16-bit Instruction-Set micro-RISC engine</li> <li>• Multi-channel DMA supporting up to 32 time-division multiplexed DMA channels</li> <li>• 48 events with total flexibility to trigger any combination of channels</li> <li>• Memory accesses including linear, FIFO, and 2D addressing</li> <li>• Shared peripherals between Arm and SDMA</li> <li>• Very fast Context-Switching with 2-level priority based preemptive multi-tasking</li> <li>• DMA units with auto-flush and prefetch capability</li> <li>• Flexible address management for DMA transfers (increment, decrement, and no address changes on source and destination address)</li> <li>• DMA ports can handle unidirectional and bidirectional flows (Copy mode)</li> <li>• Up to 8-word buffer for configurable burst transfers for EMLv2.5</li> <li>• Support of byte-swapping and CRC calculations</li> <li>• Library of Scripts and API is available</li> </ul> |
| SIMv2-1<br>SIMv2-2   | Smart Card                  | Connectivity peripherals   | Smart card interface designed to be compatible with ISO7816.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| SJC                  | System JTAG Controller      | System control peripherals | <p>The SJC provides JTAG interface (designed to be compatible with JTAG TAP standards) to internal logic. The i.MX 7Solo family of processors uses JTAG port for production, testing, and system debugging. Additionally, the SJC provides BSR (Boundary Scan Register) standard support, designed to be compatible with IEEE 1149.1 and IEEE1149.6 standards. The JTAG port must be accessible during platform initial laboratory bring-up, for manufacturing tests and troubleshooting, as well as for software debugging by authorized entities. The i.MX 7Solo SJC incorporates three security modes for protecting against unauthorized accesses. Modes are selected through eFUSE configuration.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| SNVS                 | Secure Non-Volatile Storage | Security                   | Secure Non-Volatile Storage, including Secure Real Time Clock, Security State Machine, Master Key Control, and Violation/Tamper Detection and reporting.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| TEMPSENSOR           | Temperature Sensor          | System control peripherals | Temperature sensor                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |

Table 2. i.MX 7Solo modules list(continued)

| Block Mnemonic                                              | Block Name                                                                 | Subsystem                | Brief Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|-------------------------------------------------------------|----------------------------------------------------------------------------|--------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TZASC                                                       | Trust-Zone Address Space Controller                                        | Security                 | The TZASC (TZC-380 by Arm) provides security address region control functions required for intended application. It is used on the path to the DRAM controller.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| UART1<br>UART2<br>UART3<br>UART4<br>UART5<br>UART6<br>UART7 | UART Interface                                                             | Connectivity peripherals | Each of the UARTv2 modules support the following serial data transmit/receive protocols and configurations: <ul style="list-style-type: none"> <li>• 7- or 8-bit data words, 1 or 2 stop bits, programmable parity (even, odd or none)</li> <li>• Programmable baud rates up to 4 Mbps. This is a higher max baud rate relative to the 1.875 MHz, which is stated by the TIA/EIA-232-F standard.</li> <li>• 32-byte FIFO on Tx and 32 half-word FIFO on Rx supporting auto-baud</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| uSDHC1<br>uSDHC2<br>uSDHC3                                  | SD/MMC and SDXC Enhanced Multi-Media Card / Secure Digital Host Controller | Connectivity peripherals | <p>i.MX 7Solo SoC characteristics:</p> <p>All the MMC/SD/SDIO controller IPs are based on the uSDHC IP. They are designed to be:</p> <ul style="list-style-type: none"> <li>• Fully compatible with MMC command/response sets and Physical Layer as defined in the Multimedia Card System Specification, v5.0/v4.4/v4.41/v4.4/v4.3/v4.2.</li> <li>• Fully compatible with SD command/response sets and Physical Layer as defined in the SD Memory Card Specifications v 3.0 including high-capacity SDXC cards up to 2 TB.</li> <li>• Fully compatible with SDIO command/response sets and interrupt/Read-Wait mode as defined in the SDIO Card Specification, Part E1, v. 3.0</li> </ul> <p>All the ports support:</p> <ul style="list-style-type: none"> <li>• 1-bit or 4-bit transfer mode specifications for SD and SDIO cards up to UHS-I SDR104 mode (104 MB/s max)</li> <li>• 1-bit, 4-bit, or 8-bit transfer mode specifications for MMC cards up to 200 MHz in both SDR and DDR modes, including HS200 and HS400.</li> </ul> <p>However, the SoC level integration and I/O muxing logic restrict the functionality to the following:</p> <ul style="list-style-type: none"> <li>• uSDHC1 and uSDHC2 are primarily intended to serve as external slots or interfaces to on-board SDIO devices. These ports are equipped with “Card detection” and “Write Protection” pads and do not support hardware reset.</li> <li>• uSDHC3 is primarily intended to serve interfaces to embedded MMC memory or interfaces to on-board SDIO devices. These ports do not have “Card detection” and “Write Protection” pads and do support hardware reset.</li> <li>• All ports can work with 1.8 V and 3.3 V cards. There are two completely independent I/O power domains for uSDHC1 and uSDHC2 in 4-bit configuration (SD interface). uSDHC3 is placed in his own independent power domain.</li> </ul> |

Table 2. i.MX 7Solo modules list(continued)

| Block Mnemonic          | Block Name                          | Subsystem                | Brief Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|-------------------------|-------------------------------------|--------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| USBOTG2                 | USB 2.0 High Speed OTG and HSIC USB | Connectivity peripherals | USBOTG2 contains: <ul style="list-style-type: none"> <li>• One high-speed OTG module with integrated HS USB PHYs</li> <li>• One high-speed Host module connected to HSIC USB port.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| WDOG1<br>WDOG3<br>WDOG4 | Watchdog                            | Timer peripherals        | The Watch dog timer supports two comparison points during each counting period. Each of the comparison points is configurable to evoke an interrupt to the Arm core, and a second point evokes an external event on the WDOG line.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| WDOG2 (TrustZone)       | Watchdog (TrustZone technology)     | Timer peripherals        | The TrustZone Watchdog (TZ WDOG) timer module protects against TrustZone starvation by providing a method of escaping Normal mode and forcing a switch to the TZ mode. TZ starvation is a situation where the normal OS prevents switching to the TZ mode. Such situation is undesirable as it can compromise the system's security. Once the TZ WDOG module is activated, it must be serviced by TZ software on a periodic basis. If servicing does not take place, the timer times out. Upon a time-out, the TZ WDOG asserts a TZ mapped interrupt that forces switching to the TZ mode. If it is still not served, the TZ WDOG asserts a security violation signal to the CSU. The TZ WDOG module cannot be programmed or deactivated by a normal mode SW. |

### 3.1 Special signal considerations

Table 3 lists special signal considerations for the i.MX 7Solo family of processors. The signal names are listed in alphabetical order.

The package contact assignments can be found in [Section 6, “Package information and contact assignments.”](#) Signal descriptions are provided in the *i.MX 7Solo Application Processor Reference Manual* (IMX7SRM).

**Table 3. Special signal considerations**

| Signal Name                           | Remarks                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|---------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| CCM_CLK1_P/<br>CCM_CLK1_N<br>CCM_CLK2 | <p>One general purpose differential high speed clock input/output and one single-ended clock input are provided.</p> <p>Either or both of them can be used:</p> <ul style="list-style-type: none"> <li>To feed an external reference clock to the PLLs and to the modules inside the SoC, for example, as an alternate reference clock for Video/Audio interfaces and so forth.</li> <li>To output the internal SoC clock to be used outside the SoC as either a reference clock or as a functional clock for peripherals; for example, it can be used as an output of the PCIe master clock (root complex use)</li> </ul> <p>See the <i>i.MX 7Solo Application Processor Reference Manual</i> (IMX7SRM) for details on the respective clock trees.</p> <p>The CCM_CLK1_* inputs/outputs are an LVDS differential pair.</p> <p>Alternatively, a single-ended signal may be used to drive CCM_CLK1_P input. In this case corresponding CCM_CLK1_N input should be tied to the constant voltage level equal to 1/2 of the input signal swing.</p> <p>Termination should be provided in case of high frequency signals.</p> <p>See the LVDS pad electrical specification for further details. CCM_CLK2 is a single-ended input referenced to ground.</p> <p>After initialization:</p> <ul style="list-style-type: none"> <li>The CCM_CLK1_* inputs/outputs can be disabled if not used. Any of the unused CCM_CLK1_* pins may be left floating.</li> <li>The CCM_CLK2 input should be grounded if not used.</li> </ul> |
| RTC_XTALI/RTC_XTALO                   | <p>If the user wishes to configure RTC_XTALI and RTC_XTALO as an RTC oscillator, a 32.768 kHz crystal, (100 k ESR, 10 pF load) should be connected between RTC_XTALI and RTC_XTALO. It is recommended to use the configurable load capacitors provided in the IP instead of adding them externally. To hit the exact oscillation frequency, the configurable capacitors need to be reduced to account for board and chip parasitics.</p> <p>The integrated oscillation amplifier is self biasing, but relatively weak. Care must be taken to limit parasitic leakage from RTC_XTALI and RTC_XTALO to either power or ground (&gt;100 M). This will debias the amplifier and cause a reduction of startup margin. Typically RTC_XTALI and RTC_XTALO should bias to approximately 0.5 V.</p> <p>If it is desired to feed an external low frequency clock into RTC_XTALI, the RTC_XTALO pin should be left floating or driven with a complimentary signal. The logic level of this forcing clock should not exceed VDD_SNVS_CAP level.</p> <p>In the case when a high-accuracy realtime clock is not required, the system may use internal low frequency oscillator. It is recommended to connect RTC_XTALI to ground and keep RTC_XTALO floating. This will however result in increased power consumption, because the internal oscillator uses higher power than the RTC oscillator. Thus for lowest power configuration it is recommended to always install a crystal.</p>                                          |
| XTALI/XTALO                           | A 24.0 MHz crystal should be connected between XTALI and XTALO.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |

Table 3. Special signal considerations(continued)

| Signal Name                 | Remarks                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
|-----------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DRAM_VREF                   | <p>When using DDR_VREF with DDR I/O, the nominal reference voltage must be half of the NVCC_DRAM supply. The user must tie DDR_VREF to a precision external resistor divider. Use a 1 k<math>\Omega</math> 0.5% resistor to GND and a 1 k<math>\Omega</math> 0.5% resistor to NVCC_DRAM. Shunt each resistor with a closely-mounted 0.1 <math>\mu</math>F capacitor.</p> <p>To reduce supply current, a pair of 1.5 k<math>\Omega</math> 0.1% resistors can be used. Using resistors with recommended tolerances ensures the <math>\pm 2\%</math> DDR_VREF tolerance (per the DDR3 specification) is maintained when four DDR3 ICs plus the i.MX 7Solo are drawing current on the resistor divider. It is recommended to use regulated power supply for “big” memory configurations (more than eight devices)</p>                                                                                                                                                                                                                                                                                             |
| ZQPAD                       | DRAM calibration resistor 240 $\Omega$ 1% used as reference during DRAM output buffer driver calibration should be connected between this pad and GND.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| VDDA_MIP1_1P8               | Short these pins to VDDA_PHY_1P8 if using MIPI. User can leave these pins floating or grounded if not using MIPI.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| VDD_MIP1_1P0                | Short these pins to VDDD_1P0_CAP if using MIPI. User can leave these pins floating or grounded if not using MIPI.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| GPANAIO                     | This signal is reserved for manufacturing use only. User must leave this connection floating.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| JTAG_nnnn                   | <p>The JTAG interface is summarized in <a href="#">Table 4</a>. Use of external resistors is unnecessary. However, if external resistors are used, the user must ensure that the on-chip pull-up/down configuration is followed. For example, do not use an external pull down on an input that has on-chip pull-up.</p> <p>JTAG_TDO is configured with a keeper circuit such that the floating condition is eliminated if an external pull resistor is not present. An external pull resistor on JTAG_TDO is detrimental and should be avoided.</p> <p>JTAG_MOD is referenced as SJC_MOD in the <i>i.MX 7Solo Application Processor Reference Manual</i> (IMX7SRM). Both names refer to the same signal. JTAG_MOD must be externally connected to GND for normal operation. Termination to GND through an external pull-down resistor (such as 1 k<math>\Omega</math>) is allowed. JTAG_MOD set to high configures the JTAG interface to a mode compatible with the IEEE 1149.1 standard. JTAG_MOD set to low configures the JTAG interface for common SW debug adding all the system TAPs to the chain.</p> |
| NC                          | Do not connect. These signals are reserved and should be floated by the user.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| POR_B                       | <p>This cold reset negative logic input resets all modules and logic in the IC.</p> <p>May be used in addition to internally generated power on reset signal (logical AND, both internal and external signals are considered active low).</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| ONOFF                       | In Normal mode, may be connected to ON/OFF button (De-bouncing provided at this input). Internally this pad is pulled up. Short connection to GND in OFF mode causes internal power management state machine to change state to ON. In ON mode short connection to GND generates interrupt (intended to SW controllable power down). Long above ~5s connection to GND causes “forced” OFF.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| TEST_MODE                   | TEST_MODE is for factory use. This signal is internally connected to an on-chip pull-down device. The user must tie this signal to GND.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| USB_OTG1_REXT/USB_OTG2_REXT | The bias generation and impedance calibration process for the USB OTG PHYs requires connection of 200 $\Omega$ (1% precision) reference resistors on each of the USB_OTG1_REXT and USB_OTG2_REXT pads to ground.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |

**Table 3. Special signal considerations(continued)**

| Signal Name     | Remarks                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|-----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| USB_OTG1_CHD_B  | An external pullup resistor with value in range from 10 k $\Omega$ to 100 k $\Omega$ should be connected between open-drain output USB_OTG1_CHD_B and supply VDD_USB_OTG1_3P3_IN for 3.3 V signaling. Optionally, a similarly valued pullup resistor could be connected instead between USB_OTG1_CHD_B and an unrelated supply up to 1.8 V, but in that case the output is only valid when both that supply and VDD_USB_OTG1_3P3_IN are powered. |
| TEMPSENSOR_REXT | External 100 K $\Omega$ (1% precision) resistor connection pin                                                                                                                                                                                                                                                                                                                                                                                   |

**Table 4. JTAG controller interface summary**

| JTAG       | I/O Type       | On-chip Termination    |
|------------|----------------|------------------------|
| JTAG_TCK   | Input          | 47 k $\Omega$ pull-up  |
| JTAG_TMS   | Input          | 47 k $\Omega$ pull-up  |
| JTAG_TDI   | Input          | 47 k $\Omega$ pull-up  |
| JTAG_TDO   | 3-state output | 100 k $\Omega$ pull-up |
| JTAG_TRSTB | Input          | 47 k $\Omega$ pull-up  |
| JTAG_MOD   | Input          | 100 k $\Omega$ pull-up |

## 3.2 Recommended connections for unused analog interfaces

Table 5 shows the recommended connections for unused analog interfaces.

**Table 5. Recommended connections for unused analog interfaces**

| Module | Package Net Name                                                                                                                                                                                       | Recommendation if Unused         |
|--------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------|
| ADC    | VDDA_ADC2_1P8, VDDA_ADC2_1P8, VDDA_ADC1_1P8, VDDA_ADC1_1P8                                                                                                                                             | 1.8 V                            |
|        | ADC2_IN3, ADC2_IN2, ADC2_IN1, ADC2_IN0, ADC1_IN0, ADC1_IN1, ADC1_IN2, ADC1_IN3                                                                                                                         | Tie to ground                    |
| LDO    | VDD_1P2_CAP                                                                                                                                                                                            | Floating if USB_HSIC is not used |
| MIPI   | VDD_MIPI_1P0, VDDA_MIPI_1P8                                                                                                                                                                            | Floating or tie to ground        |
|        | MIPI_DSI_D0_N, MIPI_DSI_D0_P, MIPI_VREG_0P4V, MIPI_DSI_CLK_N, MIPI_DSI_CLK_P, MIPI_DSI_D1_N, MIPI_DSI_D1_P, MIPI_CSI_D0_N, MIPI_CSI_D0_P, MIPI_CSI_CLK_N, MIPI_CSI_CLK_P, MIPI_CSI_D1_N, MIPI_CSI_D1_P | No connect                       |
| PCIe   | PCIE_REFCLKIN_N, PCIE_REFCLKIN_P, PCIE_REFCLKOUT_N, PCIE_REFCLKOUT_P, PCIE_RX_N, PCIE_RX_P, PCIE_TX_N, PCIE_TX_P                                                                                       | Floating                         |
|        | PCIE_VP, PCIE_VP_RX, PCIE_VP_TX, PCIE_VPH, PCIE_VPH_RX, PCIE_VPH_TX, PCIE_REXT                                                                                                                         | Tie to ground                    |

**Table 5. Recommended connections for unused analog interfaces(continued)**

| Module             | Package Net Name                                                                                                                                     | Recommendation if Unused                       |
|--------------------|------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------|
| SNVS               | SNVS_TAMPER00, SNVS_TAMPER01, SNVS_TAMPER02, SNVS_TAMPER03, SNVS_TAMPER04, SNVS_TAMPER05, SNVS_TAMPER06, SNVS_TAMPER07, SNVS_TAMPER08, SNVS_TAMPER09 | Float—configure with software                  |
| Temperature sensor | TEMPSENSOR_REXT                                                                                                                                      | Tie to ground or pulldown with 100 kΩ resistor |
|                    | TEMPSENSOR_RESERVE                                                                                                                                   | Floating                                       |
|                    | VDD_TEMPSENSOR_1P8                                                                                                                                   | 1.8 V                                          |
| USB HSIC           | VDD_USB_H_1P2                                                                                                                                        | Tie to ground                                  |
|                    | USB_H_DATA, USB_H_STROBE                                                                                                                             | Floating                                       |
| USB OTG1           | VDD_USB_OTG1_3P3_IN, VDD_USB_OTG1_1P0_CAP                                                                                                            | Tie to ground                                  |
|                    | USB_OTG1_VBUS, USB_OTG1_DP, USB_OTG1_DN, USB_OTG1_ID, USB_OTG1_REXT, USB_OTG1_CHD_B                                                                  | Floating                                       |
| USB OTG2           | VDD_USB_OTG2_3P3_IN, VDD_USB_OTG2_1P0_CAP                                                                                                            | Tie to ground                                  |
|                    | USB_OTG2_VBUS, USB_OTG2_DP, USB_OTG2_DN, USB_OTG2_ID, USB_OTG2_REXT                                                                                  | Floating                                       |

## 4 Electrical characteristics

This section provides the device and module-level electrical characteristics for the i.MX 7Solo family of processors.

### 4.1 Chip-level conditions

This section provides the device-level electrical characteristics for the IC. See [Table 6](#) for a quick reference to the individual tables and sections.

**Table 6. i.MX 7Solo Chip-level conditions**

| For these characteristics, ...                                         | Topic appears ...          |
|------------------------------------------------------------------------|----------------------------|
| <a href="#">Absolute maximum ratings</a>                               | <a href="#">on page 20</a> |
| <a href="#">FPBGA case “X” and case “Y” package thermal resistance</a> | <a href="#">on page 21</a> |
| <a href="#">Operating ranges</a>                                       | <a href="#">on page 22</a> |
| <a href="#">External clock sources</a>                                 | <a href="#">on page 24</a> |
| <a href="#">Maximum supply currents</a>                                | <a href="#">on page 25</a> |
| <a href="#">Power modes</a>                                            | <a href="#">on page 28</a> |
| <a href="#">USB PHY Suspend current consumption</a>                    | <a href="#">on page 31</a> |

### 4.1.1 Absolute maximum ratings

#### CAUTION

Stresses beyond those listed under [Table 7](#) may affect reliability or cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operating ranges or parameters tables is not implied.

**Table 7. Absolute maximum ratings**

| Parameter Description                                                                                                            | Symbol                                                                                                                                     | Min    | Max                    | Unit |
|----------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------|--------|------------------------|------|
| Core supply voltages                                                                                                             | VDD_ARM<br>VDD_SOC                                                                                                                         | −0.5   | 1.5                    | V    |
| GPIO supply voltage                                                                                                              | NVCC_ENET1<br>NVCC_EPDC1<br>NVCC_EPDC2<br>NVCC_I2C<br>NVCC_LCD<br>NVCC_SAI<br>NVCC_SD1<br>NVCC_SD2<br>NVArmCC_SD3<br>NVCC_SPI<br>NVCC_UART | −0.3   | 3.6                    | V    |
| DDR I/O supply voltage                                                                                                           | NVCC_DRAM                                                                                                                                  | −0.3   | 1.975                  | V    |
| Clock I/O supply voltage                                                                                                         | NVCC_DRAM_CKE                                                                                                                              | −0.3   | 1.98                   | V    |
| VDD_SNVS_IN supply voltage                                                                                                       | VDD_SNVS_IN                                                                                                                                | −0.3   | 3.6                    | V    |
| USB OTG PHY supply voltage                                                                                                       | VDD_USB_OTG1_3P3_IN<br>VDD_USB_OTG2_3P3_IN                                                                                                 | −0.3   | 3.6                    | V    |
| USB_VBUS input detected                                                                                                          | USB_OTG1_VBUS<br>USB_OTG2_VBUS                                                                                                             | −0.3   | 5.25                   | V    |
| Input voltage on USB_OTG*_DP, USB_OTG*_DN pins                                                                                   | USB_OTG1_DP/USB_OTG1_DN<br>USB_OTG2_DP/USB_OTG2_DN                                                                                         | −0.3   | 3.63                   | V    |
| USB_OTG1_CHD_B open-drain pullup voltage when external pullup resistor is connected to VDD_USB_OTG1_3P3_IN supply only           | USB_OTG1_CHD_B                                                                                                                             | —      | 3.6                    | V    |
| USB_OTG1_CHD_B open-drain pullup voltage when external pullup resistor is connected to any supply other than VDD_USB_OTG1_3P3_IN | USB_OTG2_CHD_B                                                                                                                             | —      | 1.975                  | V    |
| Input/output voltage range                                                                                                       | $V_{in}/V_{out}$                                                                                                                           | −0.3   | OVDD <sup>1</sup> +0.3 | V    |
| ESD damage immunity:<br>• Human Body Model (HBM)<br>• Charge Device Model (CDM)                                                  | $V_{esd}$                                                                                                                                  | —<br>— | 2000<br>500            | V    |
| Storage temperature range                                                                                                        | $T_{STORAGE}$                                                                                                                              | −40    | 150                    | °C   |

<sup>1</sup> OVDD is the I/O supply voltage.

## 4.1.2 Thermal resistance

### 4.1.2.1 FPBGA case “X” and case “Y” package thermal resistance

Table 8 displays the thermal resistance data.

Per JEDEC JESD51-2, the intent of thermal resistance measurements is solely for a thermal performance comparison of one package to another in a standardized environment. This methodology is not meant to and does not predict the performance of a package in an application-specific environment.

**Table 8. Thermal Resistance Data**

| Rating                                 | Test conditions                                            | Symbol              | 12x12<br>pkg value | 19x19<br>pkg value | Unit |
|----------------------------------------|------------------------------------------------------------|---------------------|--------------------|--------------------|------|
| Junction to Ambient <sup>1</sup>       | Single-layer board (1s); natural convection <sup>2</sup>   | $R_{\theta JA}$     | 55.4               | 44.4               | °C/W |
|                                        | Four-layer board (2s2p); natural convection <sup>2</sup>   | $R_{\theta JA}$     | 32.6               | 30.2               | °C/W |
| Junction to Ambient <sup>1</sup>       | Single-layer board (1s); airflow 200 ft/min <sup>2,3</sup> | $R_{\theta JA}$     | 41.8               | 34.3               | °C/W |
|                                        | Four-layer board (2s2p); airflow 200 ft/min <sup>2,3</sup> | $R_{\theta JA}$     | 28.0               | 25.8               | °C/W |
| Junction to Board <sup>1,4</sup>       | —                                                          | $R_{\theta JB}$     | 16.0               | 17.4               | °C/W |
| Junction to Case <sup>1,5</sup>        | —                                                          | $R_{\theta JC}$     | 10.5               | 10.4               | °C/W |
| Junction to Package Top <sup>1,6</sup> | Natural Convection                                         | $\Psi_{JT}$         | 0.2                | 0.2                | °C/W |
| Junction to Package Bottom             | Natural Convection                                         | $R_{\theta B\_CSB}$ | 15.3               | 17.3               | °C/W |

<sup>1</sup> Junction temperature is a function of die size, on-chip power dissipation, package thermal resistance, mounting site (board) temperature, ambient temperature, air flow, power dissipation of other components on the board, and board thermal resistance.

<sup>2</sup> Per JEDEC JESD51-2 with the single layer board horizontal. Thermal test board meets JEDEC specification for the specified package.

<sup>3</sup> Per JEDEC JESD51-6 with the board horizontal.

<sup>4</sup> Thermal resistance between the die and the printed circuit board per JEDEC JESD51-8. Board temperature is measured on the top surface of the board near the package.

<sup>5</sup> Thermal resistance between the die and the case top surface as measured by the cold plate method (MIL SPEC-883 Method 1012.1).

<sup>6</sup> Thermal characterization parameter indicating the temperature difference between package top and the junction temperature per JEDEC JESD51-2. When Greek letters are not available, the thermal characterization parameter is written as Psi-JT.

## 4.1.3 Operating ranges

Table 9 provides the operating ranges of the i.MX 7Solo family of processors. For details on the chip's power structure, see the “Power Management Unit (PMU)” chapter of the *i.MX 7Solo Application Processor Reference Manual* (IMX7SRM).

Table 9. Operating ranges

| Parameter Description                  | Symbol                   | Min                             | Typ                            | Max <sup>1</sup>                | Unit | Comment                                                                                                                          |
|----------------------------------------|--------------------------|---------------------------------|--------------------------------|---------------------------------|------|----------------------------------------------------------------------------------------------------------------------------------|
| Run Mode                               | VDD_ARM                  | 0.95                            | 1.0                            | 1.155                           | V    | Operation at 800 MHz and below                                                                                                   |
|                                        | VDD_SOC                  | 0.95                            | 1.0                            | 1.25                            | V    | —                                                                                                                                |
| Standby/<br>Deep Sleep mode            | VDD_ARM                  | 0                               | 1.0                            | 1.25                            | V    | See Table 14, “Power modes,” on page 28.                                                                                         |
|                                        | VDD_SOC                  | 0.95                            | 1.0                            | 1.155                           | V    |                                                                                                                                  |
| Power Supply Analog Domain and LDOs    | VDDA_1P8                 | 1.71                            | 1.8                            | 1.89                            | V    | Power for analog LDO and internal analog blocks. Must match the range of voltages that the rechargeable backup battery supports. |
| Backup battery supply range            | VDD_SNVIS_IN             | 2.4                             | 3.0                            | 3.6                             | V    | —                                                                                                                                |
| LDO for Low-Power State Retention mode | VDD_LPSR                 | 1.71                            | 1.8                            | 1.89                            | V    | Power rail for Low Power State Retention mode                                                                                    |
| Supply for 24 MHz crystal              | VDD_XTAL_1P8             | 1.650                           | 1.8                            | 1.950                           | V    | —                                                                                                                                |
| Temperature sensor                     | VDD_TEMPSENSOR           | 1.710                           | 1.8                            | 1.890                           | V    | —                                                                                                                                |
| USB supply voltages                    | VDD_USB_OTG1_3 P3_IN     | 3.0                             | 3.3                            | 3.6                             | V    | This rail is for USB                                                                                                             |
|                                        | VDD_USB_OTG2_3 P3_IN     | 3.0                             | 3.3                            | 3.6                             | V    | This rail is for USB                                                                                                             |
| DDR I/O supply voltage                 | NVCC_DRAM, NVCC_DRAM_CKE | 1.14                            | 1.2                            | 1.3                             | V    | LPDDR2, LPDDR3                                                                                                                   |
|                                        |                          | 1.425                           | 1.5                            | 1.575                           | V    | DDR3                                                                                                                             |
|                                        |                          | 1.283                           | 1.35                           | 1.45                            | V    | DDR3L                                                                                                                            |
|                                        | DRAM_VREF                | $0.49 \times \text{NVCC\_DRAM}$ | $0.5 \times \text{NVCC\_DRAM}$ | $0.51 \times \text{NVCC\_DRAM}$ | V    | Set to one-half NVCC_DRAM                                                                                                        |

Table 9. Operating ranges(continued)

| Parameter Description                    | Symbol                                                                                                                                  | Min          | Typ         | Max <sup>1</sup> | Unit | Comment                                                                             |
|------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------|--------------|-------------|------------------|------|-------------------------------------------------------------------------------------|
| GPIO supply voltages                     | NVCC_ENET1<br>NVCC_EPDC1<br>NVCC_EPDC2<br>NVCC_I2C<br>NVCC_LCD<br>NVCC_SAI<br>NVCC_SD1<br>NVCC_SD2<br>NVCC_SD3<br>NVCC_SPI<br>NVCC_UART | 1.65,<br>3.0 | 1.8,<br>3.3 | 1.95,<br>3.6     | V    | —                                                                                   |
|                                          | NVCC_GPIO1                                                                                                                              | 1.65<br>3.0  | 1.8,<br>3.3 | 1.95,<br>3.6     | V    | Power for GPIO1_DATA00 ~ GPIO1_DATA07                                               |
|                                          | NVCC_GPIO2                                                                                                                              | 1.65<br>3.0  | 1.8,<br>3.3 | 1.95,<br>3.6     | V    | Power for GPIO1_DATA08 ~ GPIO1_DATA15 and JTAG port                                 |
| Voltage rails supplied from internal LDO | VDDA_MIPI_1P8                                                                                                                           | 1.71         | 1.8         | 1.89             | V    | Supplied from VDDA_PHY_1P8                                                          |
|                                          | VDD_MIPI_1P0                                                                                                                            | 0.95         | 1.0         | 1.050            | V    | Supplied from VDDD_CAP_1P0                                                          |
|                                          | VDD_USB_H_1P2                                                                                                                           | 1.150        | 1.2         | 1.250            | V    | Supplied from VDD_1P2_CAP                                                           |
| Temperature sensor accuracy              | T <sub>delta</sub>                                                                                                                      | —            | ±3          | —                | °C   | Typical accuracy over the range -40°C to 125°C                                      |
| A/D converter                            | VDDA_ADC1_1P8                                                                                                                           | 1.71         | 1.8         | 1.89             | V    | —                                                                                   |
|                                          | VDDA_ADC2_1P8                                                                                                                           | 1.71         | 1.8         | 1.89             | V    | —                                                                                   |
| Fuse power                               | FUSE_FSOURCE                                                                                                                            | 1.710        | 1.8         | 1.890            | V    | Power supply for internal use                                                       |
| Junction temperature, industrial         | T <sub>J</sub>                                                                                                                          | -20          | —           | 105              | °C   | See <a href="#">Table 1</a> for complete list of junction temperature capabilities. |

<sup>1</sup> Applying the maximum voltage results in maximum power consumption and heat generation. A voltage set point = (V<sub>min</sub> + the supply tolerance) is recommended. This results in an optimized power/speed ratio. Operating a voltage of 1.2V and above will reduce the overall lifetime of the part. For details, see *i.MX 7Dual/Solo Product Lifetime Usage* (AN5334).

[Table 10](#) shows on-chip LDO regulators that can supply on-chip loads.

Table 10. On-chip LDOs<sup>1</sup> and their on-chip loads

| Voltage Source | Load          | Comment                                  |
|----------------|---------------|------------------------------------------|
| VDDD_1P0_CAP   | VDD_MIPI_1P0  | Connect directly (short) via board level |
| VDD_USB_H_1P2  | VDD_USB_H_1P2 | Connect directly (short) via board level |

**Table 10. On-chip LDOs<sup>1</sup> and their on-chip loads(continued)**

| Voltage Source | Load          | Comment                                  |
|----------------|---------------|------------------------------------------|
| VDDA_PHY_1P8   | VDDA_MIPI_1P8 | Connect directly (short) via board level |

<sup>1</sup> On-chip LDOs are designed to supply i.MX 7Solo loads and must not be used to supply external loads.

#### 4.1.4 External clock sources

Each i.MX 7Solo processor has two external input system clocks: a low frequency (RTC\_XTALI) and a high frequency (XTALI).

The RTC\_XTALI is used for low-frequency functions. It supplies the clock for wake-up circuit, power-down real time clock operation, and slow system and watch-dog counters. The clock input can be connected to either external oscillator or a crystal using internal oscillator amplifier. Additionally, there is an internal resistor-capacitor (RC) oscillator, which can be used instead of the RTC\_XTALI if accuracy is not important.

The system clock input XTALI is used to generate the main system clock. It supplies the PLLs and other peripherals. The system clock input can be connected to either an external oscillator or a crystal using internal oscillator amplifier.

Table 11 shows the interface frequency requirements.

**Table 11. External input clock frequency**

| Parameter Description               | Symbol     | Min | Typ                 | Max | Unit |
|-------------------------------------|------------|-----|---------------------|-----|------|
| RTC_XTALI Oscillator <sup>1,2</sup> | $f_{ckil}$ | —   | 32.768 <sup>3</sup> | —   | kHz  |
| XTALI Oscillator <sup>2,4</sup>     | $f_{xtal}$ |     | 24                  |     | MHz  |

<sup>1</sup> External oscillator or a crystal with internal oscillator amplifier.

<sup>2</sup> The required frequency stability of this clock source is application dependent. See *Hardware Development Guide for i.MX7Dual and 7Solo Applications Processors*.

<sup>3</sup> Recommended nominal frequency 32.768 kHz.

<sup>4</sup> External oscillator or a fundamental frequency crystal appropriately coupled to the internal oscillator amplifier.

The typical values shown in Table 11 are required for use with NXP BSPs to ensure precise time keeping and USB operation. For RTC\_XTALI operation, two clock sources are available. If there is not an externally applied oscillator to RTC\_XTALI, the internal oscillator takes over.

- On-chip 32 kHz RC oscillator—this clock source has the following characteristics:
  - Approximately 25  $\mu$ A more  $I_{DD}$  than crystal oscillator
  - Approximately  $\pm 10\%$  tolerance
  - No external component required
  - Starts up faster than 32 kHz crystal oscillator
  - Three configurations for this input:
    - External oscillator
    - External crystal coupled to RTC\_XTALI and RTC\_XTALO

- Internal oscillator

External crystal oscillator with on-chip support circuit:

- At power up, RC oscillator is utilized. After crystal oscillator is stable, the clock circuit switches over to the crystal oscillator automatically.
- Higher accuracy than RC oscillator
- If no external crystal is present, then the RC oscillator is utilized

The decision of choosing a clock source should be taken based on real-time clock use and precision timeout.

#### 4.1.5 Maximum supply currents

The Power Virus numbers shown in [Table 12](#) represent a use case designed specifically to show the maximum current consumption possible. All cores are running at the defined maximum frequency and are limited to L1 cache accesses only to ensure no pipeline stalls. Although a valid condition, it would have a very limited practical use case, if at all, and be limited to an extremely low duty cycle unless the intention was to specifically show the worst case power consumption.

The MC3xPF3000xxxx, NXP's power management IC targeted for the i.MX 7Solo family of processors, supports the Power Virus mode operating at 1% duty cycle. Higher duty cycles are allowed, but a robust thermal design is required for the increased system power dissipation.

[Table 12](#) represents the maximum momentary current transients on power lines, and should be used for power supply selection. Maximum currents are higher by far than the average power consumption of typical use cases. For typical power consumption information, see the application note, [i.MX 7DS Power Consumption Measurement \(AN5383\)](#).

**Table 12. Maximum supply currents**

| Power Rail         | Source                   | Conditions | Max Current      | Unit |
|--------------------|--------------------------|------------|------------------|------|
| VDD_ARM            | From PMIC                | —          | 500              | mA   |
| VDD_SOC            | From PMIC                | —          | 1000             | mA   |
| VDDA_1P8_IN        | From PMIC                | —          | 150 <sup>1</sup> | mA   |
| VDD_SNVIS_IN       | From PMIC or Coin cell   | —          | 1                | mA   |
| VDD_XTAL_1P8       | From PMIC                | —          | 5                | mA   |
| VDD_LPSR_IN        | From PMIC                | —          | 5                | mA   |
| VDD_TEMPSENSOR_1P8 | From PMIC                | —          | 1                | mA   |
| VDDA_ADC1_1P8      | From PMIC                | —          | 5                | mA   |
| VDDA_ADC2_1P8      | From PMIC                | —          | 5                | mA   |
| FUSE_FSOURCE       | From PMIC                | —          | 150              | mA   |
| VDD_MIPI_1P0       | From i.MX 7 internal LDO | —          | 80               | mA   |

Table 12. Maximum supply currents(continued)

| Power Rail          | Source                   | Conditions | Max Current                      | Unit |
|---------------------|--------------------------|------------|----------------------------------|------|
| NVCC_GPIO1          | From PMIC                | N=12       | Use max IO equation <sup>2</sup> | mA   |
| NVCC_GPIO2          | From PMIC                | N=14       |                                  | mA   |
| NVCC_SD2            | From PMIC                | N=9        |                                  | mA   |
| NVCC_SD3            | From PMIC                | N=12       |                                  | mA   |
| NVCC_SD1            | From PMIC                | N=9        |                                  | mA   |
| NVCC_ENET1          | From PMIC                | N=16       |                                  | mA   |
| NVCC_EPDC1          | From PMIC                | N=16       |                                  | mA   |
| NVCC_EPDC2          | From PMIC                | N=17       |                                  | mA   |
| NVCC_SAI            | From PMIC                | N=11       |                                  | mA   |
| NVCC_LCD            | From PMIC                | N=29       |                                  | mA   |
| NVCC_SPI            | From PMIC                | N=8        |                                  | mA   |
| NVCC_ECSPi          | From PMIC                | N=8        |                                  | mA   |
| NVCC_I2C            | From PMIC                | N=8        |                                  | mA   |
| NVCC_UART           | From PMIC                | N=8        |                                  | mA   |
| VDD_USB_OTG1_3P3_IN | From PMIC                | —          | 50                               | mA   |
| VDD_USB_OTG2_3P3_IN | From PMIC                | —          | 50                               | mA   |
| VDD_USB_H_1P2       | From i.MX 7 internal LDO | —          | 20                               | mA   |
| VDDA_MIPI_1P8       | From i.MX 7 internal LDO | —          | 5                                | mA   |
| DRAM_VREF           | From PMIC                | —          | 1                                | mA   |
| NVCC_DRAM_CKE       | From PMIC                | —          | 30                               | mA   |
| NVCC_DRAM           | From PMIC                | —          | — <sup>3</sup>                   | mA   |

<sup>1</sup> The actual maximum current drawn from VDDA\_1P8\_IN is as shown plus any additional current drawn from the VDDD\_1P0\_CAP, VDD\_1P2\_CAP, VDDA\_PHY\_1P8 outputs, depending on actual application configuration (for example, VDD\_MIPI\_1P0, VDD\_USB\_H\_1P2 and supplies).

<sup>2</sup> General equation for estimated, maximal power consumption of an I/O power supply:

$$I_{\max} = N \times C \times V \times (0.5 \times F)$$

where:

N = Number of I/O pins supplied by the power line

C = Equivalent external capacitive load

V = IO voltage

(0.5 × F) = Data change rate, up to 0.5 of the clock rate (F)

In this equation, I<sub>max</sub> is in amps, C in farads, V in volts, and F in hertz.

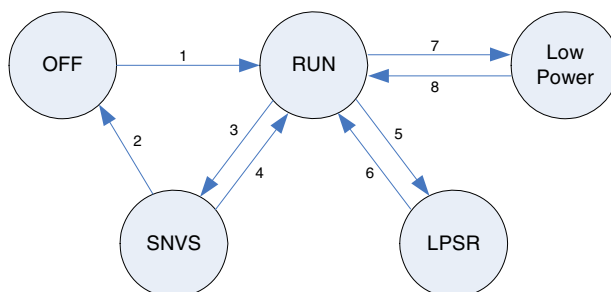
<sup>3</sup> The DRAM power consumption is dependent on several factors, such as external signal termination. DRAM power calculators are typically available from the memory vendors. They take into account factors such as signal termination. See the application note, [i.MX 7DS Power Consumption Measurement \(AN5383\)](#) for examples of DRAM power consumption during specific use case scenarios.

### 4.1.6 Power modes

The i.MX 7Solo has the following power modes:

- OFF mode: all power rails are off
- SNVS mode: only RTC and tamper detection logic is active
- LPSR mode: an extension of SNVS mode, with 16 GPIOs in low power state retention mode
- RUN Mode: all external power rails are on, CPU is active and running, other internal module can be on/off based on application;
- Low Power mode (System Idle, Low Power Idle, and Deep Sleep): most external power rails are still on, CPU is in WFI state or power gated, most of the internal modules are clock gated or power gated

The valid power mode transition is shown in this diagram.



**Figure 3. i.MX 7Solo Power Modes**

The power mode transition condition is defined in the following table.

**Table 13. Power Mode Transition**

| Transition | From      | To        | Condition                                            |
|------------|-----------|-----------|------------------------------------------------------|
| 1          | OFF       | RUN       | VDD_SVNS_IN supply present.                          |
| 2          | SNVS      | OFF       | VDD_SNVS_IN supply removal.                          |
| 3          | RUN       | SNVS      | ONOFF long press, or SW.                             |
| 4          | SNVS      | RUN       | ONOFF press, or RTC, or tamper event.                |
| 5          | RUN       | LPSR      | SW.                                                  |
| 6          | LPSR      | RUN       | ONOFF press, or RTC, or tamper event, or GPIO event. |
| 7          | RUN       | Low Power | SW (CPU execute WFI)                                 |
| 8          | Low Power | RUN       | RTC, tamper event, IRQ.                              |

The following table summarizes the external power supply state in all the power modes.

**Table 14. Power modes**

| Power rail                                 | OFF      | SNVS     | LPSR     | RUN      | Low Power |
|--------------------------------------------|----------|----------|----------|----------|-----------|
| VDD_ARM                                    | OFF      | OFF      | OFF      | ON       | ON/ OFF   |
| VDD_SOC                                    | OFF      | OFF      | OFF      | ON       | ON        |
| VDDA_1P8_IN                                | OFF      | OFF      | OFF      | ON       | ON        |
| VDD_SNVS_IN                                | OFF      | ON       | ON       | ON       | ON        |
| VDD_LPSR_IN                                | OFF      | OFF      | ON       | ON       | ON        |
| NVCC_GPIO1/2                               | OFF      | OFF      | ON       | ON       | ON        |
| NVCC_DRAM                                  | OFF      | OFF      | OFF      | ON       | ON        |
| NVCC_DRAM_CKE                              | OFF      | OFF / ON | OFF / ON | ON       | ON        |
| NVCC_XXX                                   | OFF      | OFF      | OFF      | ON / OFF | ON / OFF  |
| VDD_USB_OTG1_3P3_IN<br>VDD_USB_OTG2_3P3_IN | OFF / ON | OFF / ON | OFF / ON | ON / OFF | ON / OFF  |

The NVCC\_DRAM\_CKE can be still ON during SNVS/LPSR mode to keep the CKE/RESET pad in correct state to hold DRAM device in self-refresh mode.

The NVCC\_XXX can be off in RUN mode / Low Power mode if all the pads in that IO bank is not used in the application, the NVCC\_XXX supply could be tied to GND.

The VDD\_USB\_OTG1\_3P3\_IN and VDD\_USB\_OTG2\_3P3\_IN are fully asynchronous to other power rails, so it can be either ON/OFF in any of the power modes.

#### 4.1.6.1 OFF Mode

In OFF mode, all the power rails are shut off.

#### 4.1.6.2 SNVS Mode

SNVS mode is also called RTC mode, where only the power for the SNVS domain remain on. In this mode, only the RTC and tamper detection logic is still active.

The power consumption in SNVS model with all the tamper detection logic enabled will be less than 5  $\mu$ A @ 3.0 V on VDD\_SNVS\_IN for typical silicon at 25°C.

The external DRAM device can keep in self-refresh when the chip stays in SNVS mode with NVCC\_DRAM\_CKE still powered. During the state transition between SNVS mode to/from ON mode, the DRAM\_CKE pad and DRAM\_RESET pad has to always stay in correct state to keep DRAM in self-refresh mode. No glitch / floating is allowed.

### 4.1.6.3 LPSR Mode

LPSR is considered as an extension of the SNVS mode. All the features supported in SNVS mode is also supported in LPSR mode, including the capability of keeping DRAM device in self-refresh.

In LPSR mode, three additional power rails will remain on: VDD\_LPSR\_IN, NVCC\_GPIO1, and NVCC\_GPIO2. These three power rails are used to supply the logic and IO pads in the LPSR domain. The purpose of this mode is to retain the state of 16 GPIO pads, so the other components in the whole system will have their control signal in correct state.

Among all the 16 GPIO pads, the NVCC\_GPIO1 supply the power for 8 GPIO pads, and the NVCC\_GPIO2 supply the power for the other 8 GPIO pads. This allows the SoC to have some of its GPIO working at 1.8 V while others working at 3.3 V in the LPSR mode.

When LPSR mode is not needed for the application, the VDD\_LPSR can be connected to VDDA\_1P8 and NVCC\_GPIO1/2 can be connected to the same power supply as NVCC\_XXX for other GPIO banks.

In LPSR mode, the supported wakeup source are RTC alarm, ONOFF event, security/tamper and also the 16 GPIO pads.

### 4.1.6.4 RUN Mode

In RUN mode, the CPU is active and running, and the analog / digital peripheral modules inside the processor will be enabled. In this mode, all the external power rails to the processor have to be ON and the SoC will be able to draw as many current as listed in the Table 5 Maximum Power Requirement.

In this mode, the PMIC should allow SoC to change the voltage of power rails through I2C/SPI interface. Typically, when the CPU is doing DVFS, it switches the VDD\_ARM voltage according to [Table 9](#).

### 4.1.6.5 Low Power Mode

When the CPU is not running, the processor can enter low power mode. i.MX 7Dual processor supports a very flexible set of power mode configurations in low power mode.

Typically there are 3 low power modes used, System IDLE, Low Power IDLE and SUSPEND:

- System IDLE—This is a mode that the CPU can automatically enter when there is no thread running. All the peripherals can keep working and the CPU's state is retained so the interrupt response can be very short. The cores are able to individually enter the WAIT state.
- Low Power IDLE—This mode is for the case when the system needs to have lower power but still keep some of the peripherals alive. Most of the peripherals, analog modules, and PHYs are shut off; see Table 5-5, “Low Power Mode Definition,” in the *i.MX 7Solo Application Processor Reference Manual* (IMX7SRM) for details. The interrupt response in this mode is expected to be longer than the System IDLE, but its power is much lower.
- Suspend—This mode has the greatest power savings; all clocks, unused analog/PHYs, and peripherals are off. The external DRAM stays in Self-Refresh mode. The exit time from this mode is much longer.

In System IDLE and Low Power IDLE mode, the voltage on external power supplies remains the same as in RUN mode, so the external PMIC is not aware of the state of the processor. If any low-power setting

needs to be applied to PMIC, it is done through the I2C/SPI interface before the processor enters a low-power mode.

When the processor enters SUSPEND mode, it will assert the PMIC\_STBY\_REQ signal to PMIC. When this signal is asserted, the processor allows the PMIC to shut off VDD\_ARM externally. However, in some application scenario, SW want to keep the data in L2 Cache to avoid performance impact on cache miss. In this case, the VDD\_ARM cannot be shut off. To support both scenarios, the PMIC should have an option to shut off or keep VDD\_ARM when it receives the PMIC\_STBY\_REQ. This should be configured through I2C/SPI interface before the processor enters SUSPEND mode.

Except the VDD\_ARM, the other power rails have to keep active in SUSPEND mode. Since the current on each power rail is greatly reduced in this mode, PMIC can enter its own low power mode to get extra power saving. For example, the PMIC can change the DCDC rails to PFM mode to reduce the power consumption.

The power consumption in low power modes is defined in [Table 15](#).

**Table 15. Low Power Measurements**

| Power rail   | System IDLE |         |              | Low Power IDLE |         |             | SUSPEND |         |             | LPSR    |         |             |
|--------------|-------------|---------|--------------|----------------|---------|-------------|---------|---------|-------------|---------|---------|-------------|
|              | Voltage     | Current | Power        | Voltage        | Current | Power       | Voltage | Current | Power       | Voltage | Current | Power       |
|              | (V)         | (mA)    | (mW)         | (V)            | (mA)    | (mW)        | (V)     | (mA)    | (mW)        | (V)     | (mA)    | (mW)        |
| VDD_ARM      | 1.0         | 2.7     | 2.70         | 1.0            | 0.428   | 0.43        | 1.0     | 0.3     | 0.30        | 0.0     | —       | 0.00        |
| VDD_SOC      | 1.0         | 19.38   | 19.38        | 1.0            | 1.423   | 1.42        | 1.0     | 0.6     | 0.60        | 0.0     | —       | 0.00        |
| VDDA_1P8_IN  | 1.8         | 3.46    | 6.23         | 1.8            | 0.206   | 0.37        | 1.8     | 0.4     | 0.72        | 0.0     | —       | 0.00        |
| VDD_SNV5_IN  | 3.0         | 0.006   | 0.018        | 3.0            | 0.005   | 0.015       | 3.0     | 0.006   | 0.018       | 3.0     | 0.003   | 0.009       |
| VDD_LPSR_IN  | 1.8         | 0.04    | 0.07         | 1.8            | 0.041   | 0.07        | 1.8     | 0.039   | 0.0702      | 1.8     | 0.04    | 0.07        |
| NVCC_GPIO1/2 | 1.8         | 0.072   | 0.13         | 1.8            | 0.073   | 0.13        | 1.8     | 0.072   | 0.13        | 1.8     | 0.072   | 0.13        |
| <b>Total</b> | —           | —       | <b>28.53</b> | —              | —       | <b>2.45</b> | —       | —       | <b>1.84</b> | —       | —       | <b>0.21</b> |

All the power numbers defined in [Table 15](#) are based on typical silicon at 25°C.

## 4.1.7 USB PHY Suspend current consumption

### 4.1.7.1 Low Power Suspend Mode

The VBUS Valid comparators and their associated bandgap circuits are enabled by default. [Table 16](#) shows the USB interface current consumption in Suspend mode with default settings.

**Table 16. USB PHY current consumption with default settings<sup>1</sup>**

|         | VDD_USB_OTG1_3P3_IN | VDD_USB_OTG2_3P3_IN |
|---------|---------------------|---------------------|
| Current | 790 uA              | 790 uA              |

<sup>1</sup> Low Power Suspend is enabled by setting USBx\_PORTSC1 [PHCD]=1 [Clock Disable (PLPSCD)].

### 4.1.7.2 4.1.7.2 Power-Down modes

[Table 17](#) shows the USB interface current consumption with only the OTG block powered down.

**Table 17. USB PHY current consumption with VBUS Valid Comparators disabled<sup>1</sup>**

|         | VDD_USB_OTG1_3P3_IN | VDD_USB_OTG2_3P3_IN |
|---------|---------------------|---------------------|
| Current | 730 uA              | 730 uA              |

<sup>1</sup> VBUS Valid comparators can be disabled through software by setting USBNC\_OTG\*\_PHY\_CFG2[OTGDISABLE0] to 1. This signal powers down only the VBUS Valid comparator, and does not control power to the Session Valid Comparator, ADP Probe and Sense comparators, or the ID detection circuitry.

In Power-Down mode, everything is powered down, including the USB\_VBUS valid comparators and their associated bandgap circuitry in typical condition. [Table 18](#) shows the USB interface current consumption in Power-Down mode.

**Table 18. USB PHY current consumption in Power-Down mode<sup>1</sup>**

|         | VDD_USB_OTG1_3P3_IN | VDD_USB_OTG2_3P3_IN |
|---------|---------------------|---------------------|
| Current | 200 uA              | 200 uA              |

<sup>1</sup> The VBUS Valid Comparators and their associated bandgap circuits can be disabled through software by setting USBNC\_OTG\*\_PHY\_CFG2[OTGDISABLE0] to 1 and USBNC\_OTG\*\_PHY\_CFG2[DRVVBUS0] to 0, respectively.

The system design must comply with power-up sequence, power-down sequence, and steady state guidelines as described in this section to guarantee the reliable operation of the device. Any deviation from these sequences may result in the following situations:

- Excessive current during power-up phase
- Prevention of the device from booting
- Irreversible damage to the processor (worst-case scenario)

### 4.1.8 Power-up sequence

The i.MX7 processor has the following power-up sequence requirements:

- VDD\_SNVS\_IN to be turned on before any other power supply. If a coin cell is used to power VDD\_SNVS\_IN, then ensure that it is connected before any other supply is switched on.
- VDD\_SOC to be turned on before NVCC\_DRAM and NVCC\_DRAM\_CKE.
- VDD\_ARM, VDD\_SOC, VDDA\_1P8\_IN, VDD\_LPSR\_IN and all I/O power (NVCC\_\*) should be turned on after VDD\_SNVS\_IN is active. But there is no sequence requirement among these power rails other than the sequence requirement between VDD\_SOC and NVCC\_DRAM/NVCC\_DRAM\_CKE.
- There are no special timing requirements for VDD\_USB\_OTG1\_3P3\_IN and VDD\_USB\_OTG2\_3P3\_IN.

The POR\_B input (if used) must be immediately asserted at power-up and remain asserted until the last power rail reaches its working voltage. In the absence of an external reset feeding the POR\_B input, the internal POR module takes control.

The power-up sequence is shown in [Figure 4](#) with the following timing parameters:

- |    |                                                                                                                                      |
|----|--------------------------------------------------------------------------------------------------------------------------------------|
| T1 | Time from SVNS power stable to other power rails start to ramp, minimal delay is 2ms, no max delay requirement.                      |
| T2 | Time from first power rails (except SNVS) ramp up to all the power rails get stable, minimal delay is 0ms, no max delay requirement. |
| T3 | Time from all power rails get stable to power-on reset, minimal delay is 0ms, no max delay requirement.                              |
| T6 | Time from VDD_SOC get stable to NVCC_DRAM/NVCC_DRAM_CKE start to ramp, minimal delay is 0ms, no max delay requirement.               |

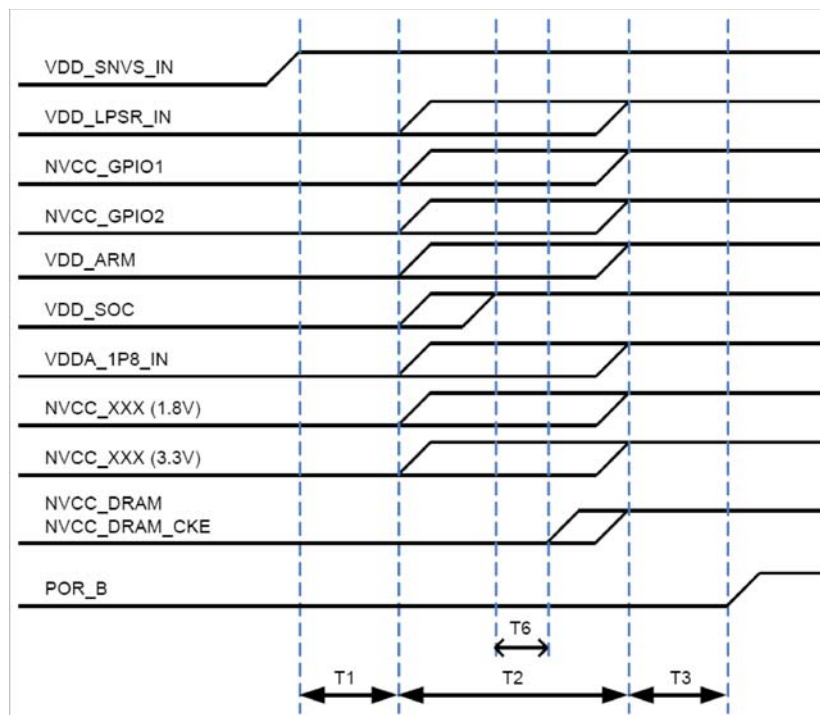


Figure 4. i.MX 7Solo power-up sequence

#### 4.1.9 Power-down sequence

The i.MX7 processors have the following power-down sequence requirements:

- VDD\_SNVS\_IN to be turned off last after any other power supply.
- NVCC\_DRAM/NVCC\_DRAM\_CKE to be turned off before VDD\_SOC.
- There are no special timing requirements for VDD\_USB\_OTG1\_3P3\_IN and VDD\_USB\_OTG2\_3P3\_IN.

The power-down sequence is shown in Figure 5 with the following timing parameters:

- T4 Time from first power rails (except SNVS) to ramp down to all the power rails (except SNVS) get to ground, minimal delay is 0ms, no max delay requirement.
- T5 Time from all the power rails power down (except SNVS) to SNVS power down, minimal delay is 0ms, no max delay requirement.
- T7 Time from NVCC\_DRAM/NVCC\_DRAM\_CKE power down to VDD\_SOC power down, minimal delay is 0ms, no max delay requirement.

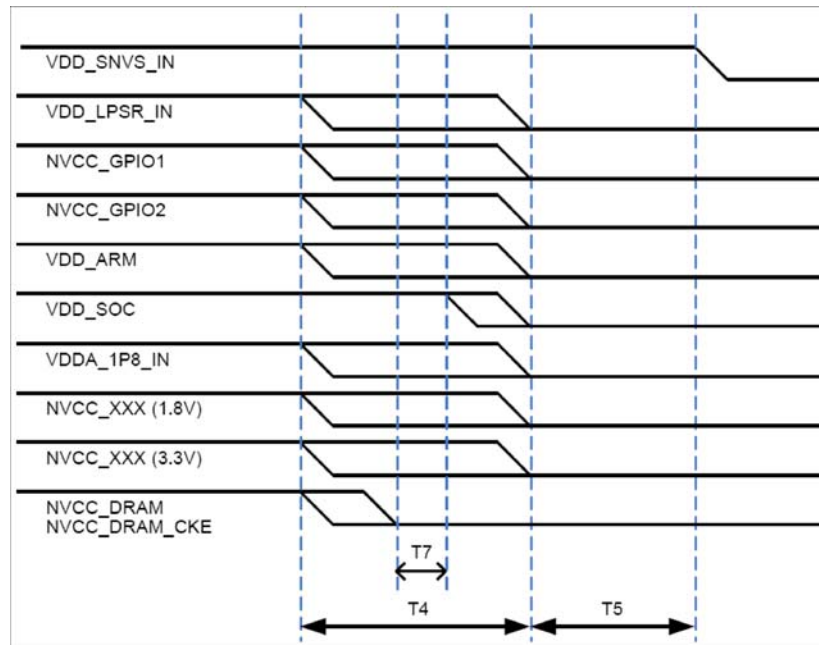


Figure 5. i.MX 7Solo power-down sequence

#### 4.1.10 Power supplies usage

I/O pins should not be externally driven while the I/O power supply for the pin (NVCC\_xxx) is OFF. This can cause internal latch-up and malfunctions due to reverse current flows. For information about I/O power supply of each pin, see “Power Rail” columns in pin list tables of [Section 6, “Package information and contact assignments.”](#)

## 4.2 Integrated LDO voltage regulator parameters

Various internal supplies can be powered from internal LDO voltage regulators. All the supply pins named \*\_CAP must be connected to external capacitors. The onboard LDOs are intended for internal use only and should not be used to power any external circuitry. See the *i.MX 7Solo Application Processor Reference Manual* (IMX7SRM) for details on the power tree scheme.

### NOTE

The \*\_CAP signals must not be powered externally. The \*\_CAP pins are for the bypass capacitor connection only.

## 4.2.1 Internal regulators

**Table 19. LDO parameters**

| Parameter           | Min  | Max   | Units |
|---------------------|------|-------|-------|
| PVCC_GPIO_AT3P3_1P8 | 1.6  | 1.98  | V     |
| VDD_1P2             | 1.1  | 1.32  | V     |
| LPSR_1P0            | 0.95 | 1.155 | V     |
| VDDA_PHY_1P8        | 1.6  | 1.98  | V     |
| USB_OTG1_1P0        | 0.95 | 1.155 | V     |

### 4.2.1.1 LDO\_1P2

The LDO\_1P2 regulator implements a programmable linear-regulator function from VDDA\_1P8\_IN (see [Table 9](#) for minimum and maximum input requirements). The typical output of the LDO, VDD\_1P2\_CAP, is 1.2 V. It is intended for use with the USB HSIC PHY, which uses this voltage level for its output driver. For additional information, see the “Power Management Unit (PMU)” chapter of the *i.MX 7Solo Application Processor Reference Manual* (IMX7SRM).

### 4.2.1.2 LDO\_1P0D

The LDO\_1P0D regulator implements a programmable linear-regulator function from VDDA\_1P8\_IN (see [Table 9](#) for minimum and maximum input requirements). The typical output of the LDO, VDD\_1P0D\_CAP, is 1.0 V. It is intended for use with the internal physical interfaces, including MIPI. For additional information, see the *i.MX 7Solo Application Processor Reference Manual* (IMX7SRM).

### 4.2.1.3 LDO\_1P0A

The LDO\_1P0A regulator implements a programmable linear-regulator function from VDDA\_1P8\_IN (see [Table 9](#) for minimum and maximum input requirements). The typical output of the LDO, VDD\_1P0A\_CAP, is 1.0 V. It is intended for use with the internal analog modules, including the XTAL, ADC, PLL, and Temperature Sensor. For additional information, see the *i.MX 7Solo Application Processor Reference Manual* (IMX7SRM).

### 4.2.1.4 LDO\_USB1\_1P0/LDO\_USB2\_1P0

The LDO\_USB1\_1P0/LDO\_USB2\_1P0 regulators implement a fixed linear-regulator function from VDD\_USB\_OTG1\_3P3\_IN and VDD\_USB\_OTG2\_3P3\_IN power inputs respectively (see [Table 9](#) for minimum and maximum input requirements). The typical output voltage is 1.0 V. It is intended for use with the internal USB physical interfaces (USB PHY1 and USB PHY2). For additional information, see the *i.MX 7Solo Application Processor Reference Manual* (IMX7SRM).

### 4.2.1.5 LDO\_SVNS\_1P8

1.8 V LDO from coin cell to generate 1.8 V power for SNVS and 32 K RTC. The LDO\_SVNS\_1P8 regulator implements a fixed linear-regulator function from VDD\_SVNS\_IN (see [Table 9](#) for minimum and maximum input requirements). The typical output is 1.7 V. It is intended for use with the internal SNVS circuitry and 32 K RTC. For additional information, see the *i.MX 7Solo Application Processor Reference Manual* (IMX7SRM).

## 4.3 PLL electrical characteristics

Table 20. PLL Electrical Parameters

| PLL type  | Parameter          | Value                           |
|-----------|--------------------|---------------------------------|
| AUDIO_PLL | Clock output range | 650 MHz–1.3 GHz                 |
|           | Reference clock    | 24 MHz                          |
|           | Lock time          | <11250 reference cycles         |
| VIDEO_PLL | Clock output range | 650 MHz–1.3 GHz                 |
|           | Reference clock    | 24 MHz                          |
|           | Lock time          | <383 reference cycles           |
| SYS_PLL   | Clock output range | 480 MHz                         |
|           | Reference clock    | 24 MHz                          |
|           | Lock time          | <383 reference cycles           |
| ENET_PLL  | Clock output range | 650 MHz–1.3 GHz, set to 1.0 GHz |
|           | Reference clock    | 24 MHz                          |
|           | Lock time          | <11250 reference cycles         |
| ARM_PLL   | Clock output range | 800 MHz–1.2 GHz                 |
|           | Reference clock    | 24 MHz                          |
|           | Lock time          | <2250 reference cycles          |
| DRAM_PLL  | Clock output range | 800 MHz–1066 MHz                |
|           | Reference clock    | 24 MHz                          |
|           | Lock time          | >2250 reference cycles          |

## 4.4 On-chip oscillators

### 4.4.1 OSC24M

Power for the oscillator is supplied from a clean source of VDDA\_1P8. This block implements an amplifier that when combined with a suitable quartz crystal and external load capacitors implements an oscillator. The oscillator is powered from VDDA\_1P8.

The system crystal oscillator consists of a Pierce-type structure running off the digital supply. A straight forward biased-inverter implementation is used.

#### 4.4.2 OSC32K

This block implements an internal amplifier, trimable load capacitors and a resistor that when combined with a suitable quartz crystal implements a low power oscillator.

In addition, if the clock monitor determines that the OSC32K is not present then the source of the 32 kHz clock will automatically switch to the internal relaxation oscillator of lesser frequency accuracy.

#### CAUTION

The internal RTC oscillator does not provide an accurate frequency and is affected by process, voltage and temperature variations. NXP strongly recommends using an external crystal as the RTC\_XTALI reference. If the internal oscillator is used instead, careful consideration must be given to the timing implications on all of the SoC modules dependent on this clock.

The OSC32k runs from VDD\_SNVs\_1p8\_CAP, which is regulated from VDD\_SNVs. The target battery is an ~3 V coin cell for VDD\_SNVs and the regulated output is ~1.75V.

**Table 21. OSC32K Main Characteristics**

|                                  | Min | Typ        | Max | Comments                                                                                                                                                                                                                                                                                                                                                   |
|----------------------------------|-----|------------|-----|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Fosc                             | —   | 32.768 KHz | —   | This frequency is nominal and determined by the crystal selected. 32.0 K would work as well.                                                                                                                                                                                                                                                               |
| Current consumption              | —   | 350 nA     | —   | The typical value shown is only for the oscillator, driven by an external crystal. If the interrelaxation oscillator is used instead of an external crystal then approximately 250 nA should be added to this value.                                                                                                                                       |
| Bias resistor                    | —   | 200 MΩ     |     | This is the integrated bias resistor that sets the amplifier into a high gain state. Any leakage through the ESD network, external board leakage, or even a scope probe that is significant relative to this value will debias the amp. The debiasing will result in low gain and will impact the circuit's ability to start up and maintain oscillations. |
| <b>Target Crystal Properties</b> |     |            |     |                                                                                                                                                                                                                                                                                                                                                            |
| Cload                            | —   | 10 pF      | —   | Usually, crystals can be purchased tuned for different Cload. This Cload value is typically 1/2 of the capacitances realized on the PCB on either side of the quartz. A higher Cload will decrease oscillation margin but increases current oscillating through the crystal. The Cload is programmable in 2 pF steps.                                      |
| ESR                              | —   | 50 KΩ      | —   | Equivalent series resistance of the crystal. Choosing a crystal with a higher value will decrease oscillating margin.                                                                                                                                                                                                                                      |

### 4.5 I/O DC parameters

This section includes the DC parameters of the following I/O types:

## Electrical characteristics

- General Purpose I/O (GPIO)
- Double Data Rate I/O (DDR) for LPDDR3 and DDR3 modes
- Differential I/O (CCM\_CLK1)

### 4.5.1 General purpose I/O (GPIO) DC parameters

Table 22 shows DC parameters for GPIO pads. The parameters in Table 22 are guaranteed per the operating ranges in Table 9, unless otherwise noted.

**Table 22. GPIO DC Parameters**

| Parameter                             | Symbol    | Test Conditions                                                                                  | Min               | Max               | Units |
|---------------------------------------|-----------|--------------------------------------------------------------------------------------------------|-------------------|-------------------|-------|
| High-level output voltage             | $V_{OH}$  | $I_{OH} = -1.8\text{mA}, -3.6\text{mA}, -7.2\text{mA}, -10.8\text{mA}$                           | $0.8 \times OVDD$ | $OVDD$            | V     |
| Low-level output voltage              | $V_{OL}$  | $I_{OL} = 1.8\text{mA}, 3.6\text{mA}, 7.2\text{mA}, 10.8\text{mA}$                               | 0                 | $0.2 \times OVDD$ | V     |
| High-level input voltage              | $V_{IH}$  | —                                                                                                | $0.7 \times OVDD$ | $OVDD + 0.3$      | V     |
| Low-level input voltage               | $V_{IL}$  | —                                                                                                | -0.3              | $0.3 \times OVDD$ | V     |
| Input hysteresis                      | $V_{HYS}$ | —                                                                                                | 0.15              | —                 | V     |
| Pull-up resistor (5_kΩ PU)            | —         | $V_{DD} = 1.8 \pm 0.15\text{ V}$                                                                 | 5.94              | 5.98              | KΩ    |
| Pull-up resistor (5_kΩ PU)            | —         | $V_{DD} = 3.3 \pm 0.3\text{ V}$                                                                  | 4.8               | 5.3               | KΩ    |
| Pull-up resistor (47_kΩ PU)           | —         | $V_{DD} = 1.8 \pm 0.15\text{ V}$                                                                 | 46.1              | 50.6              | KΩ    |
| Pull-up resistor (47_kΩ PU)           | —         | $V_{DD} = 3.3 \pm 0.3\text{ V}$                                                                  | 45.8              | 49.8              | KΩ    |
| Pull-up resistor (100_kΩ PU)          | —         | $V_{DD} = 1.8 \pm 0.15\text{ V}$                                                                 | 97.5              | 105.9             | KΩ    |
| Pull-up resistor (100_kΩ PU)          | —         | $V_{DD} = 3.3 \pm 0.3\text{ V}$                                                                  | 101               | 105               | KΩ    |
| Pull-down resistor (100_kΩ PU)        | —         | $V_{DD} = 1.8 \pm 0.15\text{ V}$                                                                 | 101               | 108.6             | KΩ    |
| Pull-down resistor (100_kΩ PD)        | —         | $V_{DD} = 3.3 \pm 0.3\text{ V}$                                                                  | 101               | 108               | KΩ    |
| Input current (no PU/PD)              | $I_{OZ}$  | —                                                                                                | -5                | 5                 | μA    |
| Sink/source current in Push-Pull mode | —         | Driving currents (@100MHz,<br>$V_{OL}/H = 0.5 \times OVDD$ , SS, 125°C)<br>$OVDD = 2.7\text{ V}$ | -32.9             | 32.9              | mA    |

### 4.5.2 DDR I/O DC electrical characteristics

The DDR I/O pads support DDR3/DDR3L, LPDDR2, and LPDDR3 operational modes. The DDR Memory Controller (DDRMCMC) is designed to be compatible with JEDEC-compliant SDRAMs. The DDRC supports the following memory types:

- DDR3 SDRAM compliant to JESD79-3E DDR3 JEDEC standard release July, 2010
- LPDDR2 SDRAM compliant to JESD209-2B LPDDR2 JEDEC standard release June, 2009
- LPDDR3 SDRAM compliant to JESD209-3B LPDDR3 JEDEC standard release August, 2013

DDRMC operation with the standards stated above is contingent upon the board DDR design adherence to the DDR design and layout requirements stated in the hardware development guide for the i.MX 7 application processor.

Table 23. DC input logic level

| Characteristics                  | Symbol       | Min             | Max             | Unit |
|----------------------------------|--------------|-----------------|-----------------|------|
| DC input logic high <sup>1</sup> | $V_{IH(DC)}$ | $V_{REF} + 100$ | —               | mV   |
| DC input logic low <sup>1</sup>  | $V_{IL(DC)}$ | —               | $V_{REF} - 100$ |      |

<sup>1</sup> It is the relationship of the  $V_{DDQ}$  of the driving device and the  $V_{REF}$  of the receiving device that determines noise margins. However, in the case of  $V_{IH(DC)}$  max (that is, input overdrive), it is the  $V_{DDQ}$  of the receiving device that is referenced.

Table 24. Output DC current drive

| Characteristics                                                   | Symbol       | Min                  | Max                  | Unit |
|-------------------------------------------------------------------|--------------|----------------------|----------------------|------|
| Output minimum source DC current <sup>1</sup>                     | $I_{OH(DC)}$ | −4                   | —                    | mA   |
| Output minimum sink DC current <sup>1</sup>                       | $I_{OL(DC)}$ | 4                    | —                    | mA   |
| DC output high voltage( $I_{OH} = -0.1\text{mA}$ ) <sup>1,2</sup> | $V_{OH}$     | $0.9 \times V_{DDQ}$ | —                    | V    |
| DC output low voltage( $I_{OL} = 0.1\text{mA}$ ) <sup>1,2</sup>   | $V_{OL}$     | —                    | $0.1 \times V_{DDQ}$ | V    |

<sup>1</sup> When DDS=[111] and without ZQ calibration.

<sup>2</sup> The values of  $V_{OH}$  and  $V_{OL}$  are valid only for 1.2 V range.

Table 25. Input DC current

| Characteristics                         | Symbol   | Min | Max | Unit          |
|-----------------------------------------|----------|-----|-----|---------------|
| High level input current <sup>1,2</sup> | $I_{IH}$ | −25 | 25  | $\mu\text{A}$ |
| Low level input current <sup>1,2</sup>  | $I_{IL}$ | −25 | 25  | $\mu\text{A}$ |

<sup>1</sup> The values of  $V_{OH}$  and  $V_{OL}$  are valid only for 1.2 V range.

<sup>2</sup> Driver Hi-Z and input power-down (PD=High)

#### 4.5.2.1 LPDDR3 mode I/O DC parameters

Table 26. LPDDR3 I/O DC electrical parameters

| Parameters                | Symbol    | Test Conditions          | Min                | Max                | Unit |
|---------------------------|-----------|--------------------------|--------------------|--------------------|------|
| High-level output voltage | $V_{OH}$  | $I_{oh} = -0.1\text{mA}$ | $0.9 \times OVDD$  | —                  | V    |
| Low-level output voltage  | $V_{OL}$  | $I_{ol} = 0.1\text{mA}$  | —                  | $0.1 \times OVDD$  | V    |
| Input Reference Voltage   | $V_{ref}$ | —                        | $0.49 \times OVDD$ | $0.51 \times OVDD$ | V    |

Table 26. LPDDR3 I/O DC electrical parameters(continued)

| Parameters                           | Symbol   | Test Conditions   | Min                   | Max                   | Unit |
|--------------------------------------|----------|-------------------|-----------------------|-----------------------|------|
| DC High-Level input voltage          | Vih_DC   | —                 | VRef + 0.100          | OVDD                  | V    |
| DC Low-Level input voltage           | Vil_DC   | —                 | OVSS                  | VRef – 0.100          | V    |
| Differential Input Logic High        | Vih_diff | —                 | 0.26                  | See note <sup>1</sup> | —    |
| Differential Input Logic Low         | Vil_diff | —                 | See note <sup>1</sup> | -0.26                 | —    |
| Pull-up/Pull-down Impedance Mismatch | Mmpupd   | —                 | -15                   | 15                    | %    |
| 240 ?unit calibration resolution     | Rres     | —                 | —                     | 10                    | ?    |
| Keeper Circuit Resistance            | Rkeep    | —                 | 110                   | 175                   | k?   |
| Input current (no pull-up/down)      | Iin      | VI = 0, VI = OVDD | -2.5                  | 2.5                   | μA   |

<sup>1</sup> The single-ended signals need to be within the respective limits (Vih(dc) max, Vil(dc) min) for single-ended signals as well as the limitations for overshoot and undershoot.

### 4.5.3 Differential I/O port (CCM\_CLK1P/N)

The clock I/O interface is designed to be compatible with TIA/EIA 644-A standard. See TIA/EIA STANDARD 644-A, *Electrical Characteristics of Low Voltage Differential Signaling (LVDS) Interface Circuits* (2001), for details.

Table 27 shows the clock I/O DC parameters.

Table 27. Differential clock I/O DC electrical characteristics

| Symbol   | Parameter                    | Test conditions                         | Min   | Typ   | Max   | Unit | Notes                           |
|----------|------------------------------|-----------------------------------------|-------|-------|-------|------|---------------------------------|
| Vod      | Output Differential Voltage  | Rload=100 Ω between padp and padn       | 250   | 350   | 450   | mV   | Vpadp–Vpadn                     |
| Voh      | High-level output voltage    |                                         | 1.025 | 1.175 | 1.325 | V    | <sup>1</sup>                    |
| Vol      | Low-level output voltage     |                                         | 0.675 | 0.825 | 0.975 |      | <sup>2</sup>                    |
| Vocm     | Output common mode voltage   |                                         | 0.9   | 1     | 1.1   |      | Core supply is used             |
| Vid      | Input Differential Voltage   |                                         | 100   |       | 600   | mV   | Vpadp–Vpadn                     |
| Vicm     | Input common mode voltage    |                                         | 50m   |       | 1.57  | V    | Vicm(max)=ovdd(m in)–Vid(min)/2 |
| Icc-ovdd | Tri-state I/O supply current | ipp_ibe=ipp_obe=0 irefin disabled (0uA) |       |       | 0.46  | uA   |                                 |

Table 27. Differential clock I/O DC electrical characteristics(continued)

| Symbol      | Parameter                                      | Test conditions                                                                   | Min | Typ  | Max | Unit | Notes                                                             |
|-------------|------------------------------------------------|-----------------------------------------------------------------------------------|-----|------|-----|------|-------------------------------------------------------------------|
| icc-ovdd-ip | Tri-state I/O supply current in low-power mode | ipp_pwr_stable_b_1p8 =1<br>(means 1.8 V)<br>vddi is OFF<br>irefin disabled (0 uA) |     | 0.35 | 1   | uA   |                                                                   |
| icc-vddi    | Tri-state core supply current                  | ipp_ibe=ipp_obe=0<br>irefin disabled (0 uA)                                       |     |      | 0.8 |      |                                                                   |
| icc         | Power supply current (ovdd)                    | Rload=100 $\Omega$ between padp and padn                                          |     |      | 4.7 | mA   | This is not including current through external Rload=100 $\Omega$ |

<sup>1</sup>  $VOH_{max} = Vos_{max} + Vod_{max}/2 = 1.1 + 0.225 = 1.325$  V.  $VOH_{min} = Vos_{min} + Vod_{min}/2 = 0.9 + 0.125 = 1.025$  V.

<sup>2</sup>  $VOL_{max} = Vos_{max} - Vod_{min}/2 = 1.1 - 0.125 = 0.975$  V.  $VOL_{min} = Vos_{min} - Vod_{max}/2 = 0.9 - 0.225 = 0.675$  V

## 4.6 I/O AC parameters

This section includes the AC parameters of the following I/O types:

- General Purpose I/O (GPIO)
- Double Data Rate I/O (DDR) for LPDDR2, LPDDR3 and DDR3/DDR3L modes
- Differential I/O (CCM\_CLK1)

The GPIO and DDR I/O load circuit and output transition time waveforms are shown in [Figure 6](#) and [Figure 7](#).

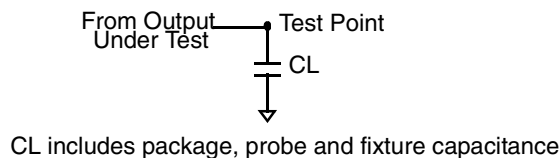


Figure 6. Load circuit for output

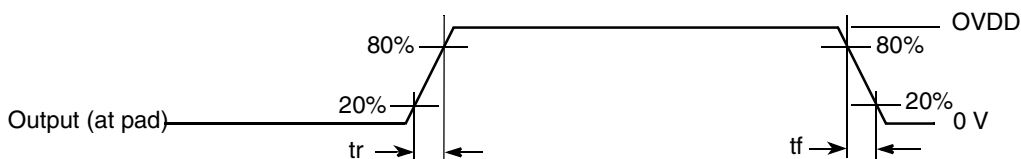


Figure 7. Output transition time waveform

### 4.6.1 General purpose I/O AC parameters

This section presents the I/O AC parameters for GPIO in different modes. Note that the fast or slow I/O behavior is determined by the appropriate control bits in the IOMUXC control registers.

Table 28. Maximum input cell delay time

| Cell name              | Max Delay PAD → Y (ns)                |                                      |                                      |
|------------------------|---------------------------------------|--------------------------------------|--------------------------------------|
|                        | VDD=1.65 V<br>T=125°C<br>Process=Slow | VDD=2.3 V<br>T=125°C<br>Process=Slow | VDD=3.0 V<br>T=125°C<br>Process=Slow |
| PBIDIRPUD_E33_33_NT_DR | 0.9                                   | 1.5                                  | 1.4                                  |

Table 29. Output cell delay time for fixed load

| Parameter |     |    |              | Simulated Cell Delay A → PAD (ns) |           |           |                        |           |           |                        |           |           |
|-----------|-----|----|--------------|-----------------------------------|-----------|-----------|------------------------|-----------|-----------|------------------------|-----------|-----------|
|           |     |    |              | VDD = 1.65 V, T = 125°C           |           |           | VDD = 2.3 V, T = 125°C |           |           | VDD = 3.0 V, T = 125°C |           |           |
| DS0       | DS1 | SR | Driver Type  | CL= 5 pF                          | CL= 10 pF | CL= 40 pF | CL= 5 pF               | CL= 10 pF | CL= 40 pF | CL= 5 pF               | CL= 10 pF | CL= 40 pF |
| 0         | 0   | 1  | 1× Slow Slew | 4.9                               | 6.0       | 12.5      | 4.8                    | 6.1       | 11.9      | 5.4                    | 6.7       | 14.6      |
| 0         | 0   | 0  | 1× Fast Slew | 3.8                               | 4.7       | 11.2      | 3.8                    | 5.1       | 12.8      | 4.2                    | 5.3       | 13.5      |
| 0         | 1   | 1  | 2× Slow Slew | 4.1                               | 4.8       | 8.2       | 4.2                    | 4.9       | 8.8       | 4.5                    | 5.3       | 9.1       |
| 0         | 1   | 0  | 2× Fast Slew | 2.8                               | 3.3       | 6.4       | 2.9                    | 3.4       | 7.2       | 3.1                    | 3.7       | 7.2       |
| 1         | 0   | 1  | 4× Slow Slew | 3.6                               | 4.1       | 6.0       | 3.7                    | 4.1       | 6.4       | 3.9                    | 4.4       | 6.6       |
| 1         | 0   | 0  | 4× Fast Slew | 2.2                               | 2.5       | 4.1       | 2.3                    | 2.6       | 4.6       | 2.4                    | 2.8       | 4.8       |
| 1         | 1   | 1  | 6× Slow Slew | 3.6                               | 4.0       | 5.5       | 3.6                    | 4.0       | 5.9       | 3.8                    | 4.3       | 6.2       |
| 1         | 1   | 0  | 6× Fast Slew | 2.0                               | 2.3       | 3.4       | 2.1                    | 2.3       | 3.8       | 2.2                    | 2.5       | 3.9       |

Table 30. Maximum frequency of operation for input

| Maximum frequency (MHz) |                      |                         |
|-------------------------|----------------------|-------------------------|
| VDD = 1.8 V, CL = 50 fF | VDD=2.5 V, CL =50 fF | VDD = 3.3 V, CL = 50 fF |
| 550                     | 400                  | 430                     |

Table 31. Maximum frequency of operation for output<sup>1</sup>

| Parameter |     |    |              | Maximum frequency (MHz) |           |           |             |           |           |             |           |           |
|-----------|-----|----|--------------|-------------------------|-----------|-----------|-------------|-----------|-----------|-------------|-----------|-----------|
|           |     |    |              | VDD = 1.8 V             |           |           | VDD = 2.5 V |           |           | VDD = 3.3 V |           |           |
| DS0       | DS1 | SR | Driver Type  | CL= 5 pF                | CL= 10 pF | CL= 40 pF | CL= 5 pF    | CL= 10 pF | CL= 40 pF | CL= 5 pF    | CL= 10 pF | CL= 40 pF |
| 0         | 0   | 1  | 1× Slow Slew | 100                     | 70        | 25        | 90          | 60        | 20        | 95          | 60        | 20        |
| 0         | 0   | 0  | 1× Fast Slew | 110                     | 75        | 25        | 100         | 65        | 20        | 100         | 65        | 20        |
| 0         | 1   | 1  | 2× Slow Slew | 120                     | 100       | 50        | 120         | 100       | 40        | 115         | 95        | 40        |
| 0         | 1   | 0  | 2× Fast Slew | 185                     | 145       | 50        | 180         | 130       | 40        | 170         | 130       | 40        |
| 1         | 0   | 1  | 4× Slow Slew | 140                     | 125       | 85        | 135         | 120       | 70        | 130         | 115       | 70        |
| 1         | 0   | 0  | 4× Fast Slew | 235                     | 200       | 100       | 225         | 195       | 80        | 215         | 185       | 80        |
| 1         | 1   | 1  | 6× Slow Slew | 140                     | 125       | 90        | 135         | 120       | 85        | 130         | 115       | 80        |
| 1         | 1   | 0  | 6× Fast Slew | 250                     | 225       | 140       | 240         | 215       | 120       | 235         | 205       | 120       |

<sup>1</sup> Maximum frequency value is obtained with lumped capacitor load. If you consider transmission line or SSN noise effect, it could be worse than suggested value.

#### 4.6.2 Clock I/O AC parameters—CCM\_CLK1\_N/CCM\_CLK1\_P

The differential output transition time waveform is shown in [Figure 8](#).

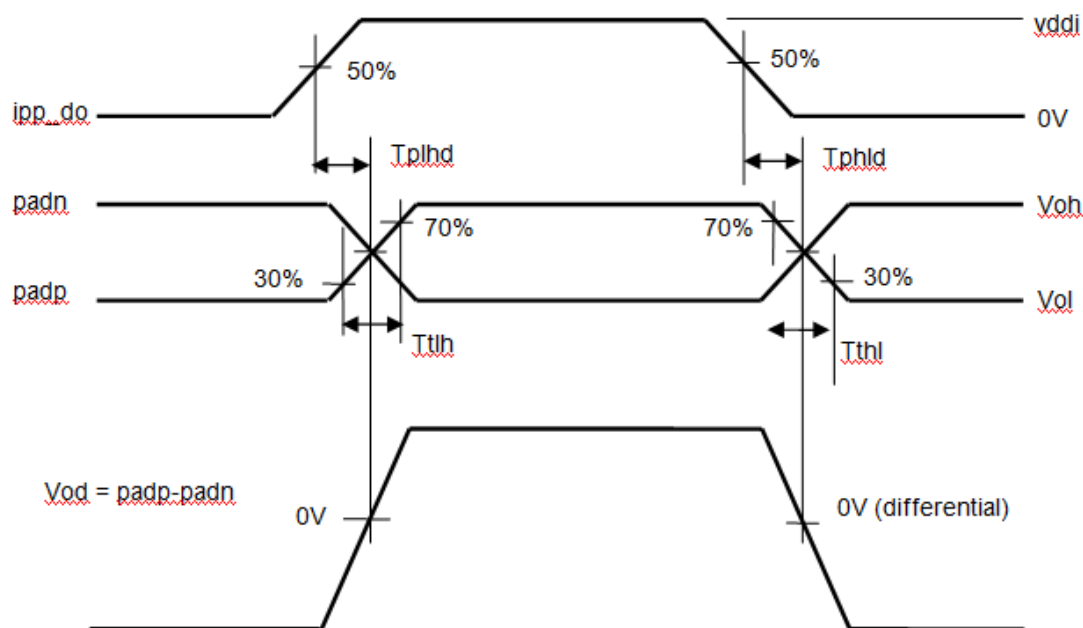


Figure 8. Differential LVDS driver transition time waveform

Table 32 shows the AC parameters for clock I/O.

Table 32. I/O AC Parameters of LVDS Pad

| Symbol     | Parameter                                          | Test conditions                                                               | Min | Typ | Max  | Unit | Notes |
|------------|----------------------------------------------------|-------------------------------------------------------------------------------|-----|-----|------|------|-------|
| $T_{phld}$ | Output Differential propagation delay high to low  | $R_{load}=100\ \Omega$ between $padp$ and $padn$ ,<br>Clod = 2pF              | —   | —   | 0.61 | ns   | 1     |
| $T_{plhd}$ | Output Differential propagation delay low to high  |                                                                               | —   | —   | 0.61 |      |       |
| $T_{tlh}$  | Output Transition time low to high                 |                                                                               | —   | —   | 0.17 |      | 2     |
| $T_{thl}$  | Output Transition time high to low                 |                                                                               | —   | —   | 0.17 |      |       |
| $T_{phlr}$ | Input Differential propagation delay high to low   | $R_{load}=100\ \Omega$ between $padp$ and $padn$ , Clod on $ipp\_ind=0.1\ pF$ | —   | —   | 0.33 | ns   | 3     |
| $T_{plhr}$ | Input Differential propagation delay low to high   |                                                                               | —   | —   | 0.33 |      |       |
| $T_{tx}$   | Transmitter startup time ( $ipp\_obe$ low to high) | —                                                                             | —   | —   | 40   | ns   | 4     |
| F          | Operating frequency                                | —                                                                             | —   | 500 | 1000 | MHz  | —     |

<sup>1</sup> At WCS, 125C, 1.62 V  $ovdd$ , 0.9 V  $vddi$ . Measurement levels are 50-50%. Output differential signal measured.

<sup>2</sup> WCS, 125C, 1.62 V  $ovdd$ , 0.9 V  $vddi$ . Measurement levels are 20-80%. Output differential signal measured

<sup>3</sup> At WCS, 125C, 1.62 V  $ovdd$ , 0.9 V  $vddi$ . Measurement levels are 50-50%.

<sup>4</sup> TX startup time is defined as the time taken by transmitter for settling after its  $ipp\_obe$  has been asserted. It is to stabilize the current reference. Functionality is guaranteed only after the startup time

## 4.7 Output buffer impedance parameters

This section defines the I/O impedance parameters of the i.MX 7Solo family of processors for the following I/O types:

- Double Data Rate I/O (DDR) for LPDDR2, LPDDR3, and DDR3/DDR3L modes
- Differential I/O (CCM\_CLK1)
- USB battery charger detection open-drain output (USB\_OTG1\_CHD\_B)

### NOTE

DDR I/O output driver impedance is measured with “long” transmission line of impedance  $Z_{tl}$  attached to I/O pad and incident wave launched into transmission line.  $R_{pu}/R_{pd}$  and  $Z_{tl}$  form a voltage divider that defines specific voltage of incident wave relative to OVDD. Output driver impedance is calculated from this voltage divider (see [Figure 9](#)).

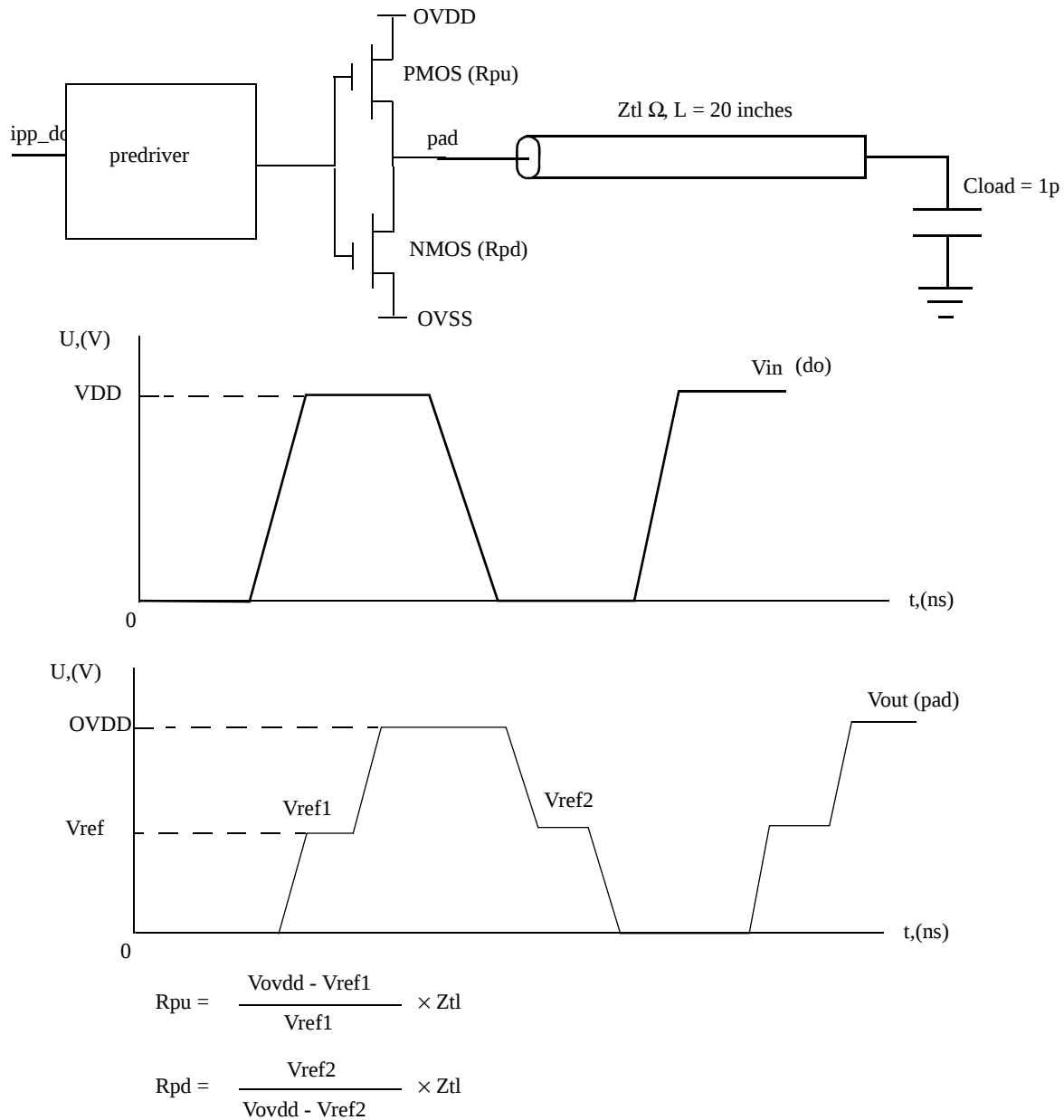


Figure 9. Impedance matching load for measurement

#### 4.7.1 DDR I/O output buffer impedance

The LPDDR2 interface is designed to be fully compatible with JESD209-2B LPDDR2 JEDEC standard release June, 2009. The LPDDR3 interface mode is designed to be compatible with JESD209-3B JEDEC standard released August, 2013. The DDR3 interface is designed to be fully compatible with JESD79-3F DDR3 JEDEC standard release July, 2012.

Table 33 shows DDR I/O output buffer impedance of i.MX 7Solo family of processors.

**Table 33. DDR I/O output buffer impedance**

| Parameter                  | Symbol | Test Conditions DSE<br>(Drive Strength) | Typical                                 |                                           | Unit     |
|----------------------------|--------|-----------------------------------------|-----------------------------------------|-------------------------------------------|----------|
|                            |        |                                         | NVCC_DRAM=1.5 V<br>(DDR3)<br>DDR_SEL=11 | NVCC_DRAM=1.2 V<br>(LPDDR2)<br>DDR_SEL=10 |          |
| Output Driver<br>Impedance | Rdrv   | 000                                     | Hi-Z                                    | Hi-Z                                      | $\Omega$ |
|                            |        | 001                                     | 240                                     | 240                                       |          |
|                            |        | 010                                     | 120                                     | 120                                       |          |
|                            |        | 011                                     | 80                                      | 80                                        |          |
|                            |        | 100                                     | 60                                      | 60                                        |          |
|                            |        | 101                                     | 48                                      | 48                                        |          |
|                            |        | 110                                     | 40                                      | 40                                        |          |
|                            |        | 111                                     | 34                                      | 34                                        |          |

**Note:**

1. Output driver impedance is controlled across PVTs using ZQ calibration procedure.
2. Calibration is done against 240  $\Omega$  external reference resistor.
3. Output driver impedance deviation (calibration accuracy) is  $\pm 5\%$  (max/min impedance) across PVTs.

## 4.7.2 Differential I/O output buffer impedance

The Differential CCM interface is designed to be compatible with TIA/EIA 644-A standard. See, TIA/EIA STANDARD 644-A, *Electrical Characteristics of Low Voltage Differential Signaling (LVDS) Interface Circuits* (2001) for details.

## 4.7.3 USB battery charger detection driver impedance

The USB\_OTG1\_CHD\_B open-drain output pin can be used to signal the results of USB Battery Charger detection routines for the USB\_OTG1 PHY instance to power management and monitoring devices. Use of this pin requires an external pullup resistor, for more information see Table 3, and Table 7.

Table 34 shows the USB\_OTG1\_CHD\_B pulldown driver impedance for the USB\_OTG1\_CHD\_B pin.

**Table 34. USB\_OTG1\_CHD\_B pulldown driver impedance (VDD\_USB\_OTG1\_3P3\_IN 3.3 V)**

| Parameter                                   | Symbol  | Typical | Unit     |
|---------------------------------------------|---------|---------|----------|
| Open-drain output driver pulldown impedance | Rdrv_pd | 1000    | $\Omega$ |

## 4.8 System modules timing

This section contains the timing and electrical parameters for the modules in each i.MX 7Solo processor.

### 4.8.1 Reset timings parameters

Figure 10 shows the reset timing and Table 35 lists the timing parameters.

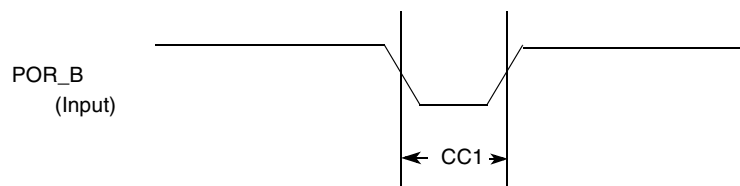


Figure 10. Reset timing diagram

Table 35. Reset timing parameters

| ID  | Parameter                                                                                               | Min | Max | Unit            |
|-----|---------------------------------------------------------------------------------------------------------|-----|-----|-----------------|
| CC1 | Duration of POR_B to be qualified as valid.<br><b>Note:</b> POR_B rise/fall times must be 5 ns or less. | 1   | —   | RTC_XTALI cycle |

### 4.8.2 WDOG Reset timing parameters

Figure 11 shows the WDOG reset timing and Table 36 lists the timing parameters.

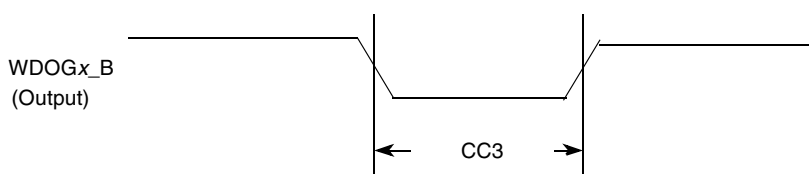


Figure 11. WDOGx\_B timing diagram

Table 36. WDOGx\_B timing parameters

| ID  | Parameter                     | Min | Max | Unit            |
|-----|-------------------------------|-----|-----|-----------------|
| CC3 | Duration of WDOG1_B Assertion | 1   | —   | RTC_XTALI cycle |

#### NOTE

RTC\_XTALI is approximately 32 kHz. RTC\_XTALI cycle is one period or approximately 30  $\mu$ s.

#### NOTE

WDOGx\_B output signals (for each one of the Watchdog modules) do not have dedicated pins, but are muxed out through the IOMUX. See the IOMUXC chapter of the *i.MX 7Solo Application Processor Reference Manual* (IMX7SRM) for detailed information.

### 4.8.3 External interface module (EIM)

The following subsections provide information on the EIM.

### 4.8.3.1 EIM interface pads allocation

EIM supports 16-bit and 8-bit devices operating in address/data separate or multiplexed modes. [Table 37](#) provides EIM interface pads allocation in different modes.

**Table 37. EIM internal module multiplexing<sup>1</sup>**

| Setup                             | Non Multiplexed Address/Data Mode |                       |                       | Multiplexed Address/<br>Data Mode |
|-----------------------------------|-----------------------------------|-----------------------|-----------------------|-----------------------------------|
|                                   | 8 Bit                             |                       | 16 Bit                | 16 Bit                            |
|                                   | MUM = 0,<br>DSZ = 100             | MUM = 0,<br>DSZ = 101 | MUM = 0,<br>DSZ = 001 | MUM = 1,<br>DSZ = 001             |
| EIM_ADDR<br>[15:00]               | EIM_AD<br>[15:00]                 | EIM_AD<br>[15:00]     | EIM_AD<br>[15:00]     | EIM_AD<br>[15:00]                 |
| EIM_ADDR<br>[25:16]               | EIM_ADDR<br>[25:16]               | EIM_ADDR<br>[25:16]   | EIM_ADDR<br>[25:16]   | EIM_ADDR<br>[25:16]               |
| EIM_DATA<br>[07:00],<br>EIM_EB0_B | EIM_DATA<br>[07:00]               | —                     | EIM_DATA<br>[07:00]   | EIM_AD<br>[07:00]                 |
| EIM_DATA<br>[15:08],<br>EIM_EB1_B | —                                 | EIM_DATA<br>[15:08]   | EIM_DATA<br>[15:08]   | EIM_AD<br>[15:08]                 |

<sup>1</sup> For more information on configuration ports mentioned in this table, see the *i.MX 7Solo Application Processor Reference Manual* (IMX7SRM).

### 4.8.3.2 General EIM Timing—Synchronous mode

Figure 12, Figure 13, and Table 38 specify the timings related to the EIM module. All EIM output control signals may be asserted and deasserted by an internal clock synchronized to the EIM\_BCLK rising edge according to corresponding assertion/negation control fields.

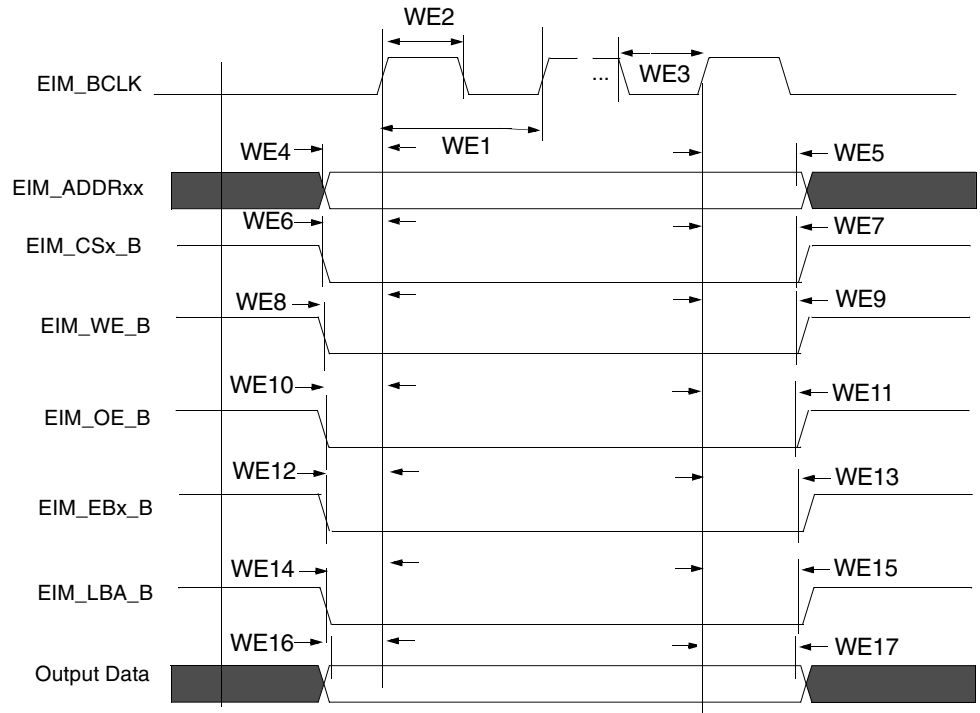


Figure 12. EIM outputs timing diagram

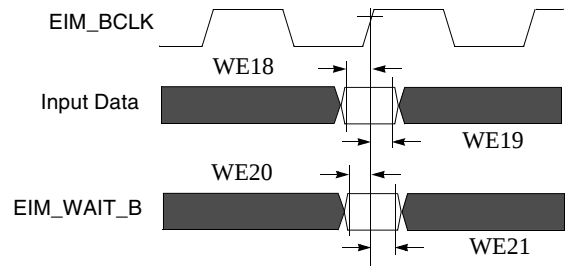


Figure 13. EIM inputs timing diagram

### 4.8.3.3 Examples of EIM synchronous accesses

Table 38. EIM bus timing parameters <sup>1</sup>

| ID   | Parameter                                | BCD = 0         |                 | BCD = 1   |           | BCD = 2         |                 | BCD = 3       |               |
|------|------------------------------------------|-----------------|-----------------|-----------|-----------|-----------------|-----------------|---------------|---------------|
|      |                                          | Min             | Max             | Min       | Max       | Min             | Max             | Min           | Max           |
| WE1  | EIM_BCLK Cycle time <sup>2</sup>         | t               | —               | 2 x t     | —         | 3 x t           | —               | 4 x t         | —             |
| WE2  | EIM_BCLK Low Level Width                 | 0.4 x t         | —               | 0.8 x t   | —         | 1.2 x t         | —               | 1.6 x t       | —             |
| WE3  | EIM_BCLK High Level Width                | 0.4 x t         | —               | 0.8 x t   | —         | 1.2 x t         | —               | 1.6 x t       | —             |
| WE4  | Clock rise to address valid <sup>3</sup> | -0.5 x t - 1.25 | -0.5 x t + 1.75 | -t - 1.25 | -t + 1.75 | -1.5 x t - 1.25 | -1.5 x t + 1.75 | -2 x t - 1.25 | -2 x t + 1.75 |
| WE5  | Clock rise to address invalid            | 0.5 x t - 1.25  | 0.5 x t + 1.75  | t - 1.25  | t + 1.75  | 1.5 x t - 1.25  | 1.5 x t + 1.75  | 2 x t - 1.25  | 2 x t + 1.75  |
| WE6  | Clock rise to EIM_CSx_B valid            | -0.5 x t - 1.25 | -0.5 x t + 1.75 | -t - 1.25 | -t + 1.75 | -1.5 x t - 1.25 | -1.5 x t + 1.75 | -2 x t - 1.25 | -2 x t + 1.75 |
| WE7  | Clock rise to EIM_CSx_B invalid          | 0.5 x t - 1.25  | 0.5 x t + 1.75  | t - 1.25  | t + 1.75  | 1.5 x t - 1.25  | 1.5 x t + 1.75  | 2 x t - 1.25  | 2 x t + 1.75  |
| WE8  | Clock rise to EIM_WE_B Valid             | -0.5 x t - 1.25 | -0.5 x t + 1.75 | -t - 1.25 | -t + 1.75 | -1.5 x t - 1.25 | -1.5 x t + 1.75 | -2 x t - 1.25 | -2 x t + 1.75 |
| WE9  | Clock rise to EIM_WE_B Invalid           | 0.5 x t - 1.25  | 0.5 x t + 1.75  | t - 1.25  | t + 1.75  | 1.5 x t - 1.25  | 1.5 x t + 1.75  | 2 x t - 1.25  | 2 x t + 1.75  |
| WE10 | Clock rise to EIM_OE_B Valid             | -0.5 x t - 1.25 | -0.5 x t + 1.75 | -t - 1.25 | -t + 1.75 | -1.5 x t - 1.25 | -1.5 x t + 1.75 | -2 x t - 1.25 | -2 x t + 1.75 |
| WE11 | Clock rise to EIM_OE_B Invalid           | 0.5 x t - 1.25  | 0.5 x t + 1.75  | t - 1.25  | t + 1.75  | 1.5 x t - 1.25  | 1.5 x t + 1.75  | 2 x t - 1.25  | 2 x t + 1.75  |
| WE12 | Clock rise to EIM_EBx_B Valid            | -0.5 x t - 1.25 | -0.5 x t + 1.75 | -t - 1.25 | -t + 1.75 | -1.5 x t - 1.25 | -1.5 x t + 1.75 | -2 x t - 1.25 | -2 x t + 1.75 |
| WE13 | Clock rise to EIM_EBx_B Invalid          | 0.5 x t - 1.25  | 0.5 x t + 1.75  | t - 1.25  | t + 1.75  | 1.5 x t - 1.25  | 1.5 x t + 1.75  | 2 x t - 1.25  | 2 x t + 1.75  |
| WE14 | Clock rise to EIM_LBA_B Valid            | -0.5 x t - 1.25 | -0.5 x t + 1.75 | -t - 1.25 | -t + 1.75 | -1.5 x t - 1.25 | -1.5 x t + 1.75 | -2 x t - 1.25 | -2 x t + 1.75 |
| WE15 | Clock rise to EIM_LBA_B Invalid          | 0.5 x t - 1.25  | 0.5 x t + 1.75  | t - 1.25  | t + 1.75  | 1.5 x t - 1.25  | 1.5 x t + 1.75  | 2 x t - 1.25  | 2 x t + 1.75  |
| WE16 | Clock rise to Output Data Valid          | -0.5 x t - 1.25 | -0.5 x t + 1.75 | -t - 1.25 | -t + 1.75 | -1.5 x t - 1.25 | -1.5 x t + 1.75 | -2 x t - 1.25 | -2 x t + 1.75 |
| WE17 | Clock rise to Output Data Invalid        | 0.5 x t - 1.25  | 0.5 x t + 1.75  | t - 1.25  | t + 1.75  | 1.5 x t - 1.25  | 1.5 x t + 1.75  | 2 x t - 1.25  | 2 x t + 1.75  |
| WE18 | Input Data setup time to Clock rise      | 2               | —               | 4         | —         | —               | —               | —             | —             |
| WE19 | Input Data hold time from Clock rise     | 2               | —               | 2         | —         | —               | —               | —             | —             |
| WE20 | EIM_WAIT_B setup time to Clock rise      | 2               | —               | 4         | —         | —               | —               | —             | —             |
| WE21 | EIM_WAIT_B hold time from Clock rise     | 2               | —               | 2         | —         | —               | —               | —             | —             |

## Electrical characteristics

<sup>1</sup>  $t$  is the maximum EIM logic (axi\_clk) cycle time. The maximum allowed axi\_clk frequency depends on the fixed/non-fixed latency configuration, whereas the maximum allowed EIM\_BCLK frequency is:

- Fixed latency for both read and write is 132 MHz.
- Variable latency for read only is 132 MHz.
- Variable latency for write only is 52 MHz.

In variable latency configuration for write, if BCD = 0 & WBCDD = 1 or BCD = 1, axi\_clk must be 104 MHz. Write BCD = 1 and 104 MHz axi\_clk, will result in a EIM\_BCLK of 52 MHz. When the clock branch to EIM is decreased to 104 MHz, other buses are impacted which are clocked from this source. See the CCM chapter of the *i.MX 7Solo Application Processor Reference Manual* (IMX7SRM) for a detailed clock tree description.

<sup>2</sup> EIM\_BCLK parameters are being measured from the 50% point, that is, high is defined as 50% of signal value and low is defined as 50% as signal value.

<sup>3</sup> For signal measurements, “High” is defined as 80% of signal value and “Low” is defined as 20% of signal value.

Figure 14 to Figure 17 provide few examples of basic EIM accesses to external memory devices with the timing parameters mentioned previously for specific control parameters settings.

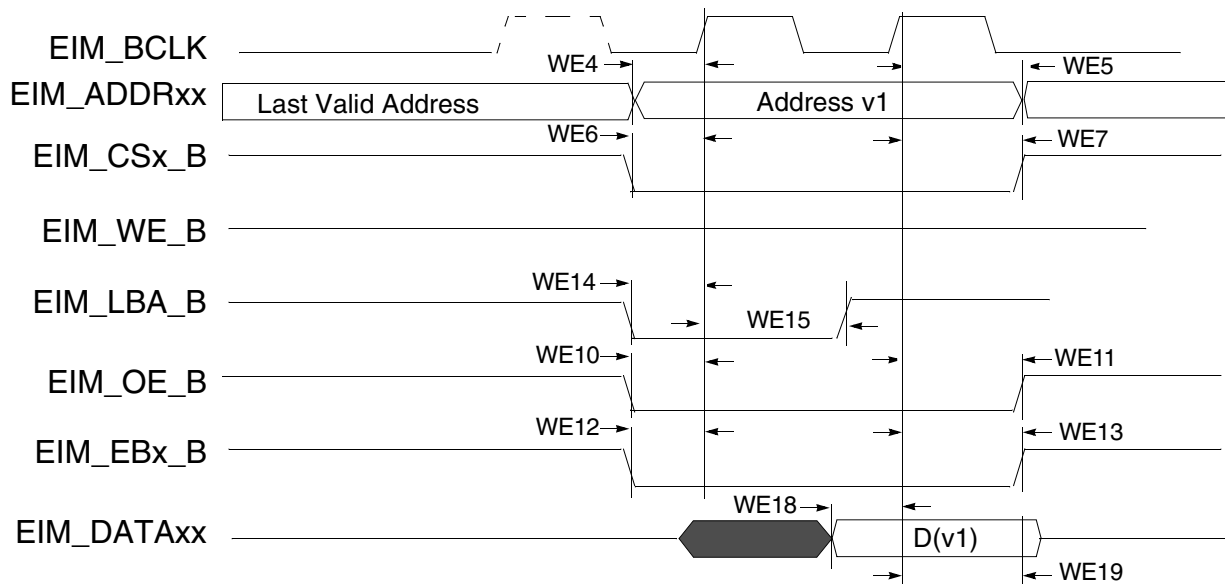


Figure 14. Synchronous memory read access, WSC=1

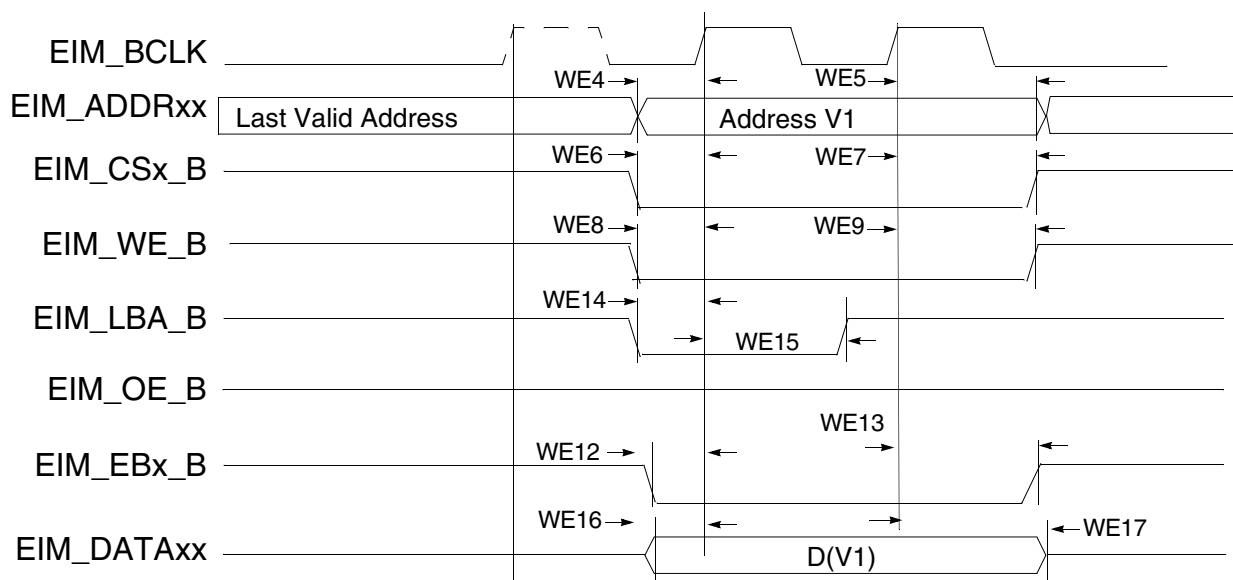


Figure 15. Synchronous memory, write access, WSC=1, WBEA=0 and WADVN=0

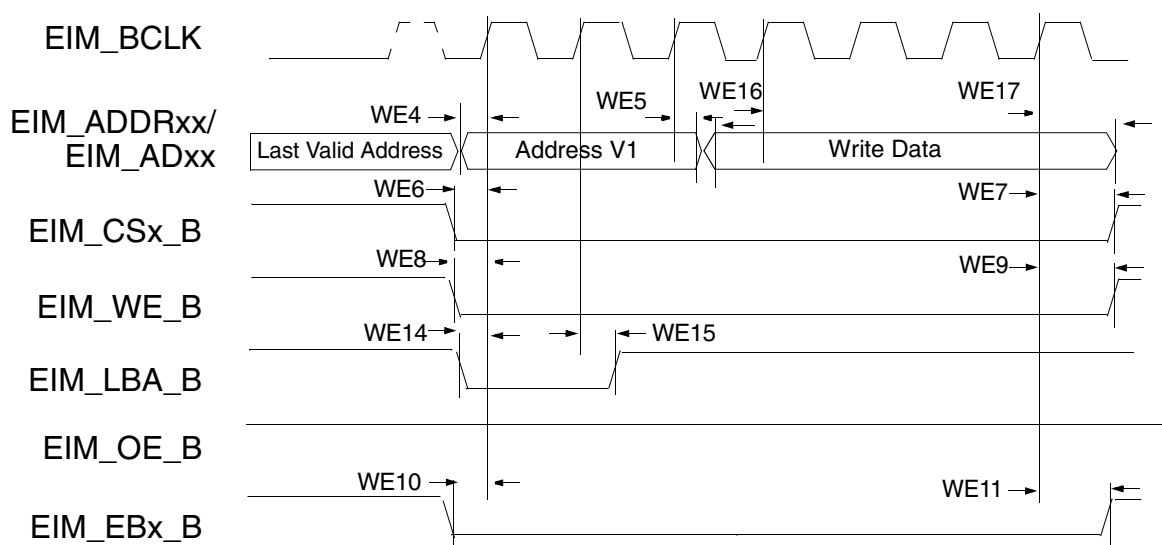


Figure 16. Muxed Address/Data (A/D) mode, synchronous write access, WSC=6, ADVA=0, ADVN=1, and ADH=1

#### NOTE

In 32-bit Muxed Address/Data (A/D) mode the 16 MSBs are driven on the data bus.

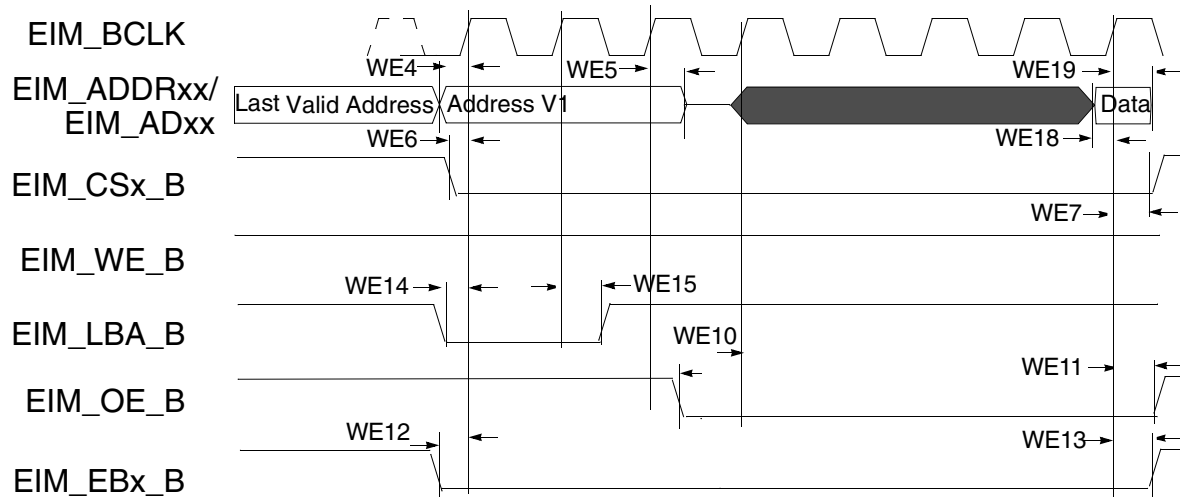


Figure 17. 16-Bit Muxed A/D Mode, Synchronous Read Access, WSC=7, RADVN=1, ADH=1, OEA=0

#### 4.8.3.4 General EIM timing—Asynchronous mode

Figure 18 through Figure 22, and Table 39 help you determine timing parameters relative to the chip select (CS) state for asynchronous and DTACK EIM accesses with corresponding EIM bit fields and the timing parameters mentioned above.

Asynchronous read & write access length in cycles may vary from what is shown in Figure 18 through Figure 21 as RWSC, OEN and CSN is configured differently. See the *i.MX 7Solo Application Processor Reference Manual* (IMX7SRM) for the EIM programming model.

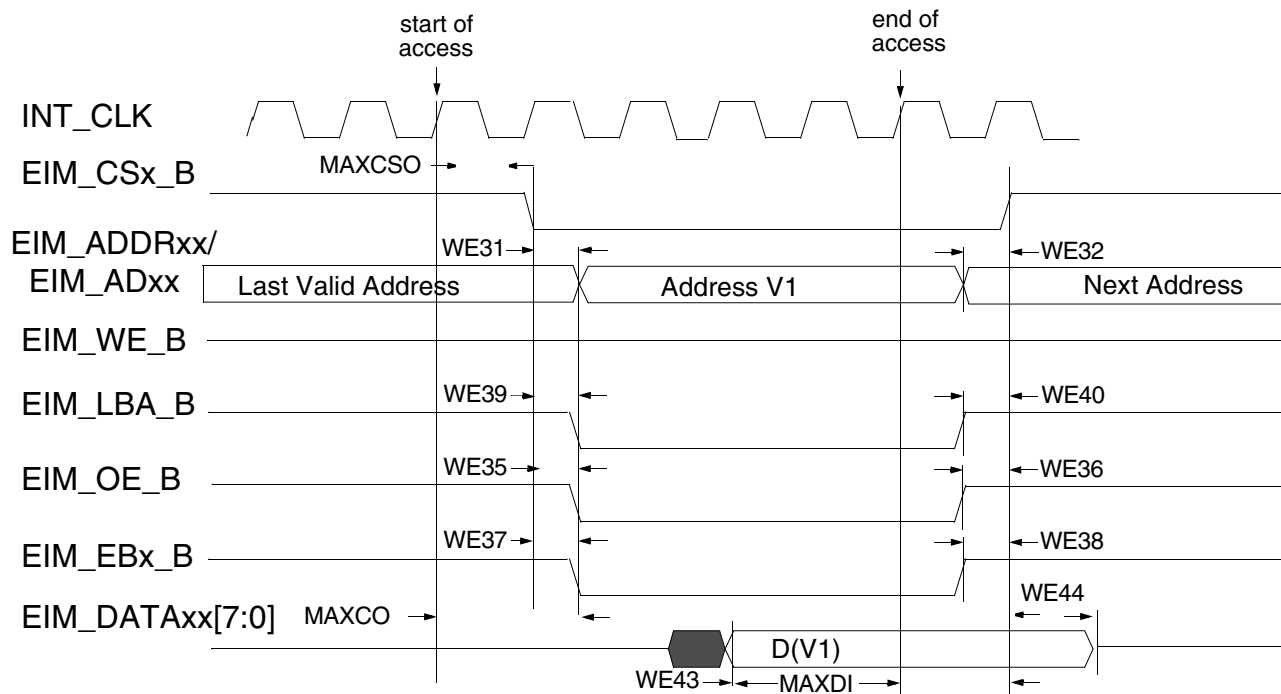


Figure 18. Asynchronous memory read access (RWSC = 5)

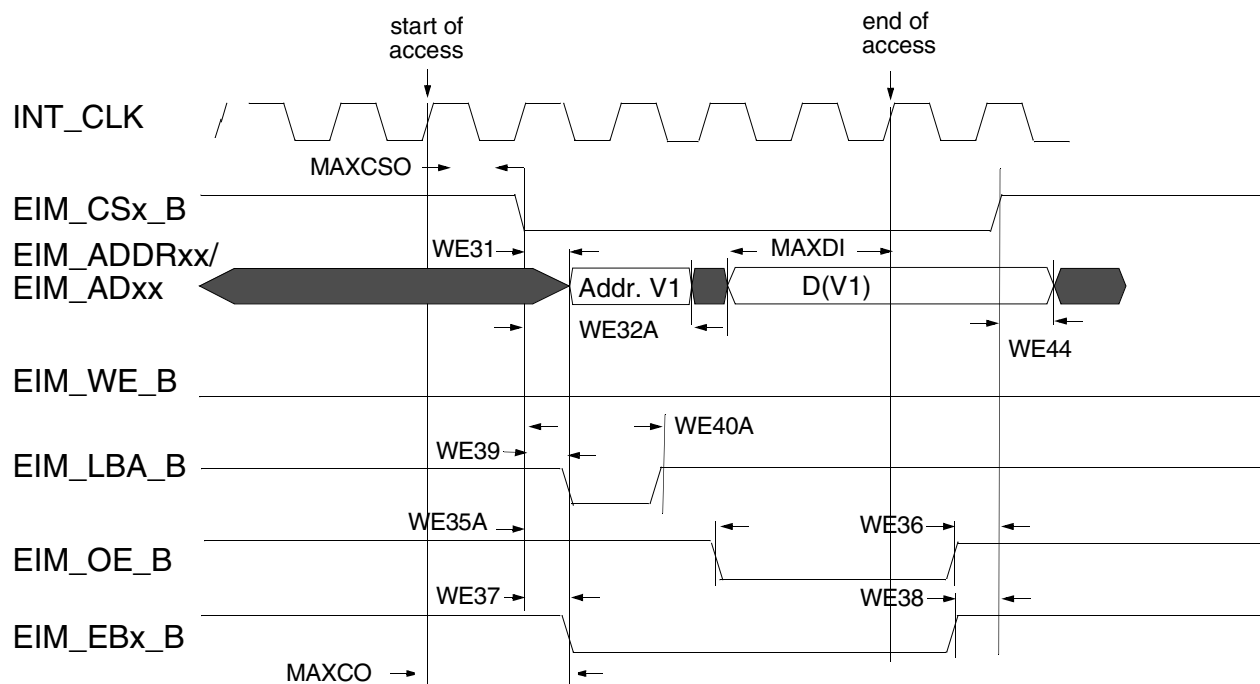


Figure 19. Asynchronous A/D muxed read access (RWSC = 5)

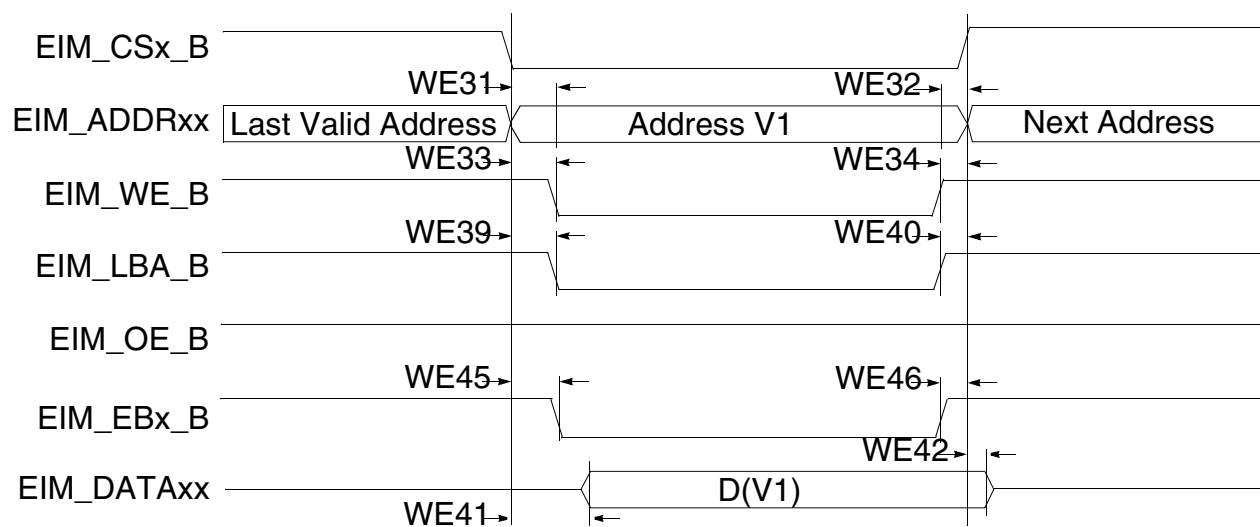


Figure 20. Asynchronous memory write access

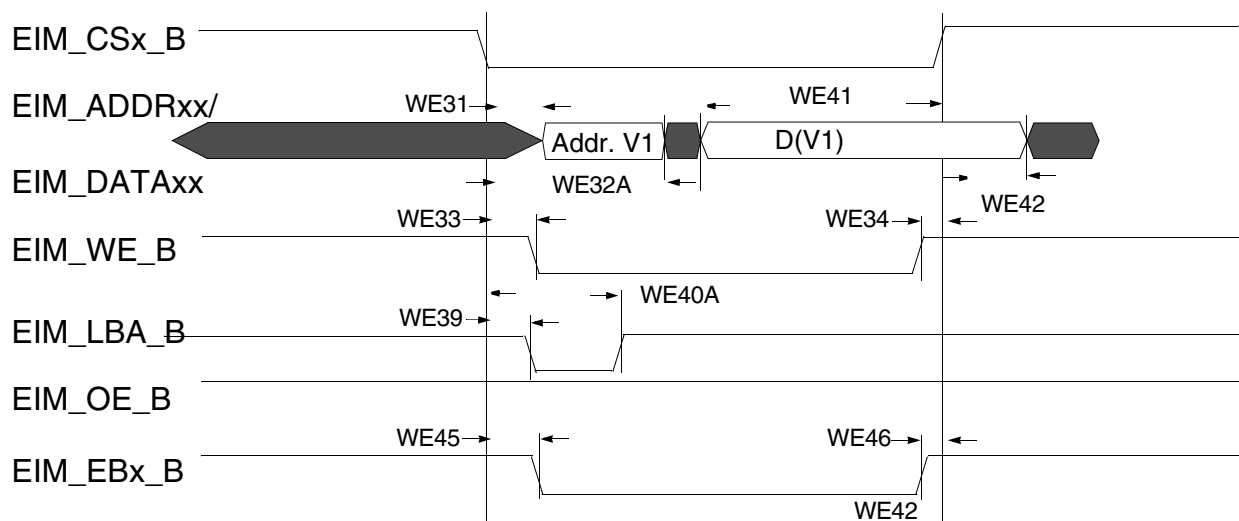


Figure 21. Asynchronous A/D muxed write access

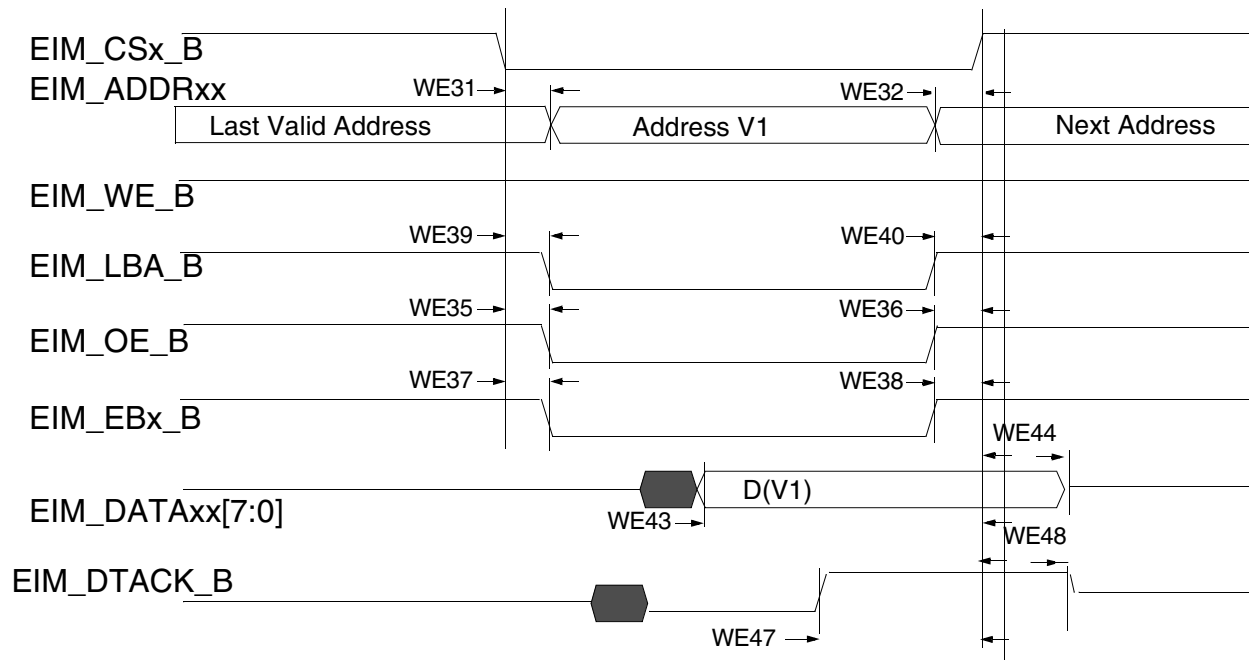


Figure 22. DTACK mode read access (DAP=0)

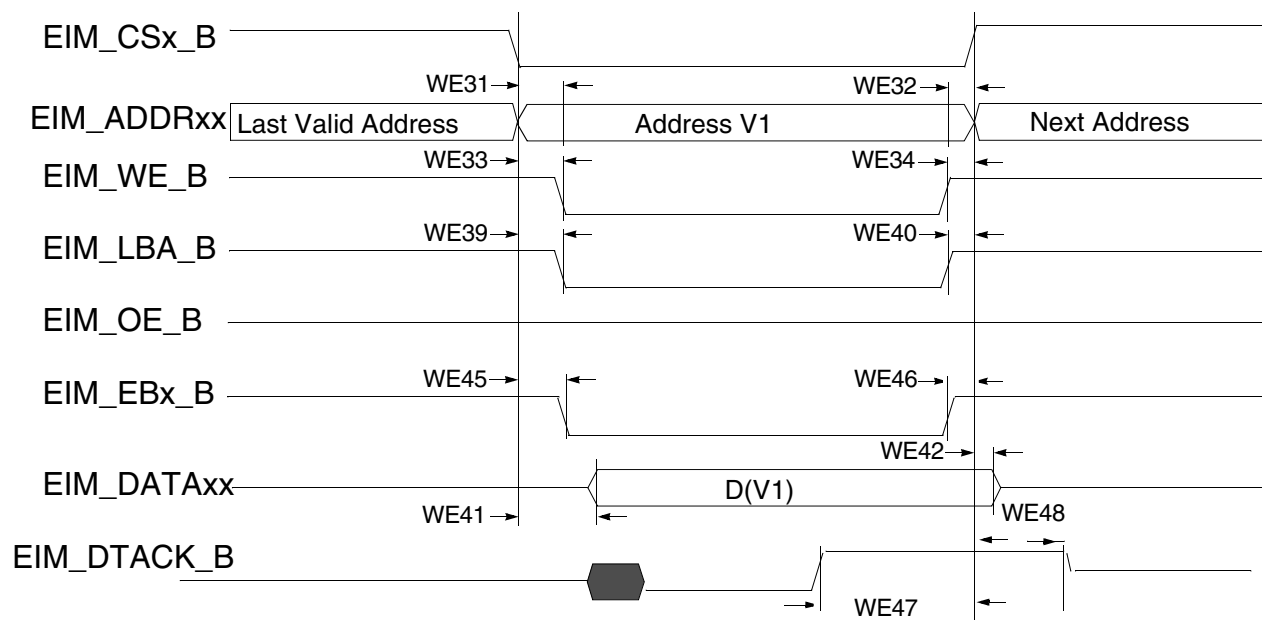


Figure 23. DTACK Mode write access (DAP=0)

Table 39. EIM asynchronous timing parameters table relative chip to select

| Ref No.           | Parameter                                        | Determination by Synchronous measured parameters <sup>1</sup> | Min                                           | Max                                          | Unit |
|-------------------|--------------------------------------------------|---------------------------------------------------------------|-----------------------------------------------|----------------------------------------------|------|
| WE31              | EIM_CSx_B valid to Address Valid                 | $WE4 - WE6 - CSA^2$                                           | —                                             | $3 - CSA$                                    | ns   |
| WE32              | Address Invalid to EIM_CSx_B invalid             | $WE7 - WE5 - CSN^3$                                           | —                                             | $3 - CSN$                                    | ns   |
| WE32A(muxed A/D)  | EIM_CSx_B valid to Address Invalid               | $t^4 + WE4 - WE7 + (ADV_N^5 + ADV_A^6 + 1 - CSA)$             | $-3 + (ADV_N + ADV_A + 1 - CSA)$              | —                                            | ns   |
| WE33              | EIM_CSx_B Valid to EIM_WE_B Valid                | $WE8 - WE6 + (WEA - WCSA)$                                    | —                                             | $3 + (WEA - WCSA)$                           | ns   |
| WE34              | EIM_WE_B Invalid to EIM_CSx_B Invalid            | $WE7 - WE9 + (WEN - WCSN)$                                    | —                                             | $3 + (WEN - WCSN)$                           | ns   |
| WE35              | EIM_CSx_B Valid to EIM_OE_B Valid                | $WE10 - WE6 + (OEA - RCSA)$                                   | —                                             | $3 + (OEA - RCSA)$                           | ns   |
| WE35A (muxed A/D) | EIM_CSx_B Valid to EIM_OE_B Valid                | $WE10 - WE6 + (OEA + RADVN + RADVA + ADH + 1 - RCSA)$         | $-3 + (OEA + RADVN + RADVA + ADH + 1 - RCSA)$ | $3 + (OEA + RADVN + RADVA + ADH + 1 - RCSA)$ | ns   |
| WE36              | EIM_OE_B Invalid to EIM_CSx_B Invalid            | $WE7 - WE11 + (OEN - RCSN)$                                   | —                                             | $3 - (OEN - RCSN)$                           | ns   |
| WE37              | EIM_CSx_B Valid to EIM_EBx_B Valid (Read access) | $WE12 - WE6 + (RBEA - RCSA)$                                  | —                                             | $3 + (RBEA - RCSA)$                          | ns   |

Table 39. EIM asynchronous timing parameters table relative chip to select(continued)

| Ref No.           | Parameter                                                                         | Determination by Synchronous measured parameters <sup>1</sup> | Min                             | Max                                     | Unit |
|-------------------|-----------------------------------------------------------------------------------|---------------------------------------------------------------|---------------------------------|-----------------------------------------|------|
| WE38              | EIM_EBx_B Invalid to EIM_CSx_B Invalid (Read access)                              | $WE7 - WE13 + (RBEN - RCSN)$                                  | —                               | $3 - (RBEN - RCSN)$                     | ns   |
| WE39              | EIM_CSx_B Valid to EIM_LBA_B Valid                                                | $WE14 - WE6 + (ADVA - CSA)$                                   | —                               | $3 + (ADVA - CSA)$                      | ns   |
| WE40              | EIM_LBA_B Invalid to EIM_CSx_B Invalid (ADV_L is asserted)                        | $WE7 - WE15 - CSN$                                            | —                               | $3 - CSN$                               | ns   |
| WE40A (muxed A/D) | EIM_CSx_B Valid to EIM_LBA_B Invalid                                              | $WE14 - WE6 + (ADV_N + ADVA + 1 - CSA)$                       | $-3 + (ADV_N + ADVA + 1 - CSA)$ | $3 + (ADV_N + ADVA + 1 - CSA)$          | ns   |
| WE41              | EIM_CSx_B Valid to Output Data Valid                                              | $WE16 - WE6 - WCSA$                                           | —                               | $3 - WCSA$                              | ns   |
| WE41A (muxed A/D) | EIM_CSx_B Valid to Output Data Valid                                              | $WE16 - WE6 + (WADV_N + WADVA + ADH + 1 - WCSA)$              | —                               | $3 + (WADV_N + WADVA + ADH + 1 - WCSA)$ | ns   |
| WE42              | Output Data Invalid to EIM_CSx_B Invalid                                          | $WE17 - WE7 - CSN$                                            | —                               | $3 - CSN$                               | ns   |
| MAXCO             | Output maximum delay from internal driving EIM_ADDRxx/control FFs to chip outputs | 10                                                            | —                               | —                                       | ns   |
| MAXCSO            | Output maximum delay from CSx internal driving FFs to CSx out                     | 10                                                            | —                               | —                                       | ns   |
| MAXDI             | EIM_DATAxx maximum delay from chip input data to its internal FF                  | 5                                                             | —                               | —                                       | ns   |
| WE43              | Input Data Valid to EIM_CSx_B Invalid                                             | $MAXCO - MAXCSO + MAXDI$                                      | $MAXCO - MAXCSO + MAXDI$        | —                                       | ns   |
| WE44              | EIM_CSx_B Invalid to Input Data invalid                                           | 0                                                             | 0                               | —                                       | ns   |
| WE45              | EIM_CSx_B Valid to EIM_EBx_B Valid (Write access)                                 | $WE12 - WE6 + (WBEA - WCSA)$                                  | —                               | $3 + (WBEA - WCSA)$                     | ns   |
| WE46              | EIM_EBx_B Invalid to EIM_CSx_B Invalid (Write access)                             | $WE7 - WE13 + (WBEN - WCSN)$                                  | —                               | $-3 + (WBEN - WCSN)$                    | ns   |

Table 39. EIM asynchronous timing parameters table relative chip to select(continued)

| Ref No. | Parameter                                                                        | Determination by Synchronous measured parameters <sup>1</sup> | Min                     | Max | Unit |
|---------|----------------------------------------------------------------------------------|---------------------------------------------------------------|-------------------------|-----|------|
| MAXDTI  | MAXIMUM delay from EIM_DTACK_B to its internal FF + 2 cycles for synchronization | 10                                                            | —                       | —   | ns   |
| WE47    | EIM_DTACK_B Active to EIM_CSx_B Invalid                                          | MAXCO – MAXCSO + MAXDTI                                       | MAXCO – MAXCSO + MAXDTI | —   | ns   |
| WE48    | EIM_CSx_B Invalid to EIM_DTACK_B Invalid                                         | 0                                                             | 0                       | —   | ns   |

<sup>1</sup> For more information on configuration parameters mentioned in this table, see the *i.MX 7Solo Application Processor Reference Manual* (IMX7SRM).

<sup>2</sup> In this table, CSA means WCSA when write operation or RCSA when read operation.

<sup>3</sup> In this table, CSN means WCSN when write operation or RCSN when read operation.

<sup>4</sup> t is axi\_clk cycle time.

<sup>5</sup> In this table, ADVN means WADV when write operation or RADVN when read operation.

<sup>6</sup> In this table, ADVA means WADVA when write operation or RADVA when read operation.

## 4.8.4 DDR SDRAM-specific parameters (DDR3, DDR3L, LPDDR3, and LPDDR2)

### 4.8.4.1 DDR3/DDR3L parameters

Figure 24 shows the DDR3 basic timing diagram with the timing parameters provided in Table 40.

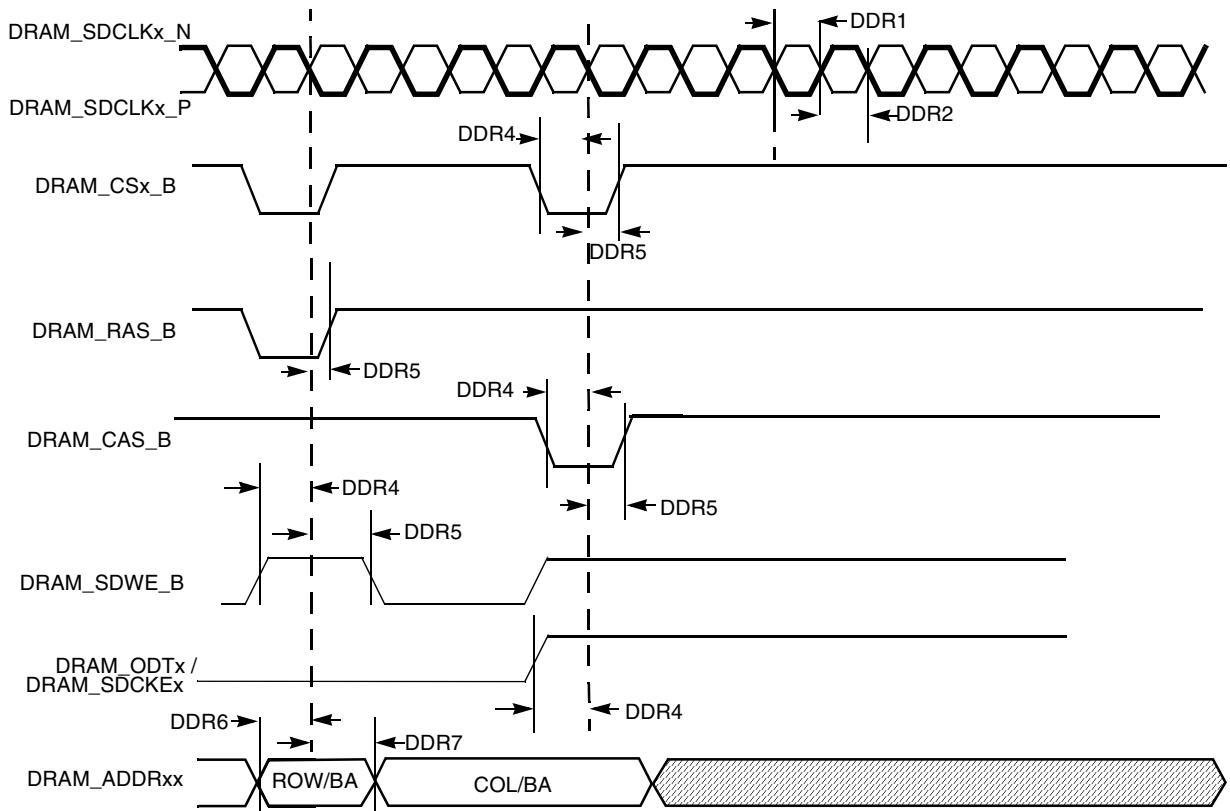


Figure 24. DDR3 Command and Address Timing Diagram

Table 40. DDR3 timing parameters

| ID   | Parameter                                                                                      | Symbol | CK = 533 MHz |      | Unit |
|------|------------------------------------------------------------------------------------------------|--------|--------------|------|------|
|      |                                                                                                |        | Min          | Max  |      |
| DDR1 | DRAM_SDCLKx_P clock high-level width                                                           | tCH    | 0.47         | 0.53 | tCK  |
| DDR2 | DRAM_SDCLKx_P clock low-level width                                                            | tCL    | 0.47         | 0.53 | tCK  |
| DDR4 | DRAM_CSx_B, DRAM_RAS_B, DRAM_CAS_B, DRAM_SCKE, DRAM_SDWE_B, DRAM_SDOdT <sub>x</sub> setup time | tIS    | 425          | —    | ps   |
| DDR5 | DRAM_CSx_B, DRAM_RAS_B, DRAM_CAS_B, DRAM_SCKE, DRAM_SDWE_B, DRAM_SDOdT <sub>x</sub> hold time  | tIH    | 375          | —    | ps   |
| DDR6 | Address output setup time                                                                      | tIS    | 425          | —    | ps   |
| DDR7 | Address output hold time                                                                       | tIH    | 375          | —    | ps   |

<sup>1</sup> All measurements are in reference to Vref level.

<sup>2</sup> Measurements were done using balanced load and 25  $\Omega$  resistor from outputs to VDD\_REF.

Figure 25 shows the DDR3 write timing diagram. The timing parameters for this diagram appear in Table 41.

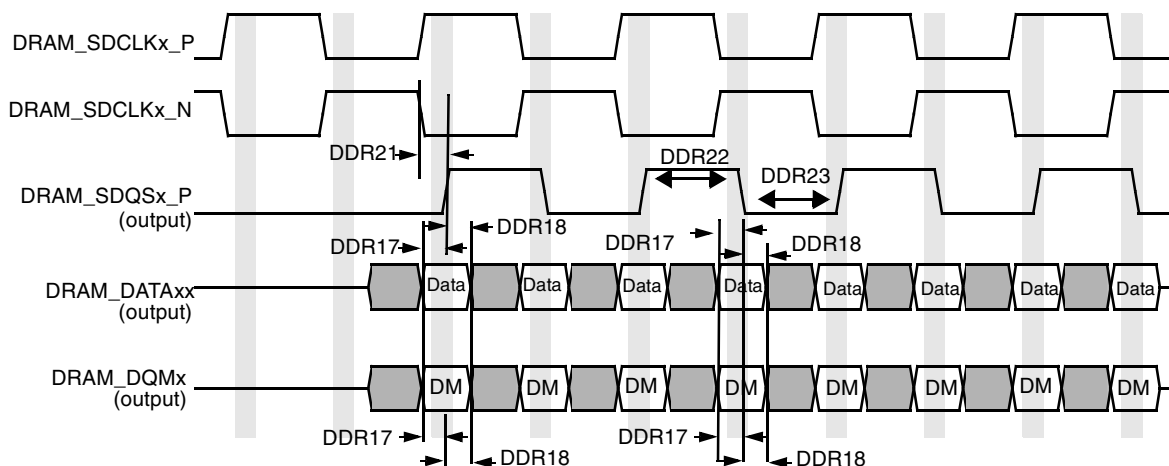


Figure 25. DDR3 write cycle

Table 41. DDR3 write cycle

| ID    | Parameter                                                                  | Symbol            | CK = 533 MHz |       | Unit |
|-------|----------------------------------------------------------------------------|-------------------|--------------|-------|------|
|       |                                                                            |                   | Min          | Max   |      |
| DDR17 | DRAM_DATAxx and DRAM_DQMx setup time to DRAM_SDQSx_P (differential strobe) | t <sub>DS</sub>   | 225          | —     | ps   |
| DDR18 | DRAM_DATAxx and DRAM_DQMx hold time to DRAM_SDQSx_P (differential strobe)  | t <sub>DH</sub>   | 250          | —     | ps   |
| DDR21 | DRAM_SDQSx_P latching rising transitions to associated clock edges         | t <sub>DQSS</sub> | -0.25        | +0.25 | tCK  |
| DDR22 | DRAM_SDQSx_P high level width                                              | t <sub>DQSH</sub> | 0.45         | 0.55  | tCK  |
| DDR23 | DRAM_SDQSx_P low level width                                               | t <sub>DQSL</sub> | 0.45         | 0.55  | tCK  |

<sup>1</sup> To receive the reported setup and hold values, write calibration should be performed in order to locate the DRAM\_SDQSx\_P in the middle of DRAM\_DATAxx window.

<sup>2</sup> All measurements are in reference to Vref level.

<sup>3</sup> Measurements were taken using balanced load and 25  $\Omega$  resistor from outputs to DDR\_VREF.

# Electrical characteristics

Figure 26 shows the DDR3 read timing diagram. The timing parameters for this diagram appear in Table 42.

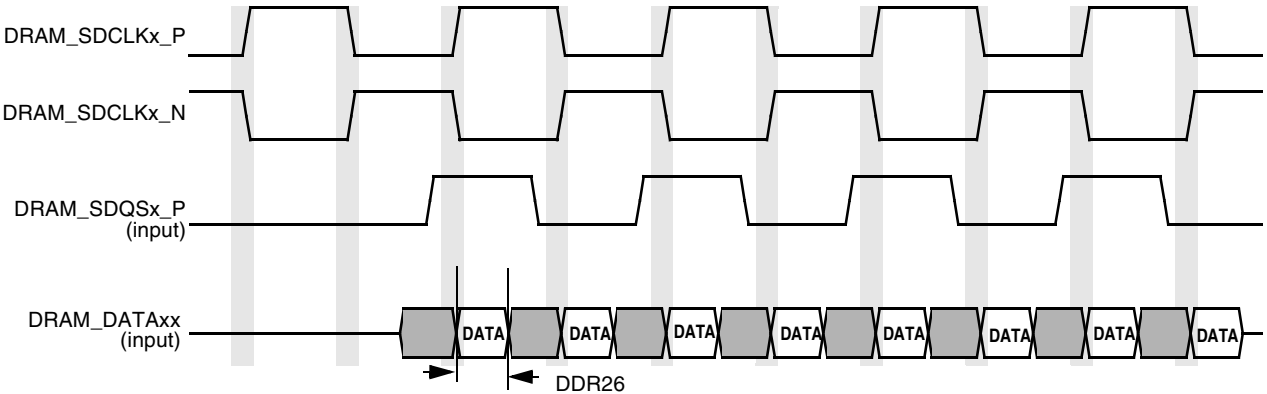


Figure 26. DDR3 read cycle

Table 42. DDR3 read cycle

| ID    | Parameter                                       | Symbol | CK = 533 MHz |     | Unit |
|-------|-------------------------------------------------|--------|--------------|-----|------|
|       |                                                 |        | Min          | Max |      |
| DDR26 | Minimum required DRAM_DATAxx valid window width | —      | 510          | —   | ps   |

- <sup>1</sup> To receive the reported setup and hold values, read calibration should be performed in order to locate the DRAM\_SDQSx\_P in the middle of DRAM\_DATAxx window.
- <sup>2</sup> All measurements are in reference to Vref level.
- <sup>3</sup> Measurements were done using balanced load and 25  $\Omega$  resistor from outputs to VDD\_REF.

## 4.8.4.2 LPDDR3 parameters

Figure 27 shows the LPDDR3 basic timing diagram. The timing parameters for this diagram appear in Table 43.

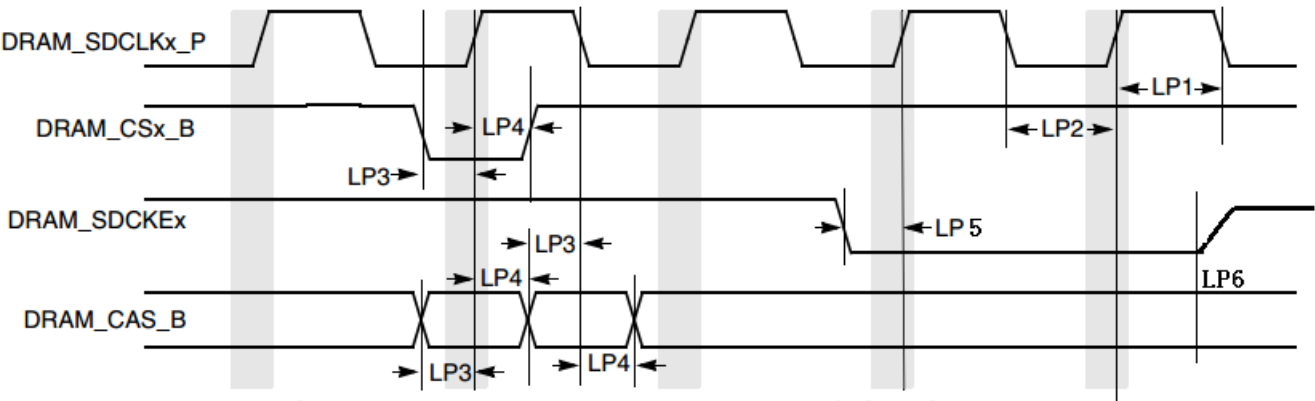


Figure 27. LPDDR3 command and address timing diagram

Table 43. LPDDR3 timing parameters<sup>1,2</sup>

| ID  | Parameter                    | Symbol   | CK = 533 MHz |      | Unit     |
|-----|------------------------------|----------|--------------|------|----------|
|     |                              |          | Min          | Max  |          |
| LP1 | SDRAM clock high-level width | $t_{CH}$ | 0.45         | 0.55 | $t_{CK}$ |
| LP2 | SDRAM clock low-level width  | $t_{CL}$ | 0.45         | 0.55 | $t_{CK}$ |
| LP3 | DRAM_CSx_B                   | $t_{IS}$ | 390          | —    | ps       |
| LP4 | DRAM_CSx_E                   | $t_{IH}$ | 390          | —    | ps       |
| LP3 | DRAM_CAS_B setup time        | $t_{IS}$ | 275          | —    | ps       |
| LP4 | DRAM_CAS_B hold time         | $t_{IH}$ | 275          | —    | ps       |

<sup>1</sup> All measurements are in reference to  $V_{ref}$  level.

<sup>2</sup> Measurements were done using balanced load and 25  $\Omega$  resistor from outputs to DDR\_VREF.

Figure 28 shows the LPDDR3 write timing diagram. The timing parameters for this diagram appear in Table 44.

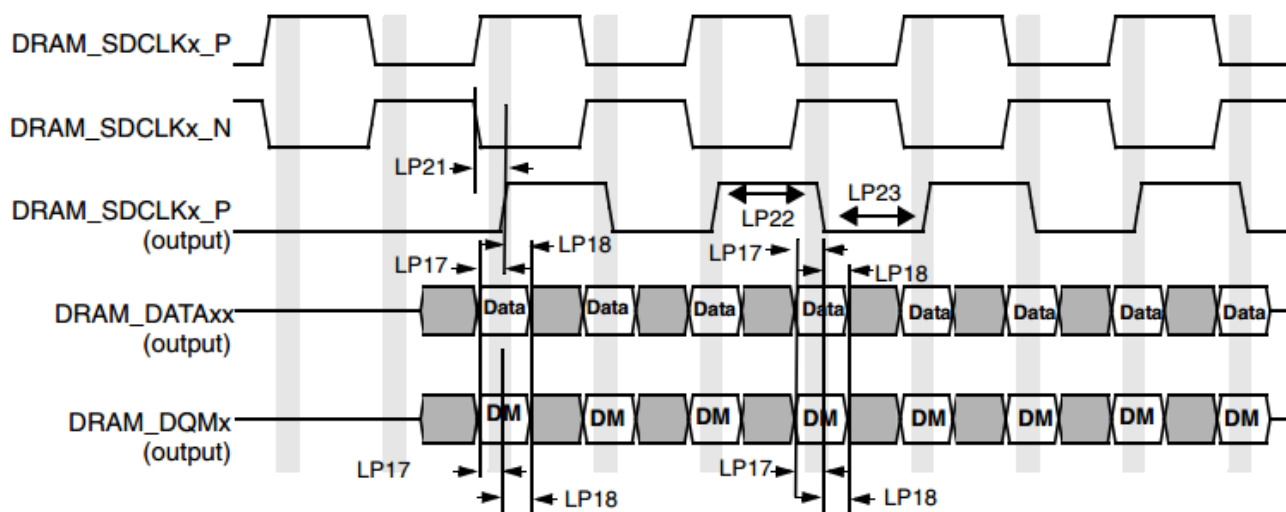


Figure 28. LPDDR3 write cycle

**Table 44. LPDDR3 write cycle<sup>1,2,3</sup>**

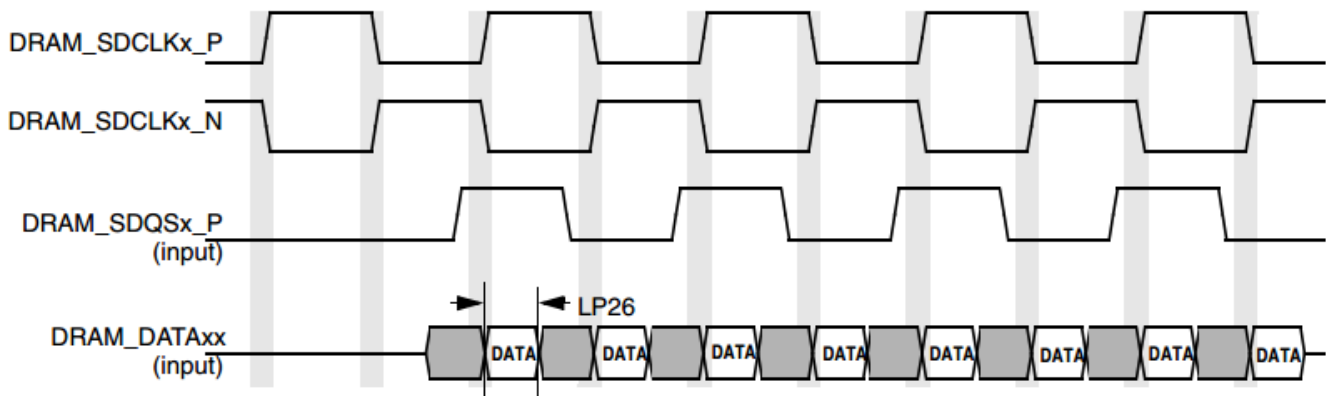
| ID   | Parameter                                                                  | Symbol | CK = 533 MHz |       | Unit            |
|------|----------------------------------------------------------------------------|--------|--------------|-------|-----------------|
|      |                                                                            |        | Min          | Max   |                 |
| LP17 | DRAM_DATAxx and DRAM_DQMx setup time to DRAM_SDQSx_P (differential strobe) | tds    | 275          | —     | ps              |
| LP18 | DRAM_DATAxx and DRAM_DQMx hold time to DRAM_SDQSx_P (differential strobe)  | tdH    | 275          | —     | ps              |
| LP21 | DRAM_SDQSx_P latching rising transitions to associated clock edges         | tdQSS  | -0.25        | +0.25 | t <sub>CK</sub> |
| LP22 | DRAM_SDQSx_P high level width                                              | tdQSH  | 0.4          | —     | t <sub>CK</sub> |
| LP23 | DRAM_SDQSx_P low level width                                               | tdQSL  | 0.4          | —     | t <sub>CK</sub> |

<sup>1</sup> To receive the reported setup and hold values, write calibration should be performed in order to locate the DRAM\_SDQS in the middle of DRAM\_DATAxx window.

<sup>2</sup> All measurements are in reference to V<sub>ref</sub> level.

<sup>3</sup> Measurements were done using balanced load and 25 Ω resistor from outputs to DDR\_VREF.

Figure 29 shows the LPDDR3 read timing diagram. The timing parameters for this diagram appear in Table 45.

**Figure 29. LPDDR3 read cycle****Table 45. LPDDR3 read cycle<sup>1,2,3</sup>**

| ID   | Parameter                                                  | Symbol | CK = 533 MHz |     | Unit |
|------|------------------------------------------------------------|--------|--------------|-----|------|
|      |                                                            |        | Min          | Max |      |
| LP26 | Minimum required DRAM_DATAxx valid window width for LPDDR3 | —      | 460          | —   | ps   |

<sup>1</sup> To receive the reported setup and hold values, read calibration should be performed in order to locate the DRAM\_SDQSx\_P in the middle of DRAM\_DATAxx window.

<sup>2</sup> All measurements are in reference to V<sub>ref</sub> level.

<sup>3</sup> Measurements were done using balanced load and 25 Ω resistor from outputs to DDR\_VREF.

### 4.8.4.3 LPDDR2 parameters

Figure 30 shows the LPDDR2 basic timing diagram. The timing parameters for this diagram appear in Table 46.

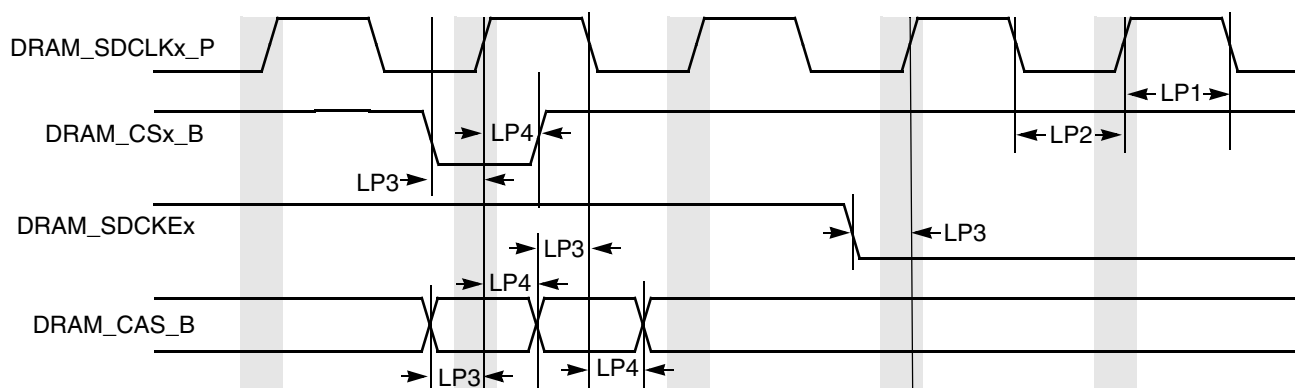


Figure 30. LPDDR2 command and address timing diagram

Table 46. LPDDR2 timing parameters<sup>1,2</sup>

| ID  | Parameter                          | Symbol   | CK = 533 MHz |      | Unit     |
|-----|------------------------------------|----------|--------------|------|----------|
|     |                                    |          | Min          | Max  |          |
| LP1 | SDRAM clock high-level width       | $t_{CH}$ | 0.45         | 0.55 | $t_{CK}$ |
| LP2 | SDRAM clock low-level width        | $t_{CL}$ | 0.45         | 0.55 | $t_{CK}$ |
| LP3 | DRAM_CSx_B, DRAM_SDCKEx setup time | $t_{IS}$ | 370          | —    | ps       |
| LP4 | DRAM_CSx_B, DRAM_SDCKEx hold time  | $t_{IH}$ | 370          | —    | ps       |
| LP3 | DRAM_CAS_B setup time              | $t_{IS}$ | 770          | —    | ps       |
| LP4 | DRAM_CAS_B hold time               | $t_{IH}$ | 770          | —    | ps       |

<sup>1</sup> All measurements are in reference to Vref level.

<sup>2</sup> Measurements were done using balanced load and 25  $\Omega$  resistor from outputs to DDR\_VREF

Figure 31 shows the LPDDR2 write timing diagram. The timing parameters for this diagram appear in Table 47.

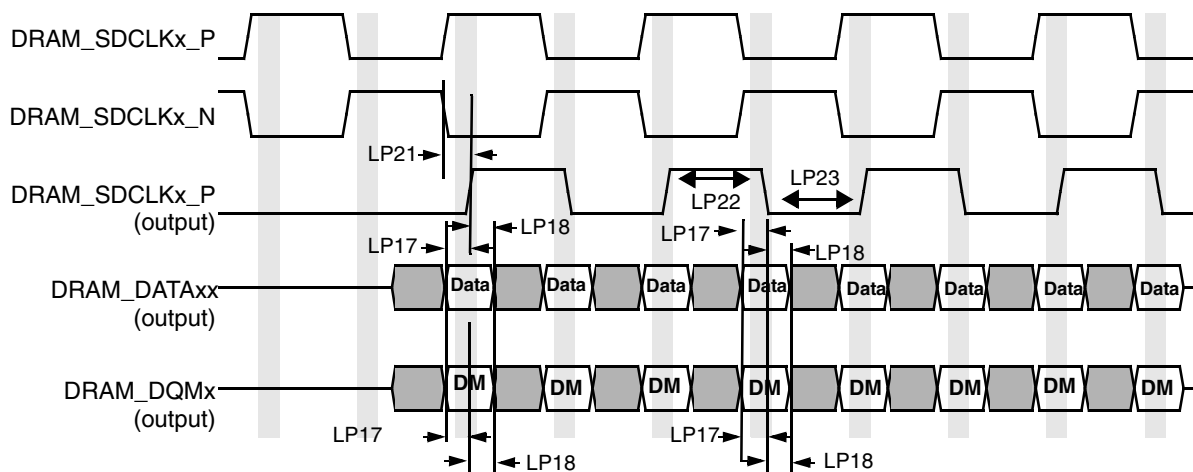


Figure 31. LPDDR2 write cycle

Table 47. LPDDR2 write cycle

| ID   | Parameter                                                                  | Symbol            | CK = 533 MHz |       | Unit |
|------|----------------------------------------------------------------------------|-------------------|--------------|-------|------|
|      |                                                                            |                   | Min          | Max   |      |
| LP17 | DRAM_DATAxx and DRAM_DQMx setup time to DRAM_SDQSx_P (differential strobe) | t <sub>DS</sub>   | 360          | —     | ps   |
| LP18 | DRAM_DATAxx and DRAM_DQMx hold time to DRAM_SDQSx_P (differential strobe)  | t <sub>DH</sub>   | 360          | —     | ps   |
| LP21 | DRAM_SDQSx_P latching rising transitions to associated clock edges         | t <sub>DQSS</sub> | -0.25        | +0.25 | tCK  |
| LP22 | DRAM_SDQSx_P high level width                                              | t <sub>DQSH</sub> | 0.4          | —     | tCK  |
| LP23 | DRAM_SDQSx_P low level width                                               | t <sub>DQSL</sub> | 0.4          | —     | tCK  |

<sup>1</sup> To receive the reported setup and hold values, write calibration should be performed in order to locate the DRAM\_SDQS in the middle of DRAM\_DATAxx window.

<sup>2</sup> All measurements are in reference to V<sub>ref</sub> level.

<sup>3</sup> Measurements were done using balanced load and 25 Ω resistor from outputs to DDR\_VREF.

Figure 32 shows the LPDDR2 read timing diagram. The timing parameters for this diagram appear in Table 48.

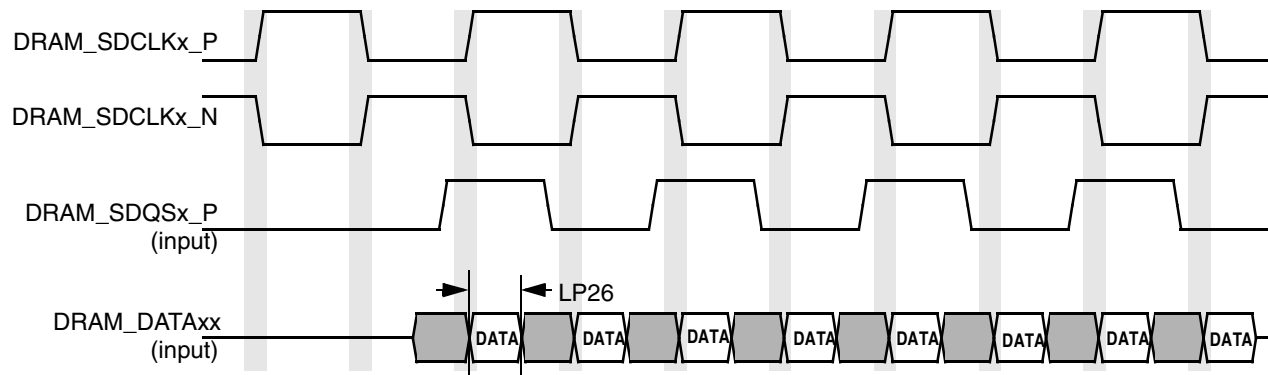


Figure 32. LPDDR2 read cycle

Table 48. LPDDR2 read cycle

| ID   | Parameter                                                  | Symbol | CK = 533 MHz |     | Unit |
|------|------------------------------------------------------------|--------|--------------|-----|------|
|      |                                                            |        | Min          | Max |      |
| LP26 | Minimum required DRAM_DATAxx valid window width for LPDDR2 | —      | 230          | —   | ps   |

- <sup>1</sup> To receive the reported setup and hold values, read calibration should be performed in order to locate the DRAM\_SDQSx\_P in the middle of DRAM\_DATA\_xx window.
- <sup>2</sup> All measurements are in reference to Vref level.
- <sup>3</sup> Measurements were done using balanced load and 25  $\Omega$  resistor from outputs to DDR\_VREF.

## 4.9 General-purpose media interface (GPMI) timing

The i.MX 7Solo GPMI controller is a flexible interface NAND Flash controller with 8-bit data width, up to 200 MB/s I/O speed and individual chip select.

It supports Asynchronous Timing mode, Source Synchronous Timing mode and Toggle Timing mode separately, as described in the following subsections.

### 4.9.1 Asynchronous mode AC timing (ONFI 1.0 compatible)

Asynchronous mode AC timings are provided as multiplications of the clock cycle and fixed delay. The maximum I/O speed of GPMI in asynchronous mode is about 50 MB/s. Figure 33 through Figure 36 depicts the relative timing between GPMI signals at the module level for different operations under asynchronous mode. Table 49 describes the timing parameters (NF1–NF17) that are shown in the figures.

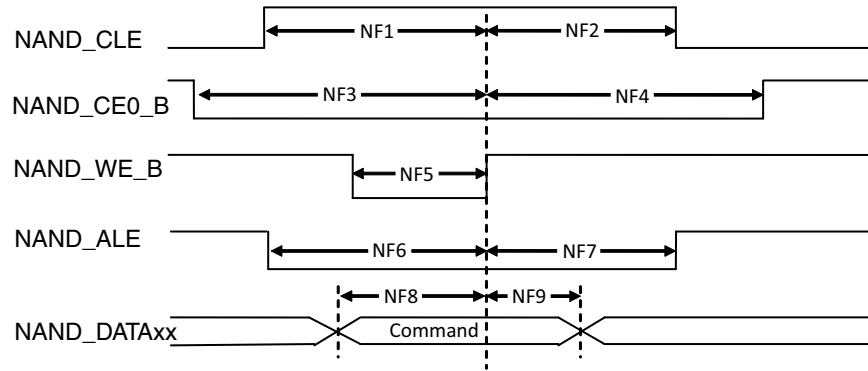


Figure 33. Command Latch cycle timing diagram

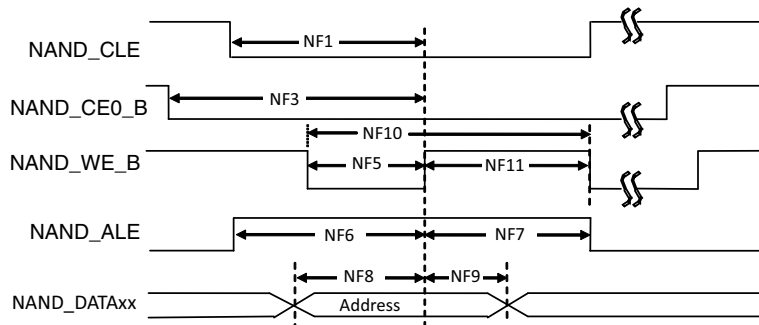


Figure 34. Address Latch cycle timing diagram

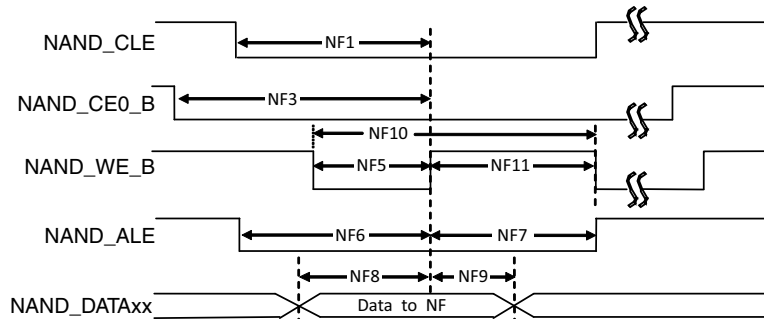


Figure 35. Write Data Latch cycle timing diagram

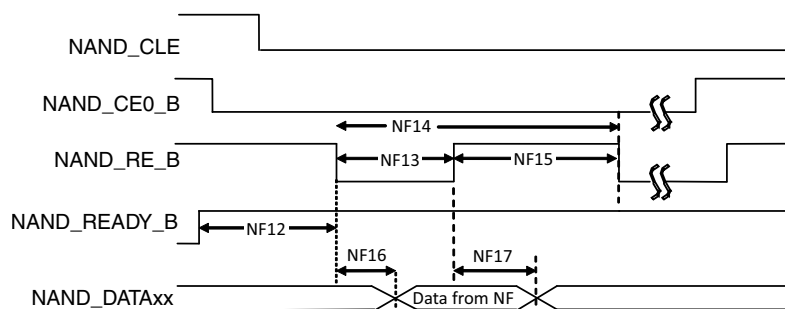


Figure 36. Read Data Latch cycle timing diagram (Non-EDO Mode)

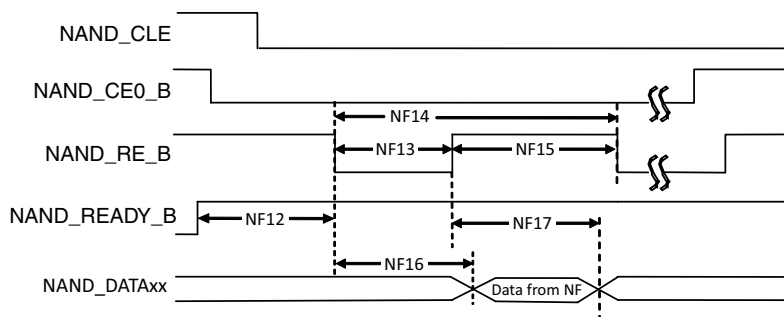


Figure 37. Read Data Latch cycle timing diagram (EDO mode)

Table 49. Asynchronous mode timing parameters<sup>1</sup>

| ID   | Parameter                | Symbol           | Timing<br>T = GPML Clock Cycle                          |                                                          | Unit |
|------|--------------------------|------------------|---------------------------------------------------------|----------------------------------------------------------|------|
|      |                          |                  | Min.                                                    | Max.                                                     |      |
| NF1  | NAND_CLE setup time      | tCLS             | $(AS + DS) \times T - 0.12$ [see notes <sup>2,3</sup> ] |                                                          | ns   |
| NF2  | NAND_CLE hold time       | tCLH             | $DH \times T - 0.72$ [see note <sup>2</sup> ]           |                                                          | ns   |
| NF3  | NAND_CE0_B setup time    | tCS              | $(AS + DS + 1) \times T$ [see notes <sup>3,2</sup> ]    |                                                          | ns   |
| NF4  | NAND_CE0_B hold time     | tCH              | $(DH + 1) \times T - 1$ [see note <sup>2</sup> ]        |                                                          | ns   |
| NF5  | NAND_WE_B pulse width    | tWP              | $DS \times T$ [see note <sup>2</sup> ]                  |                                                          | ns   |
| NF6  | NAND_ALE setup time      | tALS             | $(AS + DS) \times T - 0.49$ [see notes <sup>3,2</sup> ] |                                                          | ns   |
| NF7  | NAND_ALE hold time       | tALH             | $(DH \times T - 0.42)$ [see note <sup>2</sup> ]         |                                                          | ns   |
| NF8  | Data setup time          | tDS              | $DS \times T - 0.26$ [see note <sup>2</sup> ]           |                                                          | ns   |
| NF9  | Data hold time           | tDH              | $DH \times T - 1.37$ [see note <sup>2</sup> ]           |                                                          | ns   |
| NF10 | Write cycle time         | tWC              | $(DS + DH) \times T$ [see note <sup>2</sup> ]           |                                                          | ns   |
| NF11 | NAND_WE_B hold time      | tWH              | $DH \times T$ [see note <sup>2</sup> ]                  |                                                          | ns   |
| NF12 | Ready to NAND_RE_B low   | tRR <sup>4</sup> | $(AS + 2) \times T$ [see <sup>3,2</sup> ]               | —                                                        | ns   |
| NF13 | NAND_RE_B pulse width    | tRP              | $DS \times T$ [see note <sup>2</sup> ]                  |                                                          | ns   |
| NF14 | READ cycle time          | tRC              | $(DS + DH) \times T$ [see note <sup>2</sup> ]           |                                                          | ns   |
| NF15 | NAND_RE_B high hold time | tREH             | $DH \times T$ [see note <sup>2</sup> ]                  |                                                          | ns   |
| NF16 | Data setup on read       | tDSR             | —                                                       | $(DS \times T - 0.67)/18.38$ [see notes <sup>5,6</sup> ] | ns   |
| NF17 | Data hold on read        | tDHR             | $0.82/11.83$ [see notes <sup>5,6</sup> ]                | —                                                        | ns   |

<sup>1</sup> GPML's Asynchronous mode output timing can be controlled by the module's internal registers HW\_GPML\_TIMING0\_ADDRESS\_SETUP, HW\_GPML\_TIMING0\_DATA\_SETUP, and HW\_GPML\_TIMING0\_DATA\_HOLD. This AC timing depends on these registers settings. In the table, AS/DS/DH represents each of these settings.

<sup>2</sup> AS minimum value can be 0, while DS/DH minimum value is 1.

<sup>3</sup> T = GPML clock period - 0.075ns (half of maximum p-p jitter).

<sup>4</sup> NF12 is guaranteed by the design.

<sup>5</sup> Non-EDO mode.

<sup>6</sup> EDO mode, GPML clock  $\approx 100$  MHz  
(AS=DS=DH=1, GPML\_CTL1 [RDN\_DELAY] = 8, GPML\_CTL1 [HALF\_PERIOD] = 0).

In EDO mode (Figure 36), NF16/NF17 are different from the definition in non-EDO mode (Figure 35). They are called tREA/tRHOH (RE# access time/RE# HIGH to output hold). The typical value for them are 16 ns (max for tREA)/15 ns (min for tRHOH) at 50 MB/s EDO mode. In EDO mode, GPMI will sample NAND\_DATAxx at rising edge of delayed NAND\_RE\_B provided by an internal DPLL. The delay value can be controlled by GPMI\_CTRL1.RDN\_DELAY (see the GPMI chapter of the *i.MX 7Dual Application Processor Reference Manual* [IMX7DRM]). The typical value of this control register is 0x8 at 50 MT/s EDO mode. But if the board delay is big enough and cannot be ignored, the delay value should be made larger to compensate the board delay.

### 4.9.2 Source Synchronous mode AC timing (ONFI 2.x compatible)

Figure 38 to Figure 40 show the write and read timing of Source Synchronous mode.

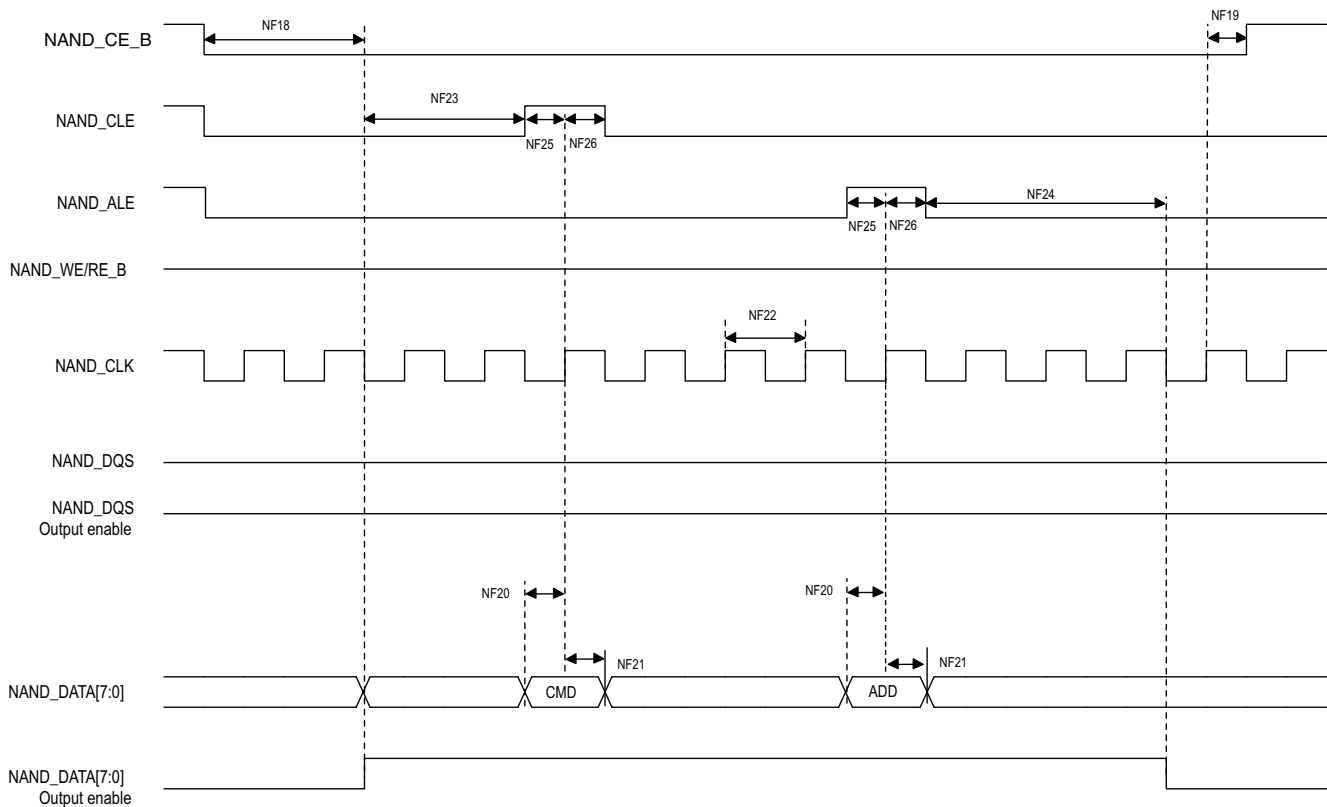


Figure 38. Source Synchronous mode command and address timing diagram

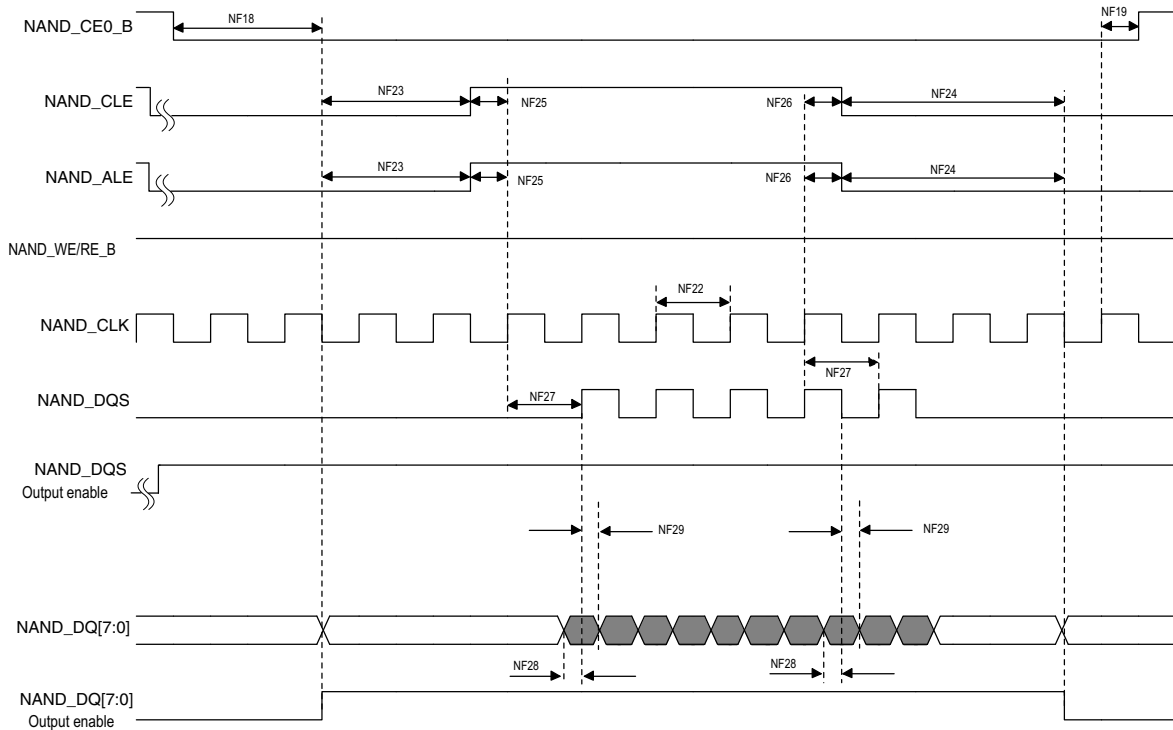


Figure 39. Source Synchronous mode data write timing diagram

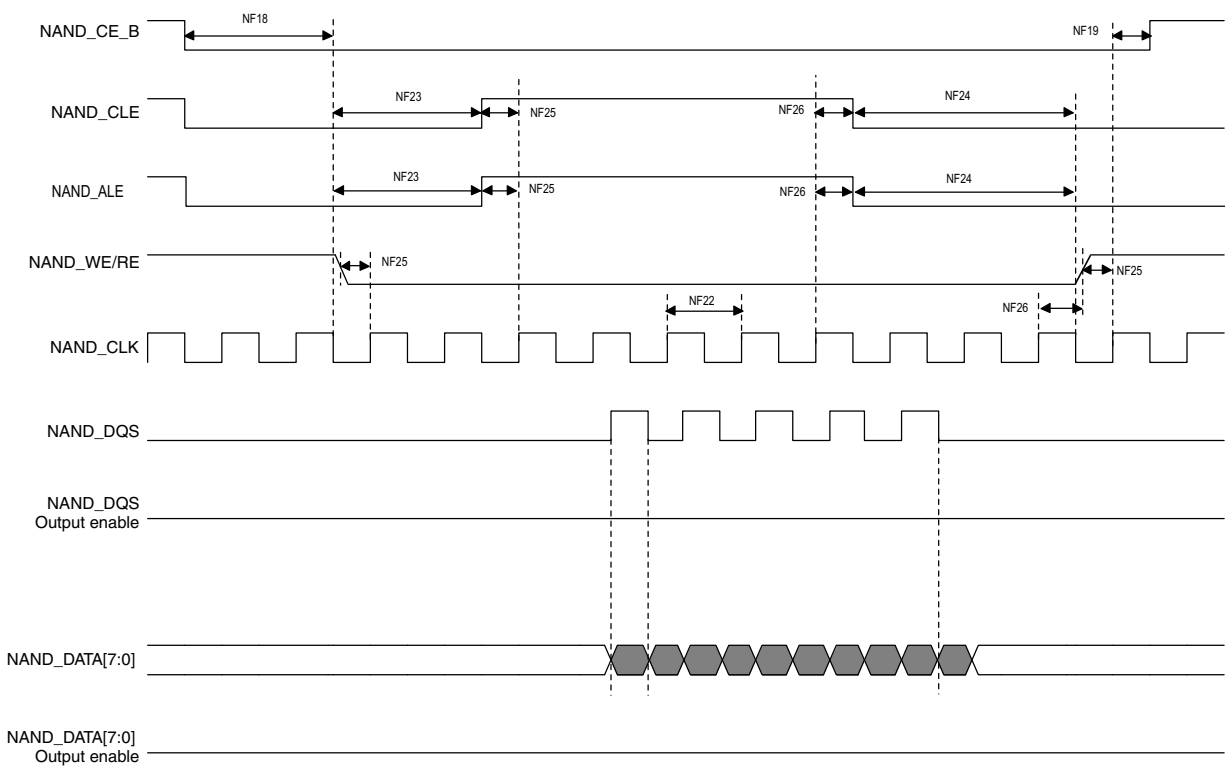


Figure 40. Source Synchronous mode data read timing diagram

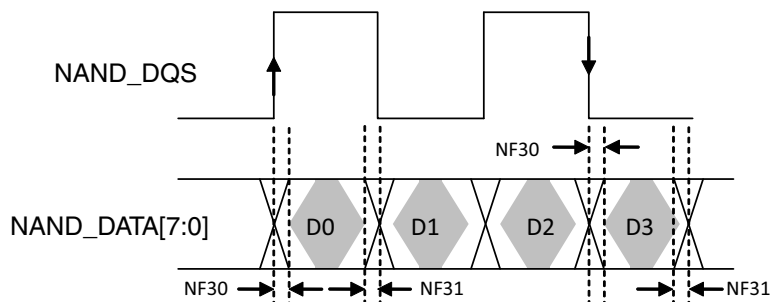


Figure 41. NAND\_DQS/NAND\_DQ Read Valid window

Table 50. Source Synchronous mode timing parameters<sup>1</sup>

| ID   | Parameter                                      | Symbol | Timing<br>T = GPMI Clock Cycle                         |      | Unit |
|------|------------------------------------------------|--------|--------------------------------------------------------|------|------|
|      |                                                |        | Min.                                                   | Max. |      |
| NF18 | NAND_CE0_B access time                         | tCE    | $CE\_DELAY \times T - 0.79$ [see note <sup>2</sup> ]   |      | ns   |
| NF19 | NAND_CE0_B hold time                           | tCH    | $0.5 \times tCK - 0.63$ [see note <sup>2</sup> ]       |      | ns   |
| NF20 | Command/address NAND_DATAxx setup time         | tCAS   | $0.5 \times tCK - 0.05$                                |      | ns   |
| NF21 | Command/address NAND_DATAxx hold time          | tCAH   | $0.5 \times tCK - 1.23$                                |      | ns   |
| NF22 | clock period                                   | tCK    | —                                                      |      | ns   |
| NF23 | preamble delay                                 | tPRE   | $PRE\_DELAY \times T - 0.29$ [see note <sup>2</sup> ]  |      | ns   |
| NF24 | postamble delay                                | tPOST  | $POST\_DELAY \times T - 0.78$ [see note <sup>2</sup> ] |      | ns   |
| NF25 | NAND_CLE and NAND_ALE setup time               | tCALS  | $0.5 \times tCK - 0.86$                                |      | ns   |
| NF26 | NAND_CLE and NAND_ALE hold time                | tCALH  | $0.5 \times tCK - 0.37$                                |      | ns   |
| NF27 | NAND_CLK to first NAND_DQS latching transition | tDQSS  | $T - 0.41$ [see note <sup>2</sup> ]                    |      | ns   |
| NF28 | Data write setup                               |        | $0.25 \times tCK - 0.35$                               |      |      |
| NF29 | Data write hold                                |        | $0.25 \times tCK - 0.85$                               |      |      |
| NF30 | NAND_DQS/NAND_DQ read setup skew               |        | —                                                      | 2.06 |      |
| NF31 | NAND_DQS/NAND_DQ read hold skew                |        | —                                                      | 1.95 |      |

<sup>1</sup> GPMI's Source Synchronous mode output timing can be controlled by the module's internal registers GPMI\_TIMING2\_CE\_DELAY, GPMI\_TIMING2\_PREAMBLE\_DELAY, GPMI\_TIMING2\_POST\_DELAY. This AC timing depends on these registers settings. In the table, CE\_DELAY/PRE\_DELAY/POST\_DELAY represents each of these settings.

<sup>2</sup> T = tCK(GPMI clock period) - 0.075 ns (half of maximum p-p jitter).

For DDR Source Synchronous mode, Figure 41 shows the timing diagram of NAND\_DQS/NAND\_DATAxx read valid window. The typical value of tDQSQ is 0.85 ns (max) and 1 ns (max) for tQHS at 200 MB/s. GPMI will sample NAND\_DATA[7:0] at both rising and falling edge of an delayed NAND\_DQS signal, which can be provided by an internal DPLL. The delay value can be controlled by GPMI register GPMI\_READ\_DDR\_DLL\_CTRL.SLV\_DLY\_TARGET (see the GPMI chapter of the *i.MX 7Dual Application Processor Reference Manual* [IMX7DRM]). Generally, the typical delay value of this register is equal to 0x7 which means 1/4 clock cycle delay expected. But if the board delay is big enough and cannot be ignored, the delay value should be made larger to compensate the board delay.

### 4.9.3 ONFI NV-DDR2 mode (ONFI 3.2 compatible)

#### 4.9.3.1 Command and address timing

ONFI 3.2 mode command and address timing is the same as ONFI 1.0 compatible Async mode AC timing. See [Section 4.9.1, “Asynchronous mode AC timing \(ONFI 1.0 compatible\),”](#) for details.

#### 4.9.3.2 Read and write timing

ONFI 3.2 mode read and write timing is the same as Toggle mode AC timing. See [Section 4.9.4, “Toggle mode AC Timing,”](#) for details.

### 4.9.4 Toggle mode AC Timing

#### 4.9.4.1 Command and address timing

##### NOTE

Toggle mode command and address timing is the same as ONFI 1.0 compatible Asynchronous mode AC timing. See [Section 4.9.1, “Asynchronous mode AC timing \(ONFI 1.0 compatible\),”](#) for details.

#### 4.9.4.2 Read and write timing

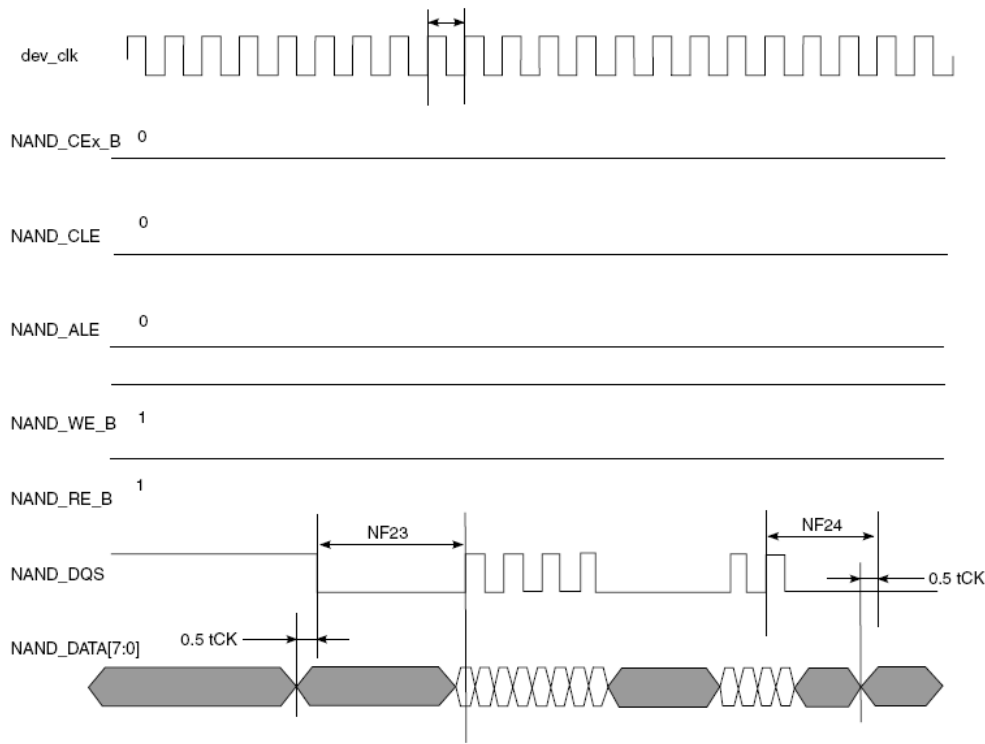


Figure 42. Toggle mode data write timing

## Electrical characteristics

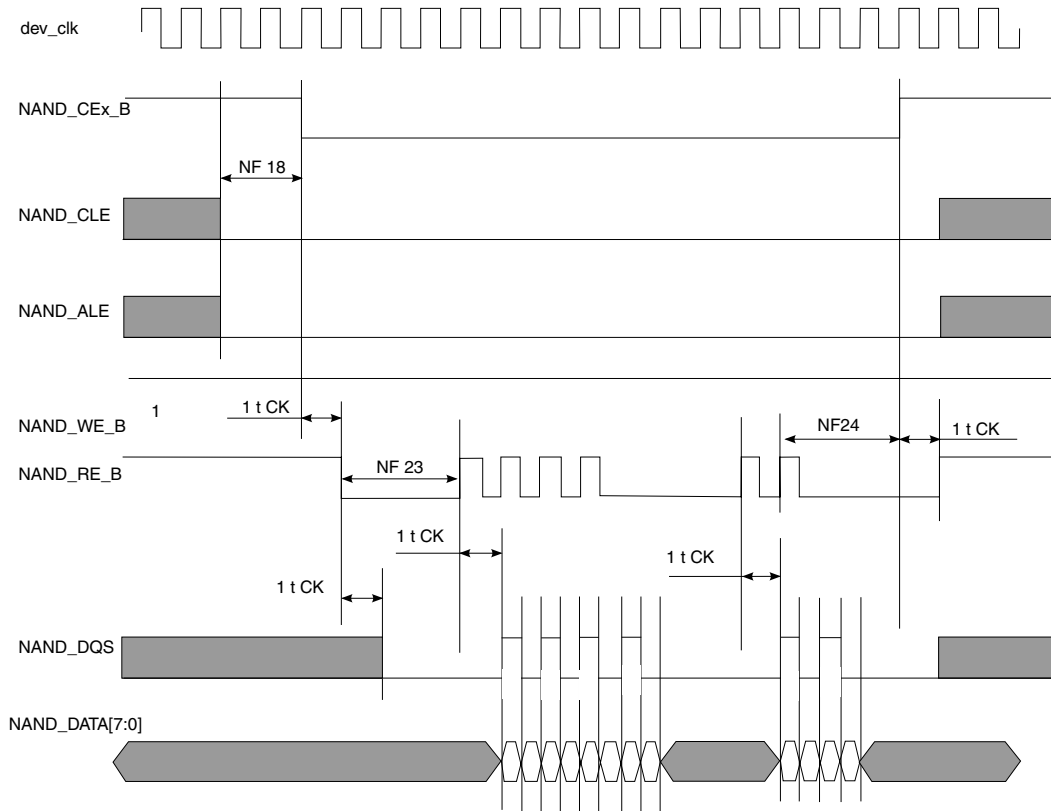


Figure 43. Toggle mode data read timing

Table 51. Toggle mode timing parameters<sup>1</sup>

| ID   | Parameter                              | Symbol | Timing<br>T = GPML Clock Cycle                         |      | Unit |
|------|----------------------------------------|--------|--------------------------------------------------------|------|------|
|      |                                        |        | Min.                                                   | Max. |      |
| NF1  | NAND_CLE setup time                    | tCLS   | $(AS + DS) \times T - 0.12$ [see note <sup>2,3</sup> ] |      |      |
| NF2  | NAND_CLE hold time                     | tCLH   | $DH \times T - 0.72$ [see note <sup>2</sup> ]          |      |      |
| NF3  | NAND_CE0_B setup time                  | tCS    | $(AS + DS) \times T - 0.58$ [see notes <sup>2</sup> ]  |      |      |
| NF4  | NAND_CE0_B hold time                   | tCH    | $DH \times T - 1$ [see note <sup>2</sup> ]             |      |      |
| NF5  | NAND_WE_B pulse width                  | tWP    | $DS \times T$ [see note <sup>2</sup> ]                 |      |      |
| NF6  | NAND_ALE setup time                    | tALS   | $(AS + DS) \times T - 0.49$ [see notes <sup>2</sup> ]  |      |      |
| NF7  | NAND_ALE hold time                     | tALH   | $DH \times T - 0.42$ [see note <sup>2</sup> ]          |      |      |
| NF8  | Command/address NAND_DATAxx setup time | tCAS   | $DS \times T - 0.26$ [see note <sup>2</sup> ]          |      |      |
| NF9  | Command/address NAND_DATAxx hold time  | tCAH   | $DH \times T - 1.37$ [see note <sup>2</sup> ]          |      |      |
| NF18 | NAND_CEx_B access time                 | tCE    | $CE\_DELAY \times T$ [see notes <sup>4,2</sup> ]       | —    | ns   |
| NF22 | clock period                           | tCK    | —                                                      | —    | ns   |
| NF23 | preamble delay                         | tPRE   | $PRE\_DELAY \times T$ [see notes <sup>5,2</sup> ]      | —    | ns   |
| NF24 | postamble delay                        | tPOST  | $POST\_DELAY \times T + 0.43$ [see note <sup>2</sup> ] | —    | ns   |

Table 51. Toggle mode timing parameters<sup>1</sup>(continued)

| ID   | Parameter                        | Symbol             | Timing<br>T = GPMI Clock Cycle |      | Unit |
|------|----------------------------------|--------------------|--------------------------------|------|------|
|      |                                  |                    | Min.                           | Max. |      |
| NF28 | Data write setup                 | tDS <sup>6</sup>   | $0.25 \times tCK - 0.32$       | —    | ns   |
| NF29 | Data write hold                  | tDH <sup>6</sup>   | $0.25 \times tCK - 0.79$       | —    | ns   |
| NF30 | NAND_DQS/NAND_DQ read setup skew | tDQSQ <sup>7</sup> | —                              | 3.18 |      |
| NF31 | NAND_DQS/NAND_DQ read hold skew  | tQHS <sup>7</sup>  | —                              | 3.27 |      |

<sup>1</sup> The GPMI toggle mode output timing can be controlled by the module's internal registers HW\_GPMI\_TIMING0\_ADDRESS\_SETUP, HW\_GPMI\_TIMING0\_DATA\_SETUP, and HW\_GPMI\_TIMING0\_DATA\_HOLD. This AC timing depends on these registers settings. In the table, AS/DS/DH represents each of these settings.

<sup>2</sup> AS minimum value can be 0, while DS/DH minimum value is 1.

<sup>3</sup> T = tCK (GPMI clock period) - 0.075 ns (half of maximum p-p jitter).

<sup>4</sup> CE\_DELAY represents HW\_GPMI\_TIMING2[CE\_DELAY]. NF18 is guaranteed by the design. Read/Write operation is started with enough time of ALE/CLE assertion to low level.

<sup>5</sup> PRE\_DELAY+1) ≥ (AS+DS)

<sup>6</sup> Shown in [Figure 42](#).

<sup>7</sup> Shown in [Figure 43](#).

For DDR Toggle mode, [Figure 41](#) shows the timing diagram of NAND\_DQS/NAND\_DATA<sub>xx</sub> read valid window. The typical value of tDQSQ is 1.4 ns (max) and 1.4 ns (max) for tQHS at 133 MB/s. GPMI will sample NAND\_DATA[7:0] at both rising and falling edge of an delayed NAND\_DQS signal, which is provided by an internal DPLL. The delay value of this register can be controlled by GPMI register GPMI\_READ\_DDR\_DLL\_CTRL.SLV\_DLY\_TARGET (see the GPMI chapter of the *i.MX 7Dual Application Processor Reference Manual* [IMX7DRM]). Generally, the typical delay value is equal to 0x7 which means 1/4 clock cycle delay expected. But if the board delay is big enough and cannot be ignored, the delay value should be made larger to compensate the board delay.

## 4.10 External peripheral interface parameters

The following subsections provide information on external peripheral interfaces.

### 4.10.1 ECSPI timing parameters

This section describes the timing parameters of the ECSPI blocks. The ECSPI have separate timing parameters for master and slave modes.

### 4.10.1.1 ECSPi Master mode timing

Figure 44 depicts the timing of ECSPi in master mode. Table 52 lists the ECSPi master mode timing characteristics.

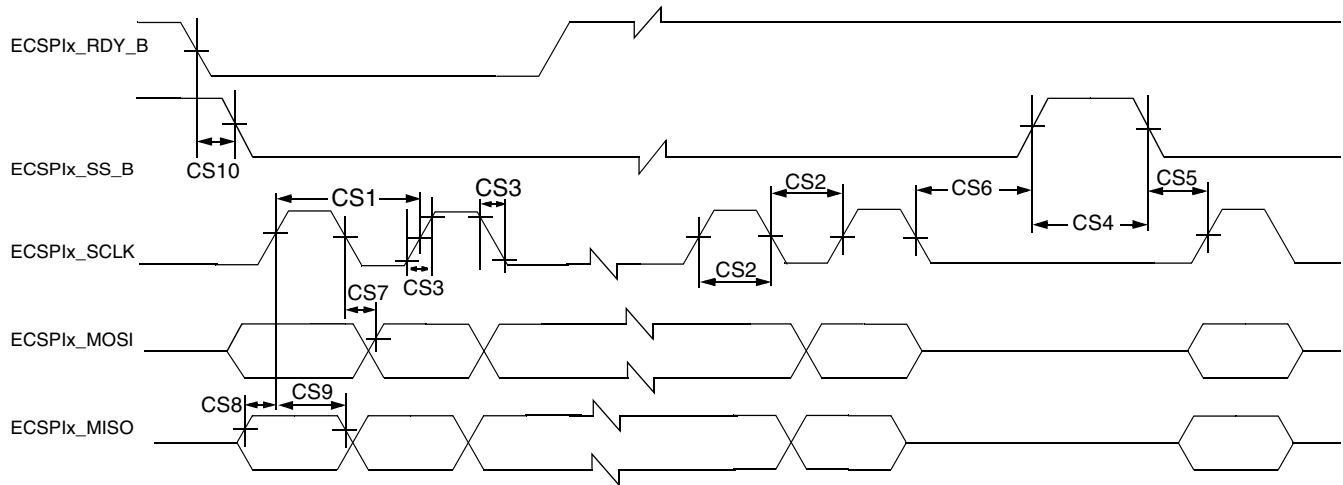


Figure 44. ECSPi Master mode timing diagram

Table 52. ECSPi Master mode timing parameters

| ID   | Parameter                                                             | Symbol          | Min                        | Max | Unit |
|------|-----------------------------------------------------------------------|-----------------|----------------------------|-----|------|
| CS1  | ECSPi_SCLK Cycle Time–Read<br>ECSPi_SCLK Cycle Time–Write             | $t_{clk}$       | 43<br>15                   | —   | ns   |
| CS2  | ECSPi_SCLK High or Low Time–Read<br>ECSPi_SCLK High or Low Time–Write | $t_{sw}$        | 21.5<br>7                  | —   | ns   |
| CS3  | ECSPi_SCLK Rise or Fall <sup>1</sup>                                  | $t_{RISE/FALL}$ | —                          | —   | ns   |
| CS4  | ECSPi_SS_B pulse width                                                | $t_{CSLH}$      | Half ECSPi_SCLK period     | —   | ns   |
| CS5  | ECSPi_SS_B Lead Time (CS setup time)                                  | $t_{SCS}$       | Half ECSPi_SCLK period - 4 | —   | ns   |
| CS6  | ECSPi_SS_B Lag Time (CS hold time)                                    | $t_{HCS}$       | Half ECSPi_SCLK period - 2 | —   | ns   |
| CS7  | ECSPi_MOSI Propagation Delay ( $C_{LOAD} = 20$ pF)                    | $t_{PDmosi}$    | -1                         | 1   | ns   |
| CS8  | ECSPi_MISO Setup Time                                                 | $t_{Smiso}$     | 18                         | —   | ns   |
| CS9  | ECSPi_MISO Hold Time                                                  | $t_{Hmiso}$     | 0                          | —   | ns   |
| CS10 | RDY to ECSPi_SS_B Time <sup>2</sup>                                   | $t_{SDRY}$      | 5                          | —   | ns   |

<sup>1</sup> See specific I/O AC parameters [Section 4.6, “I/O AC parameters.”](#)

<sup>2</sup> SPI\_RDY is sampled internally by ipg\_clk and is asynchronous to all other CSPI signals.

### 4.10.1.2 ECSPi Slave mode timing

Figure 45 depicts the timing of ECSPi in Slave mode. Table 53 lists the ECSPi Slave mode timing characteristics.

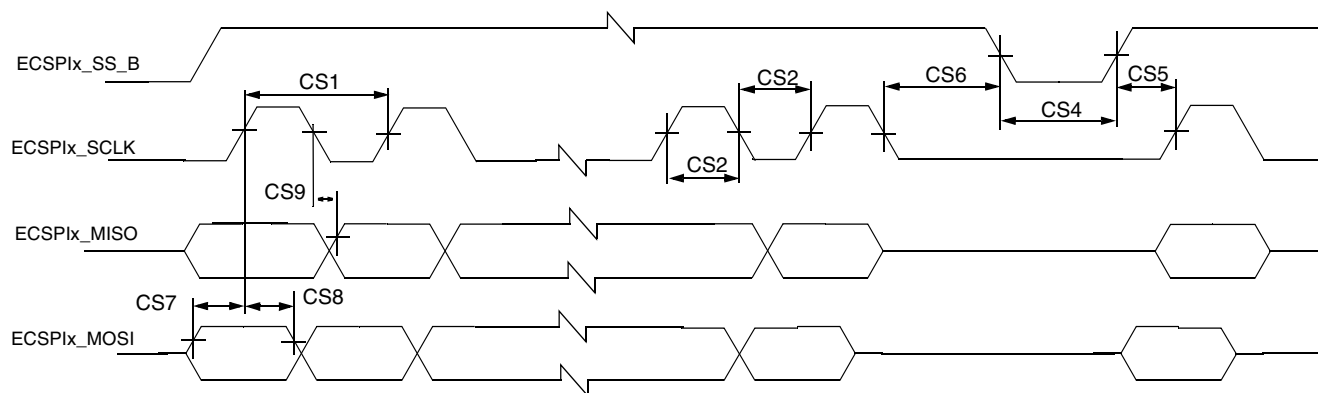


Figure 45. ECSPi Slave mode timing diagram

Table 53. ECSPi Slave mode timing parameters

| ID  | Parameter                                                             | Symbol       | Min                    | Max | Unit |
|-----|-----------------------------------------------------------------------|--------------|------------------------|-----|------|
| CS1 | ECSPi_SCLK Cycle Time–Read<br>ECSPi_SCLK Cycle Time–Write             | $t_{clk}$    | 15<br>43               | —   | ns   |
| CS2 | ECSPi_SCLK High or Low Time–Read<br>ECSPi_SCLK High or Low Time–Write | $t_{SW}$     | 7<br>21.5              | —   | ns   |
| CS4 | ECSPi_SS_B pulse width                                                | $t_{CSLH}$   | Half ECSPi_SCLK period | —   | ns   |
| CS5 | ECSPi_SS_B Lead Time (CS setup time)                                  | $t_{SCS}$    | 5                      | —   | ns   |
| CS6 | ECSPi_SS_B Lag Time (CS hold time)                                    | $t_{HCS}$    | 5                      | —   | ns   |
| CS7 | ECSPi_MOSI Setup Time                                                 | $t_{Smosi}$  | 4                      | —   | ns   |
| CS8 | ECSPi_MOSI Hold Time                                                  | $t_{Hmosi}$  | 4                      | —   | ns   |
| CS9 | ECSPi_MISO Propagation Delay ( $C_{LOAD} = 20$ pF)                    | $t_{PDmiso}$ | 4                      | 19  | ns   |

## 4.10.2 Ultra-high-speed SD/SDIO/MMC host interface (uSDHC) AC timing

This section describes the electrical information of the uSDHC, which includes SD/eMMC4.3 (single data rate) timing, eMMC4.4/4.41 (dual data rate) timing and SDR104/50(SD3.0) timing.

### 4.10.2.1 SD/eMMC4.3 (single data rate) AC timing

Figure 46 depicts the timing of SD/eMMC4.3, and Table 54 lists the SD/eMMC4.3 timing characteristics.

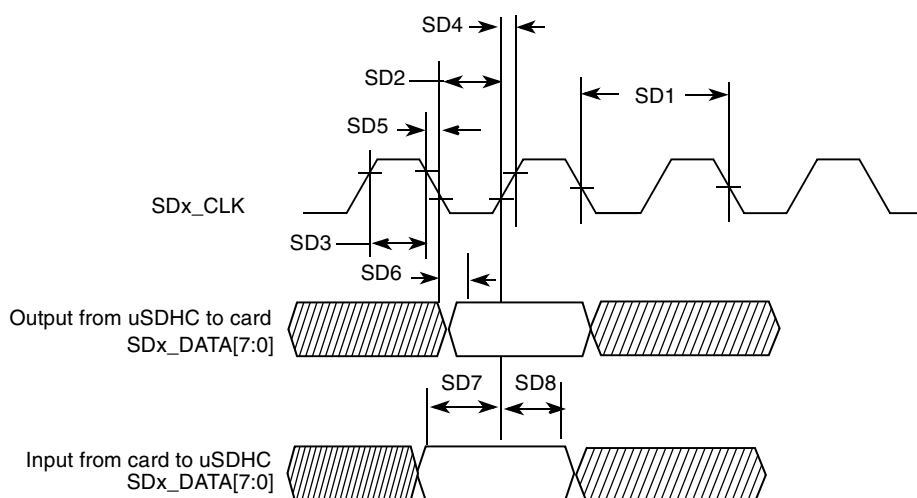


Figure 46. SD/eMMC4.3 Timing

Table 54. SD/eMMC4.3 interface timing specification

| ID                                                                   | Parameter                                       | Symbols    | Min  | Max   | Unit |
|----------------------------------------------------------------------|-------------------------------------------------|------------|------|-------|------|
| <b>Card Input Clock</b>                                              |                                                 |            |      |       |      |
| SD1                                                                  | Clock Frequency (Low Speed)                     | $f_{PP}^1$ | 0    | 400   | kHz  |
|                                                                      | Clock Frequency (SD/SDIO Full Speed/High Speed) | $f_{PP}^2$ | 0    | 25/50 | MHz  |
|                                                                      | Clock Frequency (MMC Full Speed/High Speed)     | $f_{PP}^3$ | 0    | 20/52 | MHz  |
|                                                                      | Clock Frequency (Identification Mode)           | $f_{OD}$   | 100  | 400   | kHz  |
| SD2                                                                  | Clock Low Time                                  | $t_{WL}$   | 7    | —     | ns   |
| SD3                                                                  | Clock High Time                                 | $t_{WH}$   | 7    | —     | ns   |
| SD4                                                                  | Clock Rise Time                                 | $t_{TLH}$  | —    | 3     | ns   |
| SD5                                                                  | Clock Fall Time                                 | $t_{THL}$  | —    | 3     | ns   |
| <b>uSDHC Output/Card Inputs SD_CMD, SDx_DATAx (Reference to CLK)</b> |                                                 |            |      |       |      |
| SD6                                                                  | uSDHC Output Delay                              | $t_{OD}$   | -6.6 | 3.6   | ns   |

Table 54. SD/eMMC4.3 interface timing specification(continued)

| ID                                                                   | Parameter                          | Symbols   | Min | Max | Unit |
|----------------------------------------------------------------------|------------------------------------|-----------|-----|-----|------|
| <b>uSDHC Input/Card Outputs SD_CMD, SDx_DATAx (Reference to CLK)</b> |                                    |           |     |     |      |
| SD7                                                                  | uSDHC Input Setup Time             | $t_{ISU}$ | 2.5 | —   | ns   |
| SD8                                                                  | uSDHC Input Hold Time <sup>4</sup> | $t_{IH}$  | 1.5 | —   | ns   |

<sup>1</sup> In Low-Speed mode, card clock must be lower than 400 kHz, voltage ranges from 2.7 to 3.6 V.

<sup>2</sup> In Normal (Full) -Speed mode for SD/SDIO card, clock frequency can be any value between 0–25 MHz. In High-speed mode, clock frequency can be any value between 0–50 MHz.

<sup>3</sup> In Normal (Full) -Speed mode for MMC card, clock frequency can be any value between 0–20 MHz. In High-speed mode, clock frequency can be any value between 0–52 MHz.

<sup>4</sup> To satisfy hold timing, the delay difference between clock input and cmd/data input must not exceed 2 ns.

#### 4.10.2.2 eMMC4.4/4.41 (dual data rate) AC timing

Figure 47 depicts the timing of eMMC4.4/4.41. Table 55 lists the eMMC4.4/4.41 timing characteristics. Be aware that only DATA is sampled on both edges of the clock (not applicable to CMD).

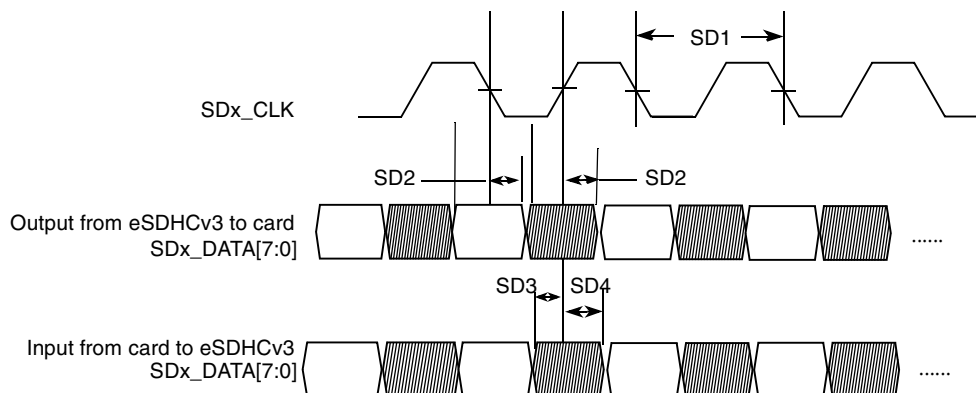


Figure 47. eMMC4.4/4.41 timing

Table 55. eMMC4.4/4.41 interface timing specification

| ID                                                                     | Parameter                          | Symbols  | Min | Max | Unit |
|------------------------------------------------------------------------|------------------------------------|----------|-----|-----|------|
| <b>Card Input Clock</b>                                                |                                    |          |     |     |      |
| SD1                                                                    | Clock Frequency (eMMC4.4/4.41 DDR) | $f_{PP}$ | 0   | 52  | MHz  |
| SD1                                                                    | Clock Frequency (SD3.0 DDR)        | $f_{PP}$ | 0   | 50  | MHz  |
| <b>uSDHC Output / Card Inputs SD_CMD, SDx_DATAx (Reference to CLK)</b> |                                    |          |     |     |      |
| SD2                                                                    | uSDHC Output Delay                 | $t_{OD}$ | 2.7 | 6.9 | ns   |
| <b>uSDHC Input / Card Outputs SD_CMD, SDx_DATAx (Reference to CLK)</b> |                                    |          |     |     |      |

Table 55. eMMC4.4/4.41 interface timing specification(continued)

| ID  | Parameter              | Symbols   | Min | Max | Unit |
|-----|------------------------|-----------|-----|-----|------|
| SD3 | uSDHC Input Setup Time | $t_{ISU}$ | 2.4 | —   | ns   |
| SD4 | uSDHC Input Hold Time  | $t_{IH}$  | 1.3 | —   | ns   |

#### 4.10.2.3 HS400 AC timing—eMMC5.0 only

Figure 48 depicts the timing of HS400. Table 56 lists the HS400 timing characteristics. Be aware that only data is sampled on both edges of the clock (not applicable to CMD). The CMD input/output timing for HS400 mode is the same as CMD input/output timing for SDR104 mode. Check SD5, SD6 and SD7 parameters in Table 58 SDR50/SDR104 Interface Timing Specification for CMD input/output timing for HS400 mode.

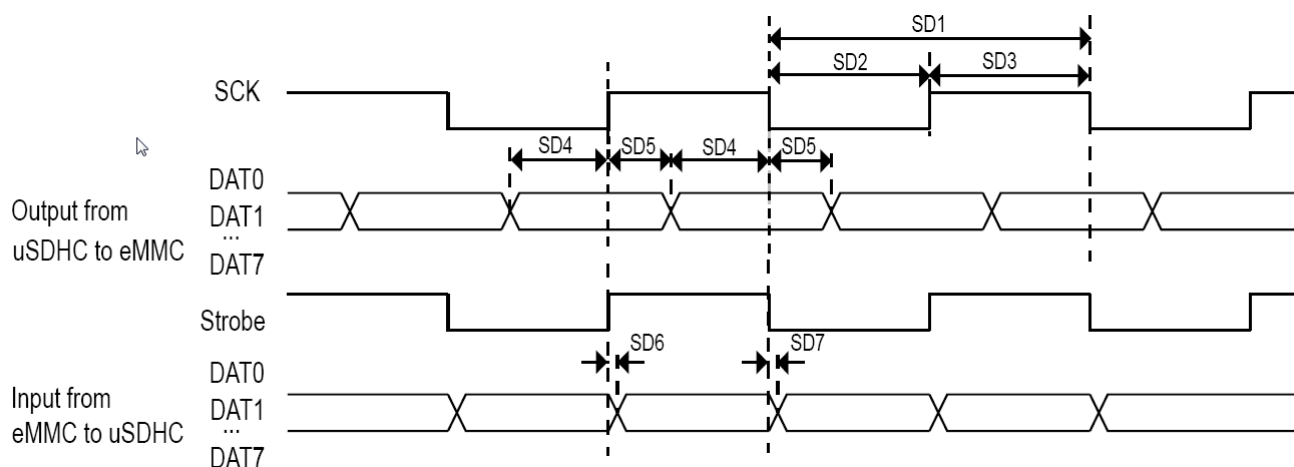


Figure 48. HS400 timing

Table 56. HS400 interface timing specifications

| ID                                                     | Parameter                            | Symbols      | Min                   | Max                   | Unit |
|--------------------------------------------------------|--------------------------------------|--------------|-----------------------|-----------------------|------|
| <b>Card Input clock</b>                                |                                      |              |                       |                       |      |
| SD1                                                    | Clock Frequency                      | fPP          | 0                     | 200                   | Mhz  |
| SD2                                                    | Clock Low Time                       | $t_{CL}$     | $0.46 \times t_{CLK}$ | $0.54 \times t_{CLK}$ | ns   |
| SD3                                                    | Clock High Time                      | $t_{CH}$     | $0.46 \times t_{CLK}$ | $0.54 \times t_{CLK}$ | ns   |
| <b>uSDHC Output/Card inputs DAT (Reference to SCK)</b> |                                      |              |                       |                       |      |
| SD4                                                    | Output Skew from Data of Edge of SCK | $t_{OSkew1}$ | 0.45                  | —                     | ns   |
| SD5                                                    | Output Skew from Edge of SCK to Data | $t_{OSkew2}$ | 0.45                  | —                     | ns   |

Table 56. HS400 interface timing specifications(continued)

| ID                                                        | Parameter        | Symbols   | Min | Max  | Unit |
|-----------------------------------------------------------|------------------|-----------|-----|------|------|
| <b>uSDHC input/Card Outputs DAT (Reference to Strobe)</b> |                  |           |     |      |      |
| SD6                                                       | uSDHC input skew | $t_{RQ}$  | —   | 0.45 | ns   |
| SD7                                                       | uSDHC hold skew  | $t_{RQH}$ | —   | 0.45 | ns   |

#### 4.10.2.4 HS200 Mode Timing

Figure 49 depicts the timing of HS200 mode, and Table 57 lists the HS200 timing characteristics.

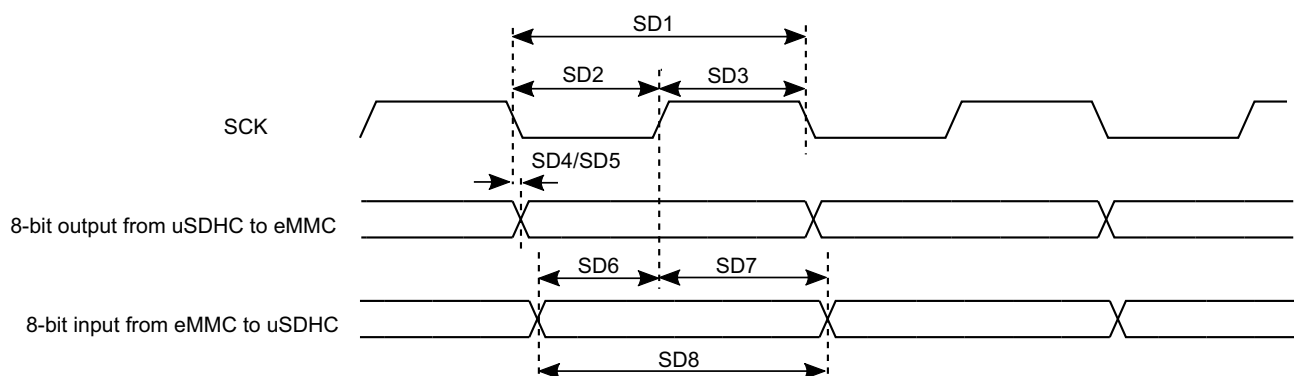


Figure 49. HS200 Mode Timing

Table 57. HS200 Interface Timing Specification

| ID                                                                                        | Parameter               | Symbols   | Min                 | Max                 | Unit |
|-------------------------------------------------------------------------------------------|-------------------------|-----------|---------------------|---------------------|------|
| <b>Card Input Clock</b>                                                                   |                         |           |                     |                     |      |
| SD1                                                                                       | Clock Frequency Period  | $t_{CLK}$ | 5.0                 | —                   | ns   |
| SD2                                                                                       | Clock Low Time          | $t_{CL}$  | $0.3 \cdot t_{CLK}$ | $0.7 \cdot t_{CLK}$ | ns   |
| SD2                                                                                       | Clock High Time         | $t_{CH}$  | $0.3 \cdot t_{CLK}$ | $0.7 \cdot t_{CLK}$ | ns   |
| <b>uSDHC Output/Card Inputs SD_CMD, SDx_DATAx in HS200 (Reference to CLK)</b>             |                         |           |                     |                     |      |
| SD5                                                                                       | uSDHC Output Delay      | $t_{OD}$  | -1.6                | 1                   | ns   |
| <b>uSDHC Input/Card Outputs SD_CMD, SDx_DATAx in HS200 (Reference to CLK)<sup>1</sup></b> |                         |           |                     |                     |      |
| SD8                                                                                       | Card Output Data Window | $t_{ODW}$ | $0.5 \cdot t_{CLK}$ | —                   | ns   |

<sup>1</sup>HS200 is for 8 bits while SDR104 is for 4 bits.

### 4.10.2.5 SDR50/SDR104 AC timing

Figure 50 depicts the timing of SDR50/SDR104, and Table 58 lists the SDR50/SDR104 timing characteristics.

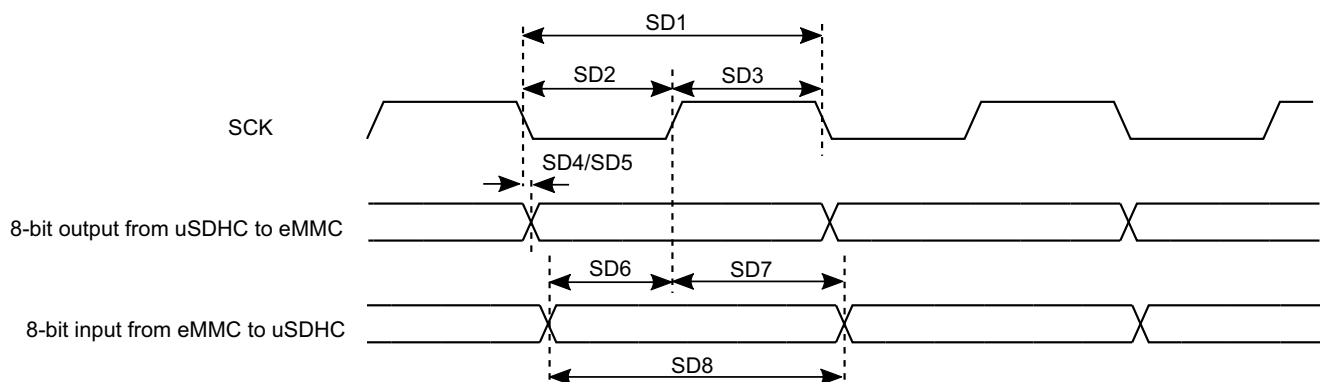


Figure 50. SDR50/SDR104 timing

Table 58. SDR50/SDR104 interface timing specification

| ID                                                                                         | Parameter               | Symbols   | Min                   | Max                   | Unit |
|--------------------------------------------------------------------------------------------|-------------------------|-----------|-----------------------|-----------------------|------|
| <b>Card Input Clock</b>                                                                    |                         |           |                       |                       |      |
| SD1                                                                                        | Clock Frequency Period  | $t_{CLK}$ | 5                     | —                     | ns   |
| SD2                                                                                        | Clock Low Time          | $t_{CL}$  | $0.46 \times t_{CLK}$ | $0.54 \times t_{CLK}$ | ns   |
| SD3                                                                                        | Clock High Time         | $t_{CH}$  | $0.46 \times t_{CLK}$ | $0.54 \times t_{CLK}$ | ns   |
| <b>uSDHC Output/Card Inputs SD_CMD, SDx_DATAx in SDR50 (Reference to CLK)</b>              |                         |           |                       |                       |      |
| SD4                                                                                        | uSDHC Output Delay      | $t_{OD}$  | -3                    | 1                     | ns   |
| <b>uSDHC Output/Card Inputs SD_CMD, SDx_DATAx in SDR104 (Reference to CLK)</b>             |                         |           |                       |                       |      |
| SD5                                                                                        | uSDHC Output Delay      | $t_{OD}$  | -1.6                  | 1                     | ns   |
| <b>uSDHC Input/Card Outputs SD_CMD, SDx_DATAx in SDR50 (Reference to CLK)</b>              |                         |           |                       |                       |      |
| SD6                                                                                        | uSDHC Input Setup Time  | $t_{ISU}$ | 2.4                   | —                     | ns   |
| SD7                                                                                        | uSDHC Input Hold Time   | $t_{IH}$  | 1.4                   | —                     | ns   |
| <b>uSDHC Input/Card Outputs SD_CMD, SDx_DATAx in SDR104 (Reference to CLK)<sup>1</sup></b> |                         |           |                       |                       |      |
| SD8                                                                                        | Card Output Data Window | $t_{ODW}$ | $0.5 \times t_{CLK}$  | —                     | ns   |

<sup>1</sup>Data window in SDR100 mode is variable.

### 4.10.2.6 Bus operation condition for 3.3 V and 1.8 V signaling

Signaling level of SD/eMMC4.3 and eMMC4.4/4.41 modes is 3.3 V. Signaling level of SDR104/SDR50 mode is 1.8 V. The DC parameters for the NVCC\_SD1, NVCC\_SD2 and NVCC\_SD3 supplies are identical to those shown in [Table 22, "GPIO DC Parameters,"](#) on page 38.

## 4.10.3 Ethernet controller (ENET) AC electrical specifications

The following timing specs are defined at the chip I/O pin and must be translated appropriately to arrive at timing specs/constraints for the physical interface.

### 4.10.3.1 ENET MII mode timing

This subsection describes MII receive, transmit, asynchronous inputs, and serial management signal timings.

#### 4.10.3.1.1 MII receive signal timing (ENET\_RX\_DATA3,2,1,0, ENET\_RX\_EN, ENET\_RX\_ER, and ENET\_RX\_CLK)

The receiver functions correctly up to an ENET\_RX\_CLK maximum frequency of 25 MHz + 1%. There is no minimum frequency requirement. Additionally, the processor clock frequency must exceed twice the ENET\_RX\_CLK frequency.

[Figure 51](#) shows MII receive signal timings. [Table 59](#) describes the timing parameters (M1–M4) shown in the figure.

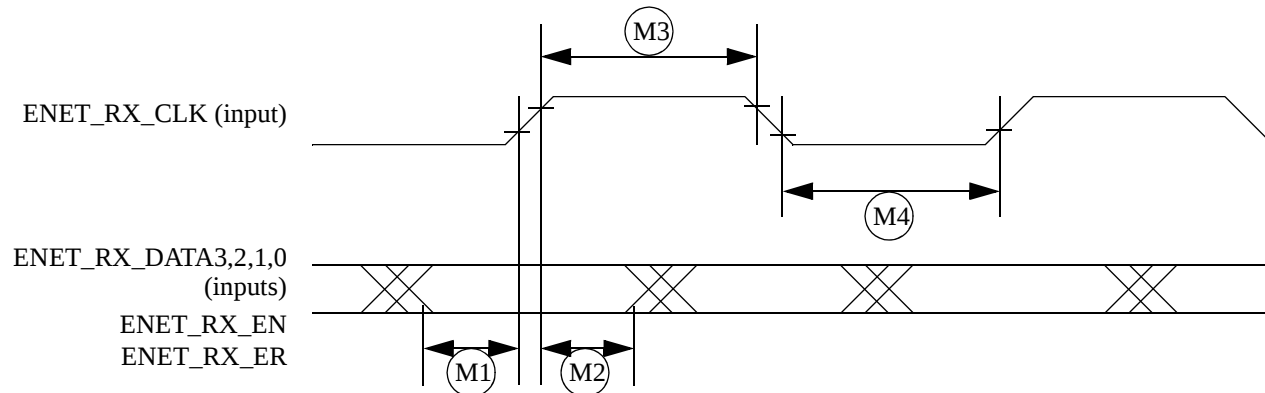


Figure 51. MII receive signal timing diagram

**Table 59. MII receive signal timing**

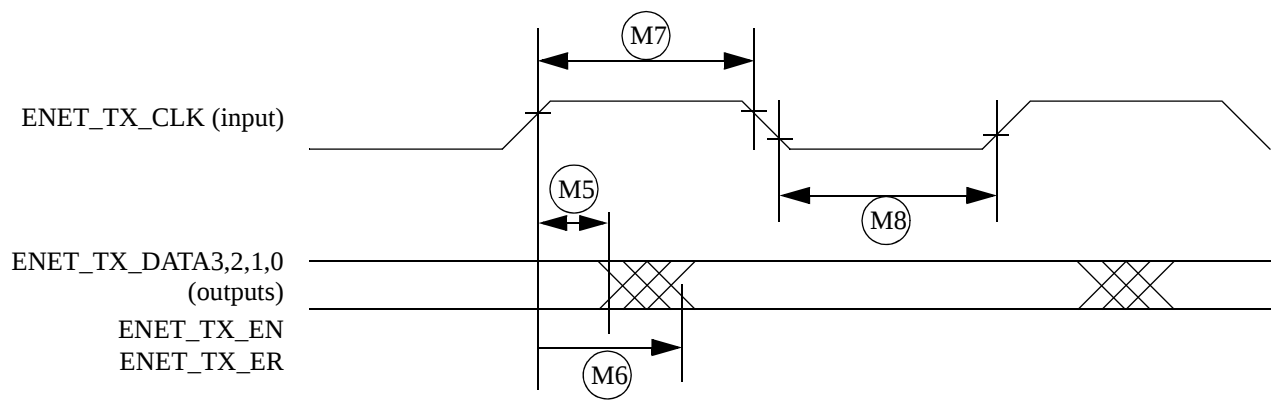
| ID | Characteristic <sup>1</sup>                                      | Min. | Max. | Unit               |
|----|------------------------------------------------------------------|------|------|--------------------|
| M1 | ENET_RX_DATA3,2,1,0, ENET_RX_EN, ENET_RX_ER to ENET_RX_CLK setup | 5    | —    | ns                 |
| M2 | ENET_RX_CLK to ENET_RX_DATA3,2,1,0, ENET_RX_EN, ENET_RX_ER hold  | 5    | —    | ns                 |
| M3 | ENET_RX_CLK pulse width high                                     | 35%  | 65%  | ENET_RX_CLK period |
| M4 | ENET_RX_CLK pulse width low                                      | 35%  | 65%  | ENET_RX_CLK period |

<sup>1</sup> ENET\_RX\_EN, ENET\_RX\_CLK, and ENET0\_RXD0 have the same timing in 10 Mbps 7-wire interface mode.

#### 4.10.3.1.2 MII transmit signal timing (ENET\_TX\_DATA3,2,1,0, ENET\_TX\_EN, ENET\_TX\_ER, and ENET\_TX\_CLK)

The transmitter functions correctly up to an ENET\_TX\_CLK maximum frequency of 25 MHz + 1%. There is no minimum frequency requirement. Additionally, the processor clock frequency must exceed twice the ENET\_TX\_CLK frequency.

Figure 52 shows MII transmit signal timings. Table 60 describes the timing parameters (M5–M8) shown in the figure.

**Figure 52. MII transmit signal timing diagram****Table 60. MII transmit signal timing**

| ID | Characteristic <sup>1</sup>                                        | Min. | Max. | Unit               |
|----|--------------------------------------------------------------------|------|------|--------------------|
| M5 | ENET_TX_CLK to ENET_TX_DATA3,2,1,0, ENET_TX_EN, ENET_TX_ER invalid | 5    | —    | ns                 |
| M6 | ENET_TX_CLK to ENET_TX_DATA3,2,1,0, ENET_TX_EN, ENET_TX_ER valid   | —    | 20   | ns                 |
| M7 | ENET_TX_CLK pulse width high                                       | 35%  | 65%  | ENET_TX_CLK period |
| M8 | ENET_TX_CLK pulse width low                                        | 35%  | 65%  | ENET_TX_CLK period |

<sup>1</sup> ENET\_TX\_EN, ENET\_TX\_CLK, and ENET0\_TXD0 have the same timing in 10-Mbps 7-wire interface mode.

#### 4.10.3.1.3 MII asynchronous inputs signal timing (ENET\_CRS and ENET\_COL)

Figure 53 shows MII asynchronous input timings. Table 61 describes the timing parameter (M9) shown in the figure.

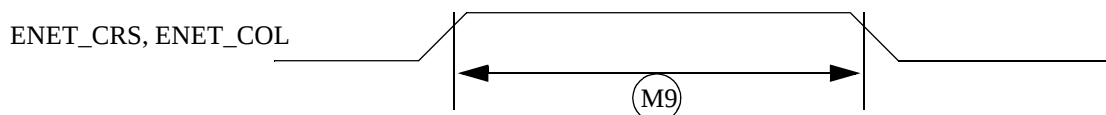


Figure 53. MII async inputs timing diagram

Table 61. MII asynchronous inputs signal timing

| ID              | Characteristic                           | Min. | Max. | Unit               |
|-----------------|------------------------------------------|------|------|--------------------|
| M9 <sup>1</sup> | ENET_CRS to ENET_COL minimum pulse width | 1.5  | —    | ENET_TX_CLK period |

<sup>1</sup> ENET\_COL has the same timing in 10-Mbit 7-wire interface mode.

#### 4.10.3.1.4 MII Serial management channel timing (ENET\_MDIO and ENET\_MDC)

The MDC frequency is designed to be equal to or less than 2.5 MHz to be compatible with the IEEE 802.3 MII specification. However the ENET can function correctly with a maximum MDC frequency of 15 MHz.

Figure 54 shows MII asynchronous input timings. Table 62 describes the timing parameters (M10–M15) shown in the figure.

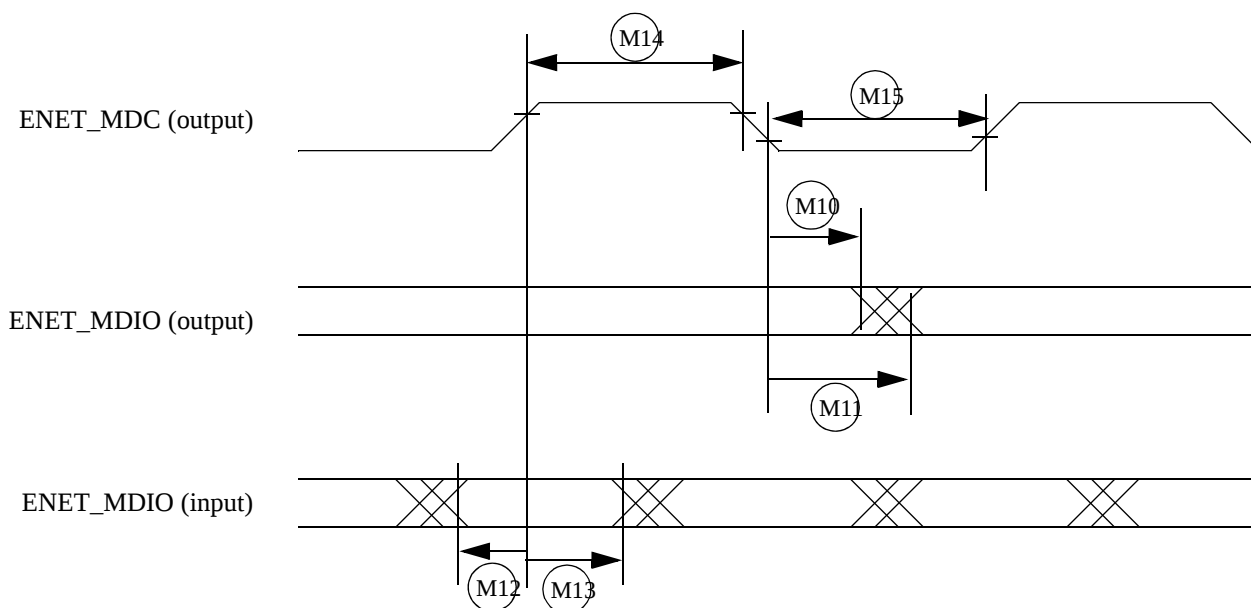


Figure 54. MII serial management channel timing diagram

Table 62. MII serial management channel timing

| ID  | Characteristic                                                             | Min. | Max. | Unit            |
|-----|----------------------------------------------------------------------------|------|------|-----------------|
| M10 | ENET_MDC falling edge to ENET_MDIO output invalid (min. propagation delay) | 0    | —    | ns              |
| M11 | ENET_MDC falling edge to ENET_MDIO output valid (max. propagation delay)   | —    | 5    | ns              |
| M12 | ENET_MDIO (input) to ENET_MDC rising edge setup                            | 18   | —    | ns              |
| M13 | ENET_MDIO (input) to ENET_MDC rising edge hold                             | 0    | —    | ns              |
| M14 | ENET_MDC pulse width high                                                  | 40%  | 60%  | ENET_MDC period |
| M15 | ENET_MDC pulse width low                                                   | 40%  | 60%  | ENET_MDC period |

#### 4.10.3.2 RMII mode timing

In RMII mode, ENET\_CLK is used as the REF\_CLK, which is a 50 MHz  $\pm$  50 ppm continuous reference clock. ENET\_RX\_EN is used as the ENET\_RX\_EN in RMII. Other signals under RMII mode include ENET\_TX\_EN, ENET\_TX\_DATA[1:0], ENET\_RX\_DATA[1:0] and ENET\_RX\_ER.

Figure 55 shows RMII mode timings. Table 63 describes the timing parameters (M16–M21) shown in the figure.

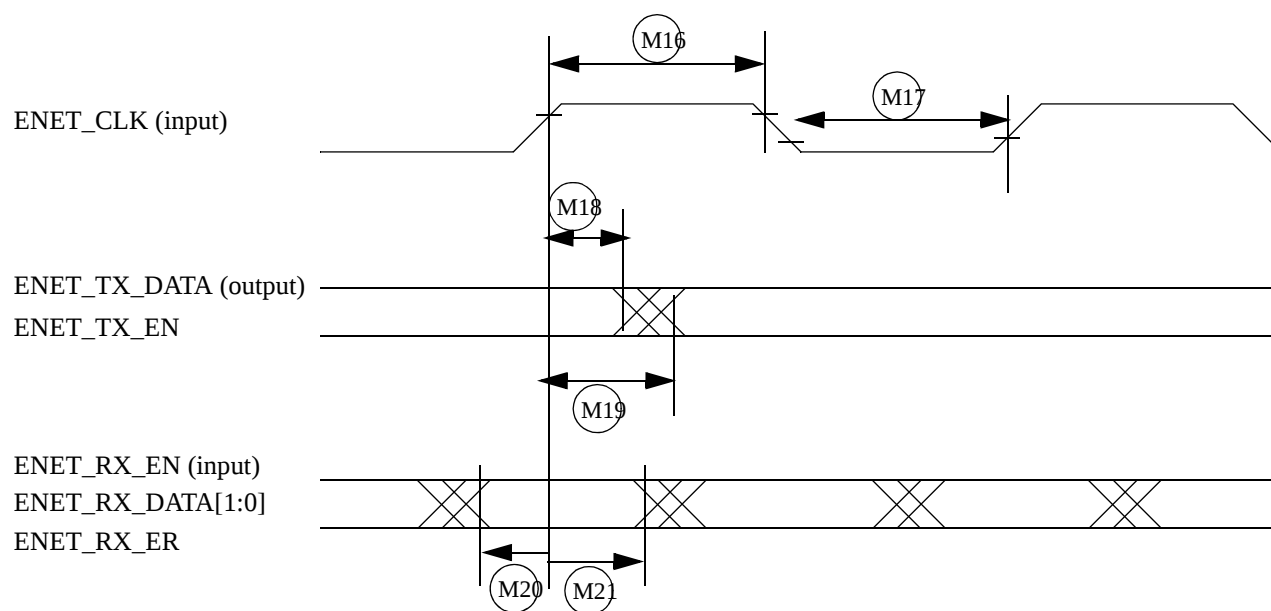


Figure 55. RMII mode signal timing diagram

Table 63. RMII signal timing

| ID  | Characteristic                                                           | Min. | Max. | Unit            |
|-----|--------------------------------------------------------------------------|------|------|-----------------|
| M16 | ENET_CLK pulse width high                                                | 35%  | 65%  | ENET_CLK period |
| M17 | ENET_CLK pulse width low                                                 | 35%  | 65%  | ENET_CLK period |
| M18 | ENET_CLK to ENET0_TXD[1:0], ENET_TX_DATA invalid                         | 4    | —    | ns              |
| M19 | ENET_CLK to ENET0_TXD[1:0], ENET_TX_DATA valid                           | —    | 15   | ns              |
| M20 | ENET_RX_DATAD[1:0], ENET_RX_EN(ENET_RX_EN), ENET_RX_ER to ENET_CLK setup | 4    | —    | ns              |
| M21 | ENET_CLK to ENET_RX_DATAD[1:0], ENET_RX_EN, ENET_RX_ER hold              | 2    | —    | ns              |

#### 4.10.3.3 Signal switching specifications

The following timing specifications meet the requirements for RGMII interfaces for a range of transceiver devices.

Table 64. RGMII signal switching specifications<sup>1</sup>

| Symbol              | Description                              | Min. | Max. | Unit |
|---------------------|------------------------------------------|------|------|------|
| $T_{cyc}^2$         | Clock cycle duration                     | 7.2  | 8.8  | ns   |
| $T_{skewT}^3$       | Data to clock output skew at transmitter | -500 | 500  | ps   |
| $T_{skewR}^3$       | Data to clock input skew at receiver     | 1    | 2.6  | ns   |
| Duty_G <sup>4</sup> | Duty cycle for Gigabit                   | 45   | 55   | %    |
| Duty_T <sup>4</sup> | Duty cycle for 10/100T                   | 40   | 60   | %    |
| Tr/Tf               | Rise/fall time (20–80%)                  | —    | 0.75 | ns   |

<sup>1</sup> The timings assume the following configuration:

DDR\_SEL = (11)b

DSE (drive-strength) = (111)b

<sup>2</sup> For 10 Mbps and 100 Mbps,  $T_{cyc}$  will scale to 400 ns  $\pm$ 40 ns and 40 ns  $\pm$ 4 ns respectively.

<sup>3</sup> For all versions of RGMII prior to 2.0; This implies that PC board design will require clocks to be routed such that an additional trace delay of greater than 1.5 ns and less than 2.0 ns will be added to the associated clock signal. For 10/100, the Max value is unspecified.

<sup>4</sup> Duty cycle may be stretched/shrunk during speed changes or while transitioning to a received packet's clock domain as long as minimum duty cycle is not violated and stretching occurs for no more than three  $T_{cyc}$  of the lowest speed transitioned between.

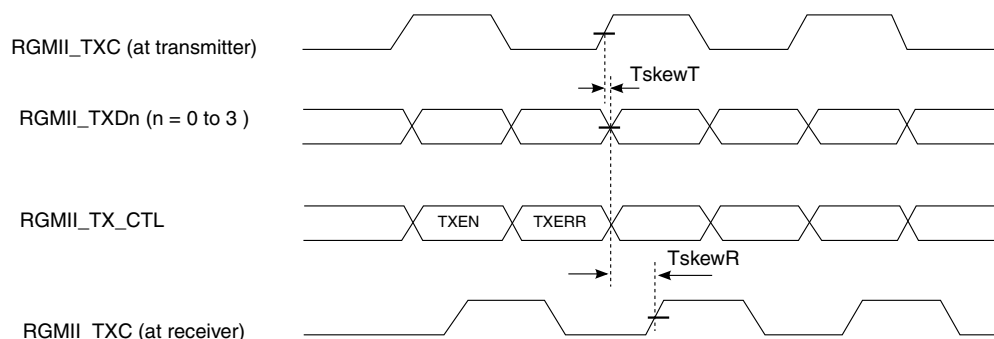


Figure 56. RGMII transmit signal timing diagram original

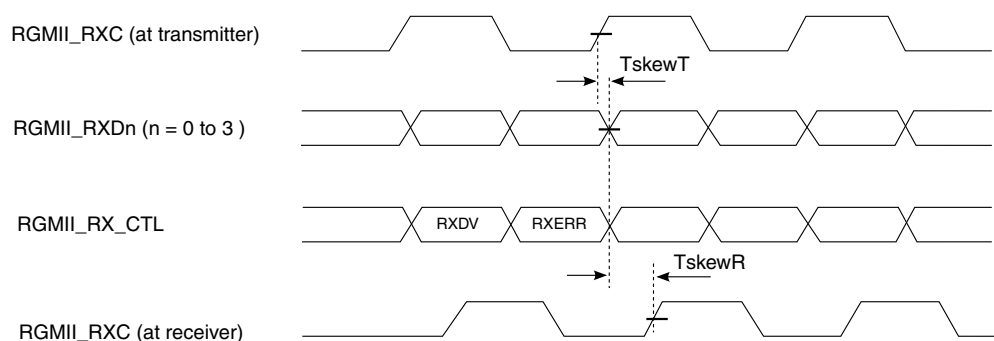


Figure 57. RGMII receive signal timing diagram original

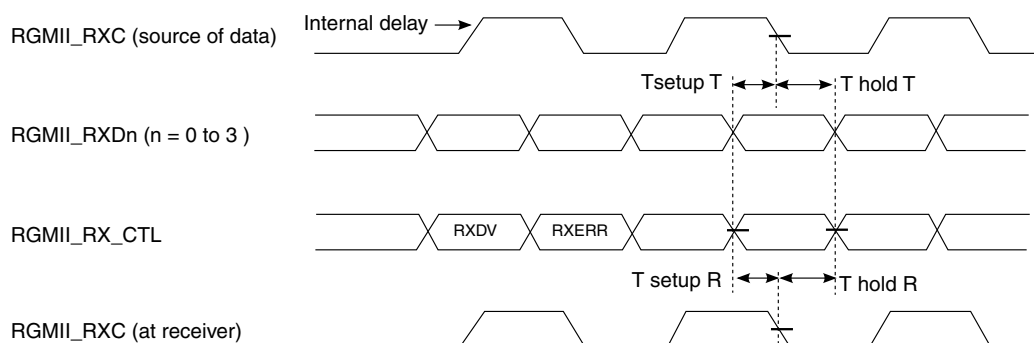


Figure 58. RGMII receive signal timing diagram with internal delay

#### 4.10.4 Flexible controller area network (flexcan) ac electrical specifications

The Flexible Controller Area Network (FlexCAN) module is a communication controller implementing the CAN protocol according to the CAN 2.0 B protocol specification. The processor has two CAN modules available for systems design. Tx and Rx ports for both modules are multiplexed with other I/O pins. See the IOMUXC chapter of the *i.MX 7Solo Application Processor Reference Manual (IMX7SRM)* to see which pins expose Tx and Rx pins; these ports are named FLEXCAN\_TX and FLEXCAN\_RX, respectively.

### 4.10.5 I<sup>2</sup>C module timing parameters

This section describes the timing parameters of the I<sup>2</sup>C module. Figure 59 depicts the timing of I<sup>2</sup>C module, and Table 65 lists the I<sup>2</sup>C module timing characteristics.

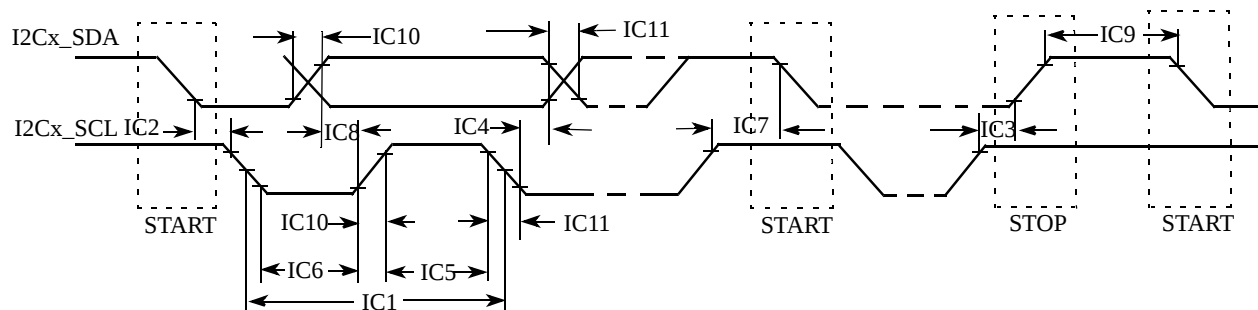


Figure 59. I<sup>2</sup>C bus timing

Table 65. I<sup>2</sup>C module timing parameters

| ID   | Parameter                                           | Standard Mode  |                   | Fast Mode                           |                  | Unit |
|------|-----------------------------------------------------|----------------|-------------------|-------------------------------------|------------------|------|
|      |                                                     | Min            | Max               | Min                                 | Max              |      |
| IC1  | I2Cx_SCL cycle time                                 | 10             | —                 | 2.5                                 | —                | μs   |
| IC2  | Hold time (repeated) START condition                | 4.0            | —                 | 0.6                                 | —                | μs   |
| IC3  | Set-up time for STOP condition                      | 4.0            | —                 | 0.6                                 | —                | μs   |
| IC4  | Data hold time                                      | 0 <sup>1</sup> | 3.45 <sup>2</sup> | 0 <sup>1</sup>                      | 0.9 <sup>2</sup> | μs   |
| IC5  | HIGH Period of I2Cx_SCL Clock                       | 4.0            | —                 | 0.6                                 | —                | μs   |
| IC6  | LOW Period of the I2Cx_SCL Clock                    | 4.7            | —                 | 1.3                                 | —                | μs   |
| IC7  | Set-up time for a repeated START condition          | 4.7            | —                 | 0.6                                 | —                | μs   |
| IC8  | Data set-up time                                    | 250            | —                 | 100 <sup>3</sup>                    | —                | ns   |
| IC9  | Bus free time between a STOP and START condition    | 4.7            | —                 | 1.3                                 | —                | μs   |
| IC10 | Rise time of both I2Cx_SDA and I2Cx_SCL signals     | —              | 1000              | 20 + 0.1C <sub>b</sub> <sup>4</sup> | 300              | ns   |
| IC11 | Fall time of both I2Cx_SDA and I2Cx_SCL signals     | —              | 300               | 20 + 0.1C <sub>b</sub> <sup>4</sup> | 300              | ns   |
| IC12 | Capacitive load for each bus line (C <sub>b</sub> ) | —              | 400               | —                                   | 400              | pF   |

<sup>1</sup> A device must internally provide a hold time of at least 300 ns for I2Cx\_SDA signal to bridge the undefined region of the falling edge of I2Cx\_SCL.

<sup>2</sup> The maximum hold time has only to be met if the device does not stretch the LOW period (ID no IC5) of the I2Cx\_SCL signal.

<sup>3</sup> A Fast-mode I<sup>2</sup>C-bus device can be used in a Standard-mode I<sup>2</sup>C-bus system, but the requirement of Set-up time (ID No IC7) of 250 ns must be met. This automatically is the case if the device does not stretch the LOW period of the I2Cx\_SCL signal. If such a device does stretch the LOW period of the I2Cx\_SCL signal, it must output the next data bit to the I2Cx\_SDA line max\_rise\_time (IC9) + data\_setup\_time (IC7) = 1000 + 250 = 1250 ns (according to the Standard-mode I<sup>2</sup>C-bus specification) before the I2Cx\_SCL line is released.

<sup>4</sup> C<sub>b</sub> = total capacitance of one bus line in pF.

## 4.10.6 LCD controller (LCDIF) timing parameters

Figure 60 shows the LCDIF timing and Table 66 lists the timing parameters.

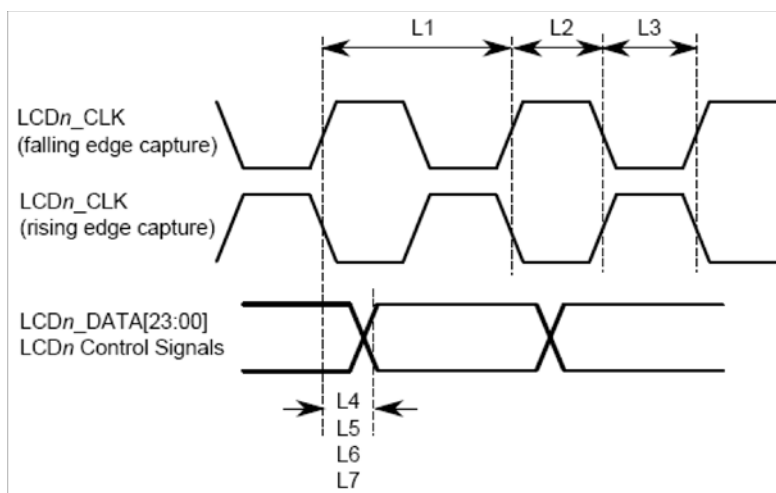


Figure 60. LCD timing

Table 66. LCD timing parameters

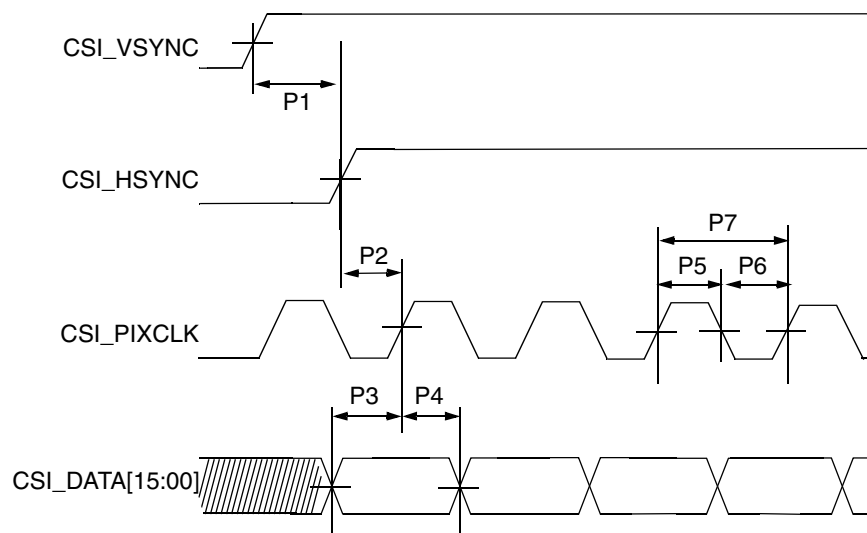
| ID | Parameter                                                            | Symbol         | Min | Max | Unit |
|----|----------------------------------------------------------------------|----------------|-----|-----|------|
| L1 | LCD pixel clock frequency                                            | tCLK(LCD)      | -   | 150 | MHz  |
| L2 | LCD pixel clock high (falling edge capture)                          | tCLKH(LCD)     | 3   | -   | ns   |
| L3 | LCD pixel clock low (rising edge capture)                            | tCLKL(LCD)     | 3   | -   | ns   |
| L4 | LCD pixel clock high to data valid (falling edge capture)            | td(CLKH-DV)    | -1  | 1   | ns   |
| L5 | LCD pixel clock low to data valid (rising edge capture)              | td(CLKL-DV)    | -1  | 1   | ns   |
| L6 | LCD pixel clock high to control signals valid (falling edge capture) | td(CLKH-CTRLV) | -1  | 1   | ns   |
| L7 | LCD pixel clock low to control signals valid (rising edge capture)   | td(CLKL-CTRLV) | -1  | 1   | ns   |

## 4.10.7 Parallel CMOS sensor interface (CSI) timing parameters

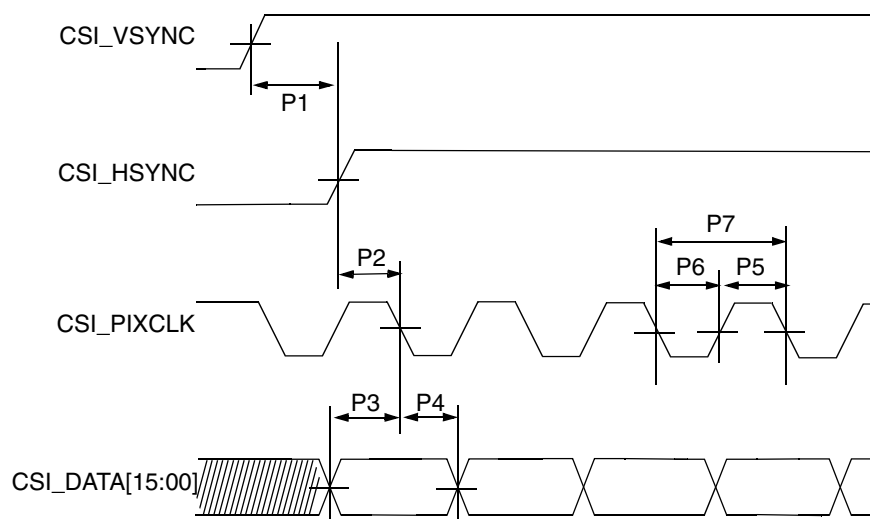
### 4.10.7.1 Gated clock mode timing

Figure 61 and Figure 62 shows the gated clock mode timings for CSI, and Table 67 describes the timing parameters (P1–P7) shown in the figures. A frame starts with a rising/falling edge on CSI\_VSYNC

(VSYNC), then CSI\_HSYNC (HSYNC) is asserted and holds for the entire line. The pixel clock, CSI\_PIXCLK (PIXCLK), is valid as long as HSYNC is asserted.



**Figure 61. CSI Gated Clock Mode—Sensor Data at Falling Edge, Latch Data at Rising Edge**



**Figure 62. CSI Gated Clock Mode—Sensor Data at Rising Edge, Latch Data at Falling Edge**

**Table 67. CSI Gated Clock Mode Timing Parameters**

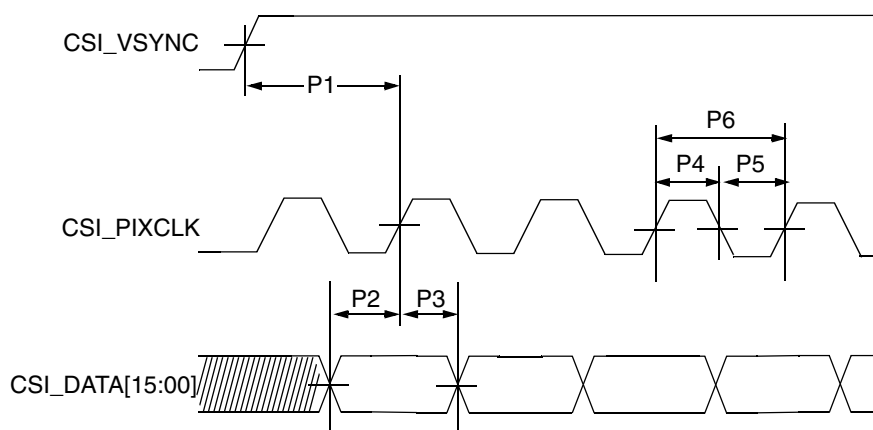
| ID | Parameter                   | Symbol | Min. | Max. | Units |
|----|-----------------------------|--------|------|------|-------|
| P1 | CSI_VSYNC to CSI_HSYNC time | tV2H   | 33.5 | —    | ns    |
| P2 | CSI_HSYNC setup time        | tHsu   | 1    | —    | ns    |
| P3 | CSI DATA setup time         | tDsu   | 1    | —    | ns    |

**Table 67. CSI Gated Clock Mode Timing Parameters(continued)**

| ID | Parameter                 | Symbol | Min. | Max.  | Units |
|----|---------------------------|--------|------|-------|-------|
| P4 | CSI DATA hold time        | tDh    | 1    | —     | ns    |
| P5 | CSI pixel clock high time | tCLKh  | 3.75 | —     | ns    |
| P6 | CSI pixel clock low time  | tCLKl  | 3.75 | —     | ns    |
| P7 | CSI pixel clock frequency | fCLK   | —    | 148.5 | MHz   |

#### 4.10.7.2 Ungated clock mode timing

Figure 63 shows the ungated clock mode timings of CSI, and Table 68 describes the timing parameters (P1–P6) that are shown in the figure. In ungated mode the CSI\_VSYNC and CSI\_PIXCLK signals are used, and the CSI\_HSYNC signal is ignored.

**Figure 63. CSI Ungated Clock Mode—Sensor Data at Falling Edge, Latch Data at Rising Edge****Table 68. CSI Ungated Clock Mode Timing Parameters**

| ID | Parameter                     | Symbol | Min. | Max.  | Units |
|----|-------------------------------|--------|------|-------|-------|
| P1 | CSI_VSYNC to pixel clock time | tVSYNC | 33.5 | —     | ns    |
| P2 | CSI DATA setup time           | tDsu   | 1    | —     | ns    |
| P3 | CSI DATA hold time            | tDh    | 1    | —     | ns    |
| P4 | CSI pixel clock high time     | tCLKh  | 3.75 | —     | ns    |
| P5 | CSI pixel clock low time      | tCLKl  | 3.75 | —     | ns    |
| P6 | CSI pixel clock frequency     | fCLK   | —    | 148.5 | MHz   |

The CSI enables the chip to connect directly to external CMOS image sensors, which are classified as dumb or smart as follows:

- Dumb sensors only support traditional sensor timing (vertical sync (VSYNC) and horizontal sync (HSYNC)) and output-only Bayer and statistics data.
- Smart sensors support CCIR656 video decoder formats and perform additional processing of the image (for example, image compression, image pre-filtering, and various data output formats).

The following subsections describe the CSI timing in gated and ungated clock modes.

## 4.10.8 MIPI PHY timing parameters

### 4.10.8.1 This section describes MIPI PHY electrical specifications. **Electrical and Timing Information**

**Table 69. Electrical and Timing Information**

| Symbol                                                                                  | Parameters                                                              | Test Conditions                                                                                                               | Min | Typ | Max  | Unit     |
|-----------------------------------------------------------------------------------------|-------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------|-----|-----|------|----------|
| Input DC Specifications - Apply to DSI_CLK_P/DSI_CLK_N and DSI_DATA_P/DSI_DATA_N inputs |                                                                         |                                                                                                                               |     |     |      |          |
| $V_I$                                                                                   | Input signal voltage range                                              | Transient voltage range is limited from -300 mV to 1600 mV                                                                    | -50 | —   | 1350 | mV       |
| $V_{LEAK}$                                                                              | Input leakage current                                                   | $V_{GND\text{SH}}(\text{min}) = V_I = V_{GND\text{SH}}(\text{max}) + V_{OH}(\text{absmax})$<br>Lane module in LP Receive Mode | -10 | —   | 10   | mA       |
| $V_{GND\text{SH}}$                                                                      | Ground Shift                                                            | —                                                                                                                             | -50 | —   | 50   | mV       |
| $V_{OH}(\text{absmax})$                                                                 | Maximum transient output voltage level                                  | —                                                                                                                             | —   | —   | 1.45 | V        |
| $t_{voh}(\text{absmax})$                                                                | Maximum transient time above $V_{OH}(\text{absmax})$                    | —                                                                                                                             | —   | —   | 20   | ns       |
| HS Line Drivers DC Specifications                                                       |                                                                         |                                                                                                                               |     |     |      |          |
| $ V_{OD} $                                                                              | HS Transmit Differential output voltage magnitude                       | $80\ \Omega \leq R_L \leq 125\ \Omega$                                                                                        | 140 | 200 | 270  | mV       |
| $\Delta V_{OD} $                                                                        | Change in Differential output voltage magnitude between logic states    | $80\ \Omega \leq R_L \leq 125\ \Omega$                                                                                        | —   | —   | 10   | mV       |
| $V_{CMTX}$                                                                              | Steady-state common-mode output voltage.                                | $80\ \Omega \leq R_L \leq 125\ \Omega$                                                                                        | 150 | 200 | 250  | mV       |
| $\Delta V_{CMTX}(1,0)$                                                                  | Changes in steady-state common-mode output voltage between logic states | $80\ \Omega \leq R_L \leq 125\ \Omega$                                                                                        | —   | —   | 5    | mV       |
| $V_{OH\text{HS}}$                                                                       | HS output high voltage                                                  | $80\ \Omega \leq R_L \leq 125\ \Omega$                                                                                        | —   | —   | 360  | mV       |
| $Z_{OS}$                                                                                | Single-ended output impedance.                                          | —                                                                                                                             | 40  | 50  | 62.5 | $\Omega$ |
| $\Delta Z_{OS}$                                                                         | Single-ended output impedance mismatch.                                 | —                                                                                                                             | —   | —   | 10   | %        |
| LP Line Drivers DC Specifications                                                       |                                                                         |                                                                                                                               |     |     |      |          |
| $V_{OL}$                                                                                | Output low-level SE voltage                                             | —                                                                                                                             | -50 | —   | 50   | mV       |
| $V_{OH}$                                                                                | Output high-level SE voltage                                            | —                                                                                                                             | 1.1 | 1.2 | 1.3  | V        |

Table 69. Electrical and Timing Information(continued)

| Symbol                                            | Parameters                                                    | Test Conditions | Min | Typ | Max | Unit     |
|---------------------------------------------------|---------------------------------------------------------------|-----------------|-----|-----|-----|----------|
| $Z_{OLP}$                                         | Single-ended output impedance.                                | —               | 110 | —   | —   | $\Omega$ |
| $\Delta Z_{OLP(01-10)}$                           | Single-ended output impedance mismatch driving opposite level | —               | —   | —   | 20  | %        |
| $\Delta Z_{OLP(0-11)}$                            | Single-ended output impedance mismatch driving same level     | —               | —   | —   | 5   | %        |
| <b>HS Line Receiver DC Specifications</b>         |                                                               |                 |     |     |     |          |
| $V_{IDTH}$                                        | Differential input high voltage threshold                     | —               | —   | —   | 70  | mV       |
| $V_{IDTL}$                                        | Differential input low voltage threshold                      | —               | -70 | —   | —   | mV       |
| $V_{IHHS}$                                        | Single ended input high voltage                               | —               | —   | —   | 460 | mV       |
| $V_{ILHS}$                                        | Single ended input low voltage                                | —               | -40 | —   | —   | mV       |
| $V_{CMRXDC}$                                      | Input common mode voltage                                     | —               | 70  | —   | 330 | mV       |
| $Z_{ID}$                                          | Differential input impedance                                  | —               | 80  | —   | 125 | $\Omega$ |
| <b>LP Line Receiver DC Specifications</b>         |                                                               |                 |     |     |     |          |
| $V_{IL}$                                          | Input low voltage                                             | —               | —   | —   | 550 | mV       |
| $V_{IH}$                                          | Input high voltage                                            | —               | 920 | —   | —   | mV       |
| $V_{HYST}$                                        | Input hysteresis                                              | —               | 25  | —   | —   | mV       |
| <b>Contention Line Receiver DC Specifications</b> |                                                               |                 |     |     |     |          |
| $V_{ILF}$                                         | Input low fault threshold                                     | —               | 200 | —   | 450 | mV       |

### 4.10.8.2 MIPI PHY signaling levels

The signal levels are different for differential HS mode and single-ended LP mode. Figure 64 shows both the HS and LP signal levels on the left and right sides, respectively. The HS signaling levels are below the LP low-level input threshold such that LP receiver always detects low on HS signals.

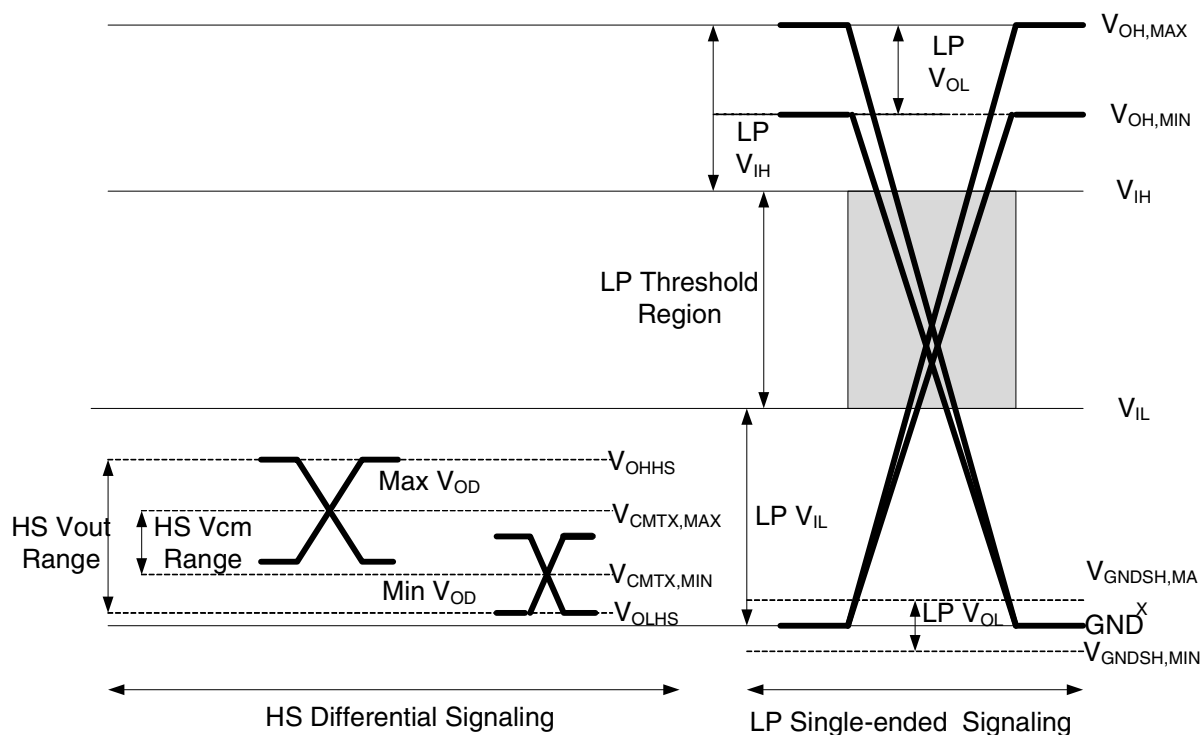


Figure 64. MIPI PHY Signaling Levels

### 4.10.8.3 MIPI HS line driver characteristics

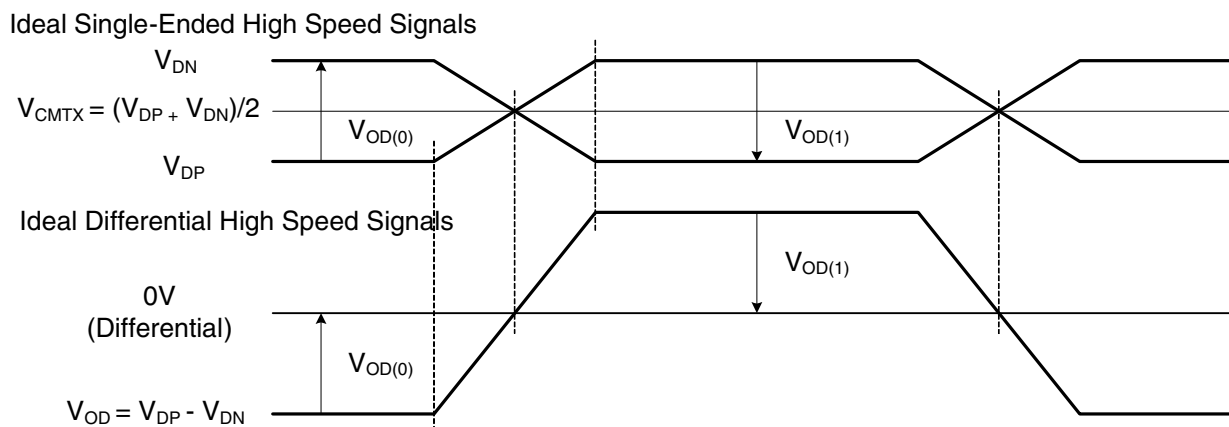


Figure 65. Ideal Single-ended and Resulting Differential HS Signals

#### 4.10.8.4 Possible $\Delta V_{CMTX}$ and $\Delta V_{OD}$ Distortions of the Single-ended HS Signals

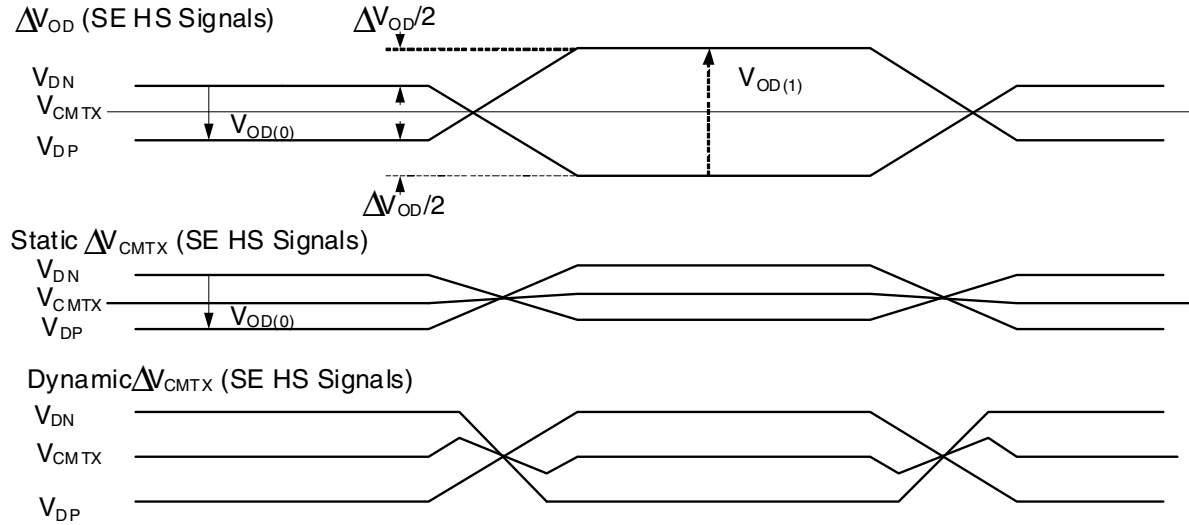


Figure 66. Possible  $\Delta V_{CMTX}$  and  $\Delta V_{OD}$  Distortions of the Single-ended HS Signals

#### 4.10.8.5 MIPI PHY switching characteristics

Table 70. Electrical and Timing Information

| Symbol                                   | Parameters                                         | Test Conditions                                                  | Min   | Typ   | Max   | Unit              |
|------------------------------------------|----------------------------------------------------|------------------------------------------------------------------|-------|-------|-------|-------------------|
| <b>HS Line Drivers AC Specifications</b> |                                                    |                                                                  |       |       |       |                   |
| —                                        | Maximum serial data rate (forward direction)       | On DATAP/N outputs.<br>80 $\Omega$ $\leq$ RL $\leq$ 125 $\Omega$ | 80    | —     | 1500  | Mbps              |
| $F_{DDRCLK}$                             | DDR CLK frequency                                  | On DATAP/N outputs.                                              | 40    | —     | 750   | MHz               |
| $P_{DDRCLK}$                             | DDR CLK period                                     | 80 $\Omega$ $\leq$ RL $\leq$ 125 $\Omega$                        | 1.33  | —     | 25    | ns                |
| $t_{CDC}$                                | DDR CLK duty cycle                                 | $t_{CDC} = t_{CPH} / P_{DDRCLK}$                                 | —     | 50    | —     | %                 |
| $t_{CPH}$                                | DDR CLK high time                                  | —                                                                | —     | 1     | —     | UI                |
| $t_{CPL}$                                | DDR CLK low time                                   | —                                                                | —     | 1     | —     | UI                |
| —                                        | DDR CLK / DATA Jitter                              | —                                                                | —     | 75    | —     | ps pk-pk          |
| $t_{SKEW[PN]}$                           | Intra-Pair (Pulse) skew                            | —                                                                | —     | 0.075 | —     | UI                |
| $t_{SKEW[TX]}$                           | Data to Clock Skew                                 | —                                                                | 0.350 | —     | 0.650 | UI                |
| $t_r$                                    | Differential output signal rise time               | 20% to 80%, RL = 50 $\Omega$                                     | 150   | —     | 0.3UI | ps                |
| $t_f$                                    | Differential output signal fall time               | 20% to 80%, RL = 50 $\Omega$                                     | 150   | —     | 0.3UI | ps                |
| $\Delta V_{CMTX(HF)}$                    | Common level variation above 450 MHz               | 80 $\Omega$ $\leq$ RL $\leq$ 125 $\Omega$                        | —     | —     | 15    | mV <sub>rms</sub> |
| $\Delta V_{CMTX(LF)}$                    | Common level variation between 50 MHz and 450 MHz. | 80 $\Omega$ $\leq$ RL $\leq$ 125 $\Omega$                        | —     | —     | 25    | mV <sub>p</sub>   |

Table 70. Electrical and Timing Information(continued)

| Symbol                                                                        | Parameters                                           | Test Conditions           | Min  | Typ | Max  | Unit     |
|-------------------------------------------------------------------------------|------------------------------------------------------|---------------------------|------|-----|------|----------|
| <b>LP Line Drivers AC Specifications</b>                                      |                                                      |                           |      |     |      |          |
| $t_{rip}, t_{flp}$                                                            | Single ended output rise/fall time                   | 15% to 85%, $C_L < 70$ pF | —    | —   | 25   | ns       |
| $t_{reo}$                                                                     |                                                      | 30% to 85%, $C_L < 70$ pF | —    | —   | 35   | ns       |
| $\delta V / \delta t_{SR}$                                                    | Signal slew rate                                     | 15% to 85%, $C_L < 70$ pF | —    | —   | 120  | mV/ns    |
| $C_L$                                                                         | Load capacitance                                     | —                         | 0    | —   | 70   | pF       |
| <b>HS Line Receiver AC Specifications</b>                                     |                                                      |                           |      |     |      |          |
| $t_{SETUP[RX]}$                                                               | Data to Clock Receiver Setup time                    | —                         | 0.15 | —   | —    | UI       |
| $t_{HOLD[RX]}$                                                                | Clock to Data Receiver Hold time                     | —                         | 0.15 | —   | —    | UI       |
| $\Delta V_{CMRX(HF)}$                                                         | Common mode interference beyond 450 MHz              | —                         | —    | —   | 200  | mVpp     |
| $\Delta V_{CMRX(LF)}$                                                         | Common mode interference between 50 MHz and 450 MHz. | —                         | -50  | —   | 50   | mVpp     |
| $C_{CM}$                                                                      | Common mode termination                              | —                         | —    | —   | 60   | pF       |
| <b>LP Line Receiver AC Specifications</b>                                     |                                                      |                           |      |     |      |          |
| $e_{SPIKE}$                                                                   | Input pulse rejection                                | —                         |      | —   | 300  | Vps      |
| $T_{MIN}$                                                                     | Minimum pulse response                               | —                         | 50   | —   |      | ns       |
| $V_{INT}$                                                                     | Pk-to-Pk interference voltage                        | —                         | —    | —   | 400  | mV       |
| $f_{INT}$                                                                     | Interference frequency                               | —                         | 450  | —   | —    | MHz      |
| <b>Model Parameters used for Driver Load switching performance evaluation</b> |                                                      |                           |      |     |      |          |
| $C_{PAD}$                                                                     | Equivalent Single ended I/O PAD capacitance.         | —                         | —    | —   | 1    | pF       |
| $C_{PIN}$                                                                     | Equivalent Single ended Package + PCB capacitance.   | —                         | —    | —   | 2    | pF       |
| $L_S$                                                                         | Equivalent wire bond series inductance               | —                         | —    | —   | 1.5  | nH       |
| $R_S$                                                                         | Equivalent wire bond series resistance               | —                         | —    | —   | 0.15 | $\Omega$ |
| $R_L$                                                                         | Load resistance                                      | —                         | 80   | 100 | 125  | $\Omega$ |

### 4.10.8.6 High-speed clock timing

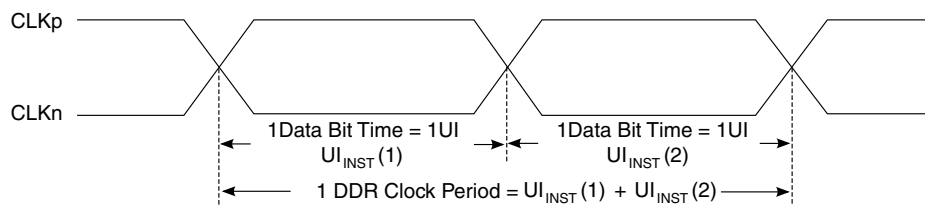


Figure 67. DDR Clock Definition

### 4.10.8.7 Forward high-speed data transmission timing

The timing relationship of the DDR Clock differential signal to the Data differential signal is shown in [Figure 68](#):

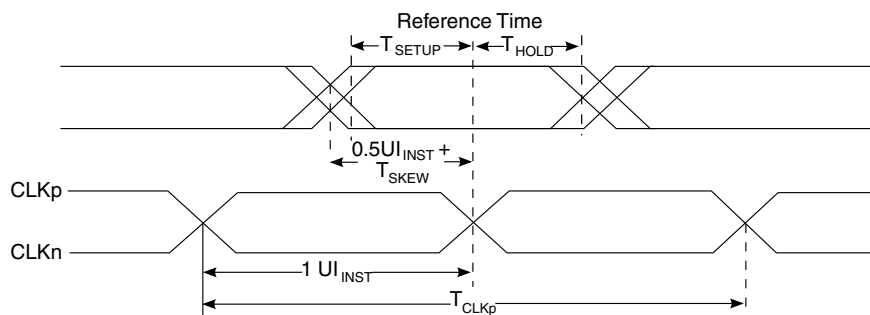


Figure 68. Data to Clock Timing Definitions

### 4.10.8.8 Reverse high-speed data transmission timing

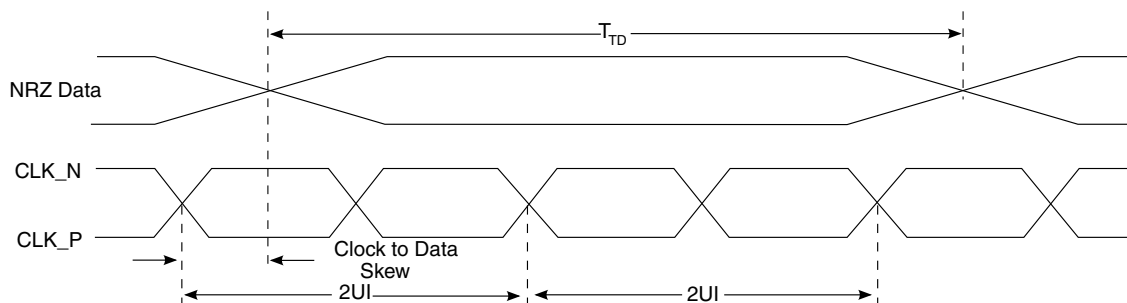
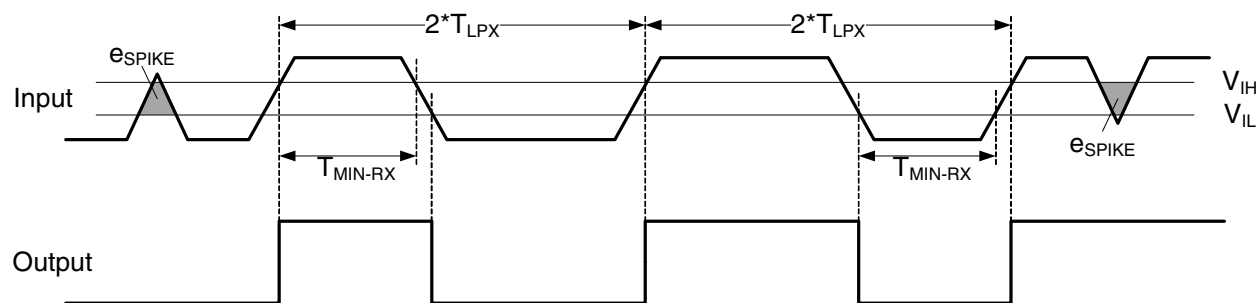


Figure 69. Reverse High-Speed Data Transmission Timing at Slave Side

#### 4.10.8.9 Low-power receiver timing



#### Input Glitch Rejection of Low-Power Receivers

#### 4.10.9 Pulse width modulator (PWM) timing parameters

This section describes the electrical information of the PWM. The PWM can be programmed to select one of three clock signals as its source frequency. The selected clock signal is passed through a prescaler before being input to the counter. The output is available at the pulse-width modulator output (PWMO) external pin.

Figure 70 depicts the timing of the PWM, and Table 71 lists the PWM timing parameters.

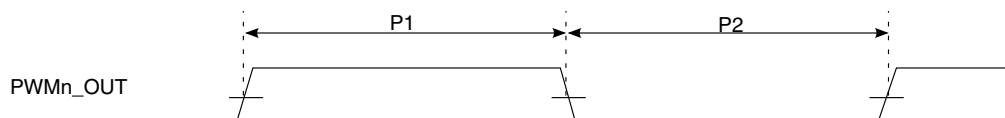


Figure 70. PWM Timing

Table 71. PWM output timing parameters

| ID | Parameter                   | Min | Max     | Unit |
|----|-----------------------------|-----|---------|------|
|    | PWM Module Clock Frequency  | 0   | ipg_clk | MHz  |
| P1 | PWM output pulse width high | 15  |         | ns   |
| P2 | PWM output pulse width low  | 15  |         | ns   |

#### 4.10.10 QUAD SPI (QSPI) Timing Parameters

Measurement conditions are with 35 pF load on SCK and SIO pins and input slew rate of 1 V/ns.

## 4.10.10.1 SDR Mode

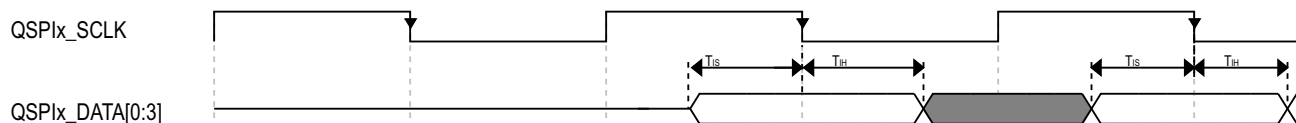


Figure 71. QuadSPI Input/Read Timing (SDR mode with internal sampling)

Table 72. QuadSPI Input Timing (SDR mode with internal sampling)

| Symbol   | Parameter                               | Value |     | Unit |
|----------|-----------------------------------------|-------|-----|------|
|          |                                         | Min   | Max |      |
| $T_{IS}$ | Setup time for incoming data            | 8.67  | —   | ns   |
| $T_{IH}$ | Hold time requirement for incoming data | 0     | —   | ns   |

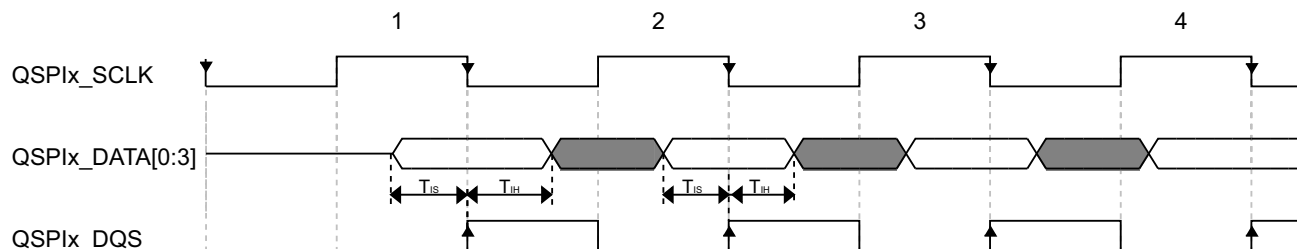


Figure 72. QuadSPI Input/Read Timing (SDR mode with loopback DQS sampling)

Table 73. QuadSPI Input/Read Timing (SDR mode with loopback DQS sampling)

| Symbol   | Parameter                               | Value |     | Unit |
|----------|-----------------------------------------|-------|-----|------|
|          |                                         | Min   | Max |      |
| $T_{IS}$ | Setup time for incoming data            | 2     | —   | ns   |
| $T_{IH}$ | Hold time requirement for incoming data | 1     | —   | ns   |

**NOTE**

- For internal sampling, the timing values assumes using sample point 0, that is QuadSPi\_x\_SMPR[SDRSMP] = 0.

- For loopback DQS sampling, the data strobe is output to the DQS pad together with the serial clock. The data strobe is looped back from DQS pad and used to sample input data.

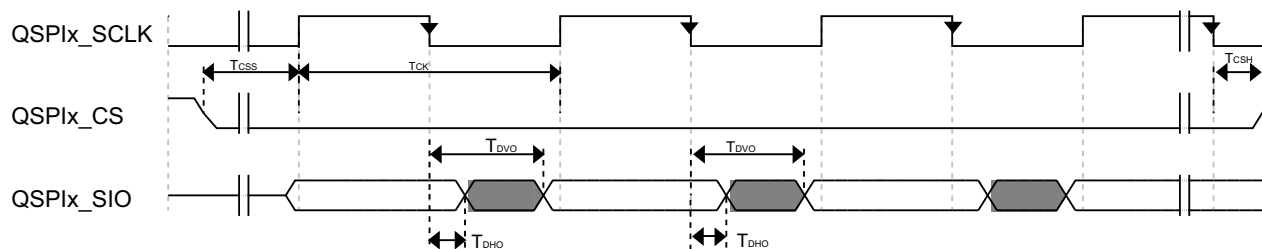


Figure 73. QuadSPI Output/Write Timing (SDR mode)

Table 74. QuadSPI Output/Write Timing (SDR mode)

| Symbol    | Parameter                     | Value |     | Unit         |
|-----------|-------------------------------|-------|-----|--------------|
|           |                               | Min   | Max |              |
| $T_{DVO}$ | Output data valid time        | —     | 2.5 | ns           |
| $T_{DHO}$ | Output data hold time         | -0.5  | —   | ns           |
| $T_{CK}$  | SCK clock period              | 10    | —   | ns           |
| $T_{CSS}$ | Chip select output setup time | 3     | —   | SCK cycle(s) |
| $T_{CSH}$ | Chip select output hold time  | 3     | —   | SCK cycle(s) |

**NOTE**

$T_{CSS}$  and  $T_{CSH}$  are configured by the QuadSPIx\_FLSHCR register, the default value of 3 are shown on the timing. Please refer to the *i.MX 6SoloX Reference Manual (IMX6ULLRM)* for more details.

## 4.10.10.2 DDR Mode

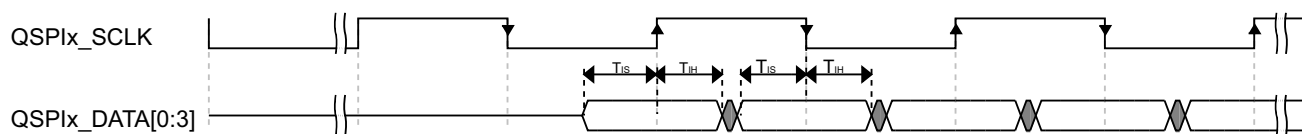


Figure 74. QuadSPI Input/Read Timing (DDR mode with internal sampling)

Table 75. QuadSPI Input/Read Timing (DDR mode with internal sampling)

| Symbol   | Parameter                               | Value |     | Unit |
|----------|-----------------------------------------|-------|-----|------|
|          |                                         | Min   | Max |      |
| $T_{IS}$ | Setup time for incoming data            | 8.67  | —   | ns   |
| $T_{IH}$ | Hold time requirement for incoming data | 0     | —   | ns   |

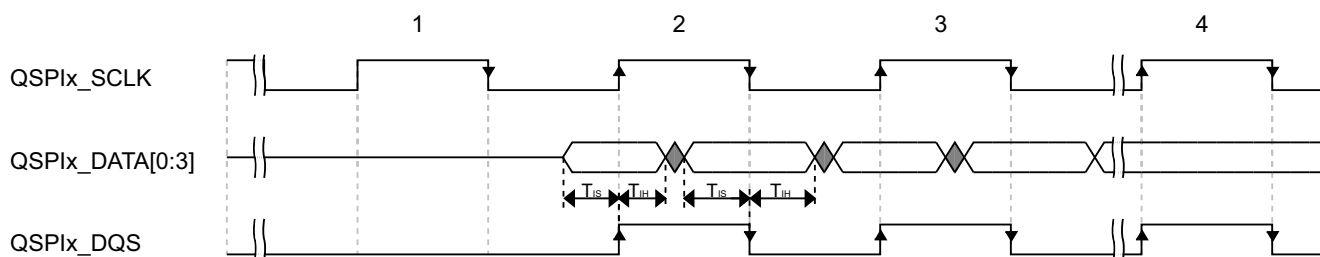


Figure 75. QuadSPI Input/Read Timing (DDR mode with loopback DQS sampling)

Table 76. QuadSPI Input/Read Timing (DDR mode with loopback DQS sampling)

| Symbol   | Parameter                               | Value |     | Unit |
|----------|-----------------------------------------|-------|-----|------|
|          |                                         | Min   | Max |      |
| $T_{IS}$ | Setup time for incoming data            | 2     | —   | ns   |
| $T_{IH}$ | Hold time requirement for incoming data | 1     | —   | ns   |

**NOTE**

- For internal sampling, the timing values assumes using sample point 0, that is QuadSPIx\_SMPR[SDRSMP] = 0.

- For loopback DQS sampling, the data strobe is output to the DQS pad together with the serial clock. The data strobe is looped back from DQS pad and used to sample input data.

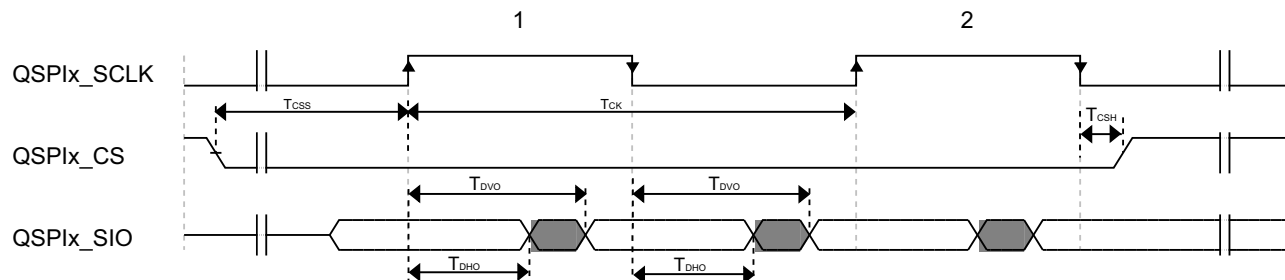


Figure 76. QuadSPI Output/Write Timing (DDR mode)

Table 77. QuadSPI Output/Write Timing (DDR mode)

| Symbol    | Parameter                     | Value                          |                                | Unit         |
|-----------|-------------------------------|--------------------------------|--------------------------------|--------------|
|           |                               | Min                            | Max                            |              |
| $T_{DVO}$ | Output data valid time        | —                              | $(0.25 \times T_{SCLK}) + 2.5$ | ns           |
| $T_{DHO}$ | Output data hold time         | $(0.25 \times T_{SCLK}) - 0.5$ | —                              | ns           |
| $T_{CK}$  | SCK clock period              | 20                             | —                              | ns           |
| $T_{CSS}$ | Chip select output setup time | 3                              | —                              | SCK cycle(s) |
| $T_{CSH}$ | Chip select output hold time  | 3                              | —                              | SCK cycle(s) |

**NOTE**

$T_{CSS}$  and  $T_{CSH}$  are configured by the QuadSPIx\_FLSHCR register, the default value of 3 are shown on the timing. See the *i.MX7Solo Reference Manual* (IMX7SRM) for more details.

#### 4.10.11 SAI/I<sup>2</sup>S switching specifications

This section provides the AC timings for the SAI in master (clocks driven) and slave (clocks input) modes. All timings are given for noninverted serial clock polarity (SAI\_TCR[TSCKP] = 0, SAI\_RCR[RSCKP] = 0) and noninverted frame sync (SAI\_TCR[TFSI] = 0, SAI\_RCR[RFSI] = 0). If the polarity of the clock and/or the frame sync have been inverted, all the timings remain valid by inverting the clock signal (SAI\_BCLK) and/or the frame sync (SAI\_FS) shown in the figures below.

Table 78. Master mode SAI timing

| Num | Characteristic                | Min | Max | Unit        |
|-----|-------------------------------|-----|-----|-------------|
| S1  | SAI_MCLK cycle time           | 20  | —   | ns          |
| S2  | SAI_MCLK pulse width high/low | 40% | 60% | MCLK period |
| S3  | SAI_BCLK cycle time           | 40  | —   | ns          |
| S4  | SAI_BCLK pulse width high/low | 40% | 60% | BCLK period |

Table 78. Master mode SAI timing(continued)

| Num | Characteristic                             | Min | Max | Unit |
|-----|--------------------------------------------|-----|-----|------|
| S5  | SAI_BCLK to SAI_FS output valid            | —   | 15  | ns   |
| S6  | SAI_BCLK to SAI_FS output invalid          | 0   | —   | ns   |
| S7  | SAI_BCLK to SAI_TXD valid                  | —   | 15  | ns   |
| S8  | SAI_BCLK to SAI_TXD invalid                | 0   | —   | ns   |
| S9  | SAI_RXD/SAI_FS input setup before SAI_BCLK | 15  | —   | ns   |
| S10 | SAI_RXD/SAI_FS input hold after SAI_BCLK   | 0   | —   | ns   |

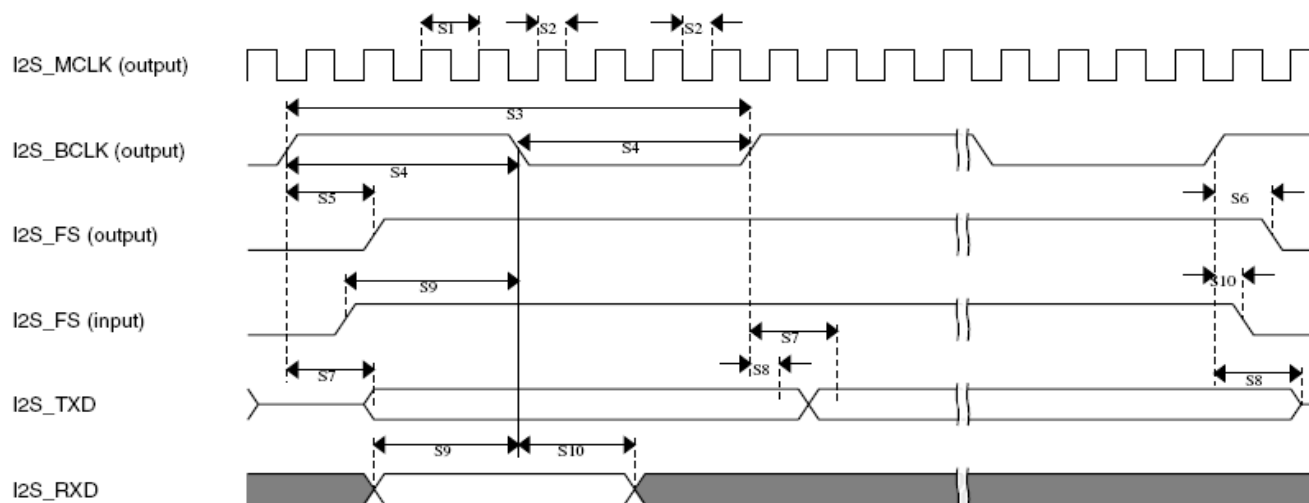


Figure 77. SAI timing — master modes

Table 79. Master mode SAI timing

| Num | Characteristic                            | Min | Max | Unit        |
|-----|-------------------------------------------|-----|-----|-------------|
| S11 | SAI_BCLK cycle time (input)               | 40  | —   | ns          |
| S12 | SAI_BCLK pulse width high/low (input)     | 40% | 60% | BCLK period |
| S13 | SAI_FS input setup before SAI_BCLK        | 10  | —   | ns          |
| S14 | SAI_FA input hold after SAI_BCLK          | 2   | —   | ns          |
| S15 | SAI_BCLK to SAI_TXD/SAI_FS output valid   | —   | 20  | ns          |
| S16 | SAI_BCLK to SAI_TXD/SAI_FS output invalid | 0   | —   | ns          |
| S17 | SAI_RXD setup before SAI_BCLK             | 10  | —   | ns          |
| S18 | SAI_RXD hold after SAI_BCLK               | 2   | —   | ns          |

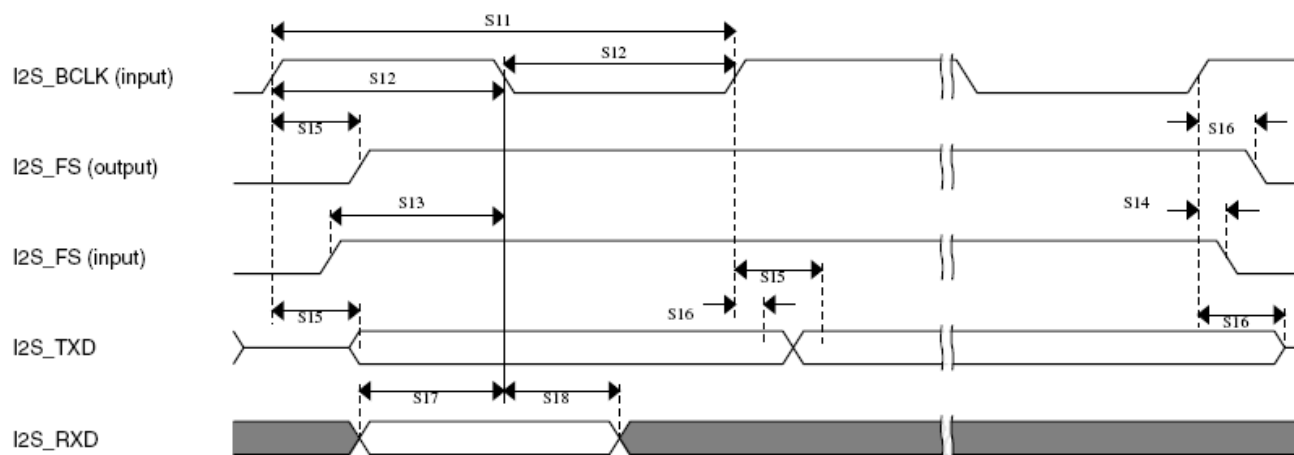


Figure 78. SAI timing — slave modes

#### 4.10.12 SCAN JTAG controller (SJC) timing parameters

Figure 79 depicts the SJC test clock input timing. Figure 80 depicts the SJC boundary scan timing. Figure 81 depicts the SJC test access port. Signal parameters are listed in Table 80.

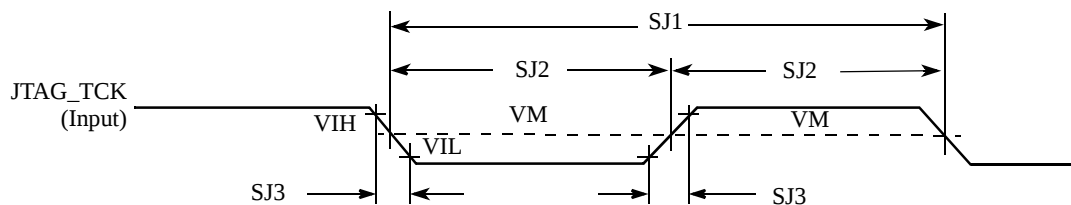


Figure 79. Test clock input timing diagram

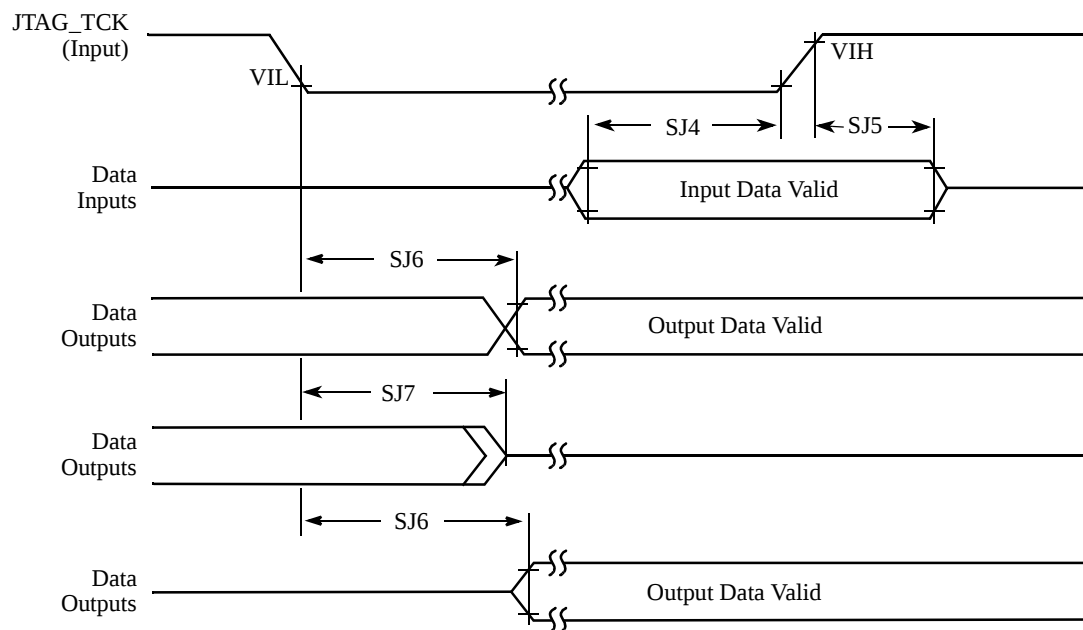


Figure 80. Boundary scan (JTAG) timing diagram

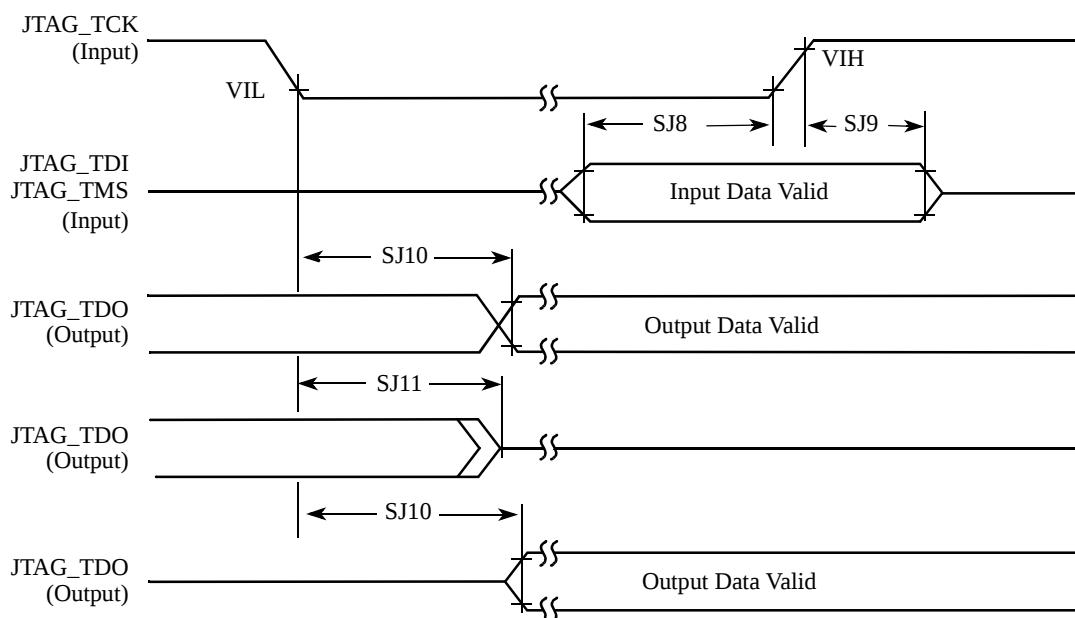


Figure 81. Test access port timing diagram

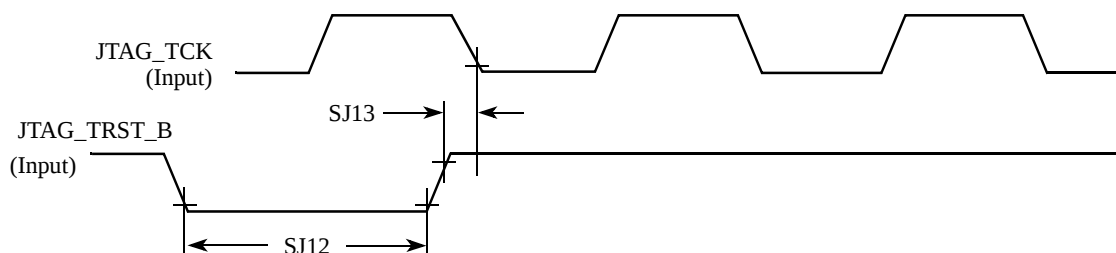


Figure 82. JTAG\_TRST\_B timing diagram

Table 80. JTAG timing

| ID  | Parameter <sup>1,2</sup>                               | All Frequencies |     | Unit |
|-----|--------------------------------------------------------|-----------------|-----|------|
|     |                                                        | Min             | Max |      |
| SJ0 | JTAG_TCK frequency of operation $1/(3 \cdot T_{DC})^1$ | 0.001           | 22  | MHz  |
| SJ1 | JTAG_TCK cycle time in Crystal mode                    | 45              | —   | ns   |
| SJ2 | JTAG_TCK clock pulse width measured at $V_M^2$         | 22.5            | —   | ns   |
| SJ3 | JTAG_TCK rise and fall times                           | —               | 3   | ns   |
| SJ4 | Boundary scan input data set-up time                   | 5               | —   | ns   |
| SJ5 | Boundary scan input data hold time                     | 24              | —   | ns   |
| SJ6 | JTAG_TCK low to output data valid                      | —               | 40  | ns   |
| SJ7 | JTAG_TCK low to output high impedance                  | —               | 40  | ns   |
| SJ8 | JTAG_TMS, JTAG_TDI data set-up time                    | 5               | —   | ns   |

Table 80. JTAG timing(continued)

| ID   | Parameter <sup>1,2</sup>                | All Frequencies |     | Unit |
|------|-----------------------------------------|-----------------|-----|------|
|      |                                         | Min             | Max |      |
| SJ9  | JTAG_TMS, JTAG_TDI data hold time       | 25              | —   | ns   |
| SJ10 | JTAG_TCK low to JTAG_TDO data valid     | —               | 44  | ns   |
| SJ11 | JTAG_TCK low to JTAG_TDO high impedance | —               | 44  | ns   |
| SJ12 | JTAG_TRST_B assert time                 | 100             | —   | ns   |
| SJ13 | JTAG_TRST_B set-up time to JTAG_TCK low | 40              | —   | ns   |

<sup>1</sup> T<sub>DC</sub> = target frequency of SJC

<sup>2</sup> V<sub>M</sub> = mid-point voltage

### 4.10.13 UART I/O configuration and timing parameters

#### 4.10.13.1 UART RS-232 I/O configuration in different modes

The i.MX 7Solo UART interfaces can serve both as DTE or DCE device. This can be configured by the DCEDTE control bit (default 0—DCE mode). Table 81 shows the UART I/O configuration based on the enabled mode.

Table 81. UART I/O configuration vs. mode

| Port          | DTE Mode  |                             | DCE Mode  |                             |
|---------------|-----------|-----------------------------|-----------|-----------------------------|
|               | Direction | Description                 | Direction | Description                 |
| UARTx_RTS_B   | Output    | UARTx_RTS_B from DTE to DCE | Input     | UARTx_RTS_B from DTE to DCE |
| UARTx_CTS_B   | Input     | UARTx_CTS_B from DCE to DTE | Output    | UARTx_CTS_B from DCE to DTE |
| UARTx_TX_DATA | Input     | Serial data from DCE to DTE | Output    | Serial data from DCE to DTE |
| UARTx_RX_DATA | Output    | Serial data from DTE to DCE | Input     | Serial data from DTE to DCE |

#### 4.10.13.2 UART RS-232 Serial mode timing

This section describes the electrical information of the UART module in the RS-232 mode.

#### 4.10.13.2.1 UART transmitter

Figure 83 depicts the transmit timing of UART in the RS-232 Serial mode, with 8 data bit/1 stop bit format. Table 82 lists the UART RS-232 Serial mode transmit timing characteristics.

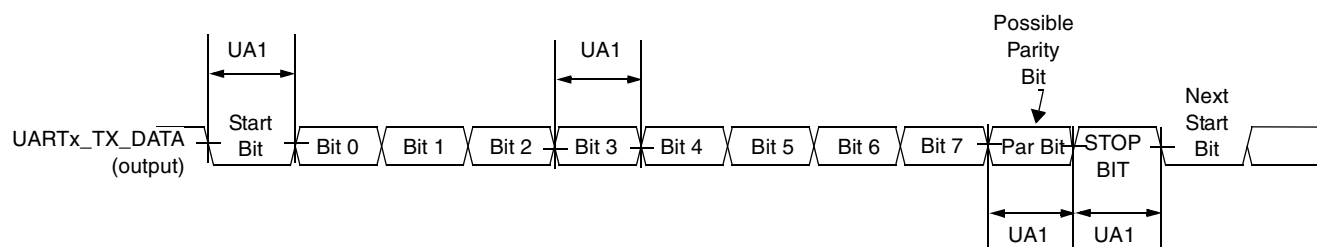


Figure 83. UART RS-232 Serial mode transmit timing diagram

Table 82. RS-232 Serial mode transmit timing parameters

| ID  | Parameter         | Symbol     | Min                                   | Max                               | Unit |
|-----|-------------------|------------|---------------------------------------|-----------------------------------|------|
| UA1 | Transmit Bit Time | $t_{Tbit}$ | $1/F_{baud\_rate}^1 - T_{ref\_clk}^2$ | $1/F_{baud\_rate} + T_{ref\_clk}$ | —    |

<sup>1</sup>  $F_{baud\_rate}$ : Baud rate frequency. The maximum baud rate the UART can support is  $(ipg\_perclk \text{ frequency})/16$ .

<sup>2</sup>  $T_{ref\_clk}$ : The period of UART reference clock  $ref\_clk$  ( $ipg\_perclk$  after RFDIV divider).

#### 4.10.13.2.2 UART receiver

Figure 84 depicts the RS-232 Serial mode receive timing with 8 data bit/1 stop bit format. Table 83 lists Serial mode receive timing characteristics.

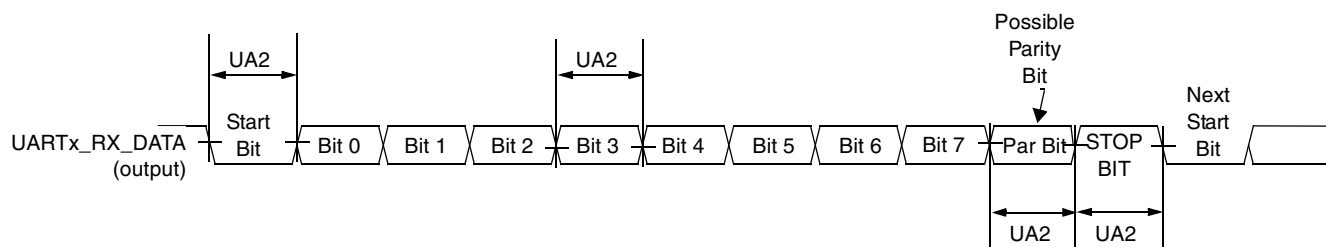


Figure 84. UART RS-232 Serial mode receive timing diagram

Table 83. RS-232 Serial mode receive timing parameters

| ID  | Parameter                     | Symbol     | Min                                                 | Max                                               | Unit |
|-----|-------------------------------|------------|-----------------------------------------------------|---------------------------------------------------|------|
| UA2 | Receive Bit Time <sup>1</sup> | $t_{Rbit}$ | $1/F_{baud\_rate}^2 - 1/(16 \times F_{baud\_rate})$ | $1/F_{baud\_rate} + 1/(16 \times F_{baud\_rate})$ | —    |

<sup>1</sup> The UART receiver can tolerate  $1/(16 \times F_{baud\_rate})$  tolerance in each bit. But accumulation tolerance in one frame must not exceed  $3/(16 \times F_{baud\_rate})$ .

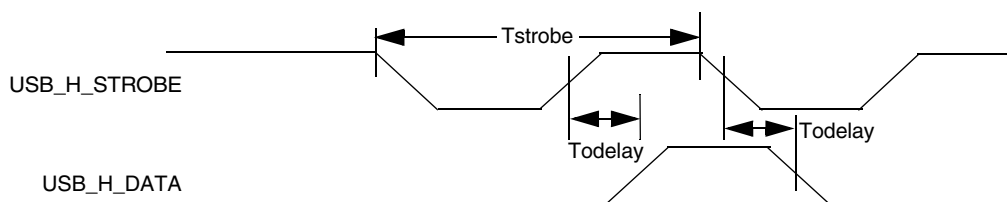
<sup>2</sup>  $F_{baud\_rate}$ : Baud rate frequency. The maximum baud rate the UART can support is  $(ipg\_perclk \text{ frequency})/16$ .

### 4.10.14 USB HSIC timing

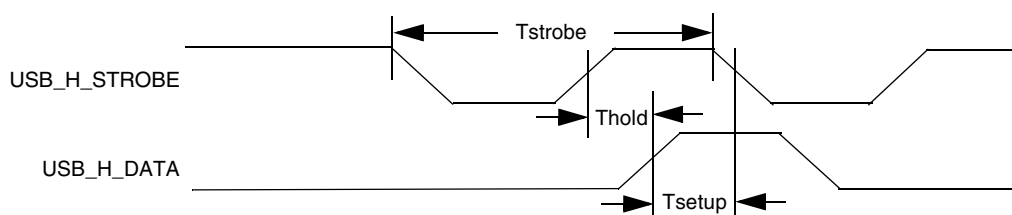
This section describes the electrical information of the USB HSIC port.

**NOTE**

HSIC is DDR signal, following timing spec is for both rising and falling edge.

**4.10.14.1 Transmit timing****Figure 85. USB HSIC transmit waveform****Table 84. USB HSIC transmit parameters**

| Name    | Parameter                       | Min   | Max   | Unit | Comment                        |
|---------|---------------------------------|-------|-------|------|--------------------------------|
| Tstrobe | strobe period                   | 4.165 | 4.169 | ns   |                                |
| Todelay | data output delay time          | 550   | 1350  | ps   | Measured at 50% point          |
| Tslew   | strobe/data rising/falling time | 0.7   | 2     | V/ns | Averaged from 30% – 70% points |

**4.10.14.2 Receive timing****Figure 86. USB HSIC receive waveform****Table 85. USB HSIC receive parameters<sup>1</sup>**

| Name    | Parameter                       | Min   | Max   | Unit | Comment                        |
|---------|---------------------------------|-------|-------|------|--------------------------------|
| Tstrobe | strobe period                   | 4.165 | 4.169 | ns   |                                |
| Thold   | data hold time                  | 300   |       | ps   | Measured at 50% point          |
| Tsetup  | data setup time                 | 365   |       | ps   | Measured at 50% point          |
| Tslew   | strobe/data rising/falling time | 0.7   | 2     | V/ns | Averaged from 30% – 70% points |

<sup>1</sup> The timings in the table are guaranteed when:  
 —AC I/O voltage is between 0.9x to 1x of the I/O supply  
 —DDR\_SEL configuration bits of the I/O are set to (10)b

### 4.10.15 USB PHY parameters

This section describes the USB-OTG PHY parameters.

The USB PHY meets the electrical compliance requirements defined in the Universal Serial Bus Revision 2.0 OTG, USB Host with the amendments below (On-The-Go and Embedded Host Supplement to the USB Revision 2.0 Specification is not applicable to Host port):

- USB ENGINEERING CHANGE NOTICE
  - Title: 5V Short Circuit Withstand Requirement Change
  - Applies to: Universal Serial Bus Specification, Revision 2.0
- Errata for USB Revision 2.0 April 27, 2000 as of 12/7/2000
- USB ENGINEERING CHANGE NOTICE
  - Title: Pull-up/Pull-down resistors
  - Applies to: Universal Serial Bus Specification, Revision 2.0
- USB ENGINEERING CHANGE NOTICE
  - Title: Suspend Current Limit Changes
  - Applies to: Universal Serial Bus Specification, Revision 2.0
- USB ENGINEERING CHANGE NOTICE
  - Title: USB 2.0 Phase Locked SOFs
  - Applies to: Universal Serial Bus Specification, Revision 2.0
- On-The-Go and Embedded Host Supplement to the USB Revision 2.0 Specification
  - Revision 2.0, version 1.1a, July 27, 2010
- Battery Charging Specification (available from USB-IF)
  - Revision 1.2, December 7, 2010

#### 4.10.15.1 USB\_OTG\*\_REXT reference resistor connection

The bias generation and impedance calibration process for the USB OTG PHYs requires connection of reference resistors 200  $\Omega$  1% precision on each of USB\_OTG1\_REXT and USB\_OTG2\_REXT pads to ground.

#### 4.10.15.2 USB\_OTG\_CHD\_B USB battery charger detection external pullup resistor connection

The usage and external resistor connection for the USB\_OTG\_CHD\_B pin are described in [Table 3](#), [Table 7](#), and [Section 4.7.3](#), “USB battery charger detection driver impedance.”

## 4.11 12-Bit A/D converter (ADC)

**Table 86. Recommended operating conditions for 12-bit ADC**

| Characteristics                               | Symbol            | Min  | Typ | Max  | Unit    |
|-----------------------------------------------|-------------------|------|-----|------|---------|
| Supply Voltage                                | AVDD18            | 1.7  | 1.8 | 1.9  | V       |
|                                               | VDDA10            | 0.95 | 1   | 1.05 | V       |
| Operating Temp                                | T <sub>J</sub>    | -25  | —   | 105  | °C      |
| Analog Input Channel                          | —                 | —    | —   | 16   | Channel |
| Analog Input Range <sup>1</sup>               | ADCx_INx          | AGND | —   | VREF | V       |
| Main Clock Frequency                          | FCLK              | 300K | —   | 6M   | Hz      |
| Start of conversion clk frequency (FCLK/3)    | FSOC              | 50K  | —   | 1M   | Hz      |
| External Input Resistance of ADC <sup>2</sup> | R <sub>IEXT</sub> | —    | 50  | 250  | Ω       |

<sup>1</sup> DO=1111111111 @AIN=AVDD18 & DO=000000000000 @AIN=AVSS18 (Input full-scale voltage = AVDD18)

<sup>2</sup> R<sub>IEXT</sub> = Output resistance of the ADC driver = Output resistance of signal generator + Series parasitic resistance between signal source and ADC input (for example, PCB and bonding wire resistance and ESD protection resistance)

**Table 87. DC Electrical characteristics**

| Specification              | Symbol | Min | Typ   | Max   | Unit | Conditions                                                  |
|----------------------------|--------|-----|-------|-------|------|-------------------------------------------------------------|
| Resolution                 | —      | —   | 12    | 12    | Bits | —                                                           |
| Differential Non-Linearity | DNL    | —   | ± 2.0 | ± 2.0 | LSB  | PD=Low<br>FCLK=6MHz<br>FSOC=1MHz<br>FAIN=10kHz<br>Ramp wave |
| Integral Non-Linearity     | INL    | —   | ± 6.0 | ± 6.0 | LSB  |                                                             |
| Top Offset Voltage         | EOT    | —   | ±10   | ± 100 | LSB  |                                                             |
| Bottom Offset Voltage      | EOB    | —   | ±11   | ± 100 | LSB  |                                                             |

**Table 88. AC Electrical characteristics**

| Specification                                     | Symbol                     | Min | Typ  | Max  | Unit |
|---------------------------------------------------|----------------------------|-----|------|------|------|
| Main Clock Duty Ratio                             | —                          | 45  | 45   | 55   | %    |
| Analog Input Frequency CH #15-0                   | FAIN                       | DC  | 50k  | 100K | Hz   |
| Normal Operation Current Consumption <sup>1</sup> | VDDA_ADCx_1P8 <sub>2</sub> | —   | 0.53 | 1.90 | mA   |
|                                                   | VDDA_1P0_CAP <sup>2</sup>  | —   | 0.02 | 0.10 | mA   |

**Table 88. AC Electrical characteristics(continued)**

| Specification                        | Symbol           | Min | Typ | Max | Unit |
|--------------------------------------|------------------|-----|-----|-----|------|
| Power Down Current <sup>2</sup>      | IPD <sup>3</sup> | —   | 3.0 | 300 | μA   |
| Signal to Noise and Distortion Ratio | SNDR             | 54  | 60  | —   | dB   |

<sup>1</sup> Normal operation current consumption includes only the current from the ADC core. It does not include static current from the power pads.

<sup>2</sup> Power-down current includes only the current from the ADC core. It does not include static current from the power pads.

<sup>3</sup> IOP and IPD are measurable only on the ADC core's test chips. Because AVDD10 is shared with internal logic power, IOP and IPD in the test plan only measure current consumption @ AVDD18, VREF.

## 5 Boot mode configuration

This section provides information on Boot mode configuration pins allocation and boot devices interfaces allocation.

### 5.1 Boot mode configuration pins

[Table 89](#) provides boot options, functionality, fuse values, and associated pins. Several input pins are also sampled at reset and can be used to override fuse values, depending on the value of BT\_FUSE\_SEL fuse. The boot option pins are in effect when BT\_FUSE\_SEL fuse is '0' (cleared, which is the case for an unblown fuse). For detailed Boot mode options configured by the Boot mode pins, see the “System Boot, Fusemap, and eFuse” chapter in the *i.MX 7Solo Application Processor Reference Manual (IMX7SRM)*.

**Table 89. Fuses and associated pins used for boot**

| Pin        | Direction at Reset | eFuse name | State during reset (POR_B asserted) | State after reset (POR_B deasserted) | Details             |
|------------|--------------------|------------|-------------------------------------|--------------------------------------|---------------------|
| BOOT_MODE0 | Input              | N/A        | Hi-Z                                | Hi-Z                                 | Boot mode selection |
| BOOT_MODE1 | Input              | N/A        | Hi-Z                                | Hi-Z                                 | Boot mode selection |

**Table 89. Fuses and associated pins used for boot(continued)**

| Pin         | Direction at Reset | eFuse name | State during reset (POR_B asserted) | State after reset (POR_B deasserted) | Details                                                                                                                                                                                                                                                                                        |
|-------------|--------------------|------------|-------------------------------------|--------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| LCD1_DATA00 | Input              | BT_CFG[0]  | 100K Pull Down                      | Keeper                               | Boot options, pin value overrides fuse settings for BT_FUSE_SEL='0'. Signal configuration as fuse override input at power up.<br>These are special I/O lines that control the boot configuration during product development. In production, the boot configuration can be controlled by fuses. |
| LCD1_DATA01 | Input              | BT_CFG[1]  | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA02 | Input              | BT_CFG[2]  | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA03 | Input              | BT_CFG[3]  | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA04 | Input              | BT_CFG[4]  | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA05 | Input              | BT_CFG[5]  | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA06 | Input              | BT_CFG[6]  | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA07 | Input              | BT_CFG[7]  | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA08 | Input              | BT_CFG[8]  | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA09 | Input              | BT_CFG[9]  | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA10 | Input              | BT_CFG[10] | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA11 | Input              | BT_CFG[11] | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA12 | Input              | BT_CFG[12] | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA13 | Input              | BT_CFG[13] | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA14 | Input              | BT_CFG[14] | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA15 | Input              | BT_CFG[15] | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA16 | Input              | BT_CFG[16] | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA17 | Input              | BT_CFG[17] | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA18 | Input              | BT_CFG[18] | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |
| LCD1_DATA19 | Input              | BT_CFG[19] | 100K Pull Down                      | Keeper                               |                                                                                                                                                                                                                                                                                                |

## 5.2 Boot device interface allocation

Table 90 lists the interfaces that can be used by the boot process in accordance with the specific Boot mode configuration. The table also describes the interface's specific modes and IOMUXC allocation, which are configured during boot when appropriate.

**Table 90. Interface allocation during boot**

| Interface | IP Instance | Allocated Pads During Boot                                                                                                                           | Comment                                                             |
|-----------|-------------|------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------|
| QSPI      | QSPI        | EPDC_D0, EPDC_D1, EPDC_D2, EPDC_D3, EPDC_D4, EPDC_D5, EPDC_D6, EPDC_D7, EPDC_D8, EPDC_D9, EPDC_D10, EPDC_D11, EPDC_D12, EPDC_D13, EPDC_D14, EPDC_D15 |                                                                     |
| SPI       | ECSPI-1     | ECSPI1_SCLK, ECSPI1_MOSI, ECSPI1_MISO, ECSPI1_SS0, UART1_RXD, UART1_TXD, UART2_RXD                                                                   | The chip-select pin used depends on the fuse "CS select (SPI only)" |

Table 90. Interface allocation during boot(continued)

| Interface  | IP Instance | Allocated Pads During Boot                                                                                                                                                               | Comment                                                                                                                                                                                                                                        |
|------------|-------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SPI        | ECSPI-2     | ECSPI2_SCLK, ECSPI2_MOSI, ECSPI2_MISO, ECSPI2_SS0, ENET1_RX_CTL, ENET1_RXC, ENET1_TD0                                                                                                    | The chip-select pin used depends on the fuse "CS select (SPI only)"                                                                                                                                                                            |
| SPI        | ECSPI-3     | SAI2_TXFS, SAI2_TXC, SAI2_RXD, SAI2_TXD, SD1_DATA3, SD2_CD_B, SD2_WP                                                                                                                     | The chip-select pin used depends on the fuse "CS select (SPI only)"                                                                                                                                                                            |
| SPI        | ECSPI-4     | SD1_CD_B, SD1_WP, SD1_RESET_B, SD1_CLK, SD1_CMD, SD1_DATA0, SD1_DATA1                                                                                                                    | The chip-select pin used depends on the fuse "CS select (SPI only)"                                                                                                                                                                            |
| EIM        | EIM         | EPDC_SDCE2, EPDC_SDCE3, EPDC_GDCLK, EPDC_GDOE, EPDC_GDRL, EPDC_GDSP, EPDC_BDR0, LCD_DAT20, LCD_DAT21, LCD_DAT22, LCD_DAT23, EPDC_D8, EPDC_D9, EPDC_D10, EPDC_D12, EPDC_D14, EPDC_PWRSTAT | Used for NOR, OneNAND boot<br>Only CS0 is supported. Allocated pads may differ depending on mux mode. See the "System Boot, Fusemap, and eFuse" chapter of the <i>i.MX 7Solo Application Processor Reference Manual</i> (IMX7SRM) for details. |
| NAND Flash | GPMI        | SD3_CLK, SD3_CMD, SD3_DATA0, SD3_DATA1, SD3_DATA2, SD3_DATA3, SD3_DATA4, SD3_DATA5, SD3_DATA6, SD3_DATA7, SD3_STROBE, SD3_RESET_B, SAI1_TXC, SAI1_TXFS, SAI1_TXD                         | 8 bit<br>Only CS0 is supported                                                                                                                                                                                                                 |
| SD/MMC     | USDHC-1     | SD1_CD_B, SD1_RESET_B, SD1_CLK, SD1_CMD, SD1_DATA0, SD1_DATA1, SD1_DATA2, SD1_DATA3, GPIO1_IO08, ECSPI2_SCLK, ECSPI2_MOSI, ECSPI2_MISO, ECSPI2_SS0                                       | 1, 4, or 8 bit                                                                                                                                                                                                                                 |
| SD/MMC     | USDHC-2     | SD2_RESET_B, SD2_CLK, SD2_CMD, SD2_DATA0, SD2_DATA1, SD2_DATA2, SD2_DATA3, GPIO1_IO12, ECSPI1_SCLK, ECSPI1_MOSI, ECSPI1_MISO, ECSPI1_SS0                                                 | 1, 4, or 8 bit                                                                                                                                                                                                                                 |
| SD/MMC     | USDHC-3     | SD3_CLK, SD3_CMD, SD3_DAT0, SD3_DAT1, SD3_DAT2, SD3_DAT3, SD3_DAT4, SD3_DAT5, SD3_DAT6, SD3_DAT7, SD3_RESET_B                                                                            | 1, 4, or 8 bit                                                                                                                                                                                                                                 |
| USB        | USB-OTG PHY |                                                                                                                                                                                          | —                                                                                                                                                                                                                                              |

# 6 Package information and contact assignments

This section includes the contact assignment information and mechanical package drawing.

## 6.1 12 x 12 mm package information

### 6.1.1 Case 1997-01, 12 x 12, 0.4 mm pitch, ball matrix

The following figure shows the top, bottom, and side views of the 12×12 mm BGA package.

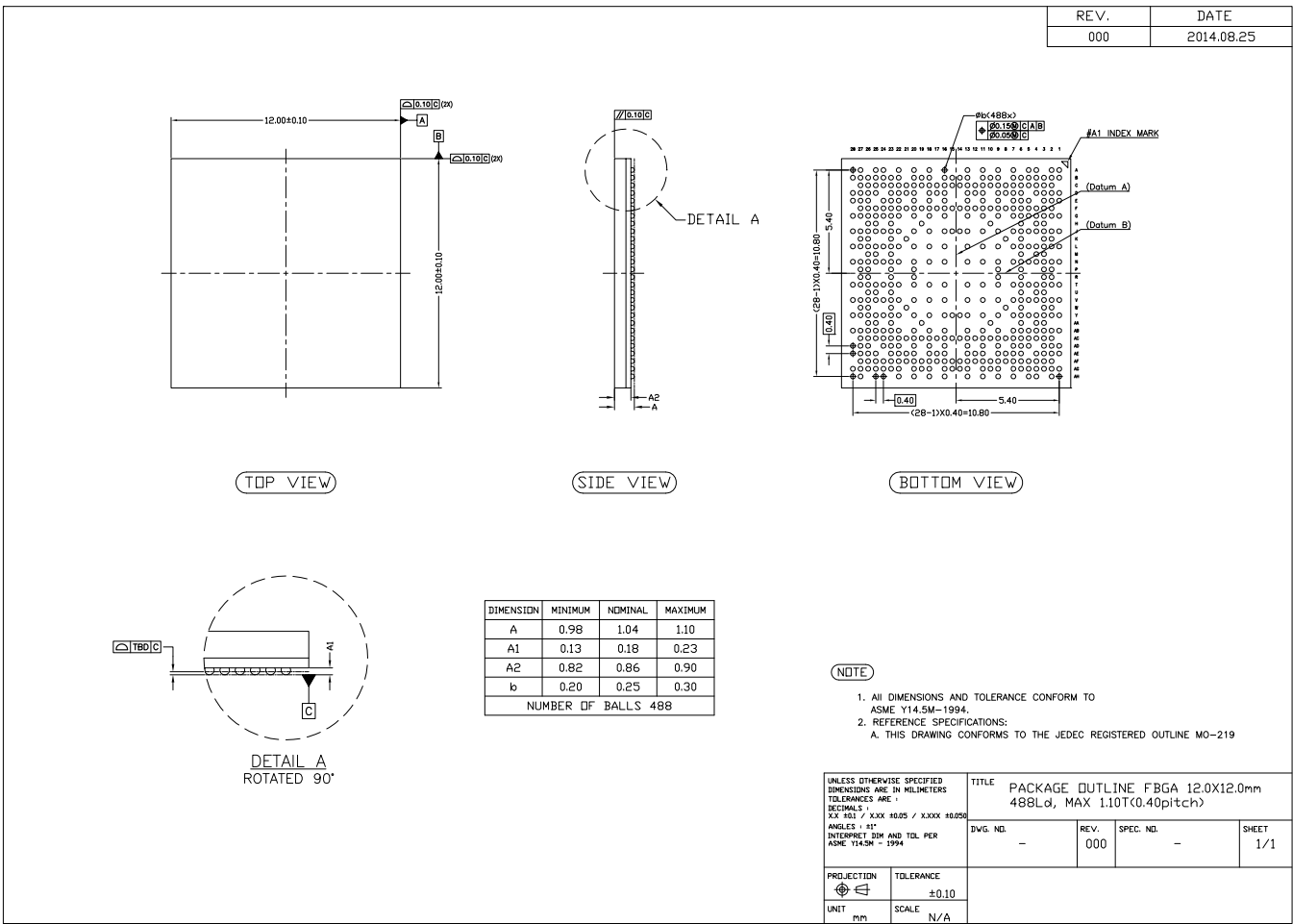


Figure 87. 12 x 12 mm BGA, Case x Package Top, Bottom, and Side Views

## 6.1.2 12 x 12 mm supplies contact assignments and functional contact assignments

Table 91 shows supplies contact assignments for the 12 x 12 mm package.

**Table 91. i.MX 7Solo 12 x 12 mm supplies contact assignments**

| Supply Rail    | Ball(s) position(s)                                                                                                                                                                                                                                                                                                                                                                                             | Remarks                                                                                                                    |
|----------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------|
| DRAM_VREF      | T20                                                                                                                                                                                                                                                                                                                                                                                                             | DDR voltage reference input. Connect to a voltage source that is 50% of NVCC_DRAM                                          |
| DRAM_ZQPAD     | Y18                                                                                                                                                                                                                                                                                                                                                                                                             | DDR output buffer driver calibration reference voltage input. Connect DRAM_ZQPAD to an external 240 ohm 1% resistor to Vss |
| FUSE_FSOURCE   | V09                                                                                                                                                                                                                                                                                                                                                                                                             |                                                                                                                            |
| GND            | A01,A28,B05,B23,B26,C03,C05,C07,C10,C13,C14,C15,C23,C24,C25,C26,D08,D11,D17,D21,E03,E05,E24,E26,F08,F09,F10,F12,F14,F15,F17,F21,H04,H06,H23,H25,L13,L16,M04,M06,M23,M25,N11,N18,T11,T18,U04,U06,U23,U25,V13,V16,W03,W06,Y16,AA04,AA06,AA23,AA25,AC08,AC10,AC12,AC14,AC15,AC17,AC21,AD03,AD05,AD06,AD24,AD26,AE06,AE07,AE08,AE09,AE17,AE21,AF03,AF05,AF08,AF09,AF10,AF11,AF13,AF14,AF15,AF24,AF26,AG10,AH01,AH28 |                                                                                                                            |
| GPANAIO        | AF02                                                                                                                                                                                                                                                                                                                                                                                                            | Test signal. Should be left unconnected.                                                                                   |
| MIPI_VREG_OP4V | B19                                                                                                                                                                                                                                                                                                                                                                                                             |                                                                                                                            |
| NVCC_DRAM      | V27,V28,W21,W23,W26,Y20,AA19,AC19,AF17,AF18,AF19,AG18,AH18                                                                                                                                                                                                                                                                                                                                                      | Supply input for the DDR I/O interface                                                                                     |
| NVCC_DRAM_CKE  | V20                                                                                                                                                                                                                                                                                                                                                                                                             |                                                                                                                            |
| NVCC_ENET1     | J18                                                                                                                                                                                                                                                                                                                                                                                                             | Supply input for the ENET interfaces                                                                                       |
| NVCC_EPDC1     | P20                                                                                                                                                                                                                                                                                                                                                                                                             | Supply for EPDC                                                                                                            |
| NVCC_EPDC2     | N20                                                                                                                                                                                                                                                                                                                                                                                                             | Supply for EPDC                                                                                                            |
| NVCC_GPIO1     | Y09                                                                                                                                                                                                                                                                                                                                                                                                             | Supply for GPIO1                                                                                                           |
| NVCC_GPIO2     | Y11                                                                                                                                                                                                                                                                                                                                                                                                             | Supply for GPIO2                                                                                                           |
| NVCC_I2C       | R09                                                                                                                                                                                                                                                                                                                                                                                                             | Supply for I2C                                                                                                             |
| NVCC_LCD       | L20                                                                                                                                                                                                                                                                                                                                                                                                             | Supply for LCD                                                                                                             |
| NVCC_SAI       | J13                                                                                                                                                                                                                                                                                                                                                                                                             | Supply for SAI                                                                                                             |
| NVCC_SD1       | J11                                                                                                                                                                                                                                                                                                                                                                                                             | Supply for SD card                                                                                                         |
| NVCC_SD2       | L09                                                                                                                                                                                                                                                                                                                                                                                                             | Supply for SD card                                                                                                         |
| NVCC_SD3       | N09                                                                                                                                                                                                                                                                                                                                                                                                             | Supply for SD card                                                                                                         |
| NVCC_SPI       | P09                                                                                                                                                                                                                                                                                                                                                                                                             | Supply for SPI                                                                                                             |

Table 91. i.MX 7Solo 12 x 12 mm supplies contact assignments(continued)

| Supply Rail           | Ball(s) position(s)                                                                         | Remarks                                                          |
|-----------------------|---------------------------------------------------------------------------------------------|------------------------------------------------------------------|
| NVCC_UART             | T09                                                                                         | Supply for UART                                                  |
| NC                    | A9, A11, B10, B11, C11, Y15, C11, AB13, AG11, AG13, AG14, AG15, AG16, AH11, AH13, AH16      | NC                                                               |
| PVCC_ENET_CAP         | G16                                                                                         | Secondary supply for ENET. Requires external capacitor           |
| PVCC_EPDC_LCD_CAP     | R20                                                                                         | Secondary supply for EPDC, LCD. Requires external capacitor      |
| PVCC_GPIO_CAP         | AB11                                                                                        | Secondary supply for GPIO. Requires external capacitor           |
| PVCC_I2C_SPI_UART_CAP | W08                                                                                         | Secondary supply for I2C, SPI, UART. Requires external capacitor |
| PVCC_SAI_SD_CAP       | J14                                                                                         | Secondary supply for SAI, SD. Requires external capacitor        |
| USB_OTG1_VBUS         | C09                                                                                         | VBUS input for USB_OTG1                                          |
| VDD_1P2_CAP           | AA10                                                                                        | Supply for HSIC                                                  |
| VDD_ARM               | A20,B20,C16,C17,C18,C19,C20,C21,C22,F19,H19,J20,K21,K23,K26,L27,L28                         | Supply voltage for ARM                                           |
| VDD_LPSR_1P0_CAP      | AG06                                                                                        | Secondary supply for LPSR. Requires external capacitor           |
| VDD_LPSR_IN           | AG05                                                                                        | Supply to LPSR                                                   |
| VDD_MIP1_1P0          | J16                                                                                         | Supply for MIPI                                                  |
| VDD_SNVS_1P8_CAP      | AG07                                                                                        | Secondary supply for SNVS. Requires external capacitor           |
| VDD_SNVS_IN           | Y13                                                                                         | Supply for SNVS                                                  |
| VDD_SOC               | H10,J09,K03,K06,K08,L01,L02,L11,L18,N13,N16,P03,P06,P23,P26,R26,T13,T16,V11,V18,R03,R06,R23 | Supply for SOC                                                   |
| VDD_TEMPSENSOR_1P8    | AH05                                                                                        | Supply for temp sensor                                           |
| VDD_USB_H_1P2         | C12,G13                                                                                     | Supply input for the USB HSIC interface                          |
| VDD_USB_OTG1_1P0_CAP  | E09                                                                                         | Secondary supply for OTG1. Requires external capacitor           |
| VDD_USB_OTG1_3P3_IN   | D09                                                                                         | Secondary supply for OTG1. Requires external capacitor           |
| VDD_XTAL_1P8          | AH02                                                                                        |                                                                  |
| VDDA_1P0_CAP          | AH07                                                                                        | Secondary supply for 1.0 V. Requires external capacitor          |
| VDDA_1P8_IN           | AF04,AG03,AG04                                                                              | Supply for 1.8 V                                                 |
| VDDA_ADC1_1P8         | AH04                                                                                        | Supply for ADC                                                   |

**Table 91. i.MX 7Solo 12 x 12 mm supplies contact assignments(continued)**

| Supply Rail   | Ball(s) position(s) | Remarks                                                 |
|---------------|---------------------|---------------------------------------------------------|
| VDDA_MIPI_1P8 | J15                 | Supply for MIPI                                         |
| VDDA_PHY_1P8  | Y14                 |                                                         |
| VDDD_1P0_CAP  | AC13,AE12,AF12      | Secondary supply for 1.0 V. Requires external capacitor |

Table 92 shows an alpha-sorted list of functional contact assignments for the 12 x 12 mm package.

**Table 92. i.MX 7Solo 12 x 12 mm functional contact assignments**

| Ball | Ball Name   | Power Group   | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|-------------|---------------|------------------------|---------------------------|-------------------------------|---------|
| AB07 | ADC1_IN0    | ADC1_VDDA_1P8 |                        |                           | ADC1_IN0                      |         |
| AC07 | ADC1_IN1    | ADC1_VDDA_1P8 |                        |                           | ADC1_IN1                      |         |
| AD07 | ADC1_IN2    | ADC1_VDDA_1P8 |                        |                           | ADC1_IN2                      |         |
| AD09 | ADC1_IN3    | ADC1_VDDA_1P8 |                        |                           | ADC1_IN3                      |         |
| Y01  | BOOT_MODE0  | NVCC_GPIO1    | GPIO                   | ALT0                      | BOOT_MODE0                    | 100K PD |
| Y02  | BOOT_MODE1  | NVCC_GPIO1    | GPIO                   | ALT0                      | BOOT_MODE1                    | 100K PD |
| AE04 | CCM_CLK1_N  | VDDA_1P8      |                        |                           | CCM_CLK1_N                    |         |
| AE03 | CCM_CLK1_P  | VDDA_1P8      |                        |                           | CCM_CLK1_P                    |         |
| AE02 | CCM_CLK2    | VDDA_1P8      |                        |                           | CCM_CLK2                      |         |
| AC24 | DRAM_ADDR00 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR00                   |         |
| AC25 | DRAM_ADDR01 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR01                   |         |
| AC26 | DRAM_ADDR02 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR02                   |         |
| AB25 | DRAM_ADDR03 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR03                   |         |
| AB24 | DRAM_ADDR04 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR04                   |         |
| AE23 | DRAM_ADDR05 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR05                   |         |
| AF23 | DRAM_ADDR06 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR06                   |         |
| AE22 | DRAM_ADDR07 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR07                   |         |
| AD22 | DRAM_ADDR08 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR08                   |         |
| AC22 | DRAM_ADDR09 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR09                   |         |
| AD23 | DRAM_ADDR10 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR10                   |         |
| AG27 | DRAM_ADDR11 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR11                   |         |
| AE27 | DRAM_ADDR12 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR12                   |         |
| AG28 | DRAM_ADDR13 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR13                   |         |
| AE20 | DRAM_ADDR14 | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR14                   |         |

Table 92. i.MX 7Solo 12 x 12 mm functional contact assignments(continued)

| Ball | Ball Name   | Power Group | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU |
|------|-------------|-------------|------------------------|---------------------------|-------------------------------|-------|
| AG26 | DRAM_ADDR15 | NVCC_DRAM   | DDR                    |                           | DRAM_ADDR15                   |       |
| AG25 | DRAM_CAS_B  | NVCC_DRAM   | DDR                    |                           | DRAM_CAS_B                    |       |
| AE26 | DRAM_CS0_B  | NVCC_DRAM   | DDR                    |                           | DRAM_CS0_B                    |       |
| AC23 | DRAM_CS1_B  | NVCC_DRAM   | DDR                    |                           | DRAM_CS1_B                    |       |
| AH22 | DRAM_DATA00 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA00                   |       |
| AG19 | DRAM_DATA01 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA01                   |       |
| AG20 | DRAM_DATA02 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA02                   |       |
| AF22 | DRAM_DATA03 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA03                   |       |
| AF20 | DRAM_DATA04 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA04                   |       |
| AG22 | DRAM_DATA05 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA05                   |       |
| AF21 | DRAM_DATA06 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA06                   |       |
| AH20 | DRAM_DATA07 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA07                   |       |
| AC18 | DRAM_DATA08 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA08                   |       |
| AB18 | DRAM_DATA09 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA09                   |       |
| AD16 | DRAM_DATA10 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA10                   |       |
| AC16 | DRAM_DATA11 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA11                   |       |
| AD18 | DRAM_DATA12 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA12                   |       |
| AE18 | DRAM_DATA13 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA13                   |       |
| AB16 | DRAM_DATA14 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA14                   |       |
| AE16 | DRAM_DATA15 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA15                   |       |
| W27  | DRAM_DATA16 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA16                   |       |
| Y27  | DRAM_DATA17 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA17                   |       |
| Y26  | DRAM_DATA18 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA18                   |       |
| Y28  | DRAM_DATA19 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA19                   |       |
| AA26 | DRAM_DATA20 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA20                   |       |
| AB26 | DRAM_DATA21 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA21                   |       |
| AB27 | DRAM_DATA22 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA22                   |       |
| AB28 | DRAM_DATA23 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA23                   |       |
| V23  | DRAM_DATA24 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA24                   |       |
| V22  | DRAM_DATA25 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA25                   |       |
| T23  | DRAM_DATA26 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA26                   |       |
| T22  | DRAM_DATA27 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA27                   |       |

Table 92. i.MX 7Solo 12 x 12 mm functional contact assignments(continued)

| Ball | Ball Name     | Power Group   | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|---------------|---------------|------------------------|---------------------------|-------------------------------|---------|
| V24  | DRAM_DATA28   | NVCC_DRAM     | DDR                    |                           | DRAM_DATA28                   |         |
| V25  | DRAM_DATA29   | NVCC_DRAM     | DDR                    |                           | DRAM_DATA29                   |         |
| T25  | DRAM_DATA30   | NVCC_DRAM     | DDR                    |                           | DRAM_DATA30                   |         |
| T24  | DRAM_DATA31   | NVCC_DRAM     | DDR                    |                           | DRAM_DATA31                   |         |
| AH24 | DRAM_DQM0     | NVCC_DRAM     | DDR                    |                           | DRAM_DQM0                     |         |
| AD20 | DRAM_DQM1     | NVCC_DRAM     | DDR                    |                           | DRAM_DQM1                     |         |
| AD28 | DRAM_DQM2     | NVCC_DRAM     | DDR                    |                           | DRAM_DQM2                     |         |
| Y25  | DRAM_DQM3     | NVCC_DRAM     | DDR                    |                           | DRAM_DQM3                     |         |
| AF16 | DRAM_ODT0     | NVCC_DRAM     | DDR                    |                           | DRAM_ODT0                     |         |
| AH25 | DRAM_RAS_B    | NVCC_DRAM     | DDR                    |                           | DRAM_RAS_B                    |         |
| V26  | DRAM_RESET    | NVCC_DRAM_CKE | DDR                    |                           | DRAM_RESET                    |         |
| AE28 | DRAM_SDBA0    | NVCC_DRAM     | DDR                    |                           | DRAM_SDBA0                    |         |
| AB22 | DRAM_SDBA1    | NVCC_DRAM     | DDR                    |                           | DRAM_SDBA1                    |         |
| AF27 | DRAM_SDBA2    | NVCC_DRAM     | DDR                    |                           | DRAM_SDBA2                    |         |
| Y22  | DRAM_SDCKE0   | NVCC_DRAM_CKE | DDR                    |                           | DRAM_SDCKE0                   |         |
| AB23 | DRAM_SDCKE1   | NVCC_DRAM_CKE | DDR                    |                           | DRAM_SDCKE1                   |         |
| AF25 | DRAM_SDCLK0_N | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDCLK0_N                 |         |
| AE25 | DRAM_SDCLK0_P | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDCLK0_P                 |         |
| AG23 | DRAM_SDQS0_N  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS0_N                  |         |
| AG24 | DRAM_SDQS0_P  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS0_P                  |         |
| AC20 | DRAM_SDQS1_N  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS1_N                  |         |
| AB20 | DRAM_SDQS1_P  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS1_P                  |         |
| AD27 | DRAM_SDQS2_N  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS2_N                  |         |
| AC27 | DRAM_SDQS2_P  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS2_P                  |         |
| Y24  | DRAM_SDQS3_N  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS3_N                  |         |
| Y23  | DRAM_SDQS3_P  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS3_P                  |         |
| AH27 | DRAM_SDWE_B   | NVCC_DRAM     | DDR                    |                           | DRAM_SDWE_B                   |         |
| M03  | ECSP11_MISO   | NVCC_SPI      | GPIO                   | ALT5                      | GPIO4_IO[18]                  | 100K PD |
| L03  | ECSP11_MOSI   | NVCC_SPI      | GPIO                   | ALT5                      | GPIO4_IO[17]                  | 100K PD |
| K02  | ECSP11_SCLK   | NVCC_SPI      | GPIO                   | ALT5                      | GPIO4_IO[16]                  | 100K PD |
| N03  | ECSP11_SS0    | NVCC_SPI      | GPIO                   | ALT5                      | GPIO4_IO[19]                  | 100K PD |
| P02  | ECSP12_MISO   | NVCC_SPI      | GPIO                   | ALT5                      | GPIO4_IO[22]                  | 100K PD |

Table 92. i.MX 7Solo 12 x 12 mm functional contact assignments(continued)

| Ball | Ball Name    | Power Group | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|--------------|-------------|------------------------|---------------------------|-------------------------------|---------|
| N02  | ECSPI2_MOSI  | NVCC_SPI    | GPIO                   | ALT5                      | GPIO4_IO[21]                  | 100K PD |
| N01  | ECSPI2_SCLK  | NVCC_SPI    | GPIO                   | ALT5                      | GPIO4_IO[20]                  | 100K PD |
| R02  | ECSPI2_SS0   | NVCC_SPI    | GPIO                   | ALT5                      | GPIO4_IO[23]                  | 100K PD |
| G18  | ENET1_COL    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[15]                  | 100K PD |
| F18  | ENET1_CRS    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[14]                  | 100K PD |
| F07  | ENET1_RD0    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[0]                   | 100K PD |
| E07  | ENET1_RD1    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[1]                   | 100K PD |
| D07  | ENET1_RD2    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO_IO[2]                    | 100K PD |
| D16  | ENET1_RD3    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[3]                   | 100K PD |
| C06  | ENET1_RX_CLK | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[13]                  | 100K PD |
| E11  | ENET1_RX_CTL | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[4]                   | 100K PD |
| F11  | ENET1_RXC    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[5]                   | 100K PD |
| E13  | ENET1_TD0    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[6]                   | 100K PD |
| D13  | ENET1_TD1    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO_IO[7]                    | 100K PD |
| E16  | ENET1_TD2    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[8]                   | 100K PD |
| F16  | ENET1_TD3    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[9]                   | 100K PD |
| F13  | ENET1_TX_CLK | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[12]                  | 100K PD |
| G11  | ENET1_TX_CTL | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[10]                  | 100K PD |
| G09  | ENET1_TXC    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[11]                  | 100K PD |
| L23  | EPDC_BDR0    | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[28]                  | 100K PD |
| L22  | EPDC_BDR1    | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[29]                  | 100K PD |
| T27  | EPDC_D00     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[0]                   | 100K PD |
| U26  | EPDC_D01     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[1]                   | 100K PD |
| T26  | EPDC_D02     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[2]                   | 100K PD |
| R27  | EPDC_D03     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[3]                   | 100K PD |
| N23  | EPDC_D04     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[4]                   | 100K PD |
| T28  | EPDC_D05     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[5]                   | 100K PD |
| P27  | EPDC_D06     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[6]                   | 100K PD |
| N28  | EPDC_D07     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[7]                   | 100K PD |
| N27  | EPDC_D08     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[8]                   | 100K PD |
| N26  | EPDC_D09     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[9]                   | 100K PD |
| N25  | EPDC_D10     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[10]                  | 100K PD |

Table 92. i.MX 7Solo 12 x 12 mm functional contact assignments(continued)

| Ball | Ball Name    | Power Group | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|--------------|-------------|------------------------|---------------------------|-------------------------------|---------|
| N24  | EPDC_D11     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[11]                  | 100K PD |
| M26  | EPDC_D12     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[12]                  | 100K PD |
| L26  | EPDC_D13     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[13]                  | 100K PD |
| L25  | EPDC_D14     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[14]                  | 100K PD |
| N22  | EPDC_D15     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[15]                  | 100K PD |
| J23  | EPDC_GDCLK   | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[24]                  | 100K PD |
| J22  | EPDC_GDOE    | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[25]                  | 100K PD |
| L24  | EPDC_GDRL    | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[26]                  | 100K PD |
| K27  | EPDC_GDSP    | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[27]                  | 100K PD |
| J27  | EPDC_PWRCOM  | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[30]                  | 100K PD |
| J26  | EPDC_PWRSTAT | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[31]                  | 100K PD |
| J25  | EPDC_SDCE0   | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[20]                  | 100K PD |
| J24  | EPDC_SDCE1   | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[21]                  | 100K PD |
| G22  | EPDC_SDCE2   | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[22]                  | 100K PD |
| G23  | EPDC_SDCE3   | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[23]                  | 100K PD |
| G24  | EPDC_SDCLK   | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[16]                  | 100K PD |
| J28  | EPDC_SDLE    | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[17]                  | 100K PD |
| G25  | EPDC_SDOE    | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[18]                  | 100K PD |
| F26  | EPDC_SDSHR   | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[19]                  | 100K PD |
| V04  | GPIO1_IO00   | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO00                    | 100K PU |
| V05  | GPIO1_IO01   | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO01                    | 100K PD |
| Y07  | GPIO1_IO02   | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO02                    | 100K PD |
| Y06  | GPIO1_IO03   | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO03                    | 100K PD |
| Y05  | GPIO1_IO04   | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO04                    | 100K PD |
| Y04  | GPIO1_IO05   | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO05                    | 100K PD |
| V06  | GPIO1_IO06   | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO06                    | 100K PD |
| V07  | GPIO1_IO07   | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO07                    | 100K PD |
| AB03 | GPIO1_IO08   | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO08                    | 100K PD |
| AB04 | GPIO1_IO09   | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO09                    | 100K PD |
| AB05 | GPIO1_IO10   | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO10                    | 100K PD |
| AB06 | GPIO1_IO11   | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO11                    | 100K PD |
| AC06 | GPIO1_IO12   | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO12                    | 100K PD |

Table 92. i.MX 7Solo 12 x 12 mm functional contact assignments(continued)

| Ball | Ball Name   | Power Group | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|-------------|-------------|------------------------|---------------------------|-------------------------------|---------|
| AC05 | GPIO1_IO13  | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO13                    | 100K PD |
| AC04 | GPIO1_IO14  | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO14                    | 100K PD |
| AC03 | GPIO1_IO15  | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO15                    | 100K PD |
| N04  | I2C1_SCL    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[8]                   | 100K PD |
| N05  | I2C1_SDA    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[9]                   | 100K PD |
| N06  | I2C2_SCL    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[10]                  | 100K PD |
| N07  | I2C2_SDA    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[11]                  | 100K PD |
| T06  | I2C3_SCL    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[12]                  | 100K PD |
| T07  | I2C3_SDA    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[13]                  | 100K PD |
| T05  | I2C4_SCL    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[14]                  | 100K PD |
| T04  | I2C4_SDA    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[15]                  | 100K PD |
| AB01 | JTAG_MOD    | NVCC_GPIO2  | GPIO                   | ALT0                      | JTAG_MOD                      | 100K PU |
| AD01 | JTAG_TCK    | NVCC_GPIO2  | GPIO                   | ALT0                      | JTAG_TCK                      | 47K PU  |
| AC02 | JTAG_TDI    | NVCC_GPIO2  | GPIO                   | ALT0                      | JTAG_TDI                      | 47K PU  |
| AE01 | JTAG_TDO    | NVCC_GPIO2  | GPIO                   | ALT0                      | JTAG_TDO                      | 100K PU |
| AD02 | JTAG_TMS    | NVCC_GPIO2  | GPIO                   | ALT0                      | JTAG_TMS                      | 47K PU  |
| AB02 | JTAG_TRST_B | NVCC_GPIO2  | GPIO                   | ALT0                      | JTAG_TRST_B                   | 47K PU  |
| D20  | LCD_CLK     | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[0]                   | 100K PD |
| F22  | LCD_DATA00  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[5]                   | 100K PD |
| F23  | LCD_DATA01  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[6]                   | 100K PD |
| E23  | LCD_DATA02  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[7]                   | 100K PD |
| E22  | LCD_DATA03  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[8]                   | 100K PD |
| D22  | LCD_DATA04  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[9]                   | 100K PD |
| D23  | LCD_DATA05  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[10]                  | 100K PD |
| E18  | LCD_DATA06  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[11]                  | 100K PD |
| D18  | LCD_DATA07  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[12]                  | 100K PD |
| F20  | LCD_DATA08  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[13]                  | 100K PD |
| G20  | LCD_DATA09  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[14]                  | 100K PD |
| A27  | LCD_DATA10  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[15]                  | 100K PD |
| E27  | LCD_DATA11  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[16]                  | 100K PD |
| F27  | LCD_DATA12  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[17]                  | 100K PD |
| E28  | LCD_DATA13  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[18]                  | 100K PD |

Table 92. i.MX 7Solo 12 x 12 mm functional contact assignments(continued)

| Ball | Ball Name      | Power Group   | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|----------------|---------------|------------------------|---------------------------|-------------------------------|---------|
| G27  | LCD_DATA14     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[19]                  | 100K PD |
| B28  | LCD_DATA15     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[20]                  | 100K PD |
| C27  | LCD_DATA16     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[21]                  | 100K PD |
| D26  | LCD_DATA17     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[22]                  | 100K PD |
| D27  | LCD_DATA18     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[23]                  | 100K PD |
| D28  | LCD_DATA19     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[24]                  | 100K PD |
| G26  | LCD_DATA20     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[25]                  | 100K PD |
| H26  | LCD_DATA21     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[26]                  | 100K PD |
| B27  | LCD_DATA22     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[27]                  | 100K PD |
| D25  | LCD_DATA23     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[28]                  | 100K PD |
| G28  | LCD_ENABLE     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[1]                   | 100K PD |
| F25  | LCD_HSYNC      | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[2]                   | 100K PD |
| E20  | LCD_RESET      | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[4]                   | 100K PD |
| F24  | LCD_VSYNC      | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[3]                   | 100K PD |
| B16  | MIPI_CSI_CLK_N | MIPI_VDDA_1P8 |                        |                           | MIPI_CSI_CLK_N                |         |
| A16  | MIPI_CSI_CLK_P | MIPI_VDDA_1P8 |                        |                           | MIPI_CSI_CLK_P                |         |
| B18  | MIPI_CSI_D0_N  | MIPI_VDDA_1P8 |                        |                           | MIPI_CSI_D0_N                 |         |
| A18  | MIPI_CSI_D0_P  | MIPI_VDDA_1P8 |                        |                           | MIPI_CSI_D0_P                 |         |
| B15  | MIPI_CSI_D1_N  | MIPI_VDDA_1P8 |                        |                           | MIPI_CSI_D1_N                 |         |
| B14  | MIPI_CSI_D1_P  | MIPI_VDDA_1P8 |                        |                           | MIPI_CSI_D1_P                 |         |
| B24  | MIPI_DSI_CLK_N | MIPI_VDDA_1P8 |                        |                           | MIPI_DSI_CLK_N                |         |
| A24  | MIPI_DSI_CLK_P | MIPI_VDDA_1P8 |                        |                           | MIPI_DSI_CLK_P                |         |
| B25  | MIPI_DSI_D0_N  | MIPI_VDDA_1P8 |                        |                           | MIPI_DSI_D0_N                 |         |
| A25  | MIPI_DSI_D0_P  | MIPI_VDDA_1P8 |                        |                           | MIPI_DSI_D0_P                 |         |
| A22  | MIPI_DSI_D1_N  | MIPI_VDDA_1P8 |                        |                           | MIPI_DSI_D1_N                 |         |
| B22  | MIPI_DSI_D1_P  | MIPI_VDDA_1P8 |                        |                           | MIPI_DSI_D1_P                 |         |
| AD13 | ONOFF          | VDD_SNV5_IN   |                        |                           | ONOFF                         |         |
| AG13 | NC             | NC            |                        |                           | NC                            |         |
| AH13 | NC             | NC            |                        |                           | NC                            |         |
| AG11 | NC             | NC            |                        |                           | NC                            |         |
| AH11 | NC             | NC            |                        |                           | NC                            |         |
| AG16 | NC             | NC            |                        |                           | NC                            |         |

Table 92. i.MX 7Solo 12 x 12 mm functional contact assignments(continued)

| Ball | Ball Name         | Power Group       | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|-------------------|-------------------|------------------------|---------------------------|-------------------------------|---------|
| AH16 | NC                | NC                |                        |                           | NC                            |         |
| AG14 | NC                | NC                |                        |                           | NC                            |         |
| AG15 | NC                | NC                |                        |                           | NC                            |         |
| AD11 | CCM_PMIC_STBY_REQ | VDD_SNVIS_IN      |                        |                           | CCM_PMIC_STBY_REQ             |         |
| Y03  | POR_B             | NVCC_GPIO1        | GPIO                   | ALT0                      | POR_B                         | 100K PU |
| AG09 | RTC_XTALI         | VDD_SNVIS_1P8_CAP |                        |                           | RTC_XTALI                     |         |
| AH09 | RTC_XTALO         | VDD_SNVIS_1P8_CAP |                        |                           | RTC_XTALO                     |         |
| D03  | SAI1_MCLK         | NVCC_SAI          | GPIO                   | ALT5                      | GPIO6_IO[18]                  | 100K PD |
| G04  | SAI1_RXC          | NVCC_SAI          | GPIO                   | ALT5                      | GPIO6_IO[17]                  | 100K PD |
| F03  | SAI1_RXD          | NVCC_SAI          | GPIO                   | ALT5                      | GPIO6_IO[12]                  | 100K PD |
| C04  | SAI1_RXFS         | NVCC_SAI          | GPIO                   | ALT5                      | GPIO6_IO[16]                  | 100K PD |
| F04  | SAI1_TXC          | NVCC_SAI          | GPIO                   | ALT5                      | GPIO6_IO[13]                  | 100K PD |
| G05  | SAI1_TXD          | NVCC_SAI          | GPIO                   | ALT5                      | GPIO6_IO[15]                  | 100K PD |
| F05  | SAI1_TXFS         | NVCC_SAI          | GPIO                   | ALT5                      | GPIO6_IO[14]                  | 100K PD |
| E06  | SAI2_RXD          | NVCC_SAI          | GPIO                   | ALT5                      | GPIO6_IO[21]                  | 100K PD |
| D04  | SAI2_TXC          | NVCC_SAI          | GPIO                   | ALT5                      | GPIO6_IO[20]                  | 100K PD |
| D06  | SAI2_TXD          | NVCC_SAI          | GPIO                   | ALT5                      | GPIO6_IO[22]                  | 100K PD |
| F06  | SAI2_TXFS         | NVCC_SAI          | GPIO                   | ALT5                      | GPIO6_IO[19]                  | 100K PD |
| A05  | SD1_CD_B          | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[0]                   | 100K PD |
| B03  | SD1_CLK           | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[3]                   | 100K PD |
| A02  | SD1_CMD           | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[4]                   | 100K PD |
| B04  | SD1_DATA0         | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[5]                   | 100K PD |
| A04  | SD1_DATA1         | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[6]                   | 100K PD |
| B02  | SD1_DATA2         | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[7]                   | 100K PD |
| B01  | SD1_DATA3         | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[8]                   | 100K PD |
| C02  | SD1_RESET_B       | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[2]                   | 100K PD |
| D02  | SD1_WP            | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[1]                   | 100K PD |
| E01  | SD2_CD_B          | NVCC_SD2          | GPIO                   | ALT5                      | GPIO5_IO[9]                   | 100K PD |
| G01  | SD2_CLK           | NVCC_SD2          | GPIO                   | ALT5                      | GPIO5_IO[12]                  | 100K PD |
| G02  | SD2_CMD           | NVCC_SD2          | GPIO                   | ALT5                      | GPIO5_IO[13]                  | 100K PD |
| F02  | SD2_DATA0         | NVCC_SD2          | GPIO                   | ALT5                      | GPIO5_IO[14]                  | 100K PD |
| E02  | SD2_DATA1         | NVCC_SD2          | GPIO                   | ALT5                      | GPIO5_IO[15]                  | 100K PD |

Table 92. i.MX 7Solo 12 x 12 mm functional contact assignments(continued)

| Ball | Ball Name          | Power Group        | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|--------------------|--------------------|------------------------|---------------------------|-------------------------------|---------|
| H03  | SD2_DATA2          | NVCC_SD2           | GPIO                   | ALT5                      | GPIO5_IO[16]                  | 100K PD |
| G03  | SD2_DATA3          | NVCC_SD2           | GPIO                   | ALT5                      | GPIO5_IO[17]                  | 100K PD |
| J03  | SD2_RESET_B        | NVCC_SD2           | GPIO                   | ALT5                      | GPIO5_IO[11]                  | 100K PD |
| D01  | SD2_WP             | NVCC_SD2           | GPIO                   | ALT5                      | GPIO5_IO[10]                  | 100K PD |
| J06  | SD3_CLK            | NVCC_SD3           | GPIO                   | ALT5                      | GPIO6_IO[0]                   | 100K PD |
| L04  | SD3_CMD            | NVCC_SD3           | GPIO                   | ALT5                      | GPIO6_IO[1]                   | 100K PD |
| G06  | SD3_DATA0          | NVCC_SD3           | GPIO                   | ALT5                      | GPIO6_IO[2]                   | 100K PD |
| G07  | SD3_DATA1          | NVCC_SD3           | GPIO                   | ALT5                      | GPIO6_IO[3]                   | 100K PD |
| L07  | SD3_DATA2          | NVCC_SD3           | GPIO                   | ALT5                      | GPIO6_IO[4]                   | 100K PD |
| L06  | SD3_DATA3          | NVCC_SD3           | GPIO                   | ALT5                      | GPIO6_IO[5]                   | 100K PD |
| L05  | SD3_DATA4          | NVCC_SD3           | GPIO                   | ALT5                      | GPIO6_IO[6]                   | 100K PD |
| J07  | SD3_DATA5          | NVCC_SD3           | GPIO                   | ALT5                      | GPIO6_IO[7]                   | 100K PD |
| J05  | SD3_DATA6          | NVCC_SD3           | GPIO                   | ALT5                      | GPIO6_IO[8]                   | 100K PD |
| J04  | SD3_DATA7          | NVCC_SD3           | GPIO                   | ALT5                      | GPIO6_IO[9]                   | 100K PD |
| J02  | SD3_RESET_B        | NVCC_SD3           | GPIO                   | ALT5                      | GPIO6_IO[11]                  | 100K PD |
| J01  | SD3_STROBE         | NVCC_SD3           | GPIO                   | ALT5                      | GPIO6_IO[10]                  | 100K PD |
| AE13 | SNVS_PMIC_ON_REQ   | VDD_SNVS_IN        |                        |                           | SNVS_PMIC_ON_REQ              |         |
| AE11 | SNVS_TAMPER0       | VDDD_SNVS_1P8_CAP  | Analog                 |                           | SNVS_TAMPER0                  |         |
| AC11 | SNVS_TAMPER1       | VDD_SNVS_1P8_CAP   | Analog                 |                           | SNVS_TAMPER1                  |         |
| AC09 | SNVS_TAMPER2       | VDDD_SNVS_1P8_CAP  | Analog                 |                           | SNVS_TAMPER2                  |         |
| AB09 | SNVS_TAMPER9       | VDD_SNVS_1P8_CAP   | Analog                 |                           | SNVS_TAMPER9                  |         |
| AF06 | TEMPSENSOR_RESERVE | VDD_TEMPSENSOR_1P8 |                        |                           |                               |         |
| AF07 | TEMPSENSOR_REXT    | VDD_TEMPSENSOR_1P8 |                        |                           | TEMPSENSOR_REXT               |         |
| AA03 | TEST_MODE          | NVCC_GPIO1         | GPIO                   | ALT0                      | TEST_MODE                     | 100K PD |
| T01  | UART1_RXD          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[0]                   | 100K PD |
| V01  | UART1_TXD          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[1]                   | 100K PD |
| T02  | UART2_RXD          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[2]                   | 100K PD |
| T03  | UART2_TXD          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[3]                   | 100K PD |
| V03  | UART3_CTS          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[7]                   | 100K PD |
| W02  | UART3_RTS          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[6]                   | 100K PD |
| V02  | UART3_RXD          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[4]                   | 100K PD |
| U03  | UART3_TXD          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[5]                   | 100K PD |

Table 92. i.MX 7Solo 12 x 12 mm functional contact assignments(continued)

| Ball | Ball Name      | Power Group       | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU |
|------|----------------|-------------------|------------------------|---------------------------|-------------------------------|-------|
| A13  | USB_H_DATA     | USB_H_VDD_1P2     |                        |                           | USB_H_DATA                    |       |
| B13  | USB_H_STROBE   | USB_H_VDD_1P2     |                        |                           | USB_H_STROBE                  |       |
| B06  | USB_OTG1_CHD_B | USB_OTG1_VDDA_3P3 |                        |                           | USB_OTG1_CHD_B                |       |
| B07  | USB_OTG1_DN    | USB_OTG1_VDDA_3P3 |                        |                           | USB_OTG1_DN                   |       |
| A07  | USB_OTG1_DP    | USB_OTG1_VDDA_3P3 |                        |                           | USB_OTG1_DP                   |       |
| B09  | USB_OTG1_ID    | USB_OTG1_VDDA_3P3 |                        |                           | USB_OTG1_ID                   |       |
| C08  | USB_OTG1_REXT  | USB_OTG1_VDDA_3P3 |                        |                           | USB_OTG1_REXT                 |       |
| B11  | NC             | NC                |                        |                           | NC                            |       |
| A11  | NC             | NC                |                        |                           | NC                            |       |
| B10  | NC             | NC                |                        |                           | NC                            |       |
| A09  | NC             | NC                |                        |                           | NC                            |       |
| AG02 | XTALI          | VDDA_1P8          |                        |                           | XTALI                         |       |
| AG01 | XTALO          | VDDA_1P8          |                        |                           | XTALO                         |       |

<sup>1</sup> The state immediately after RESET and before ROM firmware or software has executed.

### 6.1.3 i.MX 7Solo 12 x 12 mm 0.4 mm Pitch Ball Map

The following table shows the i.MX 7Solo 12 x 12 mm 0.4 mm pitch ball map.

**Table 93. i.MX 7Solo 12 x 12 mm 0.4 mm pitch ball map**

| .<br>Pin | M                    | D                   | C             | B              | A              |
|----------|----------------------|---------------------|---------------|----------------|----------------|
| 1        | SD2_CD_B             | SD2_WP              |               | SD1_DATA3      | VSS            |
| 2        | SD2_DATA1            | SD1_WP              | SD1_RESET_B   | SD1_DATA2      | SD1_CMD        |
| 3        | VSS                  | SAI1_MCLK           | VSS           | SD1_CLK        |                |
| 4        |                      | SAI2_TXC            | SAI1_RXFS     | SD1_DATA0      | SD1_DATA1      |
| 5        | VSS                  |                     | VSS           | VSS            | SD1_CD_B       |
| 6        | SAI2_RXD             | SAI2_TXD            | ENET1_RX_CLK  | USB_OTG1_CHD_B |                |
| 7        | ENET1_RDATA1         | ENET1_RDATA2        | VSS           | USB_OTG1_DN    | USB_OTG1_DP    |
| 8        |                      | VSS                 | USB_OTG1_REXT |                |                |
| 9        | VDD_USB_OTG1_1P0_CAP | VDD_USB_OTG1_3P3_IN | USB_OTG1_VBUS | USB_OTG1_ID    | NC             |
| 10       |                      |                     | VSS           | NC             |                |
| 11       | ENET1_RX_CTL         | VSS                 | NC            | NC             | NC             |
| 12       |                      | VSS                 | VDD_USB_H_1P2 |                |                |
| 13       | ENET1_TDATA0         | ENET1_TDATA1        | VSS           | USB_H_STROBE   | USB_H_DATA     |
| 14       |                      |                     | VSS           | MIPI_CSI_D1_P  |                |
| 15       |                      |                     | VSS           | MIPI_CSI_D1_N  |                |
| 16       | ENET1_TDATA2         | ENET1_RDATA3        | VDD_ARM       | MIPI_CSI_CLK_N | MIPI_CSI_CLK_P |
| 17       |                      | VSS                 | VDD_ARM       |                |                |
| 18       | LCD1_DATA06          | LCD1_DATA07         | VDD_ARM       | MIPI_CSI_D0_N  | MIPI_CSI_D0_P  |
| 19       |                      |                     | VDD_ARM       | MIPI_VREG_0P4V |                |
| 20       | LCD1_RESET           | LCD1_CLK            | VDD_ARM       | VDD_ARM        | VDD_ARM        |
| 21       |                      | VSS                 | VDD_ARM       |                |                |
| 22       | LCD1_DATA03          | LCD1_DATA04         | VDD_ARM       | MIPI_DSI_D1_P  | MIPI_DSI_D1_N  |
| 23       | LCD1_DATA02          | LCD1_DATA05         | VSS           | VSS            |                |
| 24       | VSS                  |                     | VSS           | MIPI_DSI_CLK_N | MIPI_DSI_CLK_P |
| 25       |                      | LCD1_DATA23         | VSS           | MIPI_DSI_D0_N  | MIPI_DSI_D0_P  |
| 26       | VSS                  | LCD1_DATA17         | VSS           | VSS            |                |
| 27       | LCD1_DATA11          | LCD1_DATA18         | LCD1_DATA16   | LCD1_DATA22    | LCD1_DATA10    |
| 28       | LCD1_DATA13          | LCD1_DATA19         |               | LCD1_DATA15    | VSS            |
| .        | M                    | D                   | C             | B              | A              |

Table 93. i.MX 7Solo 12 x 12 mm 0.4 mm pitch ball map(continued)

|    | M            | F            | K           | L               | H           | G             | P            |    |
|----|--------------|--------------|-------------|-----------------|-------------|---------------|--------------|----|
| 1  |              | VDD_SOC      |             | SD3_STROBE      |             | SD2_CLK       |              | 1  |
| 2  |              | VDD_SOC      | ECSP11_SCLK | SD3_RESET_B     |             | SD2_CMD       | SD2_DATA0    | 2  |
| 3  | ECSP11_MISO  | ECSP11_MOSI  | VDD_SOC     | SD2_RESET_B     | SD2_DATA2   | SD2_DATA3     | SAI1_RXD     | 3  |
| 4  | VSS          | SD3_CMD      |             | SD3_DATA7       | VSS         | SAI1_RXC      | SAI1_TXC     | 4  |
| 5  |              | SD3_DATA4    |             | SD3_DATA6       |             | SAI1_TXD      | SAI1_TXFS    | 5  |
| 6  | VSS          | SD3_DATA3    | VDD_SOC     | SD3_CLK         | VSS         | SD3_DATA0     | SAI2_TXFS    | 6  |
| 7  |              | SD3_DATA2    |             | SD3_DATA5       |             | SD3_DATA1     | ENET1_RDATA0 | 7  |
| 8  |              |              | VDD_SOC     |                 |             |               | VSS          | 8  |
| 9  |              | NVCC_SD2     |             | VDD_SOC         |             | ENET1_TXC     | VSS          | 9  |
| 10 |              |              |             |                 | VDD_SOC     |               | VSS          | 10 |
| 11 |              | VDD_SOC      |             | NVCC_SD1        |             | ENET1_TX_CTL  | ENET1_RXC    | 11 |
| 12 |              |              |             |                 |             |               | VSS          | 12 |
| 13 |              | VSS          |             | NVCC_SAI        |             | VDD_USB_H_1P2 | ENET1_TX_CLK | 13 |
| 14 |              |              |             | PVCC_SAI_SD_CAP |             |               | VSS          | 14 |
| 15 |              |              |             | VDDA_MIPI_1P8   |             |               | VSS          | 15 |
| 16 |              | VSS          |             | VDD_MIPI_1P0    |             | PVCC_ENET_CAP | ENET1_TDATA3 | 16 |
| 17 |              |              |             |                 |             |               | VSS          | 17 |
| 18 |              | VDD_SOC      |             | NVCC_ENET1      |             | ENET1_COL     | ENET1_CRS    | 18 |
| 19 |              |              |             |                 | VDD_ARM     |               | VDD_ARM      | 19 |
| 20 |              | NVCC_LCD     |             | VDD_ARM         |             | LCD1_DATA09   | LCD1_DATA08  | 20 |
| 21 |              |              | VDD_ARM     |                 |             |               | VSS          | 21 |
| 22 |              | EPDC1_BDR1   |             | EPDC1_GDOE      |             | EPDC1_SDCE2   | LCD1_DATA00  | 22 |
| 23 | VSS          | EPDC1_BDR0   | VDD_ARM     | EPDC1_GDCLK     | VSS         | EPDC1_SDCE3   | LCD1_DATA01  | 23 |
| 24 |              | EPDC1_GDRL   |             | EPDC1_SDCE1     |             | EPDC1_SDCLK   | LCD1_VSYNC   | 24 |
| 25 | VSS          | EPDC1_DATA14 |             | EPDC1_SDCE0     | VSS         | EPDC1_SDOE    | LCD1_HSYNC   | 25 |
| 26 | EPDC1_DATA12 | EPDC1_DATA13 | VDD_ARM     | EPDC1_PWRSTAT   | LCD1_DATA21 | LCD1_DATA20   | EPDC1_SDSHR  | 26 |
| 27 |              | VDD_ARM      | EPDC1_GDSP  | EPDC1_PWRCOM    |             | LCD1_DATA14   | LCD1_DATA12  | 27 |
| 28 |              | VDD_ARM      |             | EPDC1_SDLE      |             | LCD1_ENABLE   |              | 28 |
|    | M            | F            | K           | L               | H           | G             | P            |    |

**Table 93. i.MX 7Solo 12 x 12 mm 0.4 mm pitch ball map(continued)**

| .<br>Pin | ↖<br>Signal   | C<br>Type    | T<br>Function | R<br>Resistor     | P<br>Pull-up | Z<br>Zener   |
|----------|---------------|--------------|---------------|-------------------|--------------|--------------|
| 1        | UART1_TXD     |              | UART1_RXD     |                   |              | ECSP12_SCLK  |
| 2        | UART3_RXD     |              | UART2_RXD     | ECSP12_SS0        | ECSP12_MISO  | ECSP12_MOSI  |
| 3        | UART3_CTS     | UART3_TXD    | UART2_TXD     | VDD_SOC           | VDD_SOC      | ECSP11_SS0   |
| 4        | GPIO1_IO00    | VSS          | I2C4_SDA      |                   |              | I2C1_SCL     |
| 5        | GPIO1_IO01    |              | I2C4_SCL      |                   |              | I2C1_SDA     |
| 6        | GPIO1_IO06    | VSS          | I2C3_SCL      | VDD_SOC           | VDD_SOC      | I2C2_SCL     |
| 7        | GPIO1_IO07    |              | I2C3_SDA      |                   |              | I2C2_SDA     |
| 8        |               |              |               |                   |              |              |
| 9        | FUSE_FSOURCE  |              | NVCC_UART     | NVCC_I2C          | NVCC_SPI     | NVCC_SD3     |
| 10       |               |              |               |                   |              |              |
| 11       | VDD_SOC       |              | VSS           |                   |              | VSS          |
| 12       |               |              |               |                   |              |              |
| 13       | VSS           |              | VDD_SOC       |                   |              | VDD_SOC      |
| 14       |               |              |               |                   |              |              |
| 15       |               |              |               |                   |              |              |
| 16       | VSS           |              | VDD_SOC       |                   |              | VDD_SOC      |
| 17       |               |              |               |                   |              |              |
| 18       | VDD_SOC       |              | VSS           |                   |              | VSS          |
| 19       |               |              |               |                   |              |              |
| 20       | NVCC_DRAM_CKE |              | DRAM_VREF     | PVCC_EPDC_LCD_CAP | NVCC_EPDC1   | NVCC_EPDC2   |
| 21       |               |              |               |                   |              |              |
| 22       | DRAM_DATA25   |              | DRAM_DATA27   |                   |              | EPDC1_DATA15 |
| 23       | DRAM_DATA24   | VSS          | DRAM_DATA26   | VDD_SOC           | VDD_SOC      | EPDC1_DATA04 |
| 24       | DRAM_DATA28   |              | DRAM_DATA31   |                   |              | EPDC1_DATA11 |
| 25       | DRAM_DATA29   | VSS          | DRAM_DATA30   |                   |              | EPDC1_DATA10 |
| 26       | DRAM_RESET    | EPDC1_DATA01 | EPDC1_DATA02  | VDD_SOC           | VDD_SOC      | EPDC1_DATA09 |
| 27       | NVCC_DRAM     |              | EPDC1_DATA00  | EPDC1_DATA03      | EPDC1_DATA06 | EPDC1_DATA08 |
| 28       | NVCC_DRAM     |              | EPDC1_DATA05  |                   |              | EPDC1_DATA07 |

**Table 93. i.MX 7Solo 12 x 12 mm 0.4 mm pitch ball map(continued)**

| .<br>Pin | D<br>Device   | C<br>Control  | B<br>Bank     | A<br>Address | V<br>Voltage | W<br>Width            |
|----------|---------------|---------------|---------------|--------------|--------------|-----------------------|
| 1        | JTAG_TCK      |               | JTAG_MOD      |              | BOOT_MODE0   |                       |
| 2        | JTAG_TMS      | JTAG_TDI      | JTAG_TRST_B   |              | BOOT_MODE1   | UART3_RTS             |
| 3        | VSS           | GPIO1_IO15    | GPIO1_IO08    | TEST_MODE    | POR_B        | VSS                   |
| 4        |               | GPIO1_IO14    | GPIO1_IO09    | VSS          | GPIO1_IO05   |                       |
| 5        | VSS           | GPIO1_IO13    | GPIO1_IO10    |              | GPIO1_IO04   |                       |
| 6        | VSS           | GPIO1_IO12    | GPIO1_IO11    | VSS          | GPIO1_IO03   | VSS                   |
| 7        | ADC1_IN2      | ADC1_IN1      | ADC1_IN0      |              | GPIO1_IO02   |                       |
| 8        |               | VSS           |               |              |              | PVCC_I2C_SPI_UART_CAP |
| 9        | ADC1_IN3      | SNVS_TAMPER02 | SNVS_TAMPER09 |              | NVCC_GPIO1   |                       |
| 10       |               | VSS           |               | VDD_1P2_CAP  |              |                       |
| 11       | PMIC_STBY_REQ | SNVS_TAMPER01 | PVCC_GPIO_CAP |              | NVCC_GPIO2   |                       |
| 12       |               | VSS           |               |              |              |                       |
| 13       | ONOFF         | VDDD_1P0_CAP  | NC            |              | VDD_SNVS_IN  |                       |
| 14       |               | VSS           |               |              | VDDA_PHY_1P8 |                       |
| 15       |               | VSS           |               |              | NC           |                       |
| 16       | DRAM_DATA10   | DRAM_DATA11   | DRAM_DATA14   |              | VSS          |                       |
| 17       |               | VSS           |               |              |              |                       |
| 18       | DRAM_DATA12   | DRAM_DATA08   | DRAM_DATA09   |              | DRAM_ZQPAD   |                       |
| 19       |               | NVCC_DRAM     |               | NVCC_DRAM    |              |                       |
| 20       | DRAM_DQM1     | DRAM_SDQS1_N  | DRAM_SDQS1_P  |              | NVCC_DRAM    |                       |
| 21       |               | VSS           |               |              |              | NVCC_DRAM             |
| 22       | DRAM_ADDR08   | DRAM_ADDR09   | DRAM_SDBA1    |              | DRAM_SDCKE0  |                       |
| 23       | DRAM_ADDR10   | DRAM_CS1_B    | DRAM_SDCKE1   | VSS          | DRAM_SDQS3_P | NVCC_DRAM             |
| 24       | VSS           | DRAM_ADDR00   | DRAM_ADDR04   |              | DRAM_SDQS3_N |                       |
| 25       |               | DRAM_ADDR01   | DRAM_ADDR03   | VSS          | DRAM_DQM3    |                       |
| 26       | VSS           | DRAM_ADDR02   | DRAM_DATA21   | DRAM_DATA20  | DRAM_DATA18  | NVCC_DRAM             |
| 27       | DRAM_SDQS2_N  | DRAM_SDQS2_P  | DRAM_DATA22   |              | DRAM_DATA17  | DRAM_DATA16           |
| 28       | DRAM_DQM2     |               | DRAM_DATA23   |              | DRAM_DATA19  |                       |
| 29       |               |               |               |              |              |                       |

**Table 93. i.MX 7Solo 12 x 12 mm 0.4 mm pitch ball map(continued)**

| Pin No. | Pin Name           | Pin Function     | Pin Type | Pin Description  |
|---------|--------------------|------------------|----------|------------------|
| 1       | VSS                | XTALO            |          | JTAG_TDO         |
| 2       | VDD_XTAL_1P8       | XTALI            |          | CCM_CLK2         |
| 3       |                    | VDDA_1P8_IN      |          | CCM_CLK1_P       |
| 4       | VDDA_ADC1_1P8      | VDDA_1P8_IN      |          | CCM_CLK1_N       |
| 5       | VDD_TEMPSENSOR_1P8 | VDD_LPSR_IN      |          |                  |
| 6       |                    | VDD_LPSR_1P0_CAP |          | VSS              |
| 7       | VDDA_1P0_CAP       | VDD_SNVs_1P8_CAP |          | VSS              |
| 8       |                    |                  |          | VSS              |
| 9       | RTC_XTALO          | RTC_XTALI        |          | VSS              |
| 10      |                    | VSS              |          |                  |
| 11      | NC                 | NC               |          | SNVS_TAMPER00    |
| 12      |                    |                  |          | VDDD_1P0_CAP     |
| 13      | NC                 | NC               |          | SNVS_PMIC_ON_REQ |
| 14      |                    | NC               |          |                  |
| 15      |                    | NC               |          |                  |
| 16      | NC                 | NC               |          | DRAM_DATA15      |
| 17      |                    |                  |          | VSS              |
| 18      | NVCC_DRAM          | NVCC_DRAM        |          | DRAM_DATA13      |
| 19      |                    | DRAM_DATA01      |          |                  |
| 20      | DRAM_DATA07        | DRAM_DATA02      |          | DRAM_ADDR14      |
| 21      |                    |                  |          | VSS              |
| 22      | DRAM_DATA00        | DRAM_DATA05      |          | DRAM_ADDR07      |
| 23      |                    | DRAM_SDQS0_N     |          | DRAM_ADDR05      |
| 24      | DRAM_DQM0          | DRAM_SDQS0_P     |          |                  |
| 25      | DRAM_RAS_B         | DRAM_CAS_B       |          | DRAM_SDCLK0_P    |
| 26      |                    | DRAM_ADDR15      |          | DRAM_CS0_B       |
| 27      | DRAM_SDWE_B        | DRAM_ADDR11      |          | DRAM_ADDR12      |
| 28      | VSS                | DRAM_ADDR13      |          | DRAM_SDBA0       |

6.2 19 x 19 mm package information

6.2.1 Case “Y”, 19 x 19 mm, 0.75 mm pitch, ball matrix

Figure 88 shows the top, bottom, and side views of the 19×19 mm BGA package.

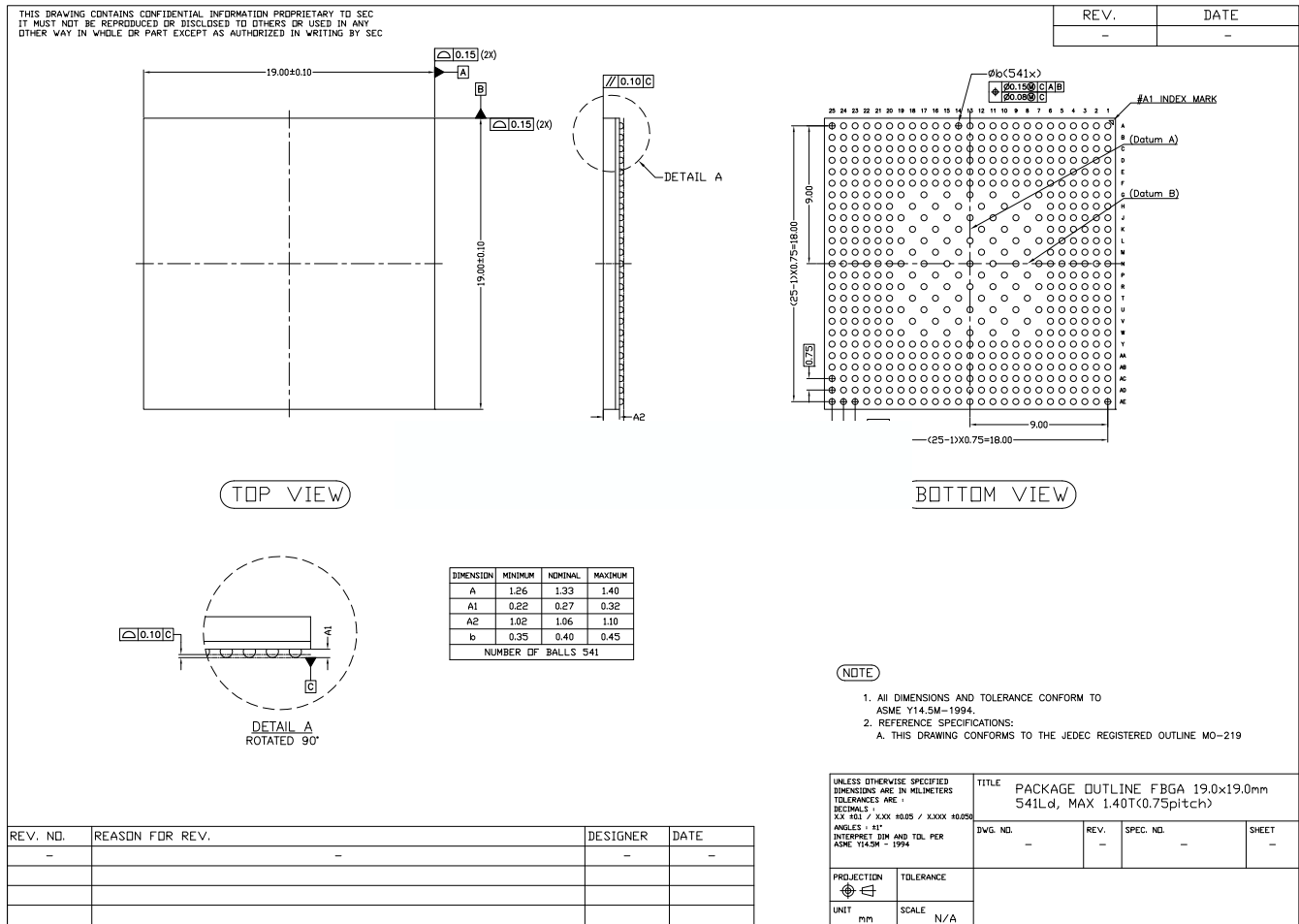


Figure 88. 19 x 19 mm BGA, Case x Package Top, Bottom, and Side Views

## 6.2.2 19 x 19 mm supplies contact assignments and functional contact assignments

Table 94 shows supplies contact assignments for the 19 x 19 mm package.

**Table 94. i.MX 7Solo 19 x 19 mm supplies contact assignments**

| Rail           | Pins                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | Comments                                                                                                                   |
|----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------|
| ADC2_VDDA_1P8  | AB03                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |                                                                                                                            |
| DRAM_VREF      | AC13                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |                                                                                                                            |
| DRAM_ZQPAD     | AB13                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       | DDR output buffer driver calibration reference voltage input. Connect DRAM_ZQPAD to an external 240 ohm 1% resistor to Vss |
| FUSE_FSOURCE0  | V08                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |                                                                                                                            |
| GND            | A01,A03,A06,A09,A13,A17,A21,A25,B03,B06,B09,B13,B17,B21,C09,C13,C15,C16,C18,C19,D01,D02,D04,D07,D10,D22,F07,F08,F09,F11,F13,G07,G04,G09,G11,G13,G15,G17,G19,G22,H01,H02,J07,J11,J19,K04,K10,K12,K14,K16,K22,L07,L11,L13,L15,L19,M10,M12,M14,M16,M24,M25,N04,N07,N11,N13,N15,N19,P10,P12,P14,P16,R07,R11,R13,R15,R19,R20,R21,R23,T04,T10,T12,T14,T16,T20,U07,U11,U19,U20,U23,V20,W01,W02,W04,W07,W09,W11,W13,W15,W17,W19,W20,W23,Y06,Y13,Y14,Y15,Y16,Y17,Y18,Y19,AA01,AA02,AA06,AA08,AA13,AA15,AA23,AB04,AB05,AB07,AB09,AB12,AC06,AC09,AC12,AC15,AC17,AC19,AC21,AC23,AD02,AD07,AD09,AD12,AE01,AE05,AE07,AE09,AE12,AE24,AE25 | Ground                                                                                                                     |
| GPANIO         | V04                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Test signal. Should be left unconnected.                                                                                   |
| MIPI_VREG_0P4V | H18                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |                                                                                                                            |
| NC             | A10, A11, B10, B11, C10, Y10, Y11, Y12, AA10, AA11, AA12, AB10, AB11, AC10, AC11, AD10, AD11, AE10, AE11                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   | Do not connect                                                                                                             |
| NVCC_DRAM      | T21,U21,V21,W21,Y21,AA16,AA17,AA18,AA19,AA20,AA21                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |                                                                                                                            |
| NVCC_DRAM_CKE  | Y20                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |                                                                                                                            |
| NVCC_ENET1     | H16                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Supply for ENET interface                                                                                                  |
| NVCC_EPDC1     | M18                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Supply for EPDC interface                                                                                                  |
| NVCC_EPDC2     | L17                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Supply for EPDC interface                                                                                                  |
| NVCC_GPIO1     | P08                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Supply for GPIO1 interface                                                                                                 |
| NVCC_GPIO2     | T08                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Supply for GPIO2 interface                                                                                                 |
| NVCC_I2C       | M08                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        | Supply for I2C interface                                                                                                   |

Table 94. i.MX 7Solo 19 x 19 mm supplies contact assignments (continued)

| Rail                  | Pins                                                                                    | Comments                                                                                    |
|-----------------------|-----------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------|
| NVCC_LCD              | K18                                                                                     | Supply for LCD interface                                                                    |
| NVCC_SAI              | F12                                                                                     | Supply for SAI interface                                                                    |
| NVCC_SD1              | E07                                                                                     | Supply for SD card interface                                                                |
| NVCC_SD2              | H08                                                                                     | Supply for SD card interface                                                                |
| NVCC_SD3              | K08                                                                                     | Supply for SD card interface                                                                |
| NVCC_SPI              | L09                                                                                     | Supply for SPI interface                                                                    |
| NVCC_UART             | N09                                                                                     | Supply for UART interface                                                                   |
| PVCC_ENET_CAP         | H14                                                                                     | Secondary supply for ENET (internal regulator output). Requires external capacitors         |
| PVCC_EPDC_LCD_CAP     | N17                                                                                     | Secondary supply for EPDC_LCD (internal regulator output). Requires external capacitors     |
| PVCC_GPIO_CAP         | V10                                                                                     | Secondary supply for GPIO (internal regulator output). Requires external capacitors         |
| PVCC_I2C_SPI_UART_CAP | R09                                                                                     | Secondary supply for I2C_SPI_UART (internal regulator output). Requires external capacitors |
| PVCC_SAI_SD_CAP       | J09                                                                                     | Secondary supply for SAI_SD (internal regulator output). Requires external capacitors       |
| USB_OTG1_VBUS         | C08                                                                                     |                                                                                             |
| USB_OTG1_VDDA_3P3_IN  | F10                                                                                     |                                                                                             |
| VDD_1P2_CAP           | U09                                                                                     | Supply for HSIC                                                                             |
| VDD_ARM               | C17,C20,D17,D20,F22,F23,J22,J23                                                         | Supply for ARM                                                                              |
| VDD_LPSR_1P0_CAP      | AC05                                                                                    | Secondary supply for LPSR (internal regulator output). Requires external capacitors         |
| VDD_LPSR_IN           | W06                                                                                     | Supply for LPSR                                                                             |
| VDD_SNVS_1P8_CAP      | AE08                                                                                    | Secondary supply for SNVS (internal regulator output). Requires external capacitors         |
| VDD_SNVS_IN           | AD08                                                                                    | Primary supply for the SNVS regulator                                                       |
| VDD_SOC               | C14,D14,F03,F04,F18,F19,J03,J04,M03,M04,P18,R03,R04,R17,T18,U13,U15,U17,V12,V14,V16,V18 | Supply for SOC                                                                              |
| VDD_TEMPSENSOR_1P8    | AC04                                                                                    | Supply for VDDe PHY                                                                         |
| VDD_USB_H_1P2         | H12                                                                                     | Supply input for the USB HSIC Interface                                                     |
| VDD_USB_OTG1_1P0_CAP  | H10                                                                                     | Secondary supply for USB OTG (internal regulator output). Requires external capacitors      |
| VDD_XTAL_1P8          | V05                                                                                     |                                                                                             |
| VDDA_1P0_CAP          | V03                                                                                     | Secondary supply for 1P0 (internal regulator output). Requires external capacitors          |

**Table 94. i.MX 7Solo 19 x 19 mm supplies contact assignments (continued)**

| Rail          | Pins    | Comments                                                                           |
|---------------|---------|------------------------------------------------------------------------------------|
| VDDA_1P8_IN   | V06,W05 |                                                                                    |
| VDDA_ADC1_1P8 | AC03    | Supply for ADC                                                                     |
| VDDA_PHY_1P8  | Y09     |                                                                                    |
| VDDD_1P0_CAP  | AA09    | Secondary supply for 1P0 (internal regulator output). Requires external capacitors |

Table 95 shows an alpha-sorted list of functional contact assignments for the 19 x 19 mm package.

**Table 95. i.MX 7Solo 19 x 19 mm functional contact assignments**

| Ball | Ball Name         | Power Group   | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|-------------------|---------------|------------------------|---------------------------|-------------------------------|---------|
| AD01 | ADC1_IN0          | ADC1_VDDA_1P8 |                        |                           | ADC1_IN0                      |         |
| AD03 | ADC1_IN1          | ADC1_VDDA_1P8 |                        |                           | ADC1_IN1                      |         |
| AE02 | ADC1_IN2          | ADC1_VDDA_1P8 |                        |                           | ADC1_IN2                      |         |
| AE03 | ADC1_IN3          | ADC1_VDDA_1P8 |                        |                           | ADC1_IN3                      |         |
| AC01 | ADC2_IN0          | ADC2_VDDA_1P8 |                        |                           | ADC2_IN0                      |         |
| AC02 | ADC2_IN1          | ADC2_VDDA_1P8 |                        |                           | ADC2_IN1                      |         |
| AB01 | ADC2_IN2          | ADC2_VDDA_1P8 |                        |                           | ADC2_IN2                      |         |
| AB02 | ADC2_IN3          | ADC2_VDDA_1P8 |                        |                           | ADC2_IN3                      |         |
| P04  | BOOT_MODE0        | NVCC_GPIO1    | GPIO                   | ALT0                      | BOOT_MODE0                    | 100K PD |
| P05  | BOOT_MODE1        | NVCC_GPIO1    | GPIO                   | ALT0                      | BOOT_MODE1                    | 100K PD |
| Y01  | CCM_CLK1_N        | VDDA_1P8      |                        |                           | CCM_CLK1_N                    |         |
| Y02  | CCM_CLK1_P        | VDDA_1P8      |                        |                           | CCM_CLK1_P                    |         |
| W03  | CCM_CLK2          | VDDA_1P8      |                        |                           | CCM_CLK2                      |         |
| AC07 | CCM_PMIC_STBY_REQ | VDD_SNVS_IN   |                        |                           | CCM_PMIC_STBY_REQ             |         |
| AB19 | DRAM_ADDR00       | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR00                   |         |
| AB16 | DRAM_ADDR01       | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR01                   |         |
| AC18 | DRAM_ADDR02       | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR02                   |         |
| AC20 | DRAM_ADDR03       | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR03                   |         |
| AB21 | DRAM_ADDR04       | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR04                   |         |
| Y23  | DRAM_ADDR05       | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR05                   |         |
| V22  | DRAM_ADDR06       | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR06                   |         |
| Y22  | DRAM_ADDR07       | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR07                   |         |
| W22  | DRAM_ADDR08       | NVCC_DRAM     | DDR                    |                           | DRAM_ADDR08                   |         |

Table 95. i.MX 7Solo 19 x 19 mm functional contact assignments (continued)

| Ball | Ball Name   | Power Group | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU |
|------|-------------|-------------|------------------------|---------------------------|-------------------------------|-------|
| V23  | DRAM_ADDR09 | NVCC_DRAM   | DDR                    |                           | DRAM_ADDR09                   |       |
| T23  | DRAM_ADDR10 |             | DDR                    |                           | DRAM_ADDR10                   |       |
| U22  | DRAM_ADDR11 | NVCC_DRAM   | DDR                    |                           | DRAM_ADDR11                   |       |
| T22  | DRAM_ADDR12 | NVCC_DRAM   | DDR                    |                           | DRAM_ADDR12                   |       |
| P23  | DRAM_ADDR13 | NVCC_DRAM   | DDR                    |                           | DRAM_ADDR13                   |       |
| AB18 | DRAM_ADDR14 | NVCC_DRAM   | DDR                    |                           | DRAM_ADDR14                   |       |
| AB20 | DRAM_ADDR15 | NVCC_DRAM   | DDR                    |                           | DRAM_ADDR15                   |       |
| AC14 | DRAM_CAS_B  | NVCC_DRAM   | DDR                    |                           | DRAM_CAS_B                    |       |
| AB23 | DRAM_CS0_B  | NVCC_DRAM   | DDR                    |                           | DRAM_CS0_B                    |       |
| AA22 | DRAM_CS1_B  | NVCC_DRAM   | DDR                    |                           | DRAM_CS1_B                    |       |
| AD22 | DRAM_DATA00 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA00                   |       |
| AD23 | DRAM_DATA01 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA01                   |       |
| AE20 | DRAM_DATA02 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA02                   |       |
| AE23 | DRAM_DATA03 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA03                   |       |
| AE22 | DRAM_DATA04 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA04                   |       |
| AD19 | DRAM_DATA05 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA05                   |       |
| AD18 | DRAM_DATA06 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA06                   |       |
| AE19 | DRAM_DATA07 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA07                   |       |
| AE14 | DRAM_DATA08 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA08                   |       |
| AE18 | DRAM_DATA09 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA09                   |       |
| AE17 | DRAM_DATA10 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA10                   |       |
| AD16 | DRAM_DATA11 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA11                   |       |
| AE16 | DRAM_DATA12 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA12                   |       |
| AD14 | DRAM_DATA13 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA13                   |       |
| AD13 | DRAM_DATA14 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA14                   |       |
| AE13 | DRAM_DATA15 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA15                   |       |
| AA25 | DRAM_DATA16 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA16                   |       |
| W24  | DRAM_DATA17 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA17                   |       |
| V25  | DRAM_DATA18 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA18                   |       |
| W25  | DRAM_DATA19 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA19                   |       |
| AC25 | DRAM_DATA20 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA20                   |       |
| AB25 | DRAM_DATA21 | NVCC_DRAM   | DDR                    |                           | DRAM_DATA21                   |       |

Table 95. i.MX 7Solo 19 x 19 mm functional contact assignments (continued)

| Ball | Ball Name     | Power Group   | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU |
|------|---------------|---------------|------------------------|---------------------------|-------------------------------|-------|
| AB24 | DRAM_DATA22   | NVCC_DRAM     | DDR                    |                           | DRAM_DATA22                   |       |
| AC24 | DRAM_DATA23   | NVCC_DRAM     | DDR                    |                           | DRAM_DATA23                   |       |
| R25  | DRAM_DATA24   | NVCC_DRAM     | DDR                    |                           | DRAM_DATA24                   |       |
| N24  | DRAM_DATA25   | NVCC_DRAM     | DDR                    |                           | DRAM_DATA25                   |       |
| P25  | DRAM_DATA26   | NVCC_DRAM     | DDR                    |                           | DRAM_DATA26                   |       |
| N25  | DRAM_DATA27   | NVCC_DRAM     | DDR                    |                           | DRAM_DATA27                   |       |
| U25  | DRAM_DATA28   | NVCC_DRAM     | DDR                    |                           | DRAM_DATA28                   |       |
| R24  | DRAM_DATA29   | NVCC_DRAM     | DDR                    |                           | DRAM_DATA29                   |       |
| U24  | DRAM_DATA30   | NVCC_DRAM     | DDR                    |                           | DRAM_DATA30                   |       |
| V24  | DRAM_DATA31   | NVCC_DRAM     | DDR                    |                           | DRAM_DATA31                   |       |
| AD20 | DRAM_DQM0     | NVCC_DRAM     | DDR                    |                           | DRAM_DQM0                     |       |
| AD17 | DRAM_DQM1     | NVCC_DRAM     | DDR                    |                           | DRAM_DQM1                     |       |
| AA24 | DRAM_DQM2     | NVCC_DRAM     | DDR                    |                           | DRAM_DQM2                     |       |
| P24  | DRAM_DQM3     | NVCC_DRAM     | DDR                    |                           | DRAM_DQM3                     |       |
| AC16 | DRAM_ODT0     | NVCC_DRAM     | DDR                    |                           | DRAM_ODT0                     |       |
| AA14 | DRAM_ODT1     | NVCC_DRAM     | DDR                    |                           | DRAM_ODT1                     |       |
| AB15 | DRAM_RAS_B    | NVCC_DRAM     | DDR                    |                           | DRAM_RAS_B                    |       |
| AC22 | DRAM_RESET    | NVCC_DRAM_CKE | DDR                    |                           | DRAM_RESET                    |       |
| R22  | DRAM_SDBA0    | NVCC_DRAM     | DDR                    |                           | DRAM_SDBA0                    |       |
| P22  | DRAM_SDBA1    | NVCC_DRAM     | DDR                    |                           | DRAM_SDBA1                    |       |
| N23  | DRAM_SDBA2    | NVCC_DRAM     | DDR                    |                           | DRAM_SDBA2                    |       |
| AB17 | DRAM_SDCKE0   | NVCC_DRAM_CKE | DDR                    |                           | DRAM_SDCKE0                   |       |
| AB22 | DRAM_SDCKE1   | NVCC_DRAM_CKE | DDR                    |                           | DRAM_SDCKE1                   |       |
| AD25 | DRAM_SDCLK0_N | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDCLK0_N                 |       |
| AD24 | DRAM_SDCLK0_P | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDCLK0_P                 |       |
| AD21 | DRAM_SDQS0_N  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS0_N                  |       |
| AE21 | DRAM_SDQS0_P  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS0_P                  |       |
| AE15 | DRAM_SDQS1_N  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS1_N                  |       |
| AD15 | DRAM_SDQS1_P  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS1_P                  |       |
| Y25  | DRAM_SDQS2_N  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS2_N                  |       |
| Y24  | DRAM_SDQS2_P  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS2_P                  |       |
| T25  | DRAM_SDQS3_N  | NVCC_DRAM     | DDRCLK                 |                           | DRAM_SDQS3_N                  |       |

Table 95. i.MX 7Solo 19 x 19 mm functional contact assignments (continued)

| Ball | Ball Name    | Power Group | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|--------------|-------------|------------------------|---------------------------|-------------------------------|---------|
| T24  | DRAM_SDQS3_P | NVCC_DRAM   | DDRCLK                 |                           | DRAM_SDQS3_P                  |         |
| AB14 | DRAM_SDWE_B  | NVCC_DRAM   | DDR                    |                           | DRAM_SDWE_B                   |         |
| H04  | ECSPI1_MISO  | NVCC_SPI    | GPIO                   | ALT5                      | GPIO4_IO[18]                  | 100K PD |
| G05  | ECSPI1_MOSI  | NVCC_SPI    | GPIO                   | ALT5                      | GPIO4_IO[17]                  | 100K PD |
| H03  | ECSPI1_SCLK  | NVCC_SPI    | GPIO                   | ALT5                      | GPIO4_IO[16]                  | 100K PD |
| H05  | ECSPI1_SS0   | NVCC_SPI    | GPIO                   | ALT5                      | GPIO4_IO[19]                  | 100K PD |
| H06  | ECSPI2_MISO  | NVCC_SPI    | GPIO                   | ALT5                      | GPIO4_IO[22]                  | 100K PD |
| G06  | ECSPI2_MOSI  | NVCC_SPI    | GPIO                   | ALT5                      | GPIO4_IO[21]                  | 100K PD |
| J05  | ECSPI2_SCLK  | NVCC_SPI    | GPIO                   | ALT5                      | GPIO4_IO[20]                  | 100K PD |
| J06  | ECSPI2_SS0   | NVCC_SPI    | GPIO                   | ALT5                      | GPIO4_IO[23]                  | 100K PD |
| D19  | ENET1_COL    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[15]                  | 100K PD |
| E19  | ENET1_CRS    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[14]                  | 100K PD |
| E14  | ENET1_RD0    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[0]                   | 100K PD |
| F14  | ENET1_RD1    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[1]                   | 100K PD |
| D13  | ENET1_RD2    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[2]                   | 100K PD |
| E13  | ENET1_RD3    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[3]                   | 100K PD |
| D15  | ENET1_RX_CLK | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[13]                  | 100K PD |
| E15  | ENET1_RX_CTL | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[4]                   | 100K PD |
| F15  | ENET1_RXC    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[5]                   | 100K PD |
| F17  | ENET1_TD0    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[6]                   | 100K PD |
| E17  | ENET1_TD1    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[7]                   | 100K PD |
| E18  | ENET1_TD2    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[8]                   | 100K PD |
| D18  | ENET1_TD3    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[9]                   | 100K PD |
| D16  | ENET1_TX_CLK | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[12]                  | 100K PD |
| E16  | ENET1_TX_CTL | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[10]                  | 100K PD |
| F16  | ENET1_TXC    | NVCC_ENET1  | GPIO                   | ALT5                      | GPIO7_IO[11]                  | 100K PD |
| K24  | EPDC_BDR0    | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[28]                  | 100K PD |
| K23  | EPDC_BDR1    | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[29]                  | 100K PD |
| P20  | EPDC_D00     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[0]                   | 100K PD |
| P21  | EPDC_D01     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[1]                   | 100K PD |
| N20  | EPDC_D02     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[2]                   | 100K PD |
| N21  | EPDC_D03     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[3]                   | 100K PD |

Table 95. i.MX 7Solo 19 x 19 mm functional contact assignments (continued)

| Ball | Ball Name    | Power Group | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|--------------|-------------|------------------------|---------------------------|-------------------------------|---------|
| N22  | EPDC_D04     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[4]                   | 100K PD |
| M20  | EPDC_D05     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[5]                   | 100K PD |
| M21  | EPDC_D06     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[6]                   | 100K PD |
| M22  | EPDC_D07     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[7]                   | 100K PD |
| M23  | EPDC_D08     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[8]                   | 100K PD |
| L25  | EPDC_D09     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[9]                   | 100K PD |
| L24  | EPDC_D10     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[10]                  | 100K PD |
| L23  | EPDC_D11     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[11]                  | 100K PD |
| L22  | EPDC_D12     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[12]                  | 100K PD |
| L21  | EPDC_D13     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[13]                  | 100K PD |
| L20  | EPDC_D14     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[14]                  | 100K PD |
| K25  | EPDC_D15     | NVCC_EPDC1  | GPIO                   | ALT5                      | GPIO2_IO[15]                  | 100K PD |
| J25  | EPDC_GDCLK   | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[24]                  | 100K PD |
| J24  | EPDC_GDOE    | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[25]                  | 100K PD |
| K21  | EPDC_GDRL    | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[26]                  | 100K PD |
| H25  | EPDC_GDSP    | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[27]                  | 100K PD |
| H24  | EPDC_PWRCOM  | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[30]                  | 100K PD |
| K20  | EPDC_PWRSTAT | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[31]                  | 100K PD |
| G25  | EPDC_SDCE0   | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[20]                  | 100K PD |
| G24  | EPDC_SDCE1   | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[21]                  | 100K PD |
| H23  | EPDC_SDCE2   | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[22]                  | 100K PD |
| H22  | EPDC_SDCE3   | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[23]                  | 100K PD |
| J21  | EPDC_SDCLK   | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[16]                  | 100K PD |
| J20  | EPDC_SDLE    | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[17]                  | 100K PD |
| H21  | EPDC_SDOE    | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[18]                  | 100K PD |
| H20  | EPDC_SDSHR   | NVCC_EPDC2  | GPIO                   | ALT5                      | GPIO2_IO[19]                  | 100K PD |
| N01  | GPIO1_IO00   | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO00                    | 100K PU |
| N02  | GPIO1_IO01   | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO01                    | 100K PD |
| N03  | GPIO1_IO02   | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO02                    | 100K PD |
| N05  | GPIO1_IO03   | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO03                    | 100K PD |
| N06  | GPIO1_IO04   | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO04                    | 100K PD |
| P01  | GPIO1_IO05   | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO05                    | 100K PD |

Table 95. i.MX 7Solo 19 x 19 mm functional contact assignments (continued)

| Ball | Ball Name   | Power Group | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|-------------|-------------|------------------------|---------------------------|-------------------------------|---------|
| P02  | GPIO1_IO06  | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO06                    | 100K PD |
| P03  | GPIO1_IO07  | NVCC_GPIO1  | GPIO                   | ALT0                      | GPIO1_IO07                    | 100K PD |
| R01  | GPIO1_IO08  | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO08                    | 100K PD |
| R02  | GPIO1_IO09  | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO09                    | 100K PD |
| R05  | GPIO1_IO10  | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO10                    | 100K PD |
| T01  | GPIO1_IO11  | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO11                    | 100K PD |
| T02  | GPIO1_IO12  | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO12                    | 100K PD |
| T03  | GPIO1_IO13  | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO13                    | 100K PD |
| T05  | GPIO1_IO14  | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO14                    | 100K PD |
| T06  | GPIO1_IO15  | NVCC_GPIO2  | GPIO                   | ALT0                      | GPIO1_IO15                    | 100K PD |
| J02  | I2C1_SCL    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[8]                   | 100K PD |
| K01  | I2C1_SDA    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[9]                   | 100K PD |
| K02  | I2C2_SCL    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[10]                  | 100K PD |
| K03  | I2C2_SDA    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[11]                  | 100K PD |
| K05  | I2C3_SCL    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[12]                  | 100K PD |
| K06  | I2C3_SDA    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[13]                  | 100K PD |
| L01  | I2C4_SCL    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[14]                  | 100K PD |
| L02  | I2C4_SDA    | NVCC_I2C    | GPIO                   | ALT5                      | GPIO4_IO[15]                  | 100K PD |
| U01  | JTAG_MOD    | NVCC_GPIO2  | GPIO                   | ALT0                      | JTAG_MOD                      | 100K PU |
| U05  | JTAG_TCK    | NVCC_GPIO2  | GPIO                   | ALT0                      | JTAG_TCK                      | 47K PU  |
| U03  | JTAG_TDI    | NVCC_GPIO2  | GPIO                   | ALT0                      | JTAG_TDI                      | 47K PU  |
| U06  | JTAG_TDO    | NVCC_GPIO2  | GPIO                   | ALT0                      | JTAG_TDO                      | 100K PU |
| U04  | JTAG_TMS    | NVCC_GPIO2  | GPIO                   | ALT0                      | JTAG_TMS                      | 47K PU  |
| U02  | JTAG_TRST_B | NVCC_GPIO2  | GPIO                   | ALT0                      | JTAG_TRST_B                   | 47K PU  |
| E20  | LCD_CLK     | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[0]                   | 100K PD |
| D21  | LCD_DATA00  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[5]                   | 100K PD |
| A22  | LCD_DATA01  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[6]                   | 100K PD |
| B22  | LCD_DATA02  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[7]                   | 100K PD |
| A23  | LCD_DATA03  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[8]                   | 100K PD |
| C22  | LCD_DATA04  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[9]                   | 100K PD |
| B23  | LCD_DATA05  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[10]                  | 100K PD |
| A24  | LCD_DATA06  | NVCC_LCD    | GPIO                   | ALT5                      | GPIO3_IO[11]                  | 100K PD |

Table 95. i.MX 7Solo 19 x 19 mm functional contact assignments (continued)

| Ball | Ball Name      | Power Group   | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|----------------|---------------|------------------------|---------------------------|-------------------------------|---------|
| F20  | LCD_DATA07     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[12]                  | 100K PD |
| E21  | LCD_DATA08     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[13]                  | 100K PD |
| C23  | LCD_DATA09     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[14]                  | 100K PD |
| B24  | LCD_DATA10     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[15]                  | 100K PD |
| G20  | LCD_DATA11     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[16]                  | 100K PD |
| F21  | LCD_DATA12     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[17]                  | 100K PD |
| E22  | LCD_DATA13     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[18]                  | 100K PD |
| D23  | LCD_DATA14     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[19]                  | 100K PD |
| C24  | LCD_DATA15     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[20]                  | 100K PD |
| B25  | LCD_DATA16     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[21]                  | 100K PD |
| G21  | LCD_DATA17     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[22]                  | 100K PD |
| E23  | LCD_DATA18     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[23]                  | 100K PD |
| D24  | LCD_DATA19     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[24]                  | 100K PD |
| C25  | LCD_DATA20     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[25]                  | 100K PD |
| E24  | LCD_DATA21     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[26]                  | 100K PD |
| D25  | LCD_DATA22     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[27]                  | 100K PD |
| G23  | LCD_DATA23     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[28]                  | 100K PD |
| F25  | LCD_ENABLE     | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[1]                   | 100K PD |
| E25  | LCD_HSYNC      | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[2]                   | 100K PD |
| C21  | LCD_RESET      | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[4]                   | 100K PD |
| F24  | LCD_VSYNC      | NVCC_LCD      | GPIO                   | ALT5                      | GPIO3_IO[3]                   | 100K PD |
| A15  | MIPI_CSI_CLK_N | MIPI_VDDA_1P8 |                        |                           | MIPI_CSI_CLK_N                |         |
| B15  | MIPI_CSI_CLK_P | MIPI_VDDA_1P8 |                        |                           | MIPI_CSI_CLK_P                |         |
| A16  | MIPI_CSI_D0_N  | MIPI_VDDA_1P8 |                        |                           | MIPI_CSI_D0_N                 |         |
| B16  | MIPI_CSI_D0_P  | MIPI_VDDA_1P8 |                        |                           | MIPI_CSI_D0_P                 |         |
| A14  | MIPI_CSI_D1_N  | MIPI_VDDA_1P8 |                        |                           | MIPI_CSI_D1_N                 |         |
| B14  | MIPI_CSI_D1_P  | MIPI_VDDA_1P8 |                        |                           | MIPI_CSI_D1_P                 |         |
| A19  | MIPI_DSI_CLK_N | MIPI_VDDA_1P8 |                        |                           | MIPI_DSI_CLK_N                |         |
| B19  | MIPI_DSI_CLK_P | MIPI_VDDA_1P8 |                        |                           | MIPI_DSI_CLK_P                |         |
| A20  | MIPI_DSI_D0_N  | MIPI_VDDA_1P8 |                        |                           | MIPI_DSI_D0_N                 |         |
| B20  | MIPI_DSI_D0_P  | MIPI_VDDA_1P8 |                        |                           | MIPI_DSI_D0_P                 |         |
| A18  | MIPI_DSI_D1_N  | MIPI_VDDA_1P8 |                        |                           | MIPI_DSI_D1_N                 |         |

Table 95. i.MX 7Solo 19 x 19 mm functional contact assignments (continued)

| Ball | Ball Name     | Power Group      | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|---------------|------------------|------------------------|---------------------------|-------------------------------|---------|
| B18  | MIPI_DSI_D1_P | MIPI_VDDA_1P8    |                        |                           | MIPI_DSI_D1_P                 |         |
| J13  | MIPI_VDDA_1P8 | MIPI_VDDA_1P8    |                        |                           | MIPI_VDDA_1P8                 |         |
| J15  | MIPI_VDDD_1P0 | MIPI_VDDD_1P0    |                        |                           | MIPI_VDDD_1P0                 |         |
| J17  | MIPI_VDDD_1P0 | MIPI_VDDD_1P0    |                        |                           | MIPI_VDDD_1P0                 |         |
| AC08 | ONOFF         | VDD_SNV5_IN      |                        |                           | ONOFF                         |         |
| AE10 | NC            | NC               |                        |                           | NC                            |         |
| AD10 | NC            | NC               |                        |                           | NC                            |         |
| AC10 | NC            | NC               |                        |                           | NC                            |         |
| AB10 | NC            | NC               |                        |                           | NC                            |         |
| AE11 | NC            | NC               |                        |                           | NC                            |         |
| AD11 | NC            | NC               |                        |                           | NC                            |         |
| AC11 | NC            | NC               |                        |                           | NC                            |         |
| AB11 | NC            | NC               |                        |                           | NC                            |         |
| AA10 | NC            | NC               |                        |                           | NC                            |         |
| AA12 | NC            | NC               |                        |                           | NC                            |         |
| AA11 | NC            | NC               |                        |                           | NC                            |         |
| Y10  | NC            | NC               |                        |                           | NC                            |         |
| Y12  | NC            | NC               |                        |                           | NC                            |         |
| Y11  | NC            | NC               |                        |                           | NC                            |         |
| R06  | POR_B         | NVCC_GPIO1       | GPIO                   | ALT0                      | POR_B                         | 100K PU |
| AE06 | RTC_XTALI     | VDD_SNV5_1P8_CAP |                        |                           | RTC_XTALI                     |         |
| AD06 | RTC_XTALO     | VDD_SNV5_1P8_CAP |                        |                           | RTC_XTALO                     |         |
| E10  | SAI1_MCLK     | NVCC_SAI         | GPIO                   | ALT5                      | GPIO6_IO[18]                  | 100K PD |
| D12  | SAI1_RXC      | NVCC_SAI         | GPIO                   | ALT5                      | GPIO6_IO[17]                  | 100K PD |
| E12  | SAI1_RXD      | NVCC_SAI         | GPIO                   | ALT5                      | GPIO6_IO[12]                  | 100K PD |
| C12  | SAI1_RXFS     | NVCC_SAI         | GPIO                   | ALT5                      | GPIO6_IO[16]                  | 100K PD |
| C11  | SAI1_TXC      | NVCC_SAI         | GPIO                   | ALT5                      | GPIO6_IO[13]                  | 100K PD |
| E11  | SAI1_TXD      | NVCC_SAI         | GPIO                   | ALT5                      | GPIO6_IO[15]                  | 100K PD |
| D11  | SAI1_TXFS     | NVCC_SAI         | GPIO                   | ALT5                      | GPIO6_IO[14]                  | 100K PD |
| E09  | SAI2_RXD      | NVCC_SAI         | GPIO                   | ALT5                      | GPIO6_IO[21]                  | 100K PD |
| D08  | SAI2_TXC      | NVCC_SAI         | GPIO                   | ALT5                      | GPIO6_IO[20]                  | 100K PD |
| E08  | SAI2_TXD      | NVCC_SAI         | GPIO                   | ALT5                      | GPIO6_IO[22]                  | 100K PD |

Table 95. i.MX 7Solo 19 x 19 mm functional contact assignments (continued)

| Ball | Ball Name        | Power Group       | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|------------------|-------------------|------------------------|---------------------------|-------------------------------|---------|
| D09  | SAI2_TXFS        | NVCC_SAI          | GPIO                   | ALT5                      | GPIO6_IO[19]                  | 100K PD |
| C06  | SD1_CD_B         | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[0]                   | 100K PD |
| B05  | SD1_CLK          | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[3]                   | 100K PD |
| C05  | SD1_CMD          | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[4]                   | 100K PD |
| A05  | SD1_DATA0        | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[5]                   | 100K PD |
| D06  | SD1_DATA1        | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[6]                   | 100K PD |
| A04  | SD1_DATA2        | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[7]                   | 100K PD |
| D05  | SD1_DATA3        | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[8]                   | 100K PD |
| B04  | SD1_RESET_B      | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[2]                   | 100K PD |
| C04  | SD1_WP           | NVCC_SD1          | GPIO                   | ALT5                      | GPIO5_IO[1]                   | 100K PD |
| E03  | SD2_CLK          | NVCC_SD2          | GPIO                   | ALT5                      | GPIO5_IO[12]                  | 100K PD |
| F06  | SD2_CMD          | NVCC_SD2          | GPIO                   | ALT5                      | GPIO5_IO[13]                  | 100K PD |
| E04  | SD2_DATA0        | NVCC_SD2          | GPIO                   | ALT5                      | GPIO5_IO[14]                  | 100K PD |
| E05  | SD2_DATA1        | NVCC_SD2          | GPIO                   | ALT5                      | GPIO5_IO[15]                  | 100K PD |
| F05  | SD2_DATA2        | NVCC_SD2          | GPIO                   | ALT5                      | GPIO5_IO[16]                  | 100K PD |
| E06  | SD2_DATA3        | NVCC_SD2          | GPIO                   | ALT5                      | GPIO5_IO[17]                  | 100K PD |
| G03  | SD2_RESET_B      | NVCC_SD2          | GPIO                   | ALT5                      | GPIO5_IO[11]                  | 100K PD |
| C03  | SD2_WP           | NVCC_SD2          | GPIO                   | ALT5                      | GPIO5_IO[10]                  | 100K PD |
| C01  | SD3_CLK          | NVCC_SD3          | GPIO                   | ALT5                      | GPIO6_IO[0]                   | 100K PD |
| E01  | SD3_CMD          | NVCC_SD3          | GPIO                   | ALT5                      | GPIO6_IO[1]                   | 100K PD |
| B02  | SD3_DATA0        | NVCC_SD3          | GPIO                   | ALT5                      | GPIO6_IO[2]                   | 100K PD |
| A02  | SD3_DATA1        | NVCC_SD3          | GPIO                   | ALT5                      | GPIO6_IO[3]                   | 100K PD |
| G02  | SD3_DATA2        | NVCC_SD3          | GPIO                   | ALT5                      | GPIO6_IO[4]                   | 100K PD |
| F01  | SD3_DATA3        | NVCC_SD3          | GPIO                   | ALT5                      | GPIO6_IO[5]                   | 100K PD |
| F02  | SD3_DATA4        | NVCC_SD3          | GPIO                   | ALT5                      | GPIO6_IO[6]                   | 100K PD |
| E02  | SD3_DATA5        | NVCC_SD3          | GPIO                   | ALT5                      | GPIO6_IO[7]                   | 100K PD |
| C02  | SD3_DATA6        | NVCC_SD3          | GPIO                   | ALT5                      | GPIO6_IO[8]                   | 100K PD |
| B01  | SD3_DATA7        | NVCC_SD3          | GPIO                   | ALT5                      | GPIO6_IO[9]                   | 100K PD |
| G01  | SD3_RESET_B      | NVCC_SD3          | GPIO                   | ALT5                      | GPIO6_IO[11]                  | 100K PD |
| J01  | SD3_STROBE       | NVCC_SD3          | GPIO                   | ALT5                      | GPIO6_IO[10]                  | 100K PD |
| AB08 | SNVS_PMIC_ON_REQ | VDD_SNVS_IN       |                        |                           | SNVS_PMIC_ON_REQ              |         |
| AA07 | SNVS_TAMPER0     | VDDD_SNVS_1P8_CAP | Analog                 |                           | SNVS_TAMPER0                  |         |

Table 95. i.MX 7Solo 19 x 19 mm functional contact assignments (continued)

| Ball | Ball Name          | Power Group        | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU   |
|------|--------------------|--------------------|------------------------|---------------------------|-------------------------------|---------|
| Y08  | SNVS_TAMPER1       | VDD_SNVS_1P8_CAP   | Analog                 |                           | SNVS_TAMPER1                  |         |
| AB06 | SNVS_TAMPER2       | VDDD_SNVS_1P8_CAP  | Analog                 |                           | SNVS_TAMPER2                  |         |
| Y07  | SNVS_TAMPER3       | VDD_SNVS_1P8_CAP   | Analog                 |                           | SNVS_TAMPER3                  |         |
| AA05 | SNVS_TAMPER4       | VDDD_SNVS_1P8_CAP  | Analog                 |                           | SNVS_TAMPER4                  |         |
| Y05  | SNVS_TAMPER5       | VDD_SNVS_1P8_CAP   | Analog                 |                           | SNVS_TAMPER5                  |         |
| AA04 | SNVS_TAMPER6       | VDDD_SNVS_1P8_CAP  | Analog                 |                           | SNVS_TAMPER6                  |         |
| Y04  | SNVS_TAMPER7       | VDD_SNVS_1P8_CAP   | Analog                 |                           | SNVS_TAMPER7                  |         |
| AA03 | SNVS_TAMPER8       | VDDD_SNVS_1P8_CAP  | Analog                 |                           | SNVS_TAMPER8                  |         |
| Y03  | SNVS_TAMPER9       | VDD_SNVS_1P8_CAP   | Analog                 |                           | SNVS_TAMPER9                  |         |
| AE04 | TEMPSENSOR_REXT    | VDD_TEMPSENSOR_1P8 |                        |                           | TEMPSENSOR_REXT               |         |
| AD04 | TEMPSENSOR_RESERVE | VDD_TEMPSENSOR_1P8 |                        |                           | TEMPSENSOR_RESERVE            |         |
| P06  | TEST_MODE          | NVCC_GPIO1         | GPIO                   | ALT0                      | TEST_MODE                     | 100K PD |
| L03  | UART1_RXD          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[0]                   | 100K PD |
| L04  | UART1_TXD          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[1]                   | 100K PD |
| L05  | UART2_RXD          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[2]                   | 100K PD |
| L06  | UART2_TXD          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[3]                   | 100K PD |
| M06  | UART3_CTS          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[7]                   | 100K PD |
| M05  | UART3_RTS          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[6]                   | 100K PD |
| M01  | UART3_RXD          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[4]                   | 100K PD |
| M02  | UART3_TXD          | NVCC_UART          | GPIO                   | ALT5                      | GPIO4_IO[5]                   | 100K PD |
| A12  | USB_H_DATA         | USB_H_VDD_1P2      |                        |                           | USB_H_DATA                    |         |
| B12  | USB_H_STROBE       | USB_H_VDD_1P2      |                        |                           | USB_H_STROBE                  |         |
| C07  | USB_OTG1_CHD_B     | USB_OTG1_VDDA_3P3  |                        |                           | USB_OTG1_CHD_B                |         |
| A08  | USB_OTG1_DN        | USB_OTG1_VDDA_3P3  |                        |                           | USB_OTG1_DN                   |         |
| B08  | USB_OTG1_DP        | USB_OTG1_VDDA_3P3  |                        |                           | USB_OTG1_DP                   |         |
| B07  | USB_OTG1_ID        | USB_OTG1_VDDA_3P3  |                        |                           | USB_OTG1_ID                   |         |
| A07  | USB_OTG1_REXT      | USB_OTG1_VDDA_3P3  |                        |                           | USB_OTG1_REXT                 |         |
| A10  | NC                 | NC                 |                        |                           | NC                            |         |
| B10  | NC                 | NC                 |                        |                           | NC                            |         |
| B11  | NC                 | NC                 |                        |                           | NC                            |         |
| A11  | NC                 | NC                 |                        |                           | NC                            |         |

Table 95. i.MX 7Solo 19 x 19 mm functional contact assignments (continued)

| Ball | Ball Name | Power Group | Ball type <sup>1</sup> | Default Mode <sup>1</sup> | Default Function <sup>1</sup> | PD/PU |
|------|-----------|-------------|------------------------|---------------------------|-------------------------------|-------|
| V01  | XTALI     | VDDA_1P8    |                        |                           | XTALI                         |       |
| V02  | XTALO     | VDDA_1P8    |                        |                           | XTALO                         |       |

<sup>1</sup> The state immediately after RESET and before ROM firmware or software has executed.

### 6.2.3 Case “Y”, i.MX 7Solo 19 × 19 mm 0.75 mm pitch ball map

The following table shows the i.MX 7Solo 19 × 19 mm, 0.75 mm pitch ball map.

Table 96. i.MX 7Solo 19 × 19 mm, 0.75 mm pitch ball map

|    | 1              | 2              | 3              | 4            | 5            | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 | 17 | 18 | 19 | 20 | 21 | 22 | 23 | 24 | 25 |   |
|----|----------------|----------------|----------------|--------------|--------------|---|---|---|---|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|---|
|    | A              | B              | C              | D            | E            |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    | A |
| 1  | VSS            | SD3_DATA7      | SD3_CLK        | VSS          | SD3_CMD      |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 2  | SD3_DATA1      | SD3_DATA0      | SD3_DATA6      | VSS          | SD3_DATA5    |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 3  | VSS            | VSS            | SD2_WP         | SD2_CD_B     | SD2_CLK      |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 4  | SD1_DATA2      | SD1_RESET_B    | SD1_WP         | VSS          | SD2_DATA0    |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 5  | SD1_DATA0      | SD1_CLK        | SD1_CMD        | SD1_DATA3    | SD2_DATA1    |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 6  | VSS            | VSS            | SD1_CD_B       | SD1_DATA1    | SD2_DATA3    |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 7  | USB_OTG1_REXT  | USB_OTG1_ID    | USB_OTG1_CHD_B | VSS          | NVCC_SD1     |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 8  | USB_OTG1_DN    | USB_OTG1_DP    | USB_OTG1_VBUS  | SAI2_TXC     | SAI2_TXD     |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 9  | VSS            | VSS            | VSS            | SAI2_TXFS    | SAI2_RXD     |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 10 | NC             | NC             | NC             | VSS          | SAI1_MCLK    |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 11 | NC             | NC             | SAI1_TXC       | SAI1_TXFS    | SAI1_TXD     |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 12 | USB_H_DATA     | USB_H_STROBE   | SAI1_RXFS      | SAI1_RXC     | SAI1_RXD     |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 13 | VSS            | VSS            | VSS            | ENET1_RDATA2 | ENET1_RDATA3 |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 14 | MIPI_CSI_D1_N  | MIPI_CSI_D1_P  | VDD_SOC        | VDD_SOC      | ENET1_RD0    |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 15 | MIPI_CSI_CLK_N | MIPI_CSI_CLK_P | VSS            | ENET1_RX_CLK | ENET1_RX_CTL |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 16 | MIPI_CSI_D0_N  | MIPI_CSI_D0_P  | VSS            | ENET1_TX_CLK | ENET1_TX_CTL |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 17 | VSS            | VSS            | VDD_ARM        | VDD_ARM      | ENET1_TDATA1 |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 18 | MIPI_DSI_D1_N  | MIPI_DSI_D1_P  | VSS            | ENET1_TDATA3 | ENET1_TDATA2 |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 19 | MIPI_DSI_CLK_N | MIPI_DSI_CLK_P | VSS            | ENET1_COL    | ENET1_CRS    |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 20 | MIPI_DSI_D0_N  | MIPI_DSI_D0_P  | VDD_ARM        | VDD_ARM      | LCD1_CLK     |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 21 | VSS            | VSS            | LCD1_RESET     | LCD1_DATA00  | LCD1_DATA08  |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 22 | LCD1_DATA01    | LCD1_DATA02    | LCD1_DATA04    | VSS          | LCD1_DATA13  |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 23 | LCD1_DATA03    | LCD1_DATA05    | LCD1_DATA09    | LCD1_DATA14  | LCD1_DATA18  |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 24 | LCD1_DATA06    | LCD1_DATA10    | LCD1_DATA15    | LCD1_DATA19  | LCD1_DATA21  |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
| 25 | VSS            | LCD1_DATA16    | LCD1_DATA20    | LCD1_DATA22  | LCD1_HSYNC   |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |
|    | A              | B              | C              | D            | E            |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |   |

**Table 96. i.MX 7Solo 19 × 19 mm, 0.75 mm pitch ball map (continued)**

|    | Σ            | Γ            | κ             | ι               | Ξ                    | ϙ           | π                   |    |
|----|--------------|--------------|---------------|-----------------|----------------------|-------------|---------------------|----|
| 1  | UART3_RXD    | I2C4_SCL     | I2C1_SDA      | SD3_STROBE      | VSS                  | SD3_RESET_B | SD3_DATA3           | 1  |
| 2  | UART3_TXD    | I2C4_SDA     | I2C2_SCL      | I2C1_SCL        | VSS                  | SD3_DATA2   | SD3_DATA4           | 2  |
| 3  | VDD_SOC      | UART1_RXD    | I2C2_SDA      | VDD_SOC         | ECSP11_SCLK          | SD2_RESET_B | VDD_SOC             | 3  |
| 4  | VDD_SOC      | UART1_TXD    | VSS           | VDD_SOC         | ECSP11_MISO          | VSS         | VDD_SOC             | 4  |
| 5  | UART3_RTS    | UART2_RXD    | I2C3_SCL      | ECSP12_SCLK     | ECSP11_SS0           | ECSP11_MOSI | SD2_DATA2           | 5  |
| 6  | UART3_CTS    | UART2_TXD    | I2C3_SDA      | ECSP12_SS0      | ECSP12_MISO          | ECSP12_MOSI | SD2_CMD             | 6  |
| 7  |              | VSS          |               | VSS             |                      | VSS         | VSS                 | 7  |
| 8  | NVCC_I2C     |              | NVCC_SD3      |                 | NVCC_SD2             |             | VSS                 | 8  |
| 9  |              | NVCC_SPI     |               | PVCC_SAI_SD_CAP |                      | VSS         | VSS                 | 9  |
| 10 | VSS          |              | VSS           |                 | VDD_USB_OTG1_1P0_CAP |             | VDD_USB_OTG1_3P3_IN | 10 |
| 11 |              | VSS          |               | VSS             |                      | VSS         | VSS                 | 11 |
| 12 | VSS          |              | VSS           |                 | VDD_USB_H_1P2        |             | NVCC_SAI            | 12 |
| 13 |              | VSS          |               | VDDA_MIPI_1P8   |                      | VSS         | VSS                 | 13 |
| 14 | VSS          |              | VSS           |                 | PVCC_ENET_CAP        |             | ENET1_RDATA1        | 14 |
| 15 |              | VSS          |               | VDD_MIPI_1P0    |                      | VSS         | ENET1_RXC           | 15 |
| 16 | VSS          |              | VSS           |                 | NVCC_ENET1           |             | ENET1_TXC           | 16 |
| 17 |              | NVCC_EPDC2   |               | VDD_MIPI_1P0    |                      | VSS         | ENET1_TD0           | 17 |
| 18 | NVCC_EPDC1   |              | NVCC_LCD      |                 | MIPI_VREG_0P4V       |             | VDD_SOC             | 18 |
| 19 |              | VSS          |               | VSS             |                      | VSS         | VDD_SOC             | 19 |
| 20 | EPDC1_DATA05 | EPDC1_DATA14 | EPDC1_PWRSTAT | EPDC1_SDLE      | EPDC1_SDSHR          | LCD1_DATA11 | LCD1_DATA07         | 20 |
| 21 | EPDC1_DATA06 | EPDC1_DATA13 | EPDC1_GDRL    | EPDC1_SDCLK     | EPDC1_SDOE           | LCD1_DATA17 | LCD1_DATA12         | 21 |
| 22 | EPDC1_DATA07 | EPDC1_DATA12 | VSS           | VDD_ARM         | EPDC1_SDCE3          | VSS         | VDD_ARM             | 22 |
| 23 | EPDC1_DATA08 | EPDC1_DATA11 | EPDC1_BDR1    | VDD_ARM         | EPDC1_SDCE2          | LCD1_DATA23 | VDD_ARM             | 23 |
| 24 | VSS          | EPDC1_DATA10 | EPDC1_BDR0    | EPDC1_GDOE      | EPDC1_PWRCOM         | EPDC1_SDCE1 | LCD1_VSYNC          | 24 |
| 25 | VSS          | EPDC1_DATA09 | EPDC1_DATA15  | EPDC1_GDCLK     | EPDC1_GDSP           | EPDC1_SDCE0 | LCD1_ENABLE         | 25 |
|    | Σ            | Γ            | κ             | ι               | Ξ                    | ϙ           | π                   |    |

Table 96. i.MX 7Solo 19 × 19 mm, 0.75 mm pitch ball map (continued)

|    | W           | V             | C           | T            | R                     | P            | Z                 |
|----|-------------|---------------|-------------|--------------|-----------------------|--------------|-------------------|
| 1  | VSS         | XTALI         | JTAG_MOD    | GPIO1_IO11   | GPIO1_IO08            | GPIO1_IO05   | GPIO1_IO00        |
| 2  | VSS         | XTALO         | JTAG_TRST_B | GPIO1_IO12   | GPIO1_IO09            | GPIO1_IO06   | GPIO1_IO01        |
| 3  | CCM_CLK2    | VDDA_1P0_CAP  | JTAG_TDI    | GPIO1_IO13   | VDD_SOC               | GPIO1_IO07   | GPIO1_IO02        |
| 4  | VSS         | GPANAIO       | JTAG_TMS    | VSS          | VDD_SOC               | BOOT_MODE0   | VSS               |
| 5  | VDDA_1P8_IN | VDD_XTAL_1P8  | JTAG_TCK    | GPIO1_IO14   | GPIO1_IO10            | BOOT_MODE1   | GPIO1_IO03        |
| 6  | VDD_LPSR_IN | VDDA_1P8_IN   | JTAG_TDO    | GPIO1_IO15   | POR_B                 | TEST_MODE    | GPIO1_IO04        |
| 7  | VSS         |               | VSS         |              | VSS                   |              | VSS               |
| 8  |             | FUSE_FSOURCE  |             | NVCC_GPIO2   |                       | NVCC_GPIO1   |                   |
| 9  | VSS         |               | VDD_1P2_CAP |              | PVCC_I2C_SPI_UART_CAP |              | NVCC_UART         |
| 10 |             | PVCC_GPIO_CAP |             | VSS          |                       | VSS          |                   |
| 11 | VSS         |               | VSS         |              | VSS                   |              | VSS               |
| 12 |             | VDD_SOC       |             | VSS          |                       | VSS          |                   |
| 13 | VSS         |               | VDD_SOC     |              | VSS                   |              | VSS               |
| 14 |             | VDD_SOC       |             | VSS          |                       | VSS          |                   |
| 15 | VSS         |               | VDD_SOC     |              | VSS                   |              | VSS               |
| 16 |             | VDD_SOC       |             | VSS          |                       | VSS          |                   |
| 17 | VSS         |               | VDD_SOC     |              | VDD_SOC               |              | PVCC_EPDC_LCD_CAP |
| 18 |             | VDD_SOC       |             | VDD_SOC      |                       | VDD_SOC      |                   |
| 19 | VSS         |               | VSS         |              | VSS                   |              | VSS               |
| 20 | VSS         | VSS           | VSS         | VSS          | VSS                   | EPDC_D00     | EPDC1_DATA02      |
| 21 | NVCC_DRAM   | NVCC_DRAM     | NVCC_DRAM   | NVCC_DRAM    | VSS                   | EPDC1_DATA01 | EPDC1_DATA03      |
| 22 | DRAM_ADDR08 | DRAM_ADDR06   | DRAM_ADDR11 | DRAM_ADDR12  | DRAM_SDBA0            | DRAM_SDBA1   | EPDC1_DATA04      |
| 23 | VSS         | DRAM_ADDR09   | VSS         | DRAM_ADDR10  | VSS                   | DRAM_ADDR13  | DRAM_SDBA2        |
| 24 | DRAM_DATA17 | DRAM_DATA31   | DRAM_DATA30 | DRAM_SDQS3_P | DRAM_DATA29           | DRAM_DQM3    | DRAM_DATA25       |
| 25 | DRAM_DATA19 | DRAM_DATA18   | DRAM_DATA28 | DRAM_SDQS3_N | DRAM_DATA24           | DRAM_DATA26  | DRAM_DATA27       |
|    | W           | V             | C           | T            | R                     | P            | Z                 |

Table 96. i.MX 7Solo 19 × 19 mm, 0.75 mm pitch ball map (continued)

|    | AE                | AD                 | AC                 | AB               | AA            | Y             |
|----|-------------------|--------------------|--------------------|------------------|---------------|---------------|
| 1  | VSS               | ADC1_IN0           | ADC2_IN0           | ADC2_IN2         | VSS           | CCM_CLK1_N    |
| 2  | ADC1_IN2          | VSS                | ADC2_IN1           | ADC2_IN3         | VSS           | CCM_CLK1_P    |
| 3  | ADC1_IN3          | ADC1_IN1           | VDDA_ADC1_1P8      | VDDA_ADC2_1P8    | SNVS_TAMPER08 | SNVS_TAMPER09 |
| 4  | TEMPSENSOR_REXT   | TEMPSENSOR_RESERVE | VDD_TEMPSENSOR_1P8 | VSS              | SNVS_TAMPER06 | SNVS_TAMPER07 |
| 5  | VSS               | VSS                | VDD_LPSR_1P0_CAP   | VSS              | SNVS_TAMPER04 | SNVS_TAMPER05 |
| 6  | RTC_XTALI         | RTC_XTALO          | VSS                | SNVS_TAMPER02    | VSS           | VSS           |
| 7  | VSS               | VSS                | PMIC_STBY_REQ      | VSS              | SNVS_TAMPER00 | SNVS_TAMPER03 |
| 8  | VDD_SNVIS_1P8_CAP | VDD_SNVIS_IN       | ONOFF              | SNVS_PMIC_ON_REQ | VSS           | SNVS_TAMPER01 |
| 9  | VSS               | VSS                | VSS                | VSS              | VDDD_1P0_CAP  | VDDA_PHY_1P8  |
| 10 | NC                | NC                 | NC                 | NC               | NC            | NC            |
| 11 | NC                | NC                 | NC                 | NC               | NC            | NC            |
| 12 | VSS               | VSS                | VSS                | VSS              | NC            | NC            |
| 13 | DRAM_DATA15       | DRAM_DATA14        | DRAM_VREF          | DRAM_ZQPAD       | VSS           | VSS           |
| 14 | DRAM_DATA08       | DRAM_DATA13        | DRAM_CAS_B         | DRAM_SDWE_B      | DRAM_ODT1     | VSS           |
| 15 | DRAM_SDQS1_N      | DRAM_SDQS1_P       | VSS                | DRAM_RAS_B       | VSS           | VSS           |
| 16 | DRAM_DATA12       | DRAM_DATA11        | DRAM_ODT0          | DRAM_ADDR01      | NVCC_DRAM     | VSS           |
| 17 | DRAM_DATA10       | DRAM_DQM1          | VSS                | DRAM_SDCKE0      | NVCC_DRAM     | VSS           |
| 18 | DRAM_DATA09       | DRAM_DATA06        | DRAM_ADDR02        | DRAM_ADDR14      | NVCC_DRAM     | VSS           |
| 19 | DRAM_DATA07       | DRAM_DATA05        | VSS                | DRAM_ADDR00      | NVCC_DRAM     | VSS           |
| 20 | DRAM_DATA02       | DRAM_DQM0          | DRAM_ADDR03        | DRAM_ADDR15      | NVCC_DRAM     | NVCC_DRAM_CKE |
| 21 | DRAM_SDQS0_P      | DRAM_SDQS0_N       | VSS                | DRAM_ADDR04      | NVCC_DRAM     | NVCC_DRAM     |
| 22 | DRAM_DATA04       | DRAM_DATA00        | DRAM_RESET         | DRAM_SDCKE1      | DRAM_CS1_B    | DRAM_ADDR07   |
| 23 | DRAM_DATA03       | DRAM_DATA01        | VSS                | DRAM_CS0_B       | VSS           | DRAM_ADDR05   |
| 24 | VSS               | DRAM_SDCLK0_P      | DRAM_DATA23        | DRAM_DATA22      | DRAM_DQM2     | DRAM_SDQS2_P  |
| 25 | VSS               | DRAM_SDCLK0_N      | DRAM_DATA20        | DRAM_DATA21      | DRAM_DATA16   | DRAM_SDQS2_N  |
|    | AE                | AD                 | AC                 | AB               | AA            | Y             |

## 7 Release notes

Table 97 provides release notes for this data sheet.

**Table 97. Release notes**

| Rev. Number | Date   | Substantive Change(s)                                                                                                       |
|-------------|--------|-----------------------------------------------------------------------------------------------------------------------------|
| Rev. 6      | 2/2019 | <ul style="list-style-type: none"><li>In Table 12, “Maximum supply currents,” updated maximum value for DRAM_VREF</li></ul> |

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Document Number: IMX7SCEC

Rev. 6

03/2019

